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Programmable Logic Controller

XGK CPU Module

XGT Series

User's Manual

XGK-CPUUN

XGK-CPUHN

XGK-CPUSN

XGK-CPUU

XGK-CPUH

XGK-CPUA

XGK-CPUS

XGK-CPUE



Safety Instructions

- Read this manual carefully before installing, wiring, operating, servicing or inspecting this equipment.
- Keep this manual within easy reach for quick reference.



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Before using the product ...

For your safety and effective operation, please read the safety instructions thoroughly before using the product.

- Safety Instructions should always be observed in order to prevent accident or risk with the safe and proper use the product.
- ► Instructions are separated into "Warning" and "Caution", and the meaning of the terms is as follows:

Warning

WARNING indicates a potentially hazardous situation which, if not avoided, could result in death or serious injury



CAUTION indicates a potentially hazardous situation which, if not avoided, may result in minor or moderate injury. It may also be used to alert against unsafe practices

► The marks displayed on the product and in the user's manual have the following meanings.



/!\ Be careful! Danger may be expected.



/\frac{1}{2} Be careful! Electric shock may occur.

► The user's manual even after read shall be kept available and accessible to any user of the product.

Safety Instructions when designing

Warning

- Please, install protection circuit on the exterior of PLC to protect the whole control system from any error in external power or PLC module. Any abnormal output or operation may cause serious problem in safety of the whole system.
 - Install applicable protection unit on the exterior of PLC to protect the system from physical damage such as emergent stop switch, protection circuit, the upper/lowest limit switch, forward/reverse operation interlock circuit, etc.
 - If any system error (watch-dog timer error, module installation error, etc.) is detected during CPU operation in PLC, the whole output is designed to be turned off and stopped for system safety. However, in case CPU error if caused on output device itself such as relay or TR can not be detected, the output may be kept on, which may cause serious problems. Thus, you are recommended to install an addition circuit to monitor the output status.
- Never connect the overload than rated to the output module nor allow the output circuit to have a short circuit, which may cause a fire.
- Never let the external power of the output circuit be designed to be On earlier than PLC power, which may cause abnormal output or operation.
- In case of data exchange between computer or other external equipment and PLC through communication or any operation of PLC (e.g. operation mode change), please install interlock in the sequence program to protect the system from any error. If not, it may cause abnormal output or operation.

Safety Instructions when designing

► I/O signal or communication line shall be wired at least 100mm away from a high-voltage cable or power line. If not, it may cause abnormal output or operation.

Safety Instructions when designing

- ▶ Use PLC only in the environment specified in PLC manual or general standard of data sheet. If not, electric shock, fire, abnormal operation of the product or flames may be caused.
- ▶ Before installing the module, be sure PLC power is off. If not, electric shock or damage on the product may be caused.
- ▶ Be sure that each module of PLC is correctly secured. If the product is installed loosely or incorrectly, abnormal operation, error or dropping may be caused.
- ▶ Be sure that I/O or extension connecter is correctly secured. If not, electric shock, fire or abnormal operation may be caused.
- ▶ If lots of vibration is expected in the installation environment, don't let PLC directly vibrated. Electric shock, fire or abnormal operation may be caused.
- ▶ Don't let any metallic foreign materials inside the product, which may cause electric shock, fire or abnormal operation..

Safety Instructions when wiring

Warning

- Prior to wiring, be sure that power of PLC and external power is turned off. If not, electric shock or damage on the product may be caused.
- ▶ Before PLC system is powered on, be sure that all the covers of the terminal are securely closed. If not, electric shock may be caused

⚠ Caution

- ▶ Let the wiring installed correctly after checking the voltage rated of each product and the arrangement of terminals. If not, fire, electric shock or abnormal operation may be caused.
- ▶ Secure the screws of terminals tightly with specified torque when wiring. If the screws of terminals get loose, short circuit, fire or abnormal operation may be caused.
- Surely use the ground wire of Class 3 for PE terminals, which is exclusively used for PLC. If the terminals not grounded correctly, abnormal operation may be caused.
- ▶ Don't let any foreign materials such as wiring waste inside the module while wiring, which may cause fire, damage on the product or abnormal operation.

Safety Instructions for test-operation or repair

Warning

- ▶ Don't touch the terminal when powered. Electric shock or abnormal operation may occur.
- Prior to cleaning or tightening the terminal screws, let all the external power off including PLC power. If not, electric shock or abnormal operation may occur.
- ▶ Don't let the battery recharged, disassembled, heated, short or soldered. Heat, explosion or ignition may cause injuries or fire.

- ▶ Don't remove PCB from the module case nor remodel the module. Fire, electric shock or abnormal operation may occur.
- Prior to installing or disassembling the module, let all the external power off including PLC power. If not, electric shock or abnormal operation may occur.
- ▶ Keep any wireless installations or cell phone at least 30cm away from PLC. If not, abnormal operation may be caused.

Safety Instructions for waste disposal

⚠ Caution

▶ Product or battery waste shall be processed as industrial waste.

The waste may discharge toxic materials or explode itself.

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Revision History

| Version | Date | Contents | Chapter |
|--|---------|---|---|
| V 1.0 | 2006. 2 | First Edition | - |
| 1. XGK-CPUU added 2. Fnet -> Rnet modified 3. Scan Time modified 4. Interrupt module removed 5. Clock data F device modified 6. Heavy error/light error modified 7. Fault mask -> "Release by program" removed 8. Skip function -> "Release by program" removed 9. Product list modified | | Ch1.1, Ch2.3.1, Ch2.4.1, Ch4.1 Ch1.3 Ch5.1.3 Ch7.1 Ch6.2 Ch6.7 Ch6.8 Ch6.9 Ch2.2 | |
| | | 10. Program language SFC, ST added11. XGQ-SOEA added12. Flag list modified | Ch4.1 Ch7.5 Appendix 1 |
| V1.6 | 2010.3 | 1. Product list modified 2. Supported functions according to OS version 3. Description on Reset/D.Clear switch added 4. Wiring diagram of Smart Link added 5. Flag added (indicated version to decimal places _OS_VER_PATCH) 6. Typos fixed | Ch2.2, Ch2.4.2 Ch4.1 Ch4.2 Ch7.6.3 App1.1 Ch1.1, Ch1.2, Ch1.3 Ch3.1, Ch4.1 Ch5.2.3, Ch5.5 Ch8.1 Ch10.3, Ch10.7 CH12.2, 12.3 |
| V1.7 | 2013.1 | 1. Product list modified 2. Size of data refresh area added 3. Supported functions according to CPU OS version added 4. Fixed cycle task's flag information added 5. Digital I/O module added XGI-A21C, XGQ-TR1C 6. Flag added | Ch2.2 Ch2.3.5 Ch4.1 Ch5.2.3 Ch7.2.10 Ch7.3.11 App1.1 |

| Version | Date | Contents | Chapter |
|---------|---------|---|--|
| V 1.8 | 2015. 2 | 1.CPU Module Added (XGK-CPUUN, XGK-CPUHN, XGK-CPUSN) | 1.2, 2.2, 2.3, 2.4, 4.1, 4.2, 5.1.3, 5.4.1, 5.4.2 5.5, 6.13, 8.1, Appendix1.1 |
| V 1.9 | 2015. 9 | Circuit configuration modified Smart Link Model name modified Rated input voltage modified Terminology modified (FG → PE) CPU Processing Speed Unit changed (us → ns) List of Configuration Products updated | 7.2, 7.3, 7.4, 7.5 7.6 8.2 8.3, 9.1, 9.2, 11.2, 13.1 1.2, 4.1 2.2 |
| V 2.0 | 2016. 3 | 1. Smart Link manual supplemented | 7.6 |

 $[\]divideontimes$ The number of User's manual is indicated right part of the back cover.

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About User's Manual

Thank you for purchasing PLC of LS Industrial System Co., Ltd.

Before use, make sure to carefully read and understand the User's Manual about the functions, performances, installation and programming of the product you purchased in order for correct use and importantly, let the end user and maintenance administrator to be provided with the User's Manual.

The User's Manual describes the product. If necessary, you may refer to the following description and order accordingly. In addition, you may connect our website(http://www.lsis.com/) and download the information as a PDF file.

Relevant User's Manuals

| Title | Description | No. of User's Manual |
|--------------------------------------|---|-------------------------|
| XGK / XGB Instructions & Programming | It is the user's manual for programming to explain how to use commands that are used PLC system with XGK CPU and XGB CPU. | 10310000510 |
| XG5000 | It describes how to use XG5000 software especially about online functions such as programming, printing, monitoring and debugging by using XGT series products. | 10310000512 |

Chapter 1 Introduction

1.1 Overview

This User's Manual provides the information for the specification, performance and operation method of each product required to use a PLC system configured by XGK series CPU modules.

The configuration of User's Manual is as follows:

| Chapter | Items | Description | | | |
|------------|--|---|--|--|--|
| Chapter 1 | Overview | Describes the configuration of this user's manual, product characteristics and terminology. | | | |
| Chapter 2 | System Configuration | Describes the product type and system configuration method to be used for XGK series. | | | |
| Chapter 3 | General Specifications | Shows the common specification of each module used for XGK series. | | | |
| Chapter 4 | CPU Module | | | | |
| Chapter 5 | Program Configuration and Operation Method | Describes the performance, specification and operation method of XGK-CPU | | | |
| Chapter 6 | Function of CPU Module | | | | |
| Chapter 7 | I/O Module | | | | |
| Chapter 8 | Power Module | Describes the specification and the method to use I/O module and power module except CPU module. | | | |
| Chapter 9 | Base and Extended Cable | | | | |
| Chapter 10 | Built-in PID | Describes on the built-in PID function | | | |
| Chapter 11 | Installation and Wiring | Describes the installation, wiring method and notices to secure the reliability of PLC system. | | | |
| Chapter 12 | Maintenance & Repair | Describes the checking items and methods to run the PLC system normally for a long time. | | | |
| Chapter 13 | EMC Directive | Summarizes the precautions on conformance to the EMC Directive of the machinery assembled using XGK series. | | | |
| Chapter 14 | Trouble Shooting | Describes various errors and action methods occurred while using a system. | | | |
| Appendix 1 | Flag List | Describes various type of each flag and its description. | | | |
| Appendix 2 | Dimensions | Shows the outer dimension of CPU, I/O module and Base. | | | |
| Appendix 3 | Compatibility with MASTER-K | | | | |

Notes

- 1) This user's manual does not describe the special/communication module and program writing method. For the corresponding function, please refer to the related user's manual.
- 2) XGK CPU is one of the XGT PLC system and CPU types of XGT PLC system are as follows.
 - ① XGK series: XGT PLC system that cosists of CPU using Master-K
 - ② XGI series: XGT PLC system that consists of single CPU using IEC language
 - ③ XGR series: XGT PLC system that consists of redundaccy CPU using IEC language

1.2 Characteristics

XGK system has the features as below.

1) Compact size

The function is extended to large sized but the size is reduced innovatively to make the installation in the small space for any purpose easily.

2) High speed processing

(1) XGK-CPUUN

• Sequence command: 8.5 ns

• MOV command: 25.5 ns

 Floating point arithmetic operation(the operation for the single real number and double real number accuracy is profoundly improved)

| Classification | + | _ | × | ÷ |
|----------------|--------|--------|--------|--------|
| Single Real | 183 ns | 183 ns | 336 ns | 345 ns |
| Double Real | 327 ns | 327 ns | 727 ns | 808 ns |

(2) XGK-CPUU

• Sequence command: 28 ns

• MOV command: 84 ns

• Floating point arithmetic operation

| Classification | + | - | × | ÷ |
|----------------|----------|----------|----------|----------|
| Single Real | 602 ns | 602 ns | 1,106 ns | 1,134 ns |
| Double Real | 1,078 ns | 1,078 ns | 2,394 ns | 2,660 ns |

(3) Improvement of data transfer speed between modules through base.

- 16 point I/O module data process: 200 ns ~ 800 ns
- Analogue 1 Ch data process: 200 ns ~ 800 ns
- 1 KB communication module data process: 12,800 ns
- Parallel process by I/O data auto refresh during programming

Convenience to use Analog Data

Analog module enforced the precision and stability and provides the convenience as below:

- Program simplification by providing analog data dedicated 'U ' device
- Setting without memory map of special module is available by providing parameter setting method.

4) System Configuration

Various convenient functions are provided to meet the demands of users.

- Filter value adjustment of input module
- Output hold at emergency time
- Varistor built-in relay output module with strong durability
- Total extension length of expanded base shall be 15m.
- Provides system RUN contact to power module.
- Cost efficiency of setup, startup and maintenance/repair by enforced self-diagnosis function

5) Various communication system

Provides various network function to satisfy both the user convenience and compatibility.

- Network opening available without writing a ladder program
- Network setting and operation status monitoring by dedicated tool(XG-PD)
- Supports Open network of various international specification
- Dedicated network to provide the ease in use and optimal performance
- Network compatibility with the existing products (MASTER-K, GLOFA-GM)

6) Enforcement of program and online function

Minimized the program writing time by providing the convenience of programming and available to complete the control system of equipment without stopping the system by enforcement of online function.

- Compatibility of ladder and text (Mnemonic) method
- Enforcement of symbolic program
- Automatic conversion of MASTER-K program
- Available to modify the program during operation and secure the stability
- Available to install and change the network during operation
- Enforcement of trend monitoring function
- User event function
- Data trace function

7) User's convenience

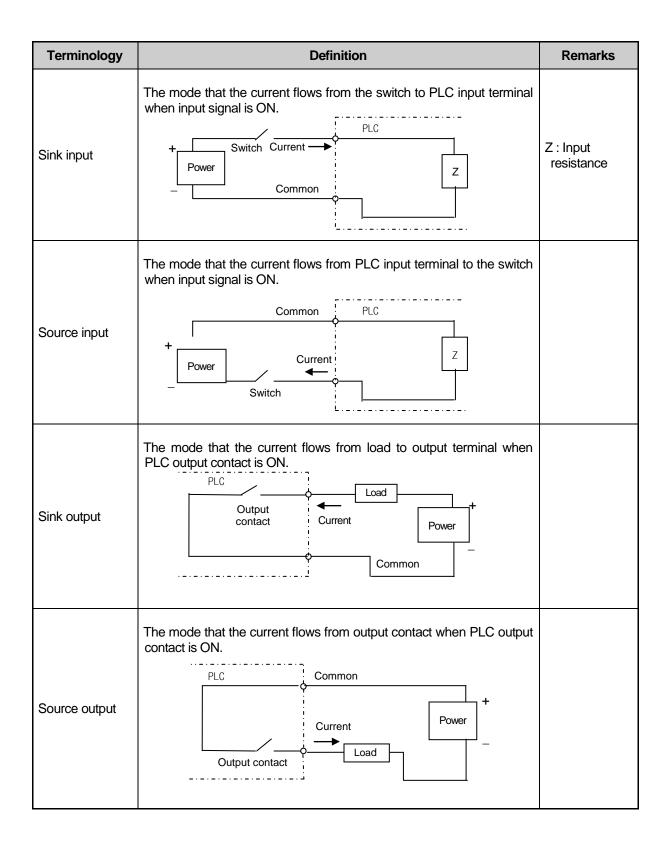
Various functions are provided for user's convenience.

- Module Changing Wizard (User's tool is unnecessary.)
- System Diagnosis
- Skip I/O
- Fault Mask
- I/O Allocation Method
- Various Operation History

1.3 Terminology

Here describes the terminology used in this user's manual.

| Terminology | Definition | Remarks |
|----------------|--|---|
| Module | A device like I/O board assembled to insert in a motherboard or base as a standardized factor having the regular function to configure the system. | Ex) CPU module, power module, I/O module etc. |
| Unit | A module or module aggregate which is the minimum unit in operation of PLC system. It configures the PLC system by connecting to other module or module aggregate. | Ex) Basic unit, Extended unit |
| PLC System | A system consisted of PLC and peripherals and which is configured to enable the control by user program | |
| XG 5000 | Graphic loader to carry out program writing, editing and debug function | |
| I/O image area | Internal memory area of CPU module installed to maintain the input and output state | |
| Rnet | Remote Network (Remote dedicated network) | |
| Fnet | Field bus Network | |
| RAPIEnet | Real-time Automation Protocols for Industrial Ethernet | |
| Cnet | Computer Network | |
| FEnet | Fast Ethernet Network | |
| Pnet | Profibus-DP Network | |
| Dnet | DeviceNet Network | |
| RTC | Real Time Clock. A general name of universal IC having the clock function | |
| Watchdog Timer | A timer to monitor the assigned running time of program and give an alarm if failed to complete the processing within the assigned time. | |
| Task | There are three kind of tasks. (cycle time task, internal device task, external device task by external interrupt module's input signal) | |

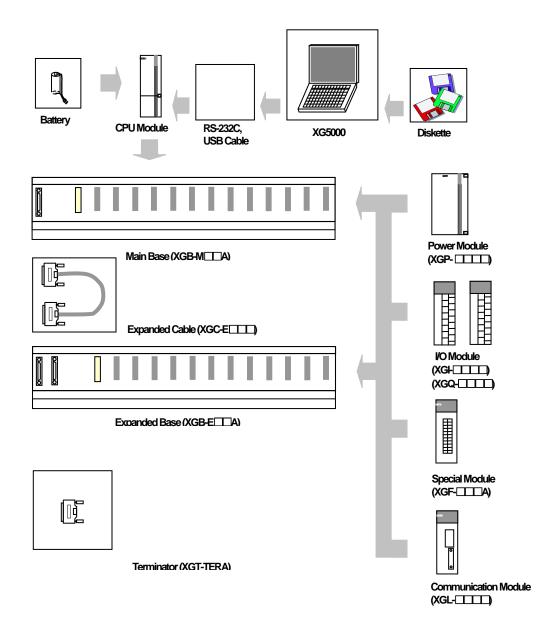


Chapter 2 System Configuration

XGT series are equipped with various products proper for basic system, computer link and network system configuration. Here describes the configuration method of each system and its features.

2.1 XGT Series System Configuration

XGT series system configuration is as below:



Recommendations of selecting USB Cable (To avoid disconnection with XG5000)

- 1. Recommend that the company's USB Cable(USB-301A) which is shielded and shorter than 3m.
- 2. Recommend using USB Hub when connecting up to the PC poor at Noise.

2.2 Configuration Products

The product configuration of XGK series is as below:

| Product | Model | Description | Remarks |
|-------------------------|-----------|---|----------|
| | XGK-CPUE | Standard type CPU module (Max I/O point: 1,536 points) | 16kstep |
| ODU Markula | XGK-CPUS | Standard type CPU module (Max I/O point: 3,072 points) | 32kstep |
| | XGK-CPUA | High speed type CPU module (Max. I/O point: 3,072 points) | 32kstep |
| | XGK-CPUH | High speed type CPU module (Max. I/O point: 6,144 points) | 64kstep |
| CPU Module | XGK-CPUU | High speed type CPU module (Max. I/O point: 6,144 points) | 128kstep |
| | XGK-CPUSN | High speed type CPU module (Max. I/O point: 3,072 points) | 64kstep |
| | XGK-CPUHN | High speed type CPU module (Max. I/O point: 6,144 points) | 128kstep |
| | XGK-CPUUN | High speed type CPU module (Max. I/O point: 6,144 points) | 256kstep |
| | XGI-D21A | DC 24V Input, 8 point (Current source / sink input) | - |
| | XGI-D21D | DC 24V Diagnostic Input, 8 point (Current sink input) | - |
| | XGI-D22A | DC 24V Input, 16 point (Current source / sink input) | - |
| | XGI-D24A | DC 24V Input, 32 point (Current source / sink input) | - |
| D: 11 . | XGI-D28A | DC 24V Input, 64 point (Current source / sink input) | - |
| Digital Input Module | XGI-D22B | DC 24V Input, 16 point (Current source input) | - |
| | XGI-D24B | DC 24V Input, 32 point (Current source input) | - |
| | XGI-D28B | DC 24V Input, 64 point (Current source input) | - |
| | XGI-A12A | AC 110V input, 16 point | - |
| | XGI-A21A | AC 220V input, 8 point | - |
| | XGI-A21C | AC 220V isolated input, 8 points | - |
| | XGQ-RY1A | Relay output, 8 point (for 2A, single COM.) | - |
| | XGQ-RY1D | Diagnostic Relay output, 8 point (for 2A, single COM.) | - |
| | XGQ-RY2A | Relay output, 16 point (for 2A) | - |
| | XGQ-RY2B | Relay output, 16 point (for 2A), Varistor attached | - |
| | XGQ-TR2A | Transistor output, 16 point (for 0.5A, Sink output) | - |
| Digital Output | XGQ-TR4A | Transistor output, 32 point (for 0.1A, Sink output) | - |
| Module | XGQ-TR8A | Transistor output, 64 point (for 0.1A, Sink output) | - |
| | XGQ-TR2B | Transistor output 16 point (for 0.5A, Source output) | - |
| | XGQ-TR4B | Transistor output 32 point (for 0.1A, Source output) | - |
| | XGQ-TR8B | Transistor output 64 point (for 0.1A, Source output) | - |
| | XGQ-SS2A | Triac output, 16 point (for 0.6A) | - |
| | XGQ-TR1C | Transistor isolated output, 8 points (2A) | - |
| Digital I/O Module | XGH-DT4A | DC 24V input, 16 point (current source / sink input) Transistor output, 16 point (for 0.1A, Sink output) | - |

| Product | Model | Desc | cription | Remarks | | | |
|----------------------|----------|------------------------------|--|---------------|--|--|--|
| | XGB-M04A | • for 4 module installation | | - | | | |
| Maio Dana | XGB-M06A | • for 6 module installation | | - | | | |
| Main Base | XGB-M08A | • for 8 module installation | | - | | | |
| | XGB-M12A | • for 12 module installation | | - | | | |
| | XGB-E04A | • for 4 module installation | • for 4 module installation | | | | |
| Expanded Base | XGB-E06A | • for 6 module installation | | - | | | |
| Expanded base | XGB-E08A | • for 8 module installation | | - | | | |
| | XGB-E12A | • for 12 module installation | • for 12 module installation | | | | |
| | XGP-ACF1 | AC100V~240V input | • DC5V: 3A, • DC24V: 0.6A | - | | | |
| Power module | XGP-ACF2 | AC100V~240V input | • DC5V: 6A | - | | | |
| Fower module | XGP-AC23 | AC100V~240V input | • DC5V: 8.5A | - | | | |
| | XGP-DC42 | DC24V Input | • DC5V: 6A | - | | | |
| | XGC-E041 | • Length: 0.4 m | | | | | |
| | XGC-E061 | • Length: 0.6 m | Total extension distance should not | | | | |
| | XGC-E121 | • Length: 1.2 m | | | | | |
| Extended cable | XGC-E301 | • Length: 3.0 m | | | | | |
| | XGC-E501 | • Length: 5.0 m | | exceed 15m | | | |
| | XGC-E102 | • Length: 10 m | 10111 | | | | |
| | XGC-E152 | • Length: 15 m | | | | | |
| Terminator | XGT-TERA | Must use for base expansion | - | | | | |
| Dust-proof Module | XGT-DMMA | Dust protection module for | - | | | | |
| Battery | XGT-BAT | Battery for XGT (DC 3.0V / | 1,800 mAh) | - | | | |

Chapter 2 System Configuration

| Product | Model | Description | Remarks |
|-------------------------------------|-----------|---|---------|
| | XGF-AV8A | Voltage Input: 8 channel DC 1 ~ 5V / 0 ~ 5V / 0 ~ 10V / -10 ~ +10V | - |
| | XGF-AC8A | Current Input: 8 channelDC 4 ~ 20mA / 0 ~ 20mA | - |
| A mala a facult | XGF-AD08A | Voltage/Current Input: 8 channels | - |
| Analog input Module | XGF-AD4S | Voltage/Current Input: 4 channels Insulation between channels | - |
| | XGF-AD16A | Voltage/Current Input: 16 channels | - |
| | XGF-AW4S | 2-wire voltage/current input: 4 –channel, insulation between channels 2-wire transmitter driver power supported | - |
| | XGF-DV4A | Voltage Output: 4 channels DC 1 ~ 5V / 0 ~ 5V / 0 ~ 10V / -10 ~ +10V | - |
| | XGF-DC4A | Current Output:: 4 channelsDC 4 ~ 20mA / 0 ~ 20mA | - |
| Analog output | XGF-DV4S | Current Output:: 4 channels Insulation between channels | - |
| Module | XGF-DC4S | Current Output:: 4 channels Insulation between channels | - |
| | XGF-DV8A | Voltage Output: 8 channels DC 1 ~ 5V / 0 ~ 5V / 0 ~ 10V / -10 ~ +10V | - |
| | XGF-DC8A | Current Output:: 8 channels DC 4 ~ 20mA / 0 ~ 20mA | - |
| Analog I/O Module | XGF-AH6A | Voltage/Current input 4 channels Voltage/Current output 2 channels | - |
| HART I/F Analog Input Module | XGF-AC4H | Current Input : 4 channel HART I/F, DC 4 ~ 20mA | - |
| HART I/F Analog Output Module | XGF-DC4H | Current Output: 4 channel HART I/F, DC 4 ~ 20mA | - |
| Thermocouple Input Module | XGF-TC4S | Temperature (T/C) Input, 4 channels, Insulation between channels | - |
| | XGF-RD4A | Temperature (RTD) Input, 4 channels | - |
| RTD Input Module | XGF-RD4S | Temperature (RTD) Input, 4 channelsInsulation between channels | - |
| | XGF-RD8A | Temperature (RTD) Input, 8 channels | - |
| Temp. control | XGF-TC4UD | Control loop: 4 loops Input(4 channels, TC/RTD/voltage/current), Output(8 channels, TR/current) | - |
| Module | XGF-TC4RT | Control loop: 4 loops input (4 channels, RTD), Output (8 channels, TR) | - |
| LP-1 | XGF-HO2A | Voltage Input type (Open Collector type) 200kHz, 2 channel | - |
| High speed Counter Module | XGF-HD2A | Differential Input type (Line Driver type) 500kHz, 2 channel | - |
| Module | XGF-HO8A | Voltage Input type (Open Collector type) 200kHz, 8 channel | - |

| Product | Model | Description | Remarks |
|-----------------------|-----------|--|---------|
| | XGF-PO3A | Pulse output (Open Collector type), 3 axes | - |
| | XGF-PO2A | Pulse output (Open Collector type), 2 axes | - |
| | XGF-PO1A | Pulse output (Open Collector type), 1 axis | - |
| | XGF-PD3A | Pulse output (Line Drive type), 3 axes | - |
| | XGF-PD2A | Pulse output (Line Drive type), 2 axes | - |
| | XGF-PD1A | Pulse output (Line Drive type), 1 axis | - |
| | XGF-PO4H | Pulse output (Open Collector type), 4 axes | - |
| Positioning | XGF-PO3H | Pulse output (Open Collector type), 3 axes | - |
| Module | XGF-PO2H | Pulse output (Open Collector type), 2 axes | - |
| | XGF-PO1H | Pulse output (Open Collector type), 1 axes | - |
| | XGF-PD4H | Pulse output (Line Drive type), 4 axes | - |
| | XGF-PD3H | Pulse output (Line Drive type), 3 axes | - |
| | XGF-PD2H | Pulse output (Line Drive type), 2 axes | - |
| | XGF-PD1H | Pulse output (Line Drive type), 1 axes | - |
| | XGF-PN8A | Network type(EtherCat), 8 axes, LS dedicated type | - |
| | XGF-PN8B | Network type(EtherCat), 8 axes, Standard type | - |
| Motion Control | XGF-M16M | Motion dedicated net (M-II) type, 16 axes | - |
| Module | XGF-M32E | Motion dedicated net (EtherCAT) type, 32 axes | - |
| Event Input Module | XGF-SOEA | DC 24V input, 32 point, Sequence of Event module | - |
| Data Log Module | XGF-DL16A | USB 2.0, CF2001, Max 16GB 32 points (Input: 22 points , Output : 10 points) | - |

Chapter 2 System Configuration

| Product | Model | Description | Remarks |
|-------------------------|----------------------|---|---------|
| | XGL-EFMF | Fast Ethernet(optical), Master 100/10 Mbps support | - |
| FEnet Module | XGL-EFMT | Fast Ethernet(electrical), Master 100/10 Mbps support | - |
| (Optical/Elec.) | XGL-ESHF | Fast Ethernet Switch module(optical) | - |
| | XGL-EH5T | Fast Ethernet Switch module(electrical) | - |
| | XGL-EIMT | Communication Module between PLCs (electrical) 100 Mbps Industrial Ethernet supported | - |
| | XGL-EIMF | Communication Module between PLCs (optical) 100 Mbps Industrial Ethernet supported | - |
| RAPIEnet | XGL-EIMH | Communication Module between PLCs (electrical / optical) 100 Mbps Industrial Ethernet supported | - |
| | XGL-ES4T | Communication Module between PLCs (electrical) 100 Mbps Industrial Ethernet supported RAPIEnet Switch | , |
| | XGL-C22A | Serial communication RS-232C, 2 channel | |
| Cnet Module | XGL-C42A | Serial communicationRS-422(485), 2 channel | - |
| | XGL-CH2A | Serial communicationRS-232C 1 channel / RS-422(485) 1 channel | |
| FDEnet | XGL-EDMF | Dedicated Ethernet(optical), Master Deterministic communication support 100/10 Mbps support | |
| Module(Master) | XGL-EDMT | Dedicated Ethernet(electrical), Master Deterministic communication support 100/10 Mbps support | |
| Rnet Module | XGL-RMEA | for Rnet Master I/F (Smart I/O communication available) Fast response speed support(against the existing Fnet module) 1 Mbps base band for twisted cable | - |
| Profibus-DP Module | XGL-PMEA XGL-PMEC | Profibus-DP Master module | - |
| Pnet Slave I/F module | XGL-PSEA | Profibus-DP Slave module | - |
| DeviceNet Module | XGL-DMEA | DeviceNet Master module | - |
| Ethernet/IP Module | XGL-EIPT | EtherNet/IP(electric)100/10 Mbps support | - |
| BACnet/IP I/F Module | XGL-BIPT | BACNet/IP(electric) 100/10 Mbps support | - |
| Fnet I/F module | XGL-FMEA | Field Bus master module | - |
| 40-point connector | 1473381-1 | • 40-point connector (For I/O, special module) | - |

Note

1) For the further information about active coupler, optical converter, repeater and block type remote module, which are network devices, refer to the user's manual of network.

2) O/S version of communication module applicable to XGK system is as follows.

| | Module | | | | | | | | |
|--------------------|----------------------|----------------------|----------------------------------|------------------|------------------|------------------|----------------------|------------------|--|
| Name | FEnet | FDEnet | Cnet | Rnet | Pnet | Dnet | RAPIEnet | IFOS module | |
| Model | XGL-EFMT XGL-EFMF | XGL-EDMT XGL-EDMF | XGL-C22A XGL-CH2A XGL-C42A | XGL-RMEA | XGL-PMEA | XGL-DMEA | XGL-EIMT XGL-EIMH | XGL-ESHF | |
| Applicable version | V2.0 or above | V2.0 or above | V2.1 or above | V1.0 or above | V1.0 or above | V1.0 or above | V1.0 or above | V1.0 or above | |

2.3 Basic System

2.3.1 Configuration method of Basic System

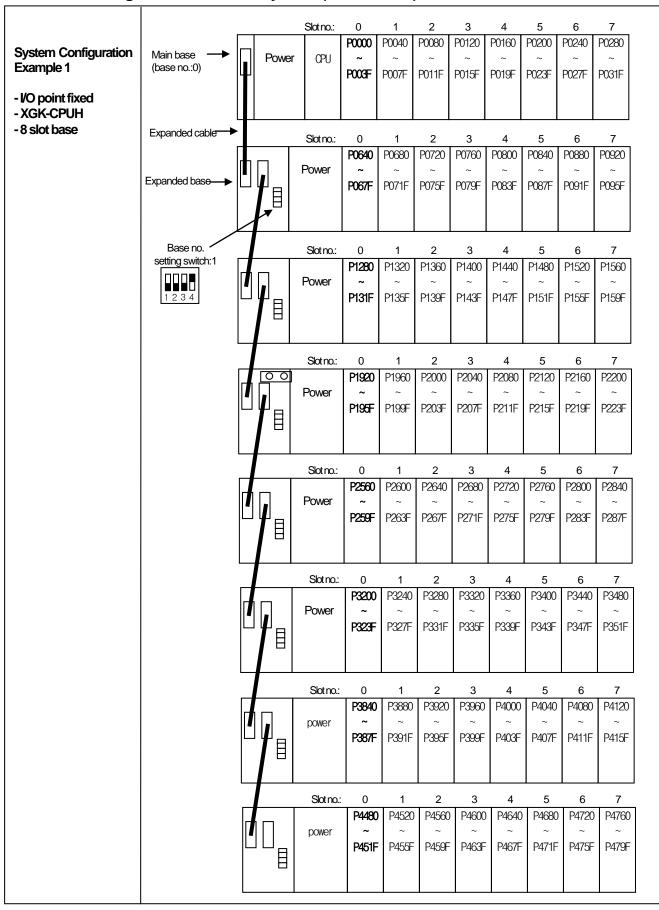
The features of Basic system consisted by connecting the main base and expanded base by a cable are as follows. The number of stages of expanded base is limited according to the CPU type and the allocation method of I/O No. is available to select the **fixed type** and **variable type** according to the setting of basic parameter.

| Classification | XGK-CPUE | XGK-CPUS XGK-CPUSN | XGK-CPUA | XGK-CPUH XGK-CPUHN | XGK-CPUU XGK-CPUUN | | |
|---|--|-----------------------|--------------|-----------------------|-----------------------|--|--|
| Max. expanded stages | 1 stage | 3 stages | 3 stages | 7 stages | 7 stages | | |
| Max. no. of I/O Module install | 24 Module | 48 Module | 48 Module | 96 Module | 96 Module | | |
| Max. I/O point | 1,536 points | 3,072 points | 3,072 points | 6,144 points | 6,144 points | | |
| Max. extended distance | | | 15m | | | | |
| Allocation of I/O No. (fixed type) | Each slot of base is allocated by 60 points regardless module installation and type. For one base, I/O no. of 16 slots is allocated. That is, the start no. of No.1 base becomes P00640. (Refer to 2.3.2) The example of I/O no. of 12 Slot base is as below: Slot No. | | | | | | |
| Allocation of I/O no. (variable type) | The point is allocated according to the assignment of installation module per slot. If assigned installation module by I/O parameter, the assigned point is allocated. The slot not assigned by I/O parameter shall be allocated automatically according to actual installation slot (Note: 8 point module shall be allocated by 16 point.) The empty slot not assigned by I/O parameter shall be processed by 16 point. Available to assign the point only by I/O parameter without module assignment. The slot installed by special module or communication module is allocated by 16 point. The example of I/O no. of 12 Slot base is as below: Slot No. O 1 P C I I I I O O O O O O O O O | | | | | | |

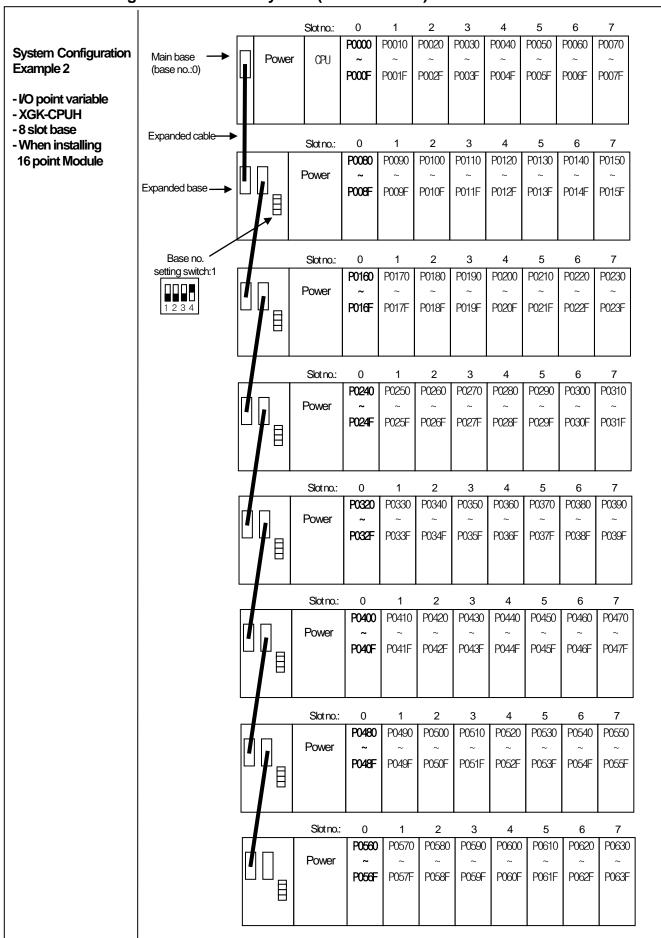
Notes

- 1) The allocation method of I/O no. shall be set in basic parameter.
- 2) For Main base, the base no. is fixed as "0" and the expanded base has a switch to set the base no.
- 3) In case of setting module type by I/O parameter, it starts the operation when the type of actually installed module is matched.

2.3.2 Max. Configuration of Basic System (Point Fixed)



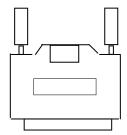
2.3.3 Max. Configuration of Basic System (Point variable)



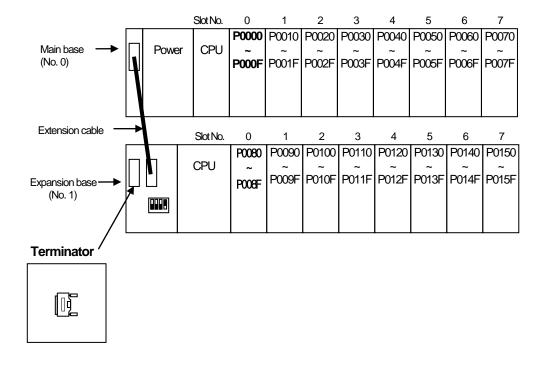
2.3.4 Terminator Connections

When an expansion base is connected, a terminator must installed for the system reliability on the expansion connector (OUT) of the last expansion base.

2.3.4.1 Structure



2.3.4.2 Installation Position



2.3.5 Module selection when configuring basic system

When configuring basic system, you must consider about size of each module's Data Refresh area. Data Refresh area is used for data transmission between CPU and modules in XGK/XGI CPU system. Data Refresh area is allocated to CPU memory, irrespective of module's operation. You must consider about maximum size of Data Refresh area. If it exceeds 1,024 words, system doesn't operate properly.

2.3.5.1 Size of each module's Data Refresh area

(Unit:WORD)

| Item | Туре | Refresh Size | ltem | Туре | Refresh Size |
|------------------------------|------------|-----------------|------------------------------|------------|-----------------|
| | XGI-A12A | 1 | | XGQ-RY1A | 1 |
| | XGI-A21A | 1 | | XGQ-RY2A | 1 |
| | XGI-A21C | 1 | | XGQ-RY2B | 1 |
| Digital input module | XGI-D21A | 1 | Digital output module | XGQ-SS2A | 1 |
| | XGI-D22A/B | 1 | Digital output module | XGQ-TR1C | 1 |
| | XGI-D24A/B | 2 | | XGQ-TR2A/B | 2 |
| | XGI-D28A/B | 4 | | XGQ-TR4A/B | 4 |
| Digital I/O module | XGH-DT4A | 2 | | XGQ-TR8A/B | 8 |
| | XGF-AC8A | 22 | | XGF-RD4A | 30 |
| | XGF-AV8A | 22 | Temperature detector input | XGF-RD4S | 30 |
| Analog input module | XGF-AD8A | 22 | module | XGF-TC4S | 30 |
| | XGF-AD16A | 21 | | XGF-RD8A | 23 |
| | XGF-AD4S | 12 | Temperature control | XGF-TC4RT | 31 |
| | XGF-AW4S | 12 | module | XGF-TC4UD | 31 |
| | XGF-AC4H | 11 | 18.1 | XGF-HO2A | 25 |
| | XGF-DC8A | 11 | High speed counter module | XGF-HD2A | 25 |
| | XGF-DV8A | 11 | | XGF-HO8A | 25 |
| Analog output | XGF-DC4A | 11 | SOE module | XGF-SOEA | 2 |
| module | XGF-DV4A | 11 | Data log module | XGF-DL16A | 32 |
| | XGF-DC4S | 11 | | XGL-EFMT | 16 |
| | XGF-DV4S | 11 | | XGL-EFMF | 16 |
| | XGF-DC4H | 7 | | XGL-ESHF | 16 |
| Analog I/O module | XGF-AH6A | 11 | | XGL-DMEA | 16 |
| | XGF-PO1A | 2 | | XGL-PSEA | 16 |
| | XGF-PO2A | 2 | | XGL-PMEA | 16 |
| | XGF-PO3A | 2 | Communication module | XGL-PMEC | 16 |
| APM module | XGF-PD1A | 2 | | XGL-EDMT | 16 |
| (Advanced Position module) | XGF-PD2A | 2 | | XGL-EDMF | 16 |
| , | XGF-PD3A | 2 | | XGL-EDST | 16 |
| | XGF-PO1H | 2 | | XGL-EDSF | 16 |
| | XGF-PO2H | 2 | | XGL-RMEA | 16 |

| Item | Туре | Refresh Size | ltem | Туре | Refresh Size |
|--------------------------------|----------|-----------------|----------------------|----------|-----------------|
| | XGF-PO3H | 2 | | XGL-FMEA | 16 |
| | XGF-PO4H | 2 | | XGL-C22A | 16 |
| | XGF-PD1H | 2 | | XGL-C42A | 16 |
| | XGF-PD2H | 2 | | XGL-CH2A | 16 |
| APM module (Advanced Position | XGF-PD3H | 2 | Communication module | XGL-EIMT | 16 |
| module) | XGF-PD4H | 2 | | XGL-EIMH | 16 |
| | XGF-PN8A | 3 | | XGL-EIMF | 16 |
| | XGF-PN8B | 3 | | XGL-ES4T | 16 |
| | XGF-M16M | 1 | | XGL-BBM | 16 |
| | XGF-M32E | 4 | | XGL-EIPT | 16 |

2.3.5.2 Calculation of Data Refresh area's size

1) Limit of Data Refresh area's size

Sum of Data Refresh area's size installed in system ≤ 1,024 words

2) Example

In a system, below modules are installed.

XGI-D28A(20 EA), XGQ-D24A(10EA), XGF-AC8A(20EA), XGF-RD4A(10EA)

 \rightarrow (4 * 20) + (2 * 10) + (22 * 20) + (30 * 10) = 840 words \leq 1,024 words

Note

- 1) Sum of Data Refresh area's size must not exceed 1,024 words.
- 2) If size of Data Refresh area exceeds 1,024 words, XGK/I system doesn't operate properly.

2.4 Network System

XG series provides various network system for easy system configuration.

This provides Ethernet (FEnet, FDEnet) and Cnet for communication between PLC and upper system or between PLCs and provides a dedicated Ethernet (FDEnet), Profibus-DP, DeviceNet, Rnet etc. as lower control network system.

2.4.1 Network Systems

(1) Local Network

It is available to install max. 24 communication module without any constraint of Main base and Expanded base. It is recommended to install the module with lots of communication capacity in Main base considering system operation and performance. The constraints per function are shown on the table as below.

| Classification per purpose | XGK-CPUE | XGK-CPUSN | XGK-CPUA | XGK-CPUHN | XGK-CPU XGK-CPUUN | |
|--|----------|-----------|----------|-----------|----------------------|--|
| No. of max. high speed link setting module | 12 | | | | | |
| No. of max. P2P service module | 8 | | | | | |
| No. of max. dedicated service module | 24 | | | | | |

*Note 1) P2P service: 1:1 communication

(2) Computer Link (Cnet I/F) System

Cnet I/F system is the system to carry out the data communication between computer or various external equipment and CPU module by using RS-232C, RS-422 (or RS-485) port of Cnet module. For further information of Cnet module, please refer to the user's manual related to Cnet module.

As mentioned on the above "Local Network", Cnet module is available to install max. 24 bases (including other communication module) regardless Main base and Expanded base.

Cnet does not provide high speed link but supports P2P service up to 8.

2.4.2 OS Version of Communication module

(1) O/S version of communication module applicable to XGK system

O/S version of communication module applicable to XGK system is as follows.

| | Module | | | | | | | |
|--------------------|----------------------|----------------------|----------------------------------|------------------|------------------|------------------|----------------------|------------------|
| Name | FEnet | FDEnet | Cnet | Rnet | Pnet | Dnet | RAPIEnet | IFOS module |
| Model | XGL-EFMT XGL-EFMF | XGL-EDMT XGL-EDMF | XGL-C22A XGL-CH2A XGL-C42A | XGL-RMEA | XGL-PMEA | XGL-DMEA | XGL-EIMT XGL-EIMH | XGL-ESHF |
| Applicable version | V2.0 or above | V2.0 or above | V2.1 or above | V1.0 or above | V1.0 or above | V1.0 or above | V1.0 or above | V1.0 or above |

2.4.3 Remote I/O System

This is the network system to control I/O module installed at far distance. Network system such as Profibus-DP, DeviceNet, Rnet, Cnet etc is applied.

(1) I/O System Application per Network Type

Remote I/O module is classified by base board type and block type (Smart I/O etc.) and there might be the one that does not support base board type according to network.

| Network type (master) | Smart IO | | | | |
|-----------------------|------------|----------------|--|--|--|
| Network type (master) | Block type | Expansion type | | | |
| Profibus-DP | 0 | 0 | | | |
| DeviceNet | 0 | 0 | | | |
| Rnet | 0 | 0 | | | |
| Modbus(Cnet) | 0 | - | | | |
| FEnet | _ | 0 | | | |
| Ethernet/IP | - | 0 | | | |
| RAPIEnet | - | _ | | | |

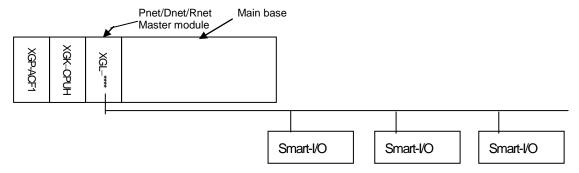
^{*} The above description is subject to change for function improvement. For correct information, please refer to each network system manual.

Max. no. of installation and max. no. of module per service is the same as local network. In case that I/O module and Special module are installed together in Rack type Remote, one remote master module shall use 1 high speed link and 1 P2P.

(2) Block Type Remote I/O System

1) System Configuration

This system is configured by Profibus-DP, DeviceNet and Rnet and it is available to use block type Remote I/O regardless of the series. Profibus-DP and DeviceNet were developed based on International Standard which enables to connect with Smart-I/O of our company as well as the product of other manufacturer.



• Master module is available to install up to max. 12 and also available in the expanded base.

2) I/O allocation method and I/O no. assignment

- It is available to allocate 'P', 'M', 'K' and 'D' device to Remote I/O by high speed link parameter. 'P' area is recommended to use the forced ON/OFF function and initial reset function.
- Max. available point of I/O device (P area) is 32,768 point(P00000 ~P2047F).
- For the setting method of high speed link parameter per module, please refer to XG-PD manual.

Chapter 3 General Specifications

3.1 General Specifications

The General Specification of XGT series is as below.

| No. | Items | Specifications | | | | | Related standards |
|-----|---------------------|----------------------------------|---|--------------------------|-----------------------------|----------------------------|-------------------|
| 1 | Ambient temperature | | 0 ~ 55 °C | | | | |
| 2 | Storage temperature | | −25 ~ +70 °C | | | | |
| 3 | Ambient humidity | | 5 | ~ 95%RH (Non-co | ndensing) | | |
| 4 | Storage humidity | | 5 | ~ 95%RH (Non-co | ndensing) | | |
| | | | Occas | sional vibration | | - | |
| | | Frequency | , | Acceleration | Amplitude | times | |
| | | $5 \leq f < 8.4 H$ | | | 3.5mm | | |
| 5 | Vibration | $8.4 \leq f \leq 150h$ | Hz 9 |).8m/s ² (1G) | _ | 10 times each | |
| Ü | resistance | | Contin | uous vibration | | 10 times each directions | IEC61131-2 |
| | | Frequency | , | Acceleration | Amplitude | (X, Y and Z) | |
| | | $5 \leq f < 8.4 H$ | | _ | 1.75mm | (71, 1 and 2) | |
| | | $8.4 \leq f \leq 150h$ | Iz 4. | 9m/s²(0.5G) | _ | | |
| 6 | Shock resistance | Duration: 11ms | Peak acceleration: 147 m/s²(15G) Duration: 11ms Half-sine, 3 times each direction per each axis | | | IEC61131-2 | |
| | | Square wave Impulse noise | ±1,500 V | | | LSIS standard | |
| | | Electrostatic discharge | 4kV | | | IEC61131-2 IEC61000-1-2 | |
| 7 | Noise resistance | radiated | | ١ | IEC61131-2, IEC61000-1-3 | | |
| | | Fast | Segm | Power supply | Digital/ana | log input/output | IEC61131-2 |
| | | transient/bust | ent | module | communic | cation interface | IEC61000-1-4 |
| | | noise Voltage 2kV 1kV | | 1200100014 | | | |
| 8 | Environment | | Free from | corrosive gasses a | nd excessive dust | | |
| 9 | Altitude | Up to 2,000 ms | | | | | |
| 10 | Pollution degree | 2 or less | | | | | |
| 11 | Cooling | | | Air-cooling | | | |

N0ote

¹⁾ IEC (International Electrotechnical Commission):

An international nongovernmental organization which promotes internationally cooperated standardization in electric/electronic field, publishes international standards and manages applicable estimation system related with.

²⁾ Pollution degree:

An index indicating pollution degree of the operating environment which decides insulation performance of the devices. For instance, Pollution degree 2 indicates the state generally that only non-conductive pollution occurs. However, this state contains temporary conduction due to dew produced.

Chapter 4 CPU Module

4.1 Technical Specifications

There are 4 types of CPU modules; Standard type (XGK-CPUS), Economic type (XGK-CPUE), Advanced type (XGK-CPUA) and High Performance type (XGK-CPUH), and their technical specifications are as follows.

| ltomo | | | | Specification | | | Domenko | |
|----------------------|---------|-------------------------------------|----------------------------------|--------------------------------|---|--|-------------------------|--|
| | Item | 18 | XGK-CPUE | XGK-CPUS | XGK-CPUA | XGK-CPUH | XGK-CPUU | Remarks |
| Ope | ation | method | | | me-driven, Fixe | | n\ | - |
| I/O c | ontrol | method | Sca | direct r | d batch method method by instr | uction | od), | - |
| Prog | ram la | anguage | | SFC (Sed | adder Diagram Instruction List quential Functio (Structured Te | on Chart) | | - |
| Number | of | Basic | | | 40 | , | | - |
| instructio | | Application | | | 700 | | | - |
| | | LD | 84 ı | ns/Step | 28 ns | s/Step | | - |
| Processi | ng | MOV | 252 | 2 ns/Step | 84 ns | s/Step | | - |
| speed (Bainstruction | on) | Real number operation | ±: 1,442 ns(S), 2,870 ns(D) | | S: Single real number D: Double real number | | | |
| | capa | g memory city uto-allocation) | 16kstep (64KB) | 32kstep (128KB) | 32kstep (128KB) | 64kstep (256KB) | 128kstep (512KB) | - |
| I/O point | (settir | ng available) | 1,536 | 3,072 | 3,072 | 6,1 | 44 | - |
| | Р | | | P00000 ~ P2047F (32,768 point) | | | | - |
| | М | | M00000 ~ M2047F (32,768 point) | | | | | - |
| | K | | K00000 ~ K2047F (32,768 point) | | | | | - |
| | L | | L00000 ~ L11263F (180,224 point) | | | | | - |
| | F | | F00000 ~ F2047F (32,768 point) | | | | | - |
| | | Т | | T0000 – T099 T1500 – T199 | | 0.1ms: T200 |) – T1499)0 – T2047 | Change area is available by parameter setting |
| Data area | | С | C0000 ~ C2047 | | | | | |
| | | S | S00.00 ~ S127.99 | | | | | |
| | | D | D0000 ~ | - D19,999 | D0 | 000 ~ D32,76 | 7 | |
| | | U | U0.0 ~ U1F.31 | | U0.0 ~ U3F.31 | U0.0 ~ U7F. | 31 | Special module data refresh area |
| | | Z | | | 128 points | | | Index |
| | | N | | NO | 00000 ~ N21,50 |)3 | | |
| | | R | 1 b | 1 block 2 block | | 32K word per 1 block (R0 ~ R32767) | | |
| F | lash : | area | | 2 | Mbyte, 32 bloc | :k | | Controlled by R device |

| | Items | | | Specification | | | Remarks |
|----------------------------------|-------------------------|---|------------------|---------------|---|----------|----------|
| | | | XGK-CPUS | XGK-CPUA | XGK-CPUH | XGK-CPUU | Remarks |
| | Total number of program | | 256 | | | | |
| Program | Initialization task | | | 1 | | | |
| configu- ration | Cyclic task | | | 32 | | | |
| | Internal device task | | 32 | | | | |
| Оре | Operation mode | | RUN, STOP, DEBUG | | | | |
| Se | lf-diagnosis | Operation delay monitoring, memory error, input/output error, battery error, power error etc. | | | | | |
| Pr | ogram port | RS-232C(1CH), USB(1CH) | | | Modbus slave supported via RS-232C port | | |
| Data storage method at power off | | Latch area setting at Basic parameter | | | · | | |
| Max. base expansion | | 1 stages | 3 stages | 3 stages | 7 sta | ages | Max. 15m |
| Internal consumption current | | 940mA 960mA | | | | | |
| | Weight | | | 0.12kg | | | |

Note

 Supported functions according to CPU OS version: the following OS version and XG500 version is needed for each function

| CPU OS | XG5000 | Function | Remark |
|--------|--------|--|--------|
| V3.0 | V3.0 | SFC, ST language Automatic assignment variable | - |
| V3.1 | V3.1 | Event input module(XGF-SOEA) | - |
| V3.2 | V3.2 | Effective conversion value, alarm function of analog input module | - |
| V3.4 | V3.3 | User defined function/function block for XGK Instruction for positioning (APM/XPM): VRD, VWR, XVRD, XVWR | - |
| V3.50 | V3.4 | Enhanced password function (in order to connect, XG5000 V3.4 or above is needed.) You can disable the Reset/D.Clear switch Version information is indicated to two decimal places (_OS_VER_PATCH flag added) | - |
| V3.60 | V3.5 | Instruction : TRAMP, RTRAMP, VTPP, XVTPP | |
| V3.70 | V3.6 | Scan time of fixed cycle task flag P2P, HS enable-disable flag SOE flag | |

The performance specifications of the CPU module (XGK-CPUUN/CPUHN/CPUSN) are as follows.

| | lt a sa | | | Specification | | Domonto | |
|--------------------------|---------|--------------------------------------|---|---|-----------------------|--|--|
| | Iten | ns | XGK-CPUSN | XGK-CPUHN | XGK-CPUUN | Remarks | |
| Ope | ation | method | | Cyclic, Time-driven, Fixed Period | | | |
| I/O c | ontro | l method | | nized batch method (ref rect method by instruction | | - | |
| Prog | ram la | anguage | SFC | - | | | |
| Number | of | Basic | | 40 | | - | |
| instructio | ns | Application | | 700 | | - | |
| | | LD | | 8.5 ns/Step | | - | |
| Processi | | MOV | | 25.5 ns/Step | | - | |
| speed (Ba instruction | on) | Real number operation | ±: 182.8ns (S), 327.3ns (D) x : 336ns (S), 727ns (D) ÷ : 345ns (S), 808ns (D) | | | S: Single real number D: Double real number | |
| | сара | ng memory city uto-allocation) | 64kstep (256KB) | 128kstep (512KB) | 256kstep (1,024KB) | - | |
| I/O point | (setti | ng available) | 3,072 6,144 | | - | | |
| | Р | | P000 |)00 ~ P4095F (65,536 բ | point) | - | |
| | М | | M000 | - | | | |
| | K | | K000 | - | | | |
| | L | | L000 | - | | | |
| | F | | F00000 ~ F4095F (65,536 point) | | | - | |
| | Т | | 100ms: T0000 – T 1ms: T6000 – T | | | Change area is available by parameter setting | |
| Data area | | С | C0000 ~ C4095 | | | - | |
| | | S | S00.00 ~ S255.99 | | | - | |
| | | D | D0000 ~ D262143 | D0000 ~ | D524287 | - | |
| | | U | U0.0 ~ U3F.31 | U0.0 ~ | U7F.31 | Special module data refresh area | |
| | | Z | | Index | | | |
| | | N | | N00000 ~ N21503 | | - | |
| | | R | 2 block | 8 block | 16 block | 32K word per 1 block (R0 ~ R32767) | |
| F | lash | area | | 2 Mbyte, 32 block | | Controlled by R device | |

| | Items | | Specification | | Remarks |
|----------------------------------|-------------------------|---|---------------|-----------|---------|
| | items | XGK-CPUSN | XGK-CPUHN | XGK-CPUUN | Remarks |
| | Total number of program | 256 | | - | |
| Program | Initialization task | | 1 | | - |
| configu- ration | Cyclic task | | 32 | | - |
| | Internal device task | | 32 | | - |
| Оре | eration mode | RUN, STOP, DEBUG | | | - |
| Se | lf-diagnosis | Operation delay monitoring, memory error, input/output error, battery error, power error etc. | | | - |
| Program port | | USB(1CH), Ethernet(1CH) | | | |
| Data storage method at power off | | Latch area setting at Basic parameter | | | - |
| Max. base expansion | | 3 stages 7 stages | | Max. 15m | |
| Internal consumption current | | 960mA | | | - |
| | Weight | 0.12kg | | | - |

XGK-CPUUN/CPUHN/CPUSN has Ethernet communication. Performance Specifications are as follows.

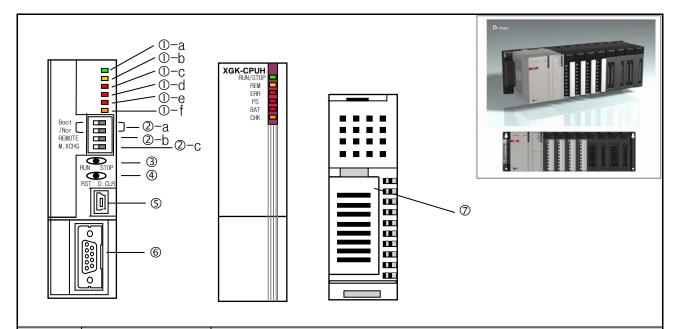
| Ite | | Specifications XGK-CPUSN/CPUHN/CPUUN | Remarks |
|----------|----------|--|---|
| | | 1 Port | - |
| | | 10/100BASE-TX | - |
| | | Auto negotiation (Full-duplex and half duplex) | - |
| | | Auto MDIX Crossover | - |
| | Features | Max. Support 4 channel | Support 8Kbyte each send and receive channel |
| | | Max. Distance between nodes : 100m | - |
| Ethernet | | Max. Protocol size : 1500Byte | IP Fragmentation is not supported. |
| | | UTP, STP, FTP cables is available | FTP, STP is recommended to prevent noise |
| | | Setting communication parameters with XG5000 | - |
| | Service | Loader service (XG5000 connection) supported | remote stage 1 connection with PLC is available |
| | OCIVICO | LS protocol(XGT) supported. | Server function & TCP |
| | | other company's protocol (MODBUS TCP/IP) | supported. |
| | | supported | UDP not supported. |

Note

 Supported functions according to CPU OS version: the following OS version and XG500 version is needed for each function.

| CPU OS | XG5000 | Function | Remark |
|--------|--------|----------------------------------|--------|
| V1.0 | V4.0 | XGK-CPUUN/CPUHN/CPUSN are added. | - |

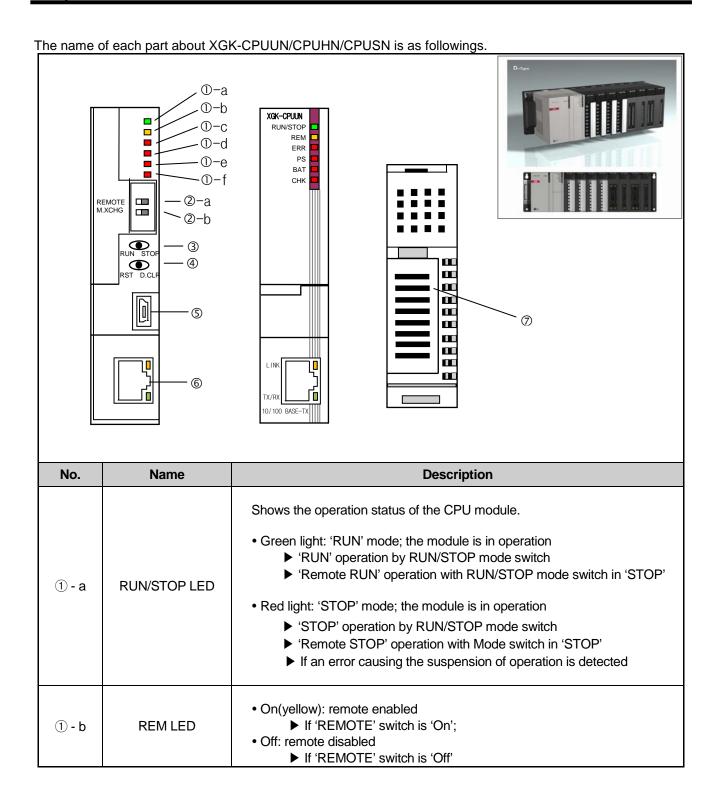
4.2 Part Names and Functions



| No. | Names | Description | |
|-----|--------------|---|--|
| ①-a | RUN/STOP LED | This indicates the operation state of CPU module. Green ON: indicates 'in operation' by 'RUN' mode state. 'RUN' operation by RUN/STOP mode switch 'REMOTE RUN' operation in the state that mode switch is at 'STOP' Red ON: indicates 'in operation' by 'STOP' mode state 'STOP' operation by RUN/STOP mode switch REMOTE 'STOP' operation in the state that mode switch is at 'STOP' | |
| ①-b | REM LED | • ON (Yellow): indicates 'remote enabled' ► In case that 'REMOTE' switch is 'On' • OFF: indicates 'remote disabled' ► In case that 'REMOTE' switch is 'Off' | |

| No. | Names | Description |
|-------------|-------------------------------------|--|
| ①-c | ERR LED | ON (Red): indicates that the error not possible to operate occurred. OFF: indicates 'no error' |
| ①-d | PS LED (Programmable Status) | ON (Red): |
| ①-e | BAT LED | ON (Red): in case that battery voltage is loweredOFF: no battery error |
| ①-f | CHK LED | ON (Red): indicates the setting is different from standard setting (Available to add/delete[clear] by parameter) ▶ In case that 'Module change' switch is set as 'Module change' ▶ 'In case of operating in 'DEBUG mode' ▶ 'Forced ON' setting state ▶ In case that 'fault mask', 'SKIP' flag is set ▶ In case that Warning occurs during operation ▶ Extended base power error ◆ Blink: indicates in case arithmetic error occurs during Program Proceeding is set. ◆ OFF: indicates during operation by standard setting |
| ② -a | Boot/Nor switch | Used when downloading the O/S before releasing. On (right): executes control action in normal operation mode. Off (left): used for manufacturing, user's operation prohibited. (Download mode of O/S) Note: Boot/Nor switches should be both set in On (right) side. If set in Off (left) side, it may cause abnormal operation. |
| 2 -b | REMOTE enabled switch | Limits the operation of PLC by remote connection. • On (right): all function enabled (REMOTE mode) • Off (left): remote function limited ▶ D/L of program, Operation mode limited ▶ Monitor, data change enabled |
| ②-c | M.XCHG (Module change switch) | Used in case of performing the module change during operation. • On (right): performs the module change • Available to change the module only by key switch operation • Off (left): completes the module change |
| 3 | RUN/STOP mode switch | Sets the operation mode of CPU module. • STOP → RUN : executes the operation of program • RUN → STOP : stops the operation of program Operates prior to REMOTE switch. |

| No. | Names | Descr | Description | | | |
|-------------|------------------------|--|--|--|--|--|
| | | You can enable/disable Reset/D.Clear → Basic Operation Setup" 1. When Reset switch is enabled Operation | switch in "XG5000 → Basic Parameter | | | |
| | | move to left → return to center | Reset | | | |
| | | move to left → keep 3 seconds or above → return to center | Overall reset | | | |
| (4) | Reset/ D.Clear | 2. When D.Clear switch is enabled | | | | |
| | switch | Operation | Result | | | |
| | | move to right → return to center: | General data area and retain area (M, Automatic variable) will be cleared. | | | |
| | | move to left → keep 3 seconds or above → return to center: | General data area, retain area (M, Automatic variable) and R area will be cleared. | | | |
| | | Note: DATA CLEAR acts only in "STOP | operation mode. | | | |
| (5) | USB connector | A connector to connect with peripherals (| (XG5000 etc.) (USB 1.1 support) | | | |
| 6 | RS-232C connector | A connector to connect with peripherals • XG5000 connection: support basically • Modbus equipment connection: Modbus protocol support(Only as Server) TX: no.7 Pin, RX: no.8 Pin, GND: no.5 Pin | | | | |
| 7 | Battery built-in cover | Back-up battery built-in cover | | | | |



| No. | Name | Description |
|-------|-------------------------------------|--|
| ① - c | ERR LED | On(red): displaying an error of operation disabledOff: displaying normal operation |
| ① - d | PS LED (Programmable Status) | On(red): If 'User Defined Flag' is 'On' Operation in erroneous status by 'Operation in Error Status' setting If removing the module or installing other module with 'M.XCHG' switch 'On' Off: displaying normal operation |
| ① - e | BAT LED | On(red): low battery voltage Off: normal battery level |
| ① - f | CHK LED | On(red): displayed if other settings but the standard setting is set (it can be added/deleted(cancelled) by parameters) ▶ If 'Module Change' switch is set to 'Module Change' ▶ If operating in 'Debug Mode' ▶ If 'Forcible On' setting ▶ If 'Fault Mask'/ 'SKIP' flag is set ▶ If a warning occurs during operation ▶ In case of power fault of extension base Off: displayed if operating in standard setting |
| ② - a | REMOTE Switch | Remotely controlling the operation of PLC. • On(right): every function enabled (REMOTE mode) • Off(left): remote functions disabled ▶ Program D/L, operation mode control limited ▶ Monitor and data change allowed |
| ② - b | M.XCHG (module change switch) | It replaces a module during operation. • On (right): replacing a module ▶ A module is replaced by operating the key switch • Off(left): module is replaced completely |
| 3 | RUN/STOP Mode switch | Setting the operation mode of the CPU module. • STOP → RUN : execute program operation • RUN → STOP : stop program operation The control is prior to Remote switch control. |

| No. | Name | Descr | iption | | | |
|-----|--------------------------|---|--|--|--|--|
| 4 | Reset/ D.Clear switch | | Result Reset Overall reset Result General data area and retain area (M, Automatic variable) will be cleared. General data area, retain area (M, Automatic variable) and R area will be cleared. | | | |
| (5) | USB connector | Connector for peripherals (XG5000 and etc): USB 1.1 supported | | | | |
| 6 | Ethernet connector | Connector for peripherals • XG5000 connection: basically supported • TCP/IP Server connection | | | | |
| 7 | Battery cover | Backup battery cover | | | | |

4.3 Battery

4.3.1 Battery Specifications

| Items | Specification | | |
|-------------------------|---|--|--|
| Nominal voltage/current | DC 3.0 V / 1,800 mAh | | |
| Warranty | 5 years (ambient temperature) | | |
| Purpose | Program and data backup, RTC operation when power-off | | |
| Specification | Manganese dioxide lithium battery | | |
| Outer dimension (mm) | φ 17.0 X 33.5 mm | | |

4.3.2 Notice in Using

- 1) Do not apply the heat or solder to the electric pole. (If not, battery life shortening may be caused.)
- 2) Do not measure the voltage with tester or have a short-circuit. (If not, fire or flames may be caused.)
- 3) Do not disassemble the battery.

4.3.3 Battery Durability

The durability of battery depends on power-out time, ambient temperature etc. However, these CPUs are designed to use the battery around 5 years under normal circumstances.

If the voltage of battery is lowered, CPU module occurs 'Battery voltage drop warning' . It is available to check it through CPU module LED and flag or error message of XG5000.

As the battery works for an amount of time normally even after 'battery voltage drop warning' occurs, you can take an action after warning in the system of daily checking.

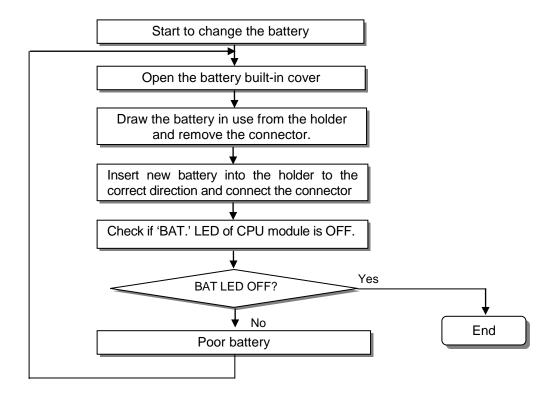
Notes

In general, the battery warning occurs 5 years after purchasing but it may occur earlier due to a poor battery or excessive current discharge caused by leakage current etc. If the warning occurs again within the short time after battery change, you need to request A/S service for CPU module.

4.3.4 Changing the Battery

The battery used for program backup or data backup at power out needs the regular change. Even if the battery is removed, program and power-out keeping data shall be kept for 30 minutes by super capacity but it is required to change the battery as fast as possible.

The battery change procedure is as below.



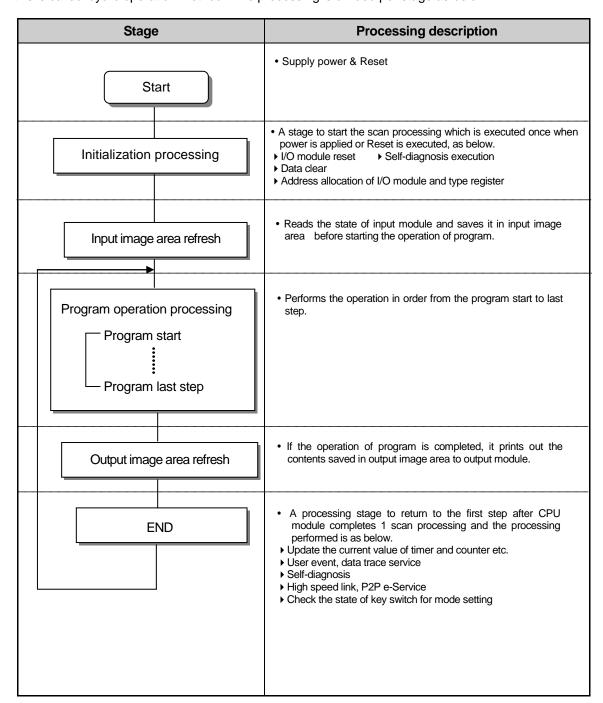
Chapter 5 Program Configuration and Operation Method

5.1 Program Instruction

5.1.1 Program Execution Methods

1) Cyclic operation method (Scan)

This is a basic program proceeding method of PLC that performs the operation repeatedly for the prepared program from the beginning to the last step, which is called 'program scan'. The series of processing like this is called 'cyclic operation method'. The processing is divided per stage as below.



2) Interrupt Operation (Time-driven, Internal Device)

This is the method that stops the program operation in proceeding temporarily and carries out the operation processing which corresponds to interrupt program immediately in case that there occurs the status to process emergently during PLC program execution.

The signal to inform this kind of urgent status to CPU module is called 'interrupt signal' and there is a timedriven method that operates program every appointed time. Besides, there is an internal device start program that starts according to the state change of device assigned inside.

3) Constant Scan (Fixed Period)

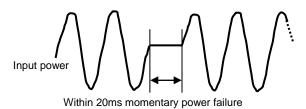
This is the operation method that performs the scan program every appointed time. This stands by for a while after performing all the scan program, and starts again the program scan when it reaches to the appointed time. The difference from constant program is the update of input/output and the thing to perform with synchronization.

At constant operation, the scan time indicates the net program processing time where the standby time is deducted. In case that scan time is bigger than 'constant', '_CONSTANT_ER [F0005C]' flag shall be 'ON'.

5.1.2 Operation Processing during Momentary Power Failure

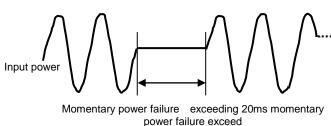
CPU module detects the momentary power failure when input power voltage supplied to power module is lower than the standard. If CPU module detects the momentary power failure, it carries out the operation processing as follows.

1) Momentary power failure within 20ms



- (1) Stops the operation in the output state when momentary power failure occurred.
- (2) If momentary power failure is released, the operation continues.
- (3) Output voltage of power module keeps the value within the standard.
- (4) Even if the operation stops by momentary power failure, timer measurement and interrupt timer measurement shall be executed normally.

2) Momentary power failure exceeding 20ms



 Restart processing like at power input shall be performed.

Notes

1) Momentary power failure?

This means the state that the voltage of supply power at power condition designated by PLC is lowered as it exceeds the allowable variable range and the short time (some ms \sim some dozens ms) interruption is called 'momentary power failure).

5.1.3 Scan Time

The time required to complete it from the first step 0 to the next step 0 of a program, that is, a time taken for a control operation is called 'scan time.' It is directly related to the control performance of the system.

1) Operation and performance of XGK

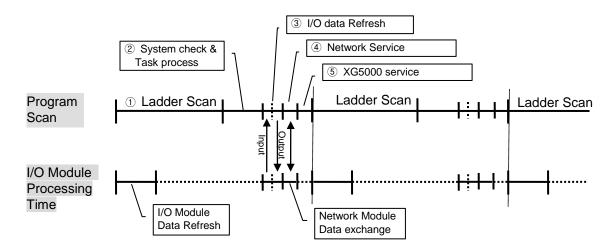
Program execution time, I/O data process time and communication service time are important factors affecting the 'scan time.'

The XGK impressively reduces scan time by means of the improved data reception performance through backplane, ladder program execution and ladder program execution by MPU and parallel execution of I/O data scan etc.

| | Program proce | ssing time | Module processing time | | | |
|-------------|----------------------------------|----------------|--|--|---|--|
| Туре | Ladder execution (32kstep) | System Task | Digital I/O module (32 points, 1module) | Analog module (8 ch, 1module) | Communication module (basic/extension) (200 byte, 1 block) | |
| CPUSN/HN/UN | 0.272 ms | 0.2 ms | | | | |
| CPUA,H,U | 0.896 ms | 0.6 ms | 20 us | 75 us | 170 + 44 (200byte 1 block) #s | |
| CPUE,S | 2.688 ms | 0.8 ms | | | | |

2) Calculation of scan time

The CPU module executes controls along the following steps. A user can estimate the control performance of a system that the user is to structure from the following calculation.



- (1) Scan time = ① Scan program process + ② System check & Task process + ③I/O data Refresh + ④ Network Service + ⑤ XG5000 Service + ⑥ User Task Program process
 - ① Scan program process = no. of program steps created x 0.028 (#\$) [0.084 for CPUS]
 - ② System check & Task process: $600 \, \mu \text{S} \sim 1.0 \, \text{ms}$ [parameter depending on the usage of auxiliary functions]
 - 3 I/O data Refresh [including special module]: minimum 0.06ms 0.2ms

Chapter 5 Program Configuration and Operation Method

- 4 Network Service = Service of communication module in basic base+ Service of communication module in expansion base
 - = (No. of Service x 3 μ s) + (total TRX data(byte)/4 x 0.056 [CPUS:0.112] μ s)
 - + (Comm. module TRX data of basic base (byte))/4 x 0.084 µs
 - + (Comm. module TRX data of expansion base (byte))/4 x 0.280 μ s
- * The number of service and TRX data occurred within one scan are standard of calculation
- (5)XG5000 Service process time: 100 μ s at the max data monitor
- (But, in case of changing the monitor screen, scan time increases for the mean time. In case of connected with "USB Max. Write", 6ms. In case of connected "USB Normal Write", 1.6ms.
- ⑥ Task Program process time: sum of task processing time that occurs within a scan; the time calculation by task programs are as same as that of scan program.

(2) Example

The scan time of a system consisting of CPUH (program 16kstep) + six 32-point I/O modules + six analog modules + four communication modules (200 byte 8 blocks per module)

Scan time(μ s) = ladder execution time + system processing time + digital module I/O processing time + analog I/O processing time

- + communication module processing time + XG5000 Service processing time
- $= (16000 \times 0.028) + (600) + (20 \times 6) + (75 \times 6) + ((170 + 44 \times 8) \times 4) + (100)$
- = 3806 µs
- = 3.806 ms
- 2) Scan time monitor
 - (1) Scan time is saved into the following flag(F) areas.
 - F0050 : max value of scan time (unit: 0.1ms) F0051 : min value of scan time (unit: 0.1ms)
 - F0052 : current scan time value (unit: 0.1ms)

Set the "F" devices as INT type monitoring the scan time.

5.2 Program Execution

5.2.1 Program Configuration

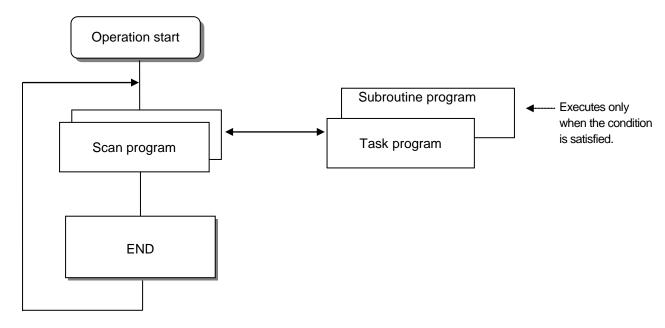
The program is consisted of all function factors required to execute the specific control and saved in the built-in RM or flash memory of CPU module. These function factors are generally classified as follows.

| Function factor | Process description |
|-------------------------------|---|
| Scan program | Processing of signal that repeats regularly every 1 scan. |
| Time-driven interrupt program | The program is performed according to the fixed time interval in case that the required processing time condition is as below. In case that the faster processing than 1 scan average processing time is required In case that the longer time interval than 1 scan average processing time is required In case that program is processed with the appointed time interval |
| Subroutine program | Only when some condition is satisfied.(in case that input condition of CALL instruction is On) |

5.2.2 Program Execution Method

Here describes the program proceeding method that is executed when the power is applied or key switch is 'RUN'.

The program performs the operation processing according to the configuration as below.



1) Scan Program

- (1) Function
 - This program performs the operation repeatedly from 0 step to last step in order prepared by the program to process the signal that is repeatedly regularly every scan.
 - In case that the execution condition of interrupt by task interrupt or interrupt module while executing scan program is established, stop the current program in execution and perform the related interrupt program.

2) Interrupt Program

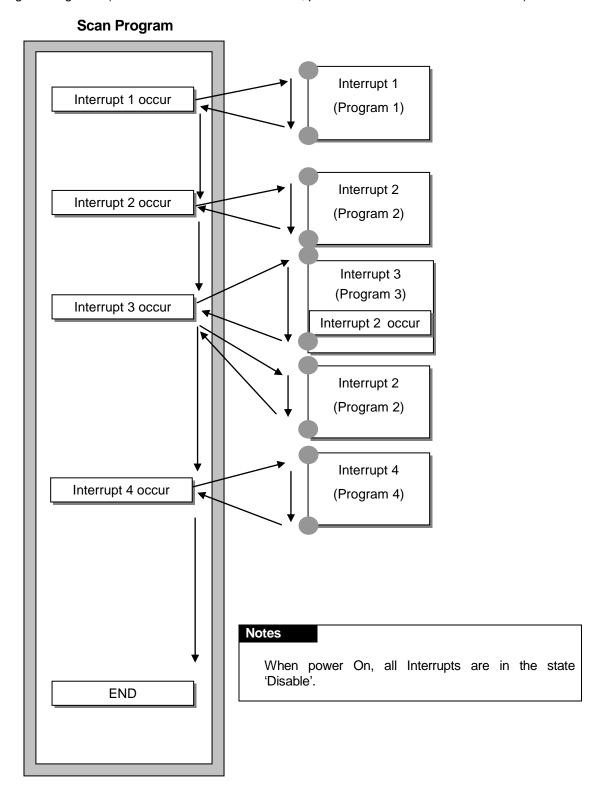
- (1) Function
 - This program stops the operation of scan program and then processes the related function in prior to process the internal/external signal occurred periodically/non-periodically.
- (2) Type
 - Task program is divided as below.
 - (a) Time-driven task program: available to use up to 32
 - (b) Internal device task program: available to use up to 32
 - Time-driven task program
 - ▶ Performs the program according to the fixed time internal.
 - Internal device task program
 - ▶ Performs the corresponding program when the start condition of internal device occurs.
 - ▶ The start condition detection of device shall be performed after processing of scan program.

Notes

1) For further information of interrupt program, please refer to 5.2.3 Interrupt.

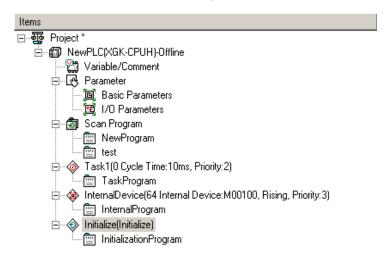
5.2.3 Interrupt

For your understanding of Interrupt function, here describes program setting method of XG5000 which is an XGT programming S/W. (For further information of XG5000, please refer to XG5000 user's manual)



1) How to Prepare Interrupt Program

Generate the task in the project window of XG5000 as below and add the program to be performed by each task. For further information, please refer to XG5000 user's manual.



2) Task Type

Task type and function is as follows.

| Type Spec | Cyclic task (interval task) | Internal device task (single task) | |
|-----------------------|--|--|--|
| Task number | 32 | 32 | |
| Start condition | Cyclic (setting up to max. 4,294,967.295 sec. by 1ms unit) | Internal device execution condition | |
| Detection & execution | Cyclic execution per setting time | Retrieve the condition and execute after completing Scan Program | |
| Detection delay time | Max. 0.2 ms delay | Delay as much as max. scan time | |
| Execution priority | 2 ~ 7 level setting (2 level is highest in priority.) | Same as left | |
| Task no. | Within 0~31 range without user duplication) | With 64~95 range without user duplication | |

3) Processing Method of Task Program

Here describes common processing method and notices for Task Program.

(1) Features of Task Program

- Task Program is executed only when execution condition occurs without every scan repeat processing. When preparing Task Program, please consider this point.
- For example, if a timer and counter were used in cyclic task program of 10 second cycle, this timer occurs the tolerance of max. 10 seconds and the counter and the timer and as the counter checks the input status of counter per 10 seconds, the input changed within 10 seconds is not counted up.

(2) Execution priority

- In case that several tasks to be executed are waiting, execute from the highest Task Program in priority. When the same priority tasks are waiting, execute from the order occurred.
- · Task priority relates to each task.
- The task program priority should be set considering the program features, importance and the emergency when the execution requested.

(3) Processing delay time

There are some causes for Task Program processing delay as below. Please consider this when task setting or program preparation.

- Task detection delay (Refer to detailed description of each task.)
- Program proceeding delay caused by Priority Task Program proceeding
- (4) Relationship of initialize, Scan Program and Task Program
 - User identification task does not start while performing Initialization Task Program.
 - As Scan Program is set as lowest priority, if task occurs, stop Scan Program and process Task
 Program in advance. Accordingly, if task occurs frequently during 1 scan or concentrates
 intermittently, scan time may extend abnormally. Cares should be taken in case of task condition
 setting.
- (5) Protection of Program in execution from Task Program
 - In case that the continuity of program execution is interrupted by high priority Task Program during program execution, it is available to prohibit the execution of Task Program partially for the part in problem. In this case, it is available to perform the program protection by 'DI(Task Program Start Disabled) and 'EI(Task Program Start Enabled)' application instruction.
 - Insert 'DI' application instruction in the start position of the part requiring the protection and insert 'EI'
 application instruction in the position to release. Initialization Task is not influenced by 'DI', 'EI'
 application instruction.

Notes

1) For further information of interrupt program, please refer to 5.2.3 Interrupt.

4) Time Driven Task Program Processing Method

Here describes the processing method in case that task (start condition) of Task Program is set as Timedriven.

- (1) Items to be set in Task
 - Set the execution cycle and priority which are the start condition of Task Program to execute. Check the task no. to manage the task.
- (2) Time-driven Task Processing
 - Performs the corresponding Time-driven task program per setting time interval (execution cycle).

- (3) Notice in using Time-driven Task Program
 - When Time-driven task program is in execution currently or waiting for execution, if the demand to execute the same task program occurs, the new occurred task shall be disregarded.
 - Timer that makes a demand to execute Time-driven task program only while operation mode is RUN mode, shall be added. The shutdown time shall be all disregarded.
 - When setting the execution cycle of Time-driven task program, consider the possibility that the demand to execute several Time-driven task program at the same time occurs.
 - If 4 Time-driven task programs that the cycle is 2sec, 4sec, 10sec and 20sec are used, 4 demands of execution per 20 seconds shall be occurred at the same time and scan time may extend instantaneously.
 - You can check maximum, minimum, and current scan time of fixed cycle task with flag of fixed cycle task

```
__CYCLE_TASK_SCANx_MAX : Maximum scan time of number 'x' Time-driven task (x=0~31)
__CYCLE_TASK_SCANx_MIN : Minimum scan time of number 'x' Time-driven task
__CYCLE_TASK_SCANx_CUR : Current scan time of number 'x' Time-driven task
```

Initial value of minimum scan time flag is 16#ffff. It can verify fixed cycle task is not used, or never executed.

5) Internal Device Task Program Processing Method

Here describes the processing method of Internal Device Task Program which extended the task (start condition) of Task Program from contact point to device as execution range.

- (1) Items to be set in Task
 - Set the execution condition and priority to the task being executed. Check the task no. for task management.
- (2) Internal Device Task Processing
 - After completing the scan program execution in CPU module, if the condition of device that becomes the start condition of internal device task program is met, according to the priority, it shall be executed.
- (3) Precautions in using internal Device Task Program
 - Accordingly, even if the execution condition of internal device task program occurs in Scan Program or Task Program (Time-driven), it shall not be executed immediately but executed at the time of completion of Scan Program.
 - If the demand to execute Internal Device Task Program occurs, the execution condition shall be
 examined at the time of completion of Scan Program. Accordingly, if the execution condition of
 Internal Device Task occurs by Scan Program or Task Program (Time-driven) during '1 scan' and
 disappears, the task shall not be executed as it is not possible to detect the execution at the time of
 examination of execution condition.

6) Task Processing at the Momentary power failure

- When restarting the task as the momentary power failure time is long, disregard the task in standby and the task issued during shutdown all and process only the task from the starting point.
- In the shutdown state within 20ms, the task in standby before shutdown shall be executed, after recovering the shutdown. The cyclic task and Interrupt task that occurred in double during shutdown, shall be disregarded.

7) Verification of Task Program

Verify the following contents after writing the Task Program.

(1) Is the task setting proper?

If task occurs frequently more than needed or several tasks occur in one scan at the same time, scan time may lengthen or be irregular. In case not possible to change the task setting, verify max. scan time.

(2) Is the priority of task arranged well?

The low priority task program shall be delayed by the high priority task program, which results in disabling the processing within the correct time and even task collision may occur as next task occurs in the state that the execution of previous task is delayed. Consider the emergency of task and execution time etc when setting the priority.

(3) Is the Task Program written in shortest?

If the execution time of Task Program is longer, scan time may lengthen or be irregular. Even it may cause the collision of task program. Write the execution time as short as possible. (Especially, when writing the cyclic task program, write the execution time so that the task program can be executed within 10% cycle of the shortest task among several tasks.)

(4) Is program protection for the high priority task needed during program execution?

If other task is inserted during task program execution, complete the task in execution and operate the standby tasks in the order of high priority. In case that it is not allowed to insert other task in Scan Program, prevent the insert partially by using 'DI' and 'EI' application instruction. The problem may occur while processing the global variables used commonly with other program or special or communication module.

8) Program Configuration and Processing Example

If task and program are registered as below,

```
    Task registration:
    T_SLOW (cycle time := 10ms, Priority:= 3)
    PROC_1 (internal device: = M0, Priority:= 5)
```

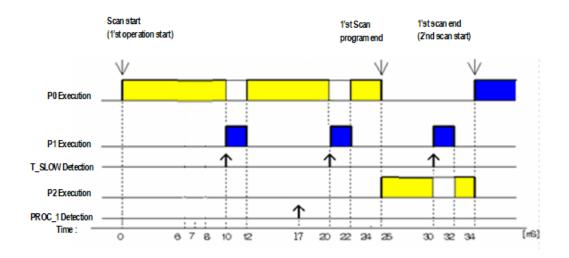
Program registration: Program --> P0
 Program --> P0 (scan program)
 Program --> P1 (start by task T_SLOW)

Program --> P2 (start by task PROC_1)

And program execution time and the occurrence time of interrupt signal is same as follows,

- Execution time of each Program: P0 = 17ms, P1 = 2ms, P2 = 7ms
- PROC_1 occur: The execution of program occurred during Scan Program is as below.

Chapter 5 Program Configuration and Operation Method



• Process per time

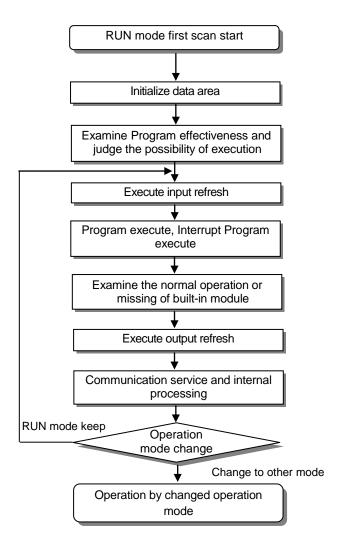
| Time (ms) | Process | | | | |
|-----------|---|--|--|--|--|
| 0 | Scan started and scan program P0 started to execute | | | | |
| 0~10 | Program P0 executed | | | | |
| 10~12 | P1 execution demand, P0 stopped and P1 executed | | | | |
| 17 | P2 execution demand | | | | |
| 12~20 | P1 execution completed and continues the stopped P0 | | | | |
| 20~22 | P1 execution demand, P0 stopped and P1 executed | | | | |
| 22~25 | P1 execution completed and the stopped P0 execution finished | | | | |
| 25 | P2 execution demand check at the completion time of Scan Program(P0), and | | | | |
| 20 | P2 executed | | | | |
| 25~30 | Program P2 executed | | | | |
| 30~32 | P1 execution demand, P2 stopped and P1 executed | | | | |
| 32~34 | P1 execution completed and the stopped P2 execution finished | | | | |
| 34 | New scan starts (P0 starts to execute) | | | | |

5.3 Operation Mode

For operation mode of CPU module, there are 3 types such as RUN mode, STOP mode and DEBUG mode.. Here describes the operation processing of each operation mode.

5.3.1 RUN Mode

This is the mode to execute Program operation normally.



1) Processing at Mode Change

At the beginning, execute initialization of data area and examine the effectiveness of program and judge the possibility of execution.

2) Operation Processing Contents

Execute I/O refresh and Program operation.

- (1) Detects the start condition of Interrupt Program and executes Interrupt Program.
- (2) Examines the normal operation or missing of built-in module.
- (3) Communication service and other internal processing.

5.3.2 STOP Mode

This is the mode in stop state without Program operation. It is available to transmit the program through XG5000 only in Remote STOP mode.

1) Processing at Mode Change

Clear the output image area and execute output refresh.

2) Operation Processing Contents

- (1) Executes I/O refresh.
- (2) Examines the normal operation or missing of built-in module.
- (3) Communication service or other internal processing.

5.3.3 DEBUG Mode

This is the mode to detect Program error or trace the operation process and the conversion to this mode is available only in STOP mode. This is the mode to check the program execution state and the contents of each data and verify the program.

1) Processing at Mode Change

- (1) Initializes the data area at the beginning of mode change.
- (2) Clears the output image area and execute input refresh.

2) Operation Processing Contents

- (1) Executes I/O refresh.
- (2) Debug operation according to setting state.
- (3) After finishing Debug operation by the end of Program, execute output refresh.
- (4) Examine the normal operation or missing of built-in module.
- (5) Executes communication service or other service.

3) Debug Operation Condition

There are 4 conditions for Debug operation and in case that it reaches break point, it is available to set other type of break point.

| Operation condition | Description |
|---|--|
| Execute by one operation unit (step over) | With operation instruction, it executes one operation unit and then stops. |
| Execute according to Break Point | If break point is assigned in Program, it stops at the assigned break point. |
| Execute according to the state of contact point | If the contact area desired to watch and the state (Read, Write, Value) desired to stop are assigned, it stops when the assigned operation occurs at the assigned contact point. |
| Execute according to scan times | If scan times to operate are assigned, it operates as much as the assigned scan times and stops. |

4) Operation Method

- (1) After setting Debug operation condition at XG5000, execute the operation.
- (2) Interrupt Program is available to set whether or not to operate (Enable/Disable) by each Interrupt unit. (For further information, please refer to Chapter 9 Debugging, XG5000 user's manual.)

5.3.4 Changing Operation Mode

1) Operation Mode Change Method

The method to change operation mode are as follows.

- (1) By mode key of CPU module
- (2) By connecting the programming tool (XG5000) to communication port of CPU
- (3) By changing the operation mode of other CPU module connected to network by XG5000 connected to communication port of CPU
- (4) By using XG5000, HMI, computer link module connected to network
- (5) By 'STOP' instruction during program execution

2) Type of Operation Mode

The operation mode setting is as follows.

| Operation mode switch | Remote enabled switch | XG5000 instruction | Operation mode |
|-----------------------|-----------------------------|-----------------------|--------------------------|
| RUN | Χ | X | Run |
| | | RUN | Remote Run |
| | ON | STOP | Remote Stop |
| STOP | | Debug | Debug Run |
| | OFF | Mode change | Previous operation mode |
| | 5 | execute | 1 Tevious operation mode |
| RUN -> STOP | X | - | Stop |

- (1) Remote mode conversion is available only in the state of 'Remote Enabled: On', 'Mode switch: Stop'.
- (2) In case of changing the Remote 'RUN' mode to 'STOP' by switch, operate the switch as follows. (STOP) \rightarrow RUN \rightarrow STOP.

Notes

- 1) In case of changing Remote RUN mode to RUN mode by switch, PLC operation continues the operation without interruption.
- It is available to modify during RUN in RUN mode by switch but the mode change operation by XG5000 is limited. This should be set only in case that remote mode change is not allowed.

5.4 Memory

There are two types of memory in CPU module that the user can use. One is Program Memory that saves the user program written by the user to build the system, and the other is Data Memory that provides the device area to save the data during operation.

5.4.1 Program Memory

The configuration of user program memory is as below.

| Items | Memory Capacity (Kbyte) | | | | | | | |
|---|-------------------------|-------|-------|-------|-------|------|------|------|
| items | CPUUN | CPUHN | CPUSN | CPUU | CPUH | CPUA | CPUS | CPUE |
| Parameter Setting area: Basic parameter area I/O parameter area Special module parameter area Communication module parameter area User Event parameter area Data Trace parameter area | 320 | 320 | 320 | | 320 | | 32 | 20 |
| Program Save area Scan Program area 1 Scan Program area 2 Variable/Explanation sentence area | 2,320 | 1,288 | 772 | | 704 | | 35 | 52 |
| System area User Event Data area Data Trace Data area System Log area Device Backup area | 2,552 | 2,040 | 1,656 | | 896 | | 89 | 96 |
| Execution Program area Execution Program area1 Execution Program area2 System Program area | 4,096 | 2.048 | 1,024 | 2,048 | 1,024 | 512 | 512 | 256 |

5.4.2 Data Memory

1) Bit Device area

Various Bit Device are provided per function. The indication method is indicated by device type for first digit, word position by decimal for middle digit and bit position for the last digit.

| Area per Device | Device features | Description |
|--------------------------|--|---|
| P00000 ~ P4095F | I/O device "P" 65,536 points | Image area to save the state of I/O device. After reading the input module state, saves it in the corresponding P area and sends P area Data saving the operation result to output module. |
| M00000 ~ M4095F | I/O device "M" 65,536 points | Internal Memory provided to save Bit Data in Program |
| L00000 ~ L11263F | I/O device "L" 180,224 points | Device to indicate high speed link/P2P service state information of communication module. |
| K00000 ~ K4095F | I/O device "K" 65,536 points | Device area to preserve the data during power shutdown, which is used without setting power shutdown preservation parameter separately. |
| F00000 ~ F4095F | I/O device "F" 65,536 points | System flag area that manages the flag necessary for system operation in PLC. |
| T0000 ~ T8191 | I/O device "T" 8,192 points | Area to save the state of timer device |
| C0000 ~ C4095 | I/O device "C" 4,096 points | Area to save the state of counter device |
| \$00.00 ~ \$255.99 | Step controller "S" 256 x 100 steps | Relay for step control |

Note

The following devices are limited to the area according to CPU type.

| 구 분 | P*** ¹ | M*** ² | K*** ³ | F*** ⁴ | T*** ⁵ | C*** ⁶ | S*** ⁷ |
|-----------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|
| XGK-CPUE | | | | | | | |
| XGK-CPUS | | | | | | | |
| XGK-CPUA | P2047F | M2047F | K2047F | F2047F | T2047 | C2047 | S127.99 |
| XGK-CPUH | | | | | | | |
| XGK-CPUU | | | | | | | |
| XGK-CPUSN | | | | | | | |
| XGK-CPUHN | P4095F | M4095F | K4095F | F4095F | T8191 | C4095 | S255.99 |
| XGK-CPUUN | | | | | | | |

2) Word Device area

| Area per Device | Device features | Description |
|-----------------------------|---|---|
| D00000 ~ D524287 ***1 | Data Register "D" 524,288 words | Area to preserve the internal data. Bit expression possible. |
| R00000 ~ R32767 | File Register "R" 32,768 words | Dedicated device to access Flash Memory. Consisted of 1,2,8,16 banks depending on the CPU Types Bit expression possible |
| U00.00 ~ U7F.31 ***2 | Analog Data Register "U" 4,096 words | Register used to read data from special module installed in the slot. Bit expression possible |
| N00000 ~ N21503 | Communication Data Register "N" 21,504 words | P2P Service Save area of communication module. Bit expression impossible |
| Z000 ~ Z255 | Index Register "Z" 256 words | Dedicated device to use Index function Bit expression impossible |
| T0000 ~ T8191 | Timer Current Value Register "T" 8192 words | Area to indicate the current value of timer |
| C0000 ~ C4095 | Counter Current Value Register "C" 4096 words | Area to indicate the current value of counter |

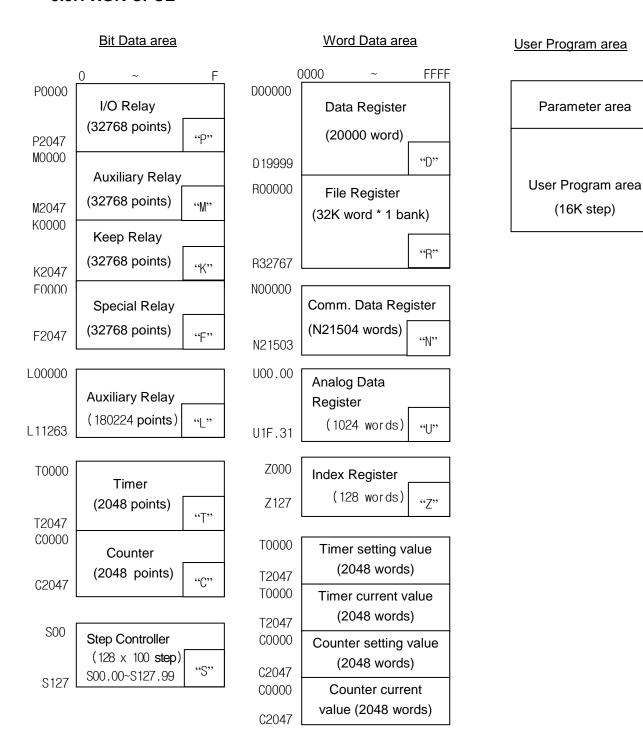
Notes

The following devices are limited to the area according to CPU type.

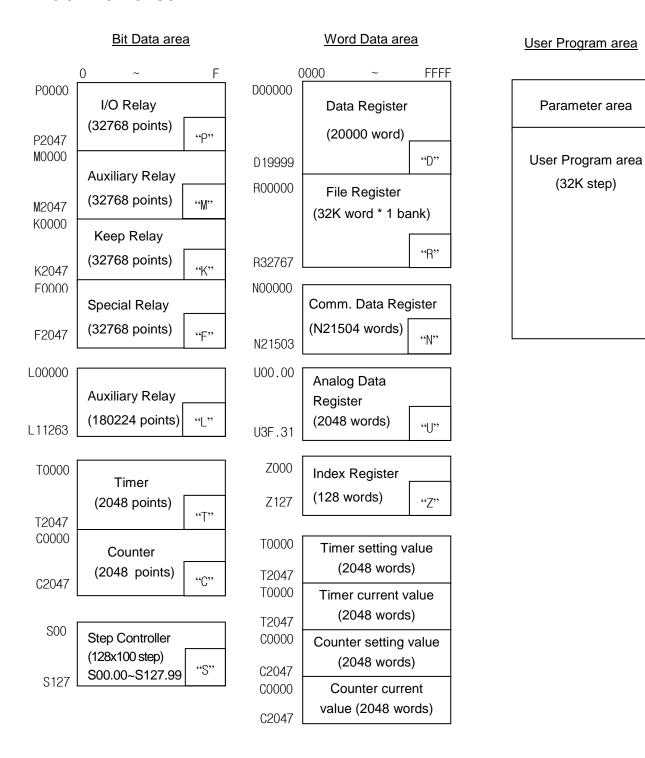
| 구 분 | D*** ¹ | U*** ² | Z*** ³ | T*** ⁴ | C*** ⁵ |
|-----------|-------------------|-------------------|-------------------|-------------------|-------------------|
| XGK-CPUE | D19999 | U1F.31 | Z127 | T2047 | C2047 |
| XGK-CPUS | | U3F.31 | | | |
| XGK-CPUA | D32767 | U3F.31 | | | |
| XGK-CPUH | | U7F.31 | | | |
| XGK-CPUU | | | | | |
| XGK-CPUSN | D262143 | U3F.31 | | | |
| XGK-CPUHN | D524287 | U7F.31 | Z255 | T8191 | C4095 |
| XGK-CPUUN | | | | | |

5.5 Configuration Diagram of Data Memory

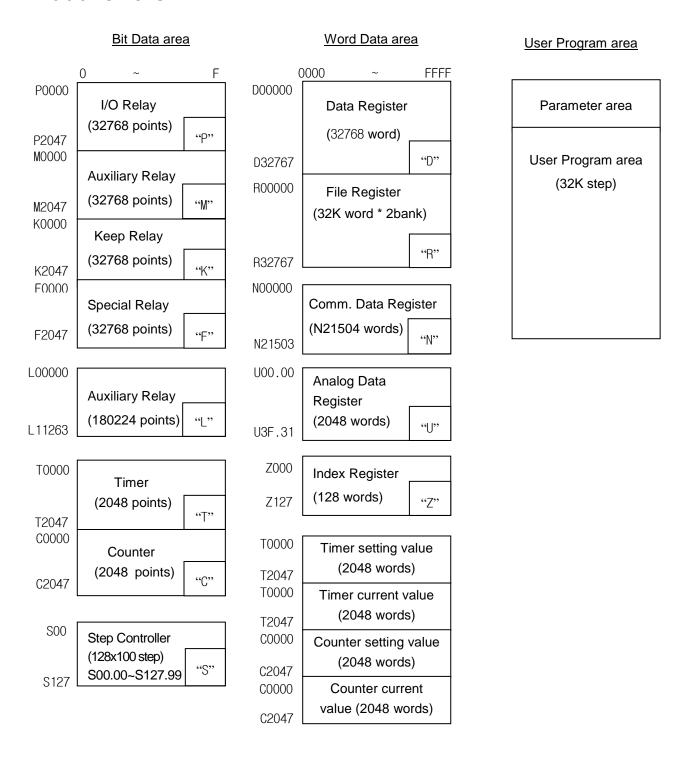
5.5.1 XGK-CPUE



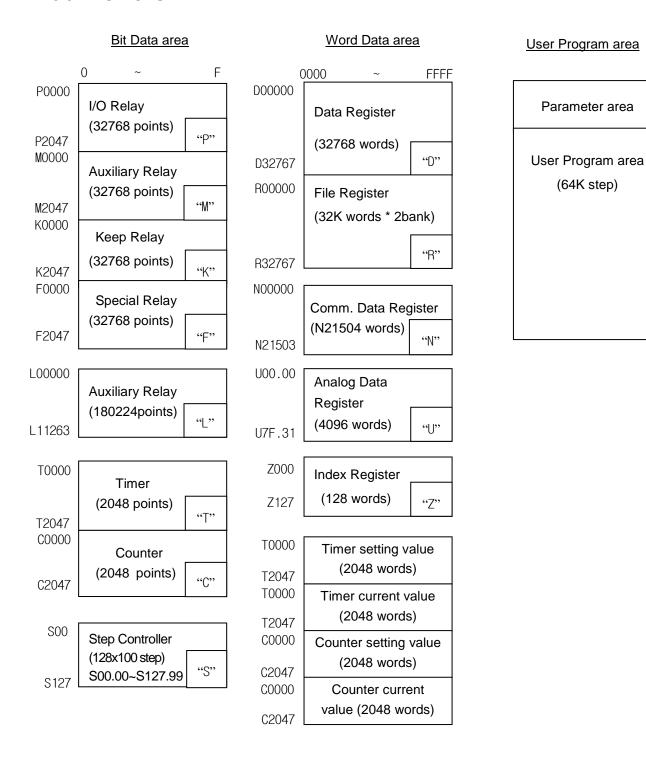
5.5.2 XGK-CPUS



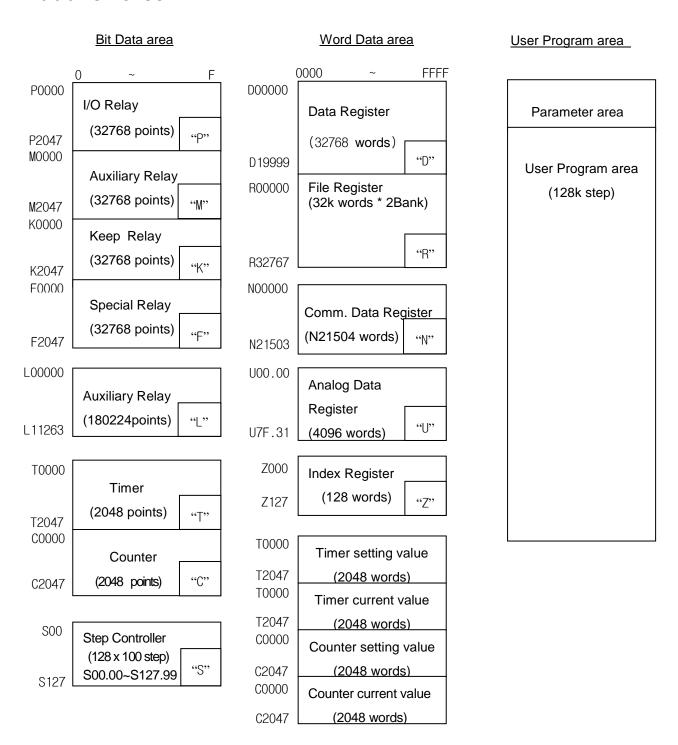
5.5.3 XGK-CPUA



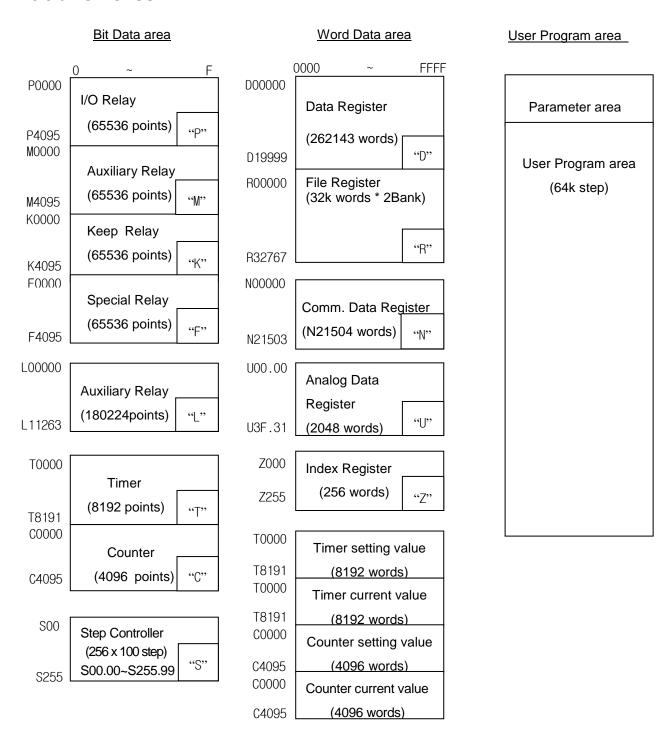
5.5.4 XGK-CPUH



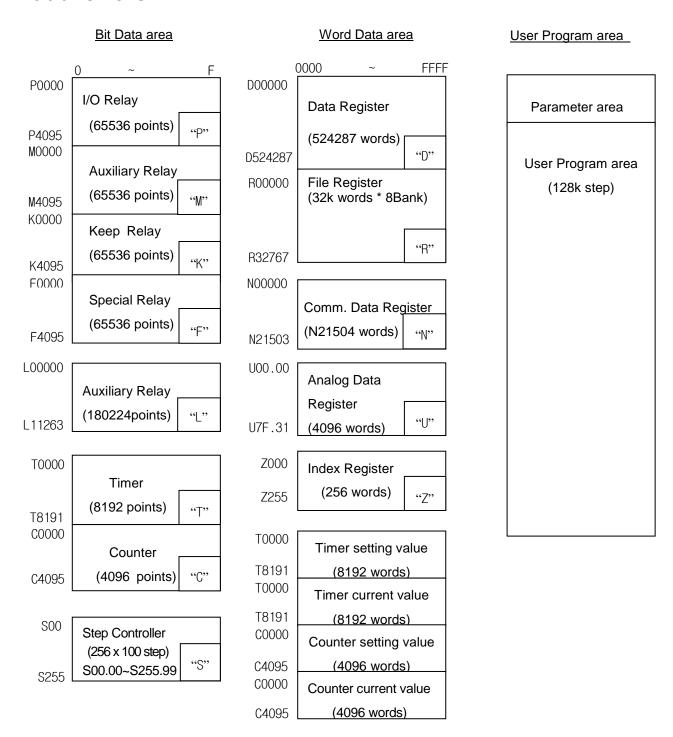
5.5.5 XGK-CPUU



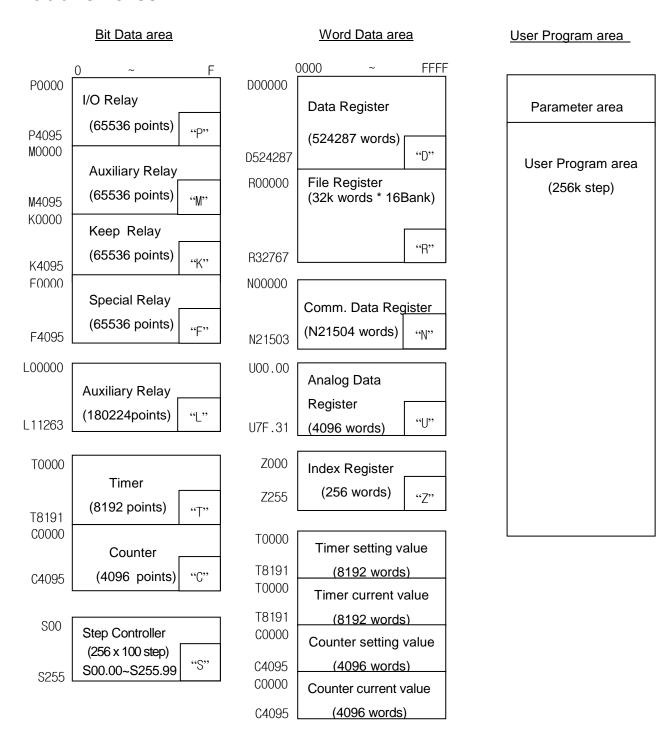
5.5.6 XGK-CPUSN



5.5.6 XGK-CPUHN



5.5.6 XGK-CPUUN



5.5.9 Data Latch Area Setting

When PLC stops and restarts the data required for operation or the data occurred during operation, if you want to keep and use those data, data latch can be used and it is available to use a certain area of some data device as latch area by parameter setting.

The below shows the features for latch device.

| Device | 1 st latch | 2 nd latch | Features |
|--------|-----------------------|-----------------------|---|
| Р | Х | Х | Image area to save the state of I/O device |
| M | 0 | 0 | Internal device area |
| K | X | Х | Device keeping the device state during power shutdown |
| F | X | Χ | System flag area |
| T | 0 | 0 | Timer related area (Bit/words both) |
| С | 0 | 0 | Counter related area (Bit/words both) |
| S | 0 | 0 | Relay for step control |
| D | 0 | 0 | General words data save area |
| U | X | Х | Analog Data Register (latch disabled) |
| | Х | Х | High speed link/P2P Service state device of communication |
| L | ^ | ^ | module (latch enabled) |
| N | Х | Χ | P2P Service address area of communication module (latch |
| IN | ^ | ^ | enabled) |
| Z | X | Χ | Index dedicated Register (latch disabled) |
| R | Χ | X | Flash memory dedicated area (latch enabled) |

Notes

- 1) K, L, N, R devices are basically latched.
- 2) K, L, R devices operate like the 1st Latch that clears data by using Overall Reset or the CPU module D.CLR switch.
- 3) For more information, refer to the Online section of the XG 5000 user's manual.

4) Data Latch Area Operation

The method to delete the latched data is as below.

- D.CLR switch operation of CPU module
- latch 1, latch 2 clear operation by XG5000
- write by Program (initialization program recommended)
- write '0' FILL from XG5000 monitor mode.

D.CLR Clear does not operate in RUN mode. Convert to STOP mode to operate. Also when clearing by D.CLR switch, bear in mind that general area shall be initialized.

When operating D.CLR momentarily, latch 1 area only shall be removed. If keeping D.CLR for 3 seconds, 6 LEDs shall be blinked and at this time, if returning the switch, even latch 2 area shall be cleared.

For keep or reset (clear) operation of latch area data according to PLC operation, please refer to the below table.

| No. | Classification | Detailed operation | Latch 1 | Latch 2 | Remarks |
|-----|------------------------|------------------------------|---------|---------|---------|
| 1 | Power change | Off/On | Keep | Keep | - |
| 2 | Reset switch | Reset | Keep | Keep | - |
| 2 | Reset Switch | Overall reset | Reset | Keep | - |
| | 3 D.CLR switch | Clear Latch 1 | Reset | Keep | - |
| 3 | | Clear Latch 2 | Reset | Reset | - |
| 4 | Program write (online) | - | Keep | Keep | - |
| 5 | Data broken | SRAM broken by battery error | Reset | Reset | - |
| 5 | Data broken | Data broken by other reason | Reset | Reset | - |
| 6 | XG5000 online | Clear Latch 1 | Reset | Keep | - |
| 6 | AGOOOD OHIINE | Clear Latch 2 | Reset | Reset | - |

5) Data Initialization

In case of Memory Delete state, the memory of all device shall be cleared as '0'. In case of giving the data value at the beginning according to system, please use the initialization task.

Chapter 6 Functions of CPU Module

6.1 Self-diagnosis

- (1) Self-diagnosis function means the function that CPU module diagnoses the error of PLC system itself.
- (2) If the power of PLC system is applied or the error occurs during operation, it detects the error and prevents the abnormal operation.

6.1.1 Scan Watchdog Timer

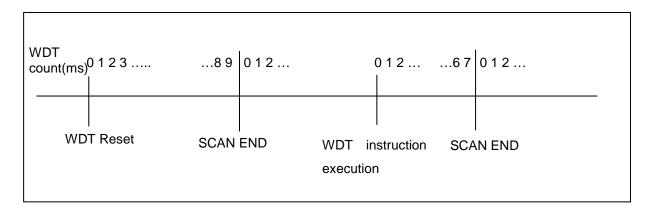
WDT (Watchdog Timer) is the function to detect the program congestion by the error of hardware and software of PLC CPU module.

- 1) WDT is the timer used to detect the operation delay by user program error. The detection time of WDT is set in Basic parameter of XG5000.
- 2) If WDT detects the excess of detection setting time while watching the elapsed time of scan during operation, it stops the operation of PLC immediately and makes the output all off.
- 3) If the excess of Scan Watchdog Time is expected in the program processing of specific part while performing the user program (FOR ~ NEXT instruction, CALL instruction), clear the timer by using 'WDT' instruction.

'WDT' instruction initializes the elapsed time of Scan Watchdog Timer and starts the time measurement from 0 again.

(For further information of WDT instruction, please refer to Instruction.)

4) To clear the error state of watchdog, we can use the following method: power re-supply, manipulation of manual reset switch, mode conversion to STOP mode.



Notes

1) The setting range of Watchdog Timer is 10 ~ 1000ms (1ms unit).

6.1.2 I/O Module Check Function

This function is to check the error state of I/O module at the time of start or during operation.

- In case that the module different from parameter setting is built-in at the time of start or it occurs the error
 or
- 2) In case I/O module is removed or occurs the error during operation,

the error state is detected and warning lamp (ERR) in front of CPU module and then CPU stops to operate.

6.1.3 Battery Voltage Check Function

If battery voltage falls less than memory backup voltage, CPU module detects it and informs of it. The warning lamp(BAT) in front of CPU module shall be ON.

For further information, please refer to "4.3.3 Durability of Battery".

6.1.4 Error History Save Function

CPU module has the function that records the error history and analyzes the cause of the error to take a proper action if the error occurs. (Refer to 6.6.1 Error History)

This is the function to save each error code in special relay F0006.

Notes

All results of self-diagnosis shall be recorded in 'F' device area.

For further information of self-diagnosis comments and error actions, please refer to Chapter 12 Trouble shooting, 12.5 Error Code List.

6.1.5 Troubleshooting

1) Classification of Error

The error occurs by PLC itself error, error in system configuration or error detection from operation results. The error is classified by heavy error mode that stops the operation for the system safety and light error mode that informs of the error occurrence warning to the user and continues the operation.

The error causes of PLC system is as follows.

- · PLC hardware error
- Error in system configuration
- Operation error during user program proceeding
- Error detection by external device failure
- 2) Action Mode in case that Error Occurs

If error occurs, PLC system records the error comments in flag and stops to operate or continues the operation according to error mode.

(1) PLC hardware error

In case of heavy error that the normal operation of PLC such as CPU module, power module is disabled, the system 'stop's and in case of light error such as battery error, it continues to operate.

(2) Error in system configuration

This error occurs when hardware configuration of PLC is different from the configuration identified in software, and the system stops.

(3) Operation Error during User Program Proceeding

This is the error occurred during user program proceeding and in case of numeric operation error, it is indicated in the error flag and the system continues to operate. While performing the operation, if the operation time exceeds the scan watchdog time or the built-in I/O module can not be controlled normally, the system stops.

Notes

- 1) The operation process is determined by selecting 'Basic Parameters → Error Operation Setup → Continue running when an arithmetic error occurs'.
- 2) The default is set to 'Continue running when an arithmetic error occurs'.

(4) Error detection by external device error

This is to detect the error of external control device by PLC user program. In case of heavy error, the system stops but in case of light error, the system indicates the error state only and continues to operate.

Notes

- If the error occurs, the error codes are saved in special relay F1026.
- 2) The error code is saved in F1027 when a soft-fault is detected.
- 3) For further information on the Flag, please refer to Appendix 1 Flag List.

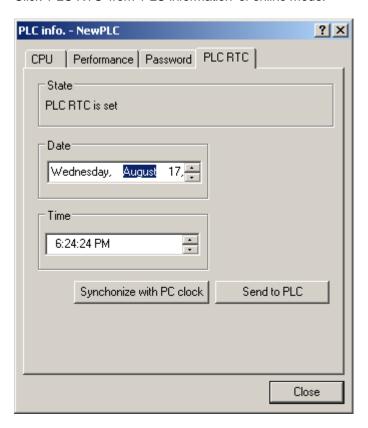
6.2 Clock

CPU module has a built-in clock device (RTC). RTC continues the clock action by battery backup even in case of power off or instantaneous interruption.

It is available to perform the time management such as operation history or failure history of system by using a clock data of RTC. The current time of RTC can be updated in F device related to the clock every scan.

1) Read and Setting from XG5000

Click 'PLC RTC' from 'PLC information' of online mode.



The time of PLC RTC is displayed. If the time of PLC RTC is wrong, you can adjust the time correct by setting the time directly to transmit to PLC or selecting 'Synchronize with PC clock' that transmits the time of PC connected to PLC.

2) RTC Read by Device

It is available to monitor RTC by special device as shown on the table below.

| RTC Read F device | Data example | Description |
|-------------------|--------------|--------------------|
| _MON_YEAR (F0053) | h0599 | May xx99 |
| _TIME_DAY (F0054) | h1512 | 12(day), 15 (time) |
| _SEC_MIN (F0055) | h4142 | 42min 41sec |
| _HUND_WK (F0056) | h2001 | Monday 20xx |

RTC Data of _TIME_DAY_DT is displayed by 24hours system.

3) RTC Data Modification by Program

It is available for the user to set the RTC value by program.

This function is used when setting the time manually through external Digit switch or making the system that corrects the time periodically through network.

'DATEWR' instruction is to insert the setting value in the F area device below and write the time to RTC at scan END.

| RTC write F device | Comments | Setting range |
|----------------------|------------------|------------------------------|
| _MON_YEAR_DT (F1034) | Month/Year | 1984 ~ 2163 Year, Jan.~ Dec. |
| _TIME_DAY_DT (F1035) | Time/Day | 1~31 Days, 0~23 Hour |
| _SEC_MIN_DT (F1036) | Second/Minute | 0~59 minute, 0~59 second |
| _HUND_WK_DT (F1037) | 100years/Weekday | 0~6 |

It is available to write the data to RTC without using a instruction, by writing the RTC data to the above area and making '_RTC_WR (F10240)' to be 'On'.

- In case that time data does not match with the form, the value is not allowed to write. (But if the week does not match, it shall be set as it is without error detection.)
- Monitor the RTC read device after writing RTC data, and check if it is modified correctly.

4) Weekday Expression Method

| No. | 0 | 1 | 2 | 3 | 4 | 5 | 6 |
|-----|--------|--------|---------|-----------|----------|--------|----------|
| Day | Sunday | Monday | Tuesday | Wednesday | Thursday | Friday | Saturday |

5) Time Tolerance

RTC tolerance depends on ambient temperature. Time tolerance according to temperature per day was indicated on the table as below.

| Operation | Max. tolerance | Normal case |
|-------------|----------------|--------------|
| temperature | (second/day) | (second/day) |
| 0 °C | - 4.67 ~ 1.38 | -1.46 |
| 25 °C | - 1.64 ~ 2.42 | 0.43 |
| 55 °C | - 5.79 ~ 0.78 | -2.29 |

Note

- 1) RTC may not have the clock data written at first.
- 2) When using a CPU module, you must set the clock data correctly at first.
- 3) In case that the data out of range of clock data is written in RTC, it may not work normally. Ex) 14Month 32Day 25Hour
- 4) RTC may stop or occur error because of battery error. If new clock data is written in RTC, the error shall be cleared.
- 5) For more information about the time date modification by program, refer to the XGK Instructions user's manual.

6.3 Remote Function

CPU module enables to change the operation by communication except key switch mounted in the module. If you want to operate it by Remote, you should set 'REM enable' switch (4-pin deep) of CPU module as 'ON' position and 'RUN/STOP' switch as 'STOP' position.

1) Type of Remote Operation

- (1) Operated by connecting XG5000 through USB or RS-232 port mounted in CPU module.
- (2) Available to operate other PLC connected to the network of PLC in the state that XG5000 is connected to CPU module.
- (3) Controls the operation state of PLC by MMI software through dedicated communication

2) Remote RUN/STOP

- (1) Remote RUN/STOP performs RUN/STOP when the deep switch of the CPU module is in the REMOTE position and the RUN/STOP switch is in the STOP position.
- (2) Convenient function in case that CPU module is installed in the position difficult to operate or CPU module inside control panel is controlled by RUN/STOP from outside.

3) Remote DEBUG

- (1) Remote DEBUG is the function to perform DEBUG operation in the state that Deep switch of CPU module is in REMOTE position and the RUN/STOP switch is in the STOP position. DEBUG operation means the function performed according to the operation condition assigned for program operation.
- (2) Convenient function in case of checking the execution state of program or the contents of each data from Debugging work

4) Remote Reset

- (1) Remote Reset is the function to reset a CPU module by remote operation in case that the error occurs in the place not possible to operate a CPU module.
- (2) This supports 'Reset' and "Overall Reset' as like an operation by switch.

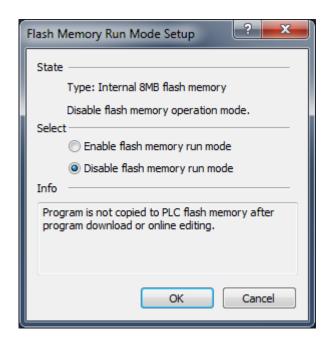
Notes

1) For operation method of Remote Function, please refer to 'Online' part from XG5000 user's manual.

5) Flash memory operation of PLC

- (1) When PLC operation mode Changes to Run, it executes Run operation after copying the program in the flash memory to the program memory. In other words, it runs PLC through the program in the flash memory.
 - (PLC operation in Run mode: it means that the operation mode changes from Stop to Run, and that the operation mode is Run when PLC is powered back on)

(2) Flash memory operation mode setting
Online → Set Flash Memory → Check the 'Enable flash memory operation mode' → Click OK





Notes

- 1) Initial mode is Disable flash memory run mode
- 2) Set Enable flash memory run mode at once, it keeps the mode On until the PADT is Off
- 3) Change of the flash memory operation mode is available regardless of RUN/STOP Mode
- 4) Make sure that the program write to the flash memory completely when you try 'modification during run' in flash memory operation mode. If it can't be written completely, the program you write before will be carried out.
- 5) When you set the flash memory operation mode, it is necessary that flash memory programming Is completed, the flash memory operation mode is applied. If you restart the PLC before program writing is completed, "flash memory operation mode" will be canceled.

Chapter 6 Function of CPU Module

(3) Flash memory operation method

If you want to change the restart or operation mode the PLC system to RUN, depending on the setting

of the flash operation mode, it works as follows.

| Set of flash memory operation mode | Operation contents |
|------------------------------------|--|
| ON | Or different contents of the flash memory and program memory, if the contents of the reasons the program memory such as a decrease in the battery voltage is damaged, then operation after downloading the program stored in the flash memory to program memory. |
| 0FF | CPU runs at a program that is recognized as programmed into the flash memory does not exist are stored in on-chip RAM. |

(4) The saving data in flash memory mode

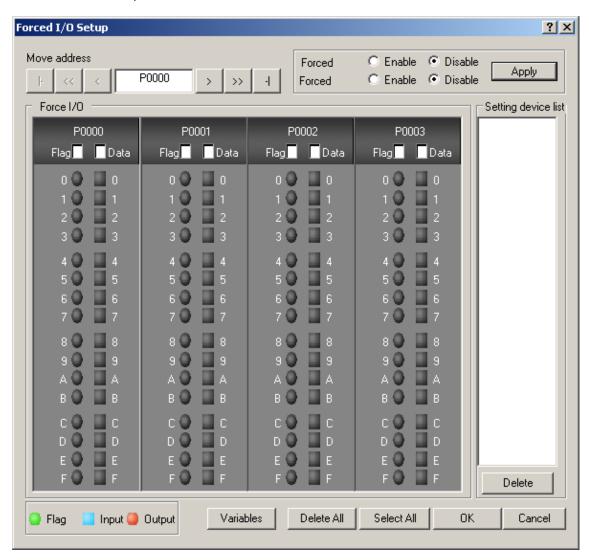
| CPU Mode | Saving data |
|--------------|--------------------------|
| Run | Local Ethernet Parameter |
| nuii | Communication Parameter |
| | Program |
| | Basic Parameter |
| | Local Ethernet Parameter |
| Stop | Communication Parameter |
| | Special module Parameter |
| | Auto Variable |
| | Comments |
| Modification | Program |
| During | Auto Variable |
| Run | Comments |

6.4 Forced I/O On/Off Function

Forced I/O function is used to force I/O area ON/OFF regardless of the result of program execution.

6.4.1 Forced I/O Setup Method

Click 'Forced I/O setup' in online mode.



To set Forced I/O, select the proper flag and data check box of P device.

To set the value "1", select the correspond bit data and flag. To set the value "0", select the flag only not bit data.

The setting is applied when forced input or output is enabled.

For further information of setting method, please refer to the XG5000 user's manual.

Notes

- 1) The Forced I/O setting is only available for the local I/O module.
- 2) It is not available for the remote I/O module (Smart I/O module).
- 3) The PS LED is turned On if Forced I/O is selected.

6.4.2 Forced On/Off Execution Point and Execution Method

(1) Forced Input

Input replaces the data of contact point set as forced On/Off from the data read in input module at the time of input refresh with the forced setting data and updates the input image area. Therefore, the user program operates with actual input data while the forced setting area operates with forced setting data.

(2) Forced Output

Output replaces the data of contact point set as forced On/Off from the data of output image area having the operation result, at the time of output refresh after completion of user program operation execution, with the forced setting data and makes prints in output module. In case of output other than input, the data of output image area does not change by forced On/Off setting.

(3) Notices in using forced I/O function

- It operates from the point setting 'enable' of each input/output, after setting the forced data.
- It is available to set the forced input even if actual I/O module is not built-in.
- Even if there are power Off -> On, change of operation mode or operation by reset key, On/Off setting data set in before is kept in CPU module.
- Forced I/O data shall not be cleared even in Stop mode.
- If you want to set the new data from the beginning, clear all settings by using 'Delete all' before using.

6.5 Direct I/O Operation

By making Refresh for I/O contact point with using 'IORF' instruction, it enables to read the state of input contact point directly during program execution and use it for operation, and also this is used when printing out the result of operation directly in output contact point.

Notes

- 1) For further information of IORF instructions, please refer to XGK Instruction manual.
- 2) If IORF instruction is used, the value is applied immediately, and it is used prior to Forced I/O.

6.6 Saving Operation History

For operation history, there are 4 types such as error history, mode conversion history, power shutdown history and system history.

The time, numbers and operation contents that each event occurred, are saved in the memory and is monitored conveniently through XG5000.

Operation history is kept saving in PLC unless it is deleted by XG5000 etc.

6.6.1 Error History

This saves the error history occurred during operation.

- Saves the error code, date, time, error detailed contents etc.
- Saves up to max. 2048
- Automatic release in case that memory backup is broken by battery voltage falling etc.

6.6.2 Mode Conversion History

This saves the changed mode information and time in case of operation mode change.

- Saves the date, time, mode conversion contents
- Saves up to max, 1024

6.6.3 Power Shutdown History

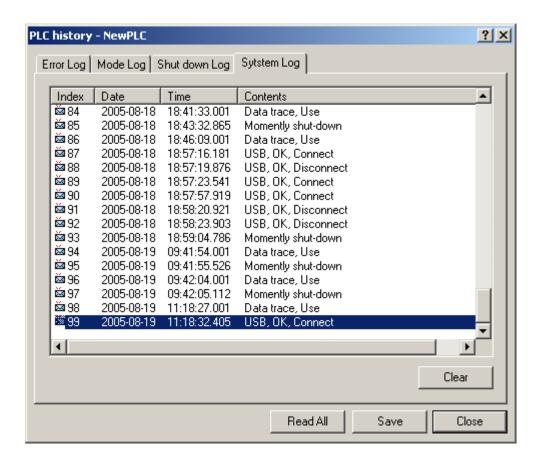
This saves the time that the power is ON or OFF with ON/OFF information.

- Saves ON/OFF information, date, time
- Saves up to max. 1024

6.6.4 System History

This saves the operation history of system occurred during operation.

- Saves the date, time and operation change contents
- XG5000 operation information, key switch change information
- Saves up to max. 2048



Notes

- 1) The saved information will not be deleted before selecting the menu from XG5000 to delete.
- 2) If the index number saved is over 100, select Read All to check previous history.

6.7 External Device Error Diagnosis

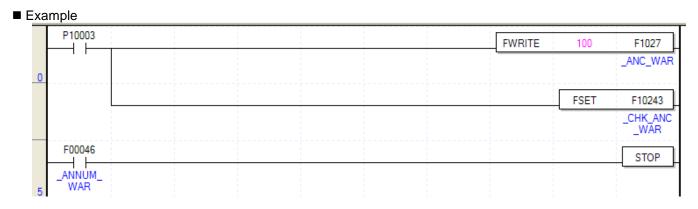
This is the flag provided so that the user can detect the error of external device and realize the stop and warning of system easily. By using this flag, it enables to indicate the error of external device without preparing the complicated program and monitor the error position without special device (XG5000) or source program.

- 1) Detection and classification of external device error
 - (1) The error of external device is detected by the user program and classified by heavy error that needs to stop the PLC operation and light error (warning) that continues the PLC operation and only indicates the error state, according to the contents of detected error.
 - (2) For heavy error, '_ANC_ERR flag' is used and for light error, '_ANC_WAR flag' is used.
- 2) Treatment of heavy error of external device
 - (1) In case that heavy error of external device is detected in the user program, classify the type of error defined by the user and write the value except '0' in the system flag '_ANC_ERR', and set system flag '_CHK_ANC_ERR'. System representative error flag '_ANNUN_ER' of '_CNF_ER' is set, PLC shall shut off all output module and becomes the error state same as PLC own error detection.
 - (2) If the error occurs, the user can find the cause of error by using a XG5000 or by monitoring '_ANC_ERR flag'.
 - (3 It is available to write the error code assigned temporarily by the user at _ANC_ERR and the available numbers are from 1 to 65,535.

3) Treatment of light error of external device

- (1) In case that heavy error is detected in the user program, classify the type of error defined by the user and write the value except '0' in the system flag '_ANC_WAR', and set system flag '_CHK_ANC_WAR'. Then, system representative error flag '_ANNUN_WAR' of '_CNF_WAR' is set and light error code of external device is saved at _ANC_WAR.
- (2) If the error occurs, the user can find the cause of error by monitoring '_ANC_WAR' flag directly.
- (3) If the light error of external device is released, '_ANC_WAR' will be released after user program is executed and system flag '_ANNUN_WAR" of '_CNF_WAR' will be reset.

Chapter 6 Function of CPU Module



If P10003 is on, inputs '100' at '_ANC_WAR' and sets system flag '_CHK_ANC_WAR'. And '_ANNUM_WAR' is set and stops PLC.

6.8 Fault Mask

1) Purpose and Operation Overview

- Fault Mask is the function to continue the program execution even if the module error occurs during operation. The module assigned as Fault Mask shall be operated normally before error occurs.
- If the error occurs in the module where the Fault Mask is set, the corresponding module stops the operation but the whole system continues the operation.
- If the module error occurs during operation, CPU module will set the error flag and the front "PS LED" shall be "ON". If connecting XG5000, you can see the error state.

2) Fault Mask Setting Method

- The Fault Mask Setting is available on the online menu of XG5000. For further information, please refer to XG5000 user's manual.
- The Fault Mask Setting is also available by setting the Fault Mask flag by program. (Please refer to Appendix 1 Flag List.)

3) Release of Fault Mask

The Fault Mask is released only by the same method as the setting.

- Setting release from online menu of XG5000.
- Automatic release in case that memory backup is broken by battery voltage falling.

The Fault Mask shall not be released in the following cases. Cares should be taken.

- Power Off → On
- Change of operation mode
- Program download
- Operation of reset key
- Data clear

Notes

 If releasing the Fault Mask in the state that error flag of CPU module is not deleted even if the cause of error occurrence is removed, the system stops. Before releasing the Fault Mask flag, check the state of error flag.

6.9 I/O Module Skip

1) Purpose and Operation Overview

This is the function to exclude the module assigned during operation, from operation. For the assigned module, it is disabled to update I/O data or diagnose the error from the assigned moment. It is allowed to use only in case of temporary operation excluding the error part.

2) Setting Method and I/O Data Processing

- It is available to set by I/O module unit.
 (For further information, please refer to XG5000 user's manual.)
- As Input(I) image area stops input refresh, it keeps the value before skip setting. But, at this time, it is
 effective to operate the image by forced On/Off.
- Actual output of output module shall be OFF in case of skip setting but output(Q) image area is changed
 according to the user program operation regardless of skip setting. It is not allowed to operate output value
 of output module by forced On/Off after skip setting.
- The execution of skip function when using direct I/O function is same.

3) Release of Skip Function

The skip of I/O module shall be released only by the same method as setting.

- Setting release from online menu of XG5000
- Automatic release in case the memory backup is broken by battery voltage falling

The Fault Mask shall be released even in the cases as below. Cares should be taken.

- Power Off→On
- Change of operation mode
- Program download
- Operation of reset key
- Data clear

Notes

When releasing a skip, if the error occurs in the corresponding module, the system may stop.
Release the skip in the state that the Fault Mask is set and check the normal operation of module
before releasing the skip.

6.10 Changing Module during Operation

XGK system enables to change the module during operation. But, as the change of module during operation may occur the abnormal operation of whole system, special attention should be taken. Just follow the procedure assigned in this user's manual.

- 1) Notices in Using
 - Not allowed to change the base and power module.
 - Some part of communication module (XGL-PMEA, XGL-DMEA) needs the network setting (Sycon used) for communication.
 - In case of module change, match the joint part of the lower part of base and module correctly before inserting. If not, it may cause the system shutdown.
- 2) Module Change Method

There are 2 kinds of module change method.

- (1) By using XG5000 "Module Change Wizard" function. For further information, please refer to XG5000 user's manual.
- (2) By using CPU module switch
 - (1) Set "Module change switch (M.XCHG)" in front of CPU module as right(ON).
 - (2) Remove the module. (PS LED is ON)
 - (3) Setup the new module. (in case of normal module setup, PS LED is OFF)
 - (4) Check if module operates normally.
 - (5) Set "Module change switch (M.XCHG)" as left (OFF).

Notes

- 1) When changing the module, shut down the load power for safety.
- 2) When changing the input module, consider the setting of input image state by using the forced On/Off.

Warning

When installing the module, it may cause an abnormal operation if the lower connection is not mounted on the base completely.

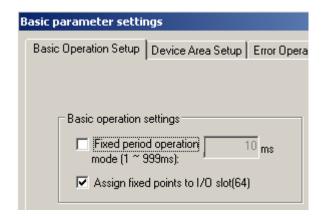
6.11 I/O No. Allocation Method

The allocation of I/O No. is to give the address to the I/O terminal of each module in order to read the data from input module and print the data to output module when performing the operation.

For I/O No. allocation, base no., slot position, module type for setup and parameter setting etc. are related. XGK provides 2 types such as fixed and variable.

6.11.1 Fixed I/O No. Allocation

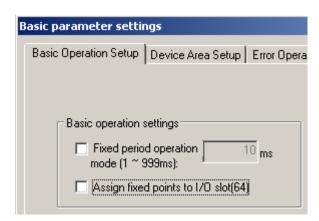
By selecting "Assign fixed points to I/O slot" from basic parameter, 64 points shall be allocated to each slot regardless of setup module. In this case, I/O parameter shall be applied only to judge whether the module type installed in the system corresponds, but not applied to point allocation.



For example of point allocation, please refer to "2.3 Basic System".

6.11.2 Variable I/O No. Allocation

By releasing "Assign fixed points to I/O slot" from basic parameter, the variable type that the point allocation is changed per slot shall be set.

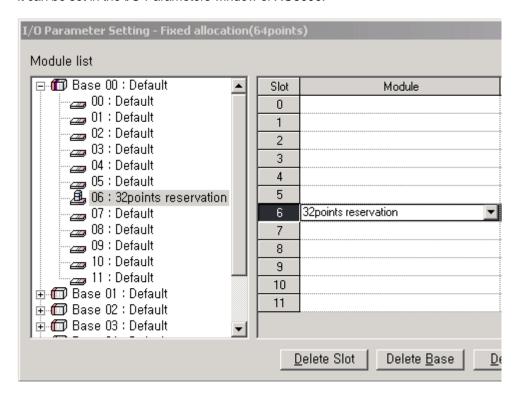


If setting I/O parameter, the point related to the setting module shall be given to the assigned slot. For the next slot, the number following I/O no. occupied by the previous slot shall be allocated.

For example of point allocation, please refer to "2.3 Basic System".

6.11.3 Module Reservation Function

This function is used for the variable I/O number allocation method to reserve modules to be mounted. If this function is used, the program modification is not necessary to change the I/O number. It can be set in the I/O Parameters window of XG5000.



Notes

- 1) If a module greater than 16-point is mounted on without reservation, the I/O number will become different and an abnormal operation will occur.
- 2) Only reserved points are available although larger point modules are mounted. The remainder are ignored.
- 3) Program modification is not necessary because all slots are assigned as 64points in Fixed Allocation.

6.12 Program Modification during Operation

It is available to modify program or some parameter without stopping the control operation during PLC operation. For further information, please refer to XG5000 user's manual.

The items available to modify during operation are as below.

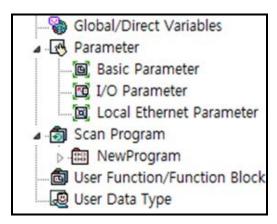
- Program modification
- Communication parameter modification

6.13 Local Ethernet function(XGK-CPUUN/CPUHN/CPUSN)

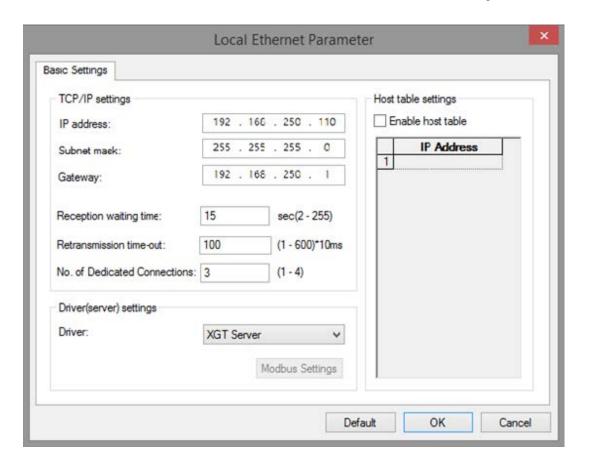
XGK-CPUUN/CPUHN/CPUSN can carry out the functions of Ethernet server using internal local Ethernet function without extra Enet I/F module.(Note, The internal local Ethernet doesn't offer remote connections. Only used for local connection.)

6.13.1 Local Ethernet Parameter Settings.

Make a new project. Then user can see Local Ethernet Parameters as shown below figure.



If user selects Local Ethernet Parameter item, Local Ethernet Parameter setting window will be displayed.



To use the Local Ethernet function, user should set the parameters.

(1) TCP/IP Setting

| (1) TOP/IP Setting | |
|---------------------------------|--|
| Classification | Description |
| IP address | Specify the IP Address of the applicable CPU module. |
| | * Note: There can be a communications disruption if you set more than 2 servers |
| | as a same IP |
| Subnet mask | Value necessary to check if destination station is on the same network of the applicable station. |
| Gateway | IP address of Gateway or Router to transmit/receive data through the public network or a network different from the network where the applicable FEnet module is included. |
| Reception waiting time | If there is no request during the specified time from the host PC or MMI connected for dedicated communication, it will end the dedicated service connection regardless of normal ending procedures supposing that the higher level system is with error. This time is used in dedicated service to reset the channel when any error occurs on the destination station or the cable is disconnected. Reception waiting time can be set as a unit of 1 sec (available range is 2s to 255s) |
| | It is the time it takes CPU to send a data to the destination station if the destination station does not answer the data sent by applicable station during setting time. (Applicable station considers it as a data missing.) (available range is 10 ms \sim 6000 ms) |
| Retransmission time-out (10 ms) | * Note : Retransmission time-out should be set depending on the network situation. If the setting time is too long, it takes a long time to resend a data in case of data missing. This will deteriorate the network performance. But if the setting time is too short, there is a chance to make a frequent disconnection or increase the load to the network. |
| Number of dedicated connections | Number of TCP dedicated services accessible at a time. (Max.4) |

(2) Driver(Server) setting

| Classification | Description | | |
|----------------------|---|--|--|
| XGT server | Set when operated as dedicated communication server (slave) | | |
| Modbus TCP/IP server | Set when operated as Modbus server driver (slave) | | |

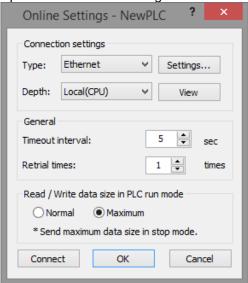
(3) Host table setting

| - 1 | riot table county | | |
|----------------|-------------------|---|--|
| Classification | | Description | |
| | Enable host table | Access allowed to applicable module of IP address registered in host table (unregistered client(IP address) is prohibited from connection when enabled) | |

6.13.2 Local Ethernet connection with XG5000

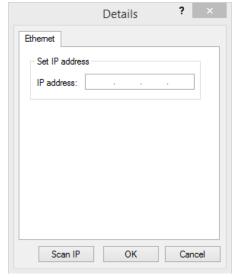
After finishing Local Ethernet Parameter settings, download the settings to the CPU, then user can connect to XG5000.

Select Online Settings and set the options as shown below figure.



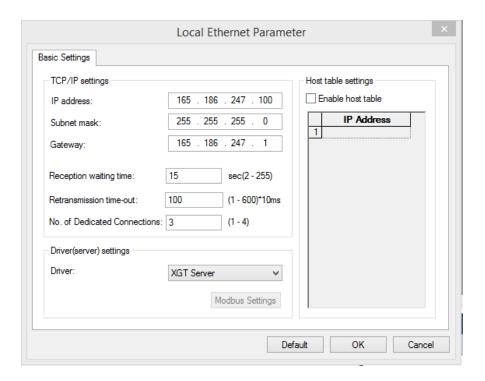
Click the setting button to specify Ethernet IP. Click OK after specify the Ethernet IP set before.

User can find the IP information available now.



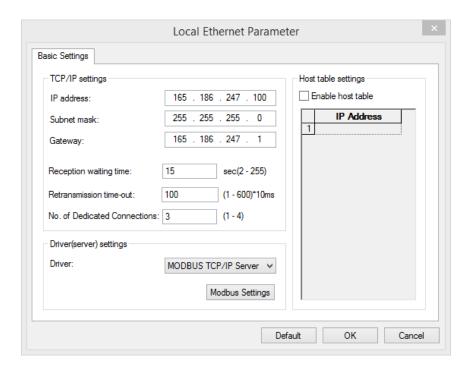
6.13.3 Local Ethernet connection with XGT Server.

Set the Local Ethernet Parameters as shown below figure. User can use it as a XGT Server (LSIS dedicated Protocol Communication).

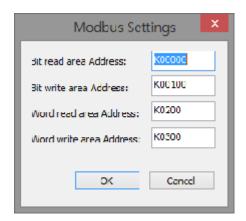


6.13.4 Local Ethernet connection with TCP/IP Server.

Set the Local Ethernet Parameters as shown below figure. User can use it as a Modbus server



Below figure is about Modbus settings. .



Note

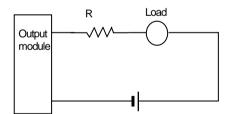
- 1) Modbus TCP/IP server connection function allows RST packet transmission depending on the network condition.(TCP/IP protocol)
 - So the user devices connecting to CPU module should have RST packet process.
- 2) Connection to user devices can be disconnected for retransmission time-out.
 Retransmission time-out = retransmission time-out value(set in the Local Ethernet Parameter window) x
 30ms
- 3) Too much Network loads can affect a scan time. So user should consider appropriate network loads for CPU scan time.

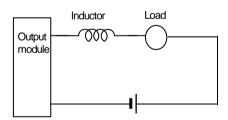
Chapter 9. I/O Module

9.1 Cautions for Selecting Module

It describes the cautions when selecting digital I/O modules used for the XGI series.

- 1) There are two digital input types; current sink input and current source input Since the wiring method of external input power varies in a DC input module, it should be selected considering the specifications of input connectors.
- 2) The max. simultaneous input point varies depending on a module type. That is, it may be different, depending on input voltage and ambient temperature. Please review the specifications of input module to apply before use.
- 3) In case of an application for highly frequent switching or inductive load switching, the relay output module may have a shorter life, so it needs a transistor module or triac output module, instead of it.
- 4) If an output module operates an inductive load(L), the max. On/Off frequency should be limited to On per 1 second and Off per 1 second, each.
- 5) In case a counter timer using DC/DC converter is used as a load in an output module, setting the average current may cause a trouble because it may have inrush current in case of On or a certain cycle during operation. Therefore, if using the foresaid load, it is necessary to connect resistance or inductor parallel to load or alternatively use a module of which max. load current is large.

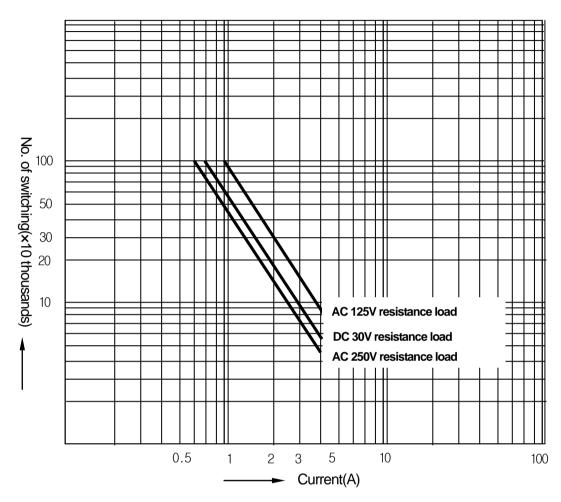




6) A fuse in an output module can not be replaced. That's why it is intended to prevent external wiring from being damaged when the output of a module is short-circuited. Therefore, the output module may not be protected. If an output module is destructed in any other fault mode save for short-circuit, a fuse may not work.

Chapter 9. I/O Module

7) The following figure shows the relay life of relay output module. It also shows the max. life of relay used for relay output.



8) A clamped terminal with sleeve can not be used for the XGI terminal strip. The clamped terminals suitable for terminal strip are as follows(JOR 1.25-3:Daedong Electricity).



- 9) The cable size connected to a terminal strip should be 0.3~0.75 mm² stranded cable and 2.8 mm thick. The cable may have different current allowance depending on the insulation thickness.
- 10) The coupling torque available for fixation screw and terminal strip screw should follow the table below.

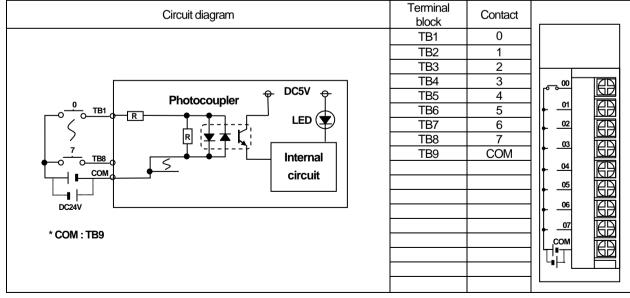
| Coupling position | Coupling torque range |
|---|-----------------------|
| IO module terminal strip screw(M3 screw) | 42 ~ 58 N·cm |
| IO module terminal strip fixation screw(M3 screw) | 66 ~ 89 N-cm |

Transistor output module(XGQ-TR4A, XGQ-TR8A) supports terminal protector function.
 Thermal Protector is the function to prevent overload and overheat.

9.2 Digital Input Module Specifications

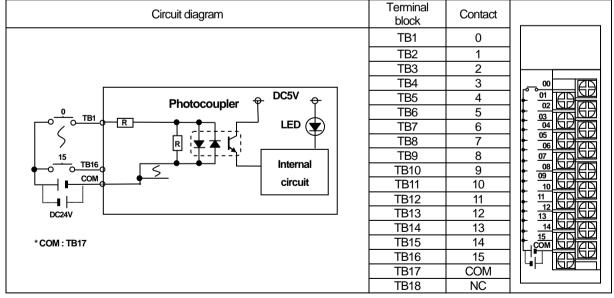
9.2.1 8 point DC24V input module (source/sink type)

| Spec. | Module type | DC Input module XGI-D21A | | | | | | |
|-------------------------|-------------|--|--|--|--|--|--|--|
| Input point | | 8 points | | | | | | |
| Insulation method | | Photo coupler insulation | | | | | | |
| Rated input voltage | | DC24V | | | | | | |
| Rated input current | | Approx. 4 mA | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower ripple rate) | | | | | | |
| Input derating | | None | | | | | | |
| On voltage / On curre | ent | DC19V and higher / 3 mA and higher | | | | | | |
| Off voltage / Off curre | ent | DC11V and lower / 1.7 mA and lower | | | | | | |
| Input resistance | | Approx. 5.6 k Ω | | | | | | |
| Deemana tima | Off → On | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | |
| Response time | On → Off | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | |
| Withstand voltage | | AC560V rms/3 Cycle (altitude 2000m) | | | | | | |
| Insulation resistance | | 10 MΩ and higher by Insulation ohmmeter | | | | | | |
| Common method | | 16 point/ COM | | | | | | |
| Suitable cable size | | Stranded cable between 0.3~0.75 mm² (2.8mm and smaller outer dia.) | | | | | | |
| Suitable clamped ter | minal | R1.25-3 (Sleeve built-in clamped terminal is not available) | | | | | | |
| Current consumption | n(mA) | 20mA | | | | | | |
| Operation display | | LED On with Input On | | | | | | |
| External connection | method | 9 point Terminal strip connector (M3 X 6 screws) | | | | | | |
| Weight | | 0.1 kg | | | | | | |



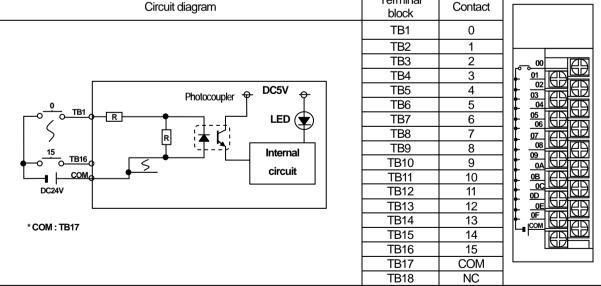
9.2.2 16 point DC24V input module (source/sink type)

| Spec. Input point | | YGLD22A | | | | | | | |
|----------------------|-------------------------------|--|--|--|--|--|--|--|--|
| Input point | | XGI-D22A | | | | | | | |
| | | 16 points | | | | | | | |
| Insulation method | | Photo coupler insulation | | | | | | | |
| Rated input voltage | | DC24V | | | | | | | |
| Rated input curren | t | Approx. 4 mA | | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower ripple rate) | | | | | | | |
| Input derating | | None | | | | | | | |
| On voltage / On cu | ırrent | DC 19V and higher / 3mA and higher | | | | | | | |
| Off voltage / Off cu | ırrent | DC 11V and lower / 1.7mA and lower | | | | | | | |
| Input resistance | | Approx. 5.6 kΩ | | | | | | | |
| Deen once time | $Off \rightarrow On$ | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | |
| Response time - | $On \mathop{\rightarrow} Off$ | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | |
| Insulation withstan | d voltage | AC560V rms/3 Cycle (altitude 2000m) | | | | | | | |
| Insulation resistand | ce | 10 MΩ and higher by Insulation ohmmeter | | | | | | | |
| Common method | | 16 point/ COM | | | | | | | |
| Suitable cable size |) | Stranded cable between 0.3~0.75 mm² (2.8mm and smaller outer dia.) | | | | | | | |
| Suitable clamped t | terminal | R1.25-3 (Sleeve built-in clamped terminal is not available) | | | | | | | |
| Current consumpti | ion(^{mA}) | 30mA | | | | | | | |
| Operation display | | LED On with Input On | | | | | | | |
| External connectio | n method | 18 point Terminal strip connector (M3 X 6 screws) | | | | | | | |
| Weight | | 0.12 kg | | | | | | | |



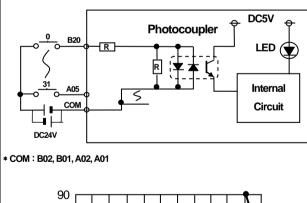
9.2.3 16 point DC24V input module (source type)

| | Module type | DO | C Input module | | | | | | | |
|----------------------|------------------------|--|--|-----------------|-------|--|--|--|--|--|
| Spec. | | | XGI-D22B | | | | | | | |
| Input point | | 16 points | | | | | | | | |
| Insulation metho | d | Photo coupler insulation | | | | | | | | |
| Rated input volta | ige | DC24V | | | | | | | | |
| Rated input curre | ent | Approx. 4 mA | | | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower rippl | e rate) | | | | | | | |
| Input derating | | None | | | | | | | | |
| On voltage / On | current | DC 19V and higher / 3mA and high | er | | | | | | | |
| Off voltage / Off of | current | DC 11V and lower / 1.7mA and low | er er | | | | | | | |
| Input resistance | | Approx. 5.6 kΩ | | | | | | | | |
| Response time | Off → On | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | | |
| Response une | $On \rightarrow Off$ | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | | |
| Insulation withsta | and voltage | AC560V rms/3 Cycle (altitude 2000 | 2000m) | | | | | | | |
| Insulation resista | ince | 10 MΩ and higher by Insulation ohmmeter | | | | | | | | |
| Common metho | d | 16 point/ COM | | | | | | | | |
| Suitable cable siz | ze | Stranded cable between 0.3~0.75 | m² (2.8mm and | smaller outer o | dia.) | | | | | |
| Suitable clamped | d terminal | R1.25-3 (Sleeve built-in clamped te | rminal is not ava | nilable) | | | | | | |
| Current consump | ption(^{mA}) | 30mA | 30mA | | | | | | | |
| Operation display | у | LED On with Input On | | | | | | | | |
| External connect | tion method | 18point Terminal strip connector (M | 18point Terminal strip connector (M3 X 6 screws) | | | | | | | |
| Weight | | 0.12 kg | | | | | | | | |
| | Circuit | diagram | Terminal block | Contact | | | | | | |
| | | | TB1 | 0 | | | | | | |
| | | | TB2 | 1 | | | | | | |
| | | | TB3 | 2 | | | | | | |



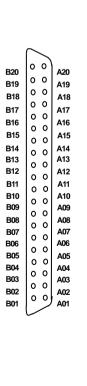
9.2.4 32 point DC24V input module (source/sink type)

| | Module type | DC Input module | | | | | | | | |
|----------------------|------------------------|--|--------------|-----------|---------|------------|--|--|--|--|
| Spec. | | | Х | GI-D24A | 1 | | | | | |
| Input point | | 32 points | | | | | | | | |
| Insulation metho | d | Photo coupler insulation | | | | | | | | |
| Rated input volta | ge | DC24V | | | | | | | | |
| Rated input curre | ent | Approx. 4 mA | | | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower | er ripple ra | ate) | | | | | | |
| Input derating | | Refer to the below derating le | evel | | | | | | | |
| On voltage / On o | current | DC 19V and higher / 3mA ar | nd higher | | | | | | | |
| Off voltage / Off of | current | DC 11V and lower / 1.7mA and lower | | | | | | | | |
| Input resistance | | Approx. 5.6 kΩ | | | | | | | | |
| Decrease time | Off → On | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | | |
| Response time | $On \rightarrow Off$ | 1ms/3ms/5ms/10ms/20ms/7 Initial value:3ms | '0ms/100 | ms (Set b | y CPU F | Parameter) | | | | |
| Insulation withsta | and voltage | AC560V rms/3 Cycle (altitude 2000m) | | | | | | | | |
| Insulation resista | nce | 10 MΩ and higher by Insulation ohmmeter | | | | | | | | |
| Common method | d | 32points / COM | | | | | | | | |
| Suitable cable siz | ze | 0.3 mm² | | | | | | | | |
| Current consump | otion(^{mA}) | 50mA | | | | | | | | |
| Operation display | <i>y</i> | LED On with Input On | | | | | | | | |
| External connect | ion method | 40point connector | | | | | | | | |
| Weight | | 0.1 kg | | | | | | | | |
| | Circuit diag | gram | No | Contact | No | Contact | | | | |



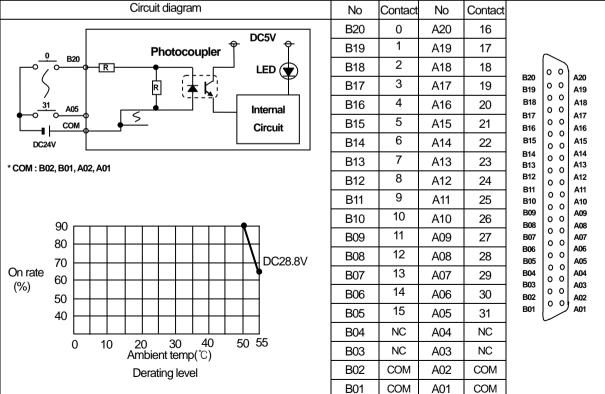
| | 90 | П | | | | | | | | | | | | |
|---------|----|---|---|-----|-------|-------|------|------|---|---|---------------|----|------|----|
| | 80 | Н | | | | | | - | | | + | | | |
| _ | 70 | Ш | | | | | | Ш | | | \rightarrow | DC | 28.8 | BV |
| On rate | 60 | Ш | | | | | | | | | | | | |
| (%) | 50 | Ш | | | | | | | | | | | | |
| | 40 | Н | | | | | | | | | | | | |
| | | Ш | | | | | | Ш | | | | | | |
| | (| 0 | 1 | 2 | | 3 | | 40 | 0 | 5 | 0 5 | 55 | | |
| | | | | Aml | oier | nt te | mp(| (°C) | | | | | | |
| | | | | De | ratii | ng le | evel | | | | | | | |

| No | Contact | No | Contact |
|-----|---------|-----|---------|
| B20 | 0 | A20 | 16 |
| B19 | 1 | A19 | 17 |
| B18 | 2 | A18 | 18 |
| B17 | 3 | A17 | 19 |
| B16 | 4 | A16 | 20 |
| B15 | 5 | A15 | 21 |
| B14 | 6 | A14 | 22 |
| B13 | 7 | A13 | 23 |
| B12 | 8 | A12 | 24 |
| B11 | 9 | A11 | 25 |
| B10 | 10 | A10 | 26 |
| B09 | 11 | A09 | 27 |
| B08 | 12 | A08 | 28 |
| B07 | 13 | A07 | 29 |
| B06 | 14 | A06 | 30 |
| B05 | 15 | A05 | 31 |
| B04 | NC | A04 | NC |
| B03 | NC | A03 | NC |
| B02 | COM | A02 | COM |
| B01 | COM | A01 | COM |



9.2.5 32 point DC24V input module (source type)

| | Module type | DC Input module | | | | | | | |
|---------------------------|----------------------|---|--|--|--|--|--|--|--|
| Spec. | | XGI-D24B | | | | | | | |
| Input point | | 32 points | | | | | | | |
| Insulation method | | Photo coupler insulation | | | | | | | |
| Rated input volta | ige | DC24V | | | | | | | |
| Rated input curre | ent | Approx. 4 mA | | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower ripple rate) | | | | | | | |
| Input derating | | Refer to the below derating level | | | | | | | |
| On voltage / On current | | DC19V and higher / 3 mA and higher | | | | | | | |
| Off voltage / Off current | | DC 11V and lower / 1.7mA and lower | | | | | | | |
| Input resistance | | Approx. 5.6 kΩ | | | | | | | |
| Decrease time | Off → On | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | |
| Response time | $On \rightarrow Off$ | 1ms/3ms/5ms/10ms/20ms/70ms/100ms (Set by CPU Parameter) Initial value:3ms | | | | | | | |
| Insulation withsta | and voltage | AC560V rms/3 Cycle (altitude 2000m) | | | | | | | |
| Insulation resista | nce | 10 MΩ and higher by Insulation ohmmeter | | | | | | | |
| Common method | d | 32 points / COM | | | | | | | |
| Suitable cable siz | ze | 0.3 m² | | | | | | | |
| Current consump | otion(mA) | 50mA | | | | | | | |
| Operation display | у | LED On with Input On | | | | | | | |
| External connect | tion method | 40point connector | | | | | | | |
| Weight | | 0.1 kg | | | | | | | |
| | 0::: | · | | | | | | | |



9.2.6 64 point DC24V input module (source/sink type)

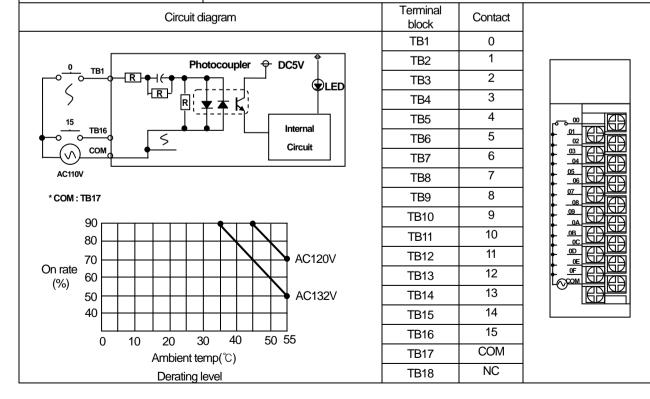
| M | DC Input module | | | | | | | | | | | | | |
|----------------------------|-----------------------|--|-----------------------|--|-------------|---------|-----------|---------|---------|------------|-----|------------|--|--|
| Spec. | | | | | | XGI-E |)28A | | | | | | | |
| Input point | | 64 points | | | | | | | | | | | | |
| Insulation method | Insulation method | | | Photo coupler insulation | | | | | | | | | | |
| Rated input voltage | DC24V | | | | | | | | | | | | | |
| Rated input current | | Approx. 4 mA | | | | | | | | | | | | |
| Voltage range | | DC20.4~28.8V (5% and lower ripple rate) | | | | | | | | | | | | |
| Input derating | | Refer to the below derating level | | | | | | | | | | | | |
| On voltage / On current | | DC 19 | 9V and h | igher / 3r | mA and h | igher | | | | | | | | |
| Off voltage / Off current | | DC 1 | 1V and lo | ower / 1.7 | mA and I | ower | | | | | | | | |
| Input resistance | | Appro | x. 5.6 k | 2 | | | | | | | | | | |
| Danaga tima | Off → On | | 3ms/5ms I value:3r | |)ms/70m: | s/100ms | (Set by 0 | CPU Par | ameter) | | | | | |
| Response time | $On \rightarrow Off$ | | 3ms/5ms I value:3i | | Oms/70m | s/100ms | (Set by 0 | CPU Par | ameter) | | | | | |
| Insulation withstand volta | nge | AC56 | 0V rms/3 | 3 Cycle (a | altitude 20 | 000m) | | | | | | | | |
| Insulation resistance | | 10 MΩ | and high | her by In: | sulation o | hmmetei | • | | | | | | | |
| Common method | | 32poi | nt / COM | 1 | | | | | | | | | | |
| Suitable cable size | | 0.3 mm | 2 | | | | | | | | | | | |
| Current consumption(mA) | | 60mA | | | | | | | | | | | | |
| Operation display | Operation display | | | LED On with Input On (32point LED on by switching) | | | | | | | | | | |
| External connection meth | nod | 40point connector × 2 | | | | | | | | | | | | |
| Weight | | 0.15 k | g | | | | | | | | | | | |
| Circuit di | agram | No | Contact | No | Contact | No | Contact | No | Contact | | | | | |
| | | 1B20 | 0 | 1A20 | 16 | 2B20 | 32 | 2A20 | 48 | | | | | |
| Dhata | DC5V DC5V | 1B19 | 1 | 1A19 | 17 | 2B19 | 33 | 2A19 | 49 | | _ | | | |
| 0 Prioto | LED | 1B18 | 2 | 1A18 | 18 | 2B18 | 34 | 2A18 | 50 | B20 | 0 0 | A20 | | |
| | | 1B17 | 3 | 1A17 | 19 | 2B17 | 35 | 2A17 | 51 | B19 B18 | | A19 A18 | | |
| 63 2405 | Internal | 1B16 | 4 | 1A16 | 20 | 2B16 | 36 | 2A16 | 52 | B17 | 0 0 | A17 | | |
| COM | Circuit | 1B15 | 5 | 1A15 | 21 | 2B15 | 37 | 2A15 | 53 | B16 B15 | 0 0 | A16 | | |
| | <u> </u> | 1B14 | 6 | 1A14 | 22 | 2B14 | 38 | 2A14 | 54 | B14 B13 | 0 0 | A14 | | |
| DC24V | | 1B13 | 7 | 1A13 | 23 | 2B13 | 39 | 2A13 | 55 | B12 | 0 0 | A12 | | |
| | A Switching Circuit | 1B12 | 8 | 1A12 | 24 | 2B12 | 40 | 2A12 | 56 | B11 B10 | 0 0 | A11 | | |
| | Bo Circuit | 1B11 | 9 | 1A11 | 25 | 2B11 | 41 | 2A11 | 57 | B09 B08 | 0 0 | A09 | | |
| * COM: 1B02, 1B01 | A: Displaying 0~31 | 1B10 | 10 | 1A10 | 26 | 2B10 | 42 | 2A10 | 58 | B07 | 0 0 | A07 | | |
| 2B02, 2B01 | B: Displaying 32~63 | 1B09 | 11 | 1A09 | 27 | 2B09 | 43 | 2A09 | 59 | B06 B05 | 0 0 | A06 | | |
| 90 | | 1B08 | 12 | 1A08 | 28 | 2B08 | 44 | 2A08 | 60 | B04 B03 | 0 0 | A04 | | |
| 90 80 70 | | 1B07 | 13 | 1A07 | 29 | 2B07 | 45 | 2A07 | 61 | B02 | 0 0 | A02 | | |
| On rate 60 | | 1B06 | 14 | 1A06 | 30 | 2B06 | 46 | 2A06 | 62 | B01 | | A01 | | |
| (%) 50 40 | DC28.8V | 1B05 | 15 | 1A05 | 31 | 2B05 | 47 | 2A05 | 63 | | | | | |
| 30 20 | | 1B04 | NC | 1A04 | NC | 2B04 | NC | 2A04 | NC | | | | | |
| 0 10 20 3 | 30 40 50 55 | 1B03 | NC | 1A03 | NC | 2B03 | NC | 2A03 | NC | | | | | |
| Ambient | | 1B02 | COM | 1A02 | NC | 2B02 | COM | 2A02 | NC | | | | | |
| Deratino | g level | 1B01 | COM | 1A01 | NC | 2B01 | COM | 2A01 | NC | | | | | |

9.2.7 64 point DC24V input module (source type)

| Spec. | Module type | | | | | DC Input XGI-I | |) | | | | | | |
|---|-------------------------|---|--------------------|--------------|------------|-------------------|-----------|--------------|----------|------------|--------------------|--|--|--|
| Input point | | 64 poi | ints | | | XOI L | 200 | | | | | | | |
| Insulation method | | · - | | insulation | า | | | | | | | | | |
| Rated input voltage | | Photo coupler insulation DC24V | | | | | | | | | | | | |
| Rated input current | | Approx. 4 mA | | | | | | | | | | | | |
| Voltage range | | | | √ (5% an | d lower ri | pple rate |) | | | | | | | |
| Input derating | | DC20.4~28.8V (5% and lower ripple rate) Refer to the below derating level | | | | | | | | | | | | |
| On voltage / On current | | <u> </u> | | igher/3r | | | | | | | | | | |
| Off voltage / Off current | | | | ower / 1.7 | | | | | | | | | | |
| Input resistance | | Appro | x. 5.6 k | 2 | | | | | | | | | | |
| | Off → On | 1ms/3 | | /10ms/20 |)ms/70m | s/100ms | (Set by C | PU Para | ameter) | | | | | |
| Response time | $On \rightarrow Off$ | | 3ms/5ms value:3 | |)ms/70m | s/100ms | (Set by 0 | CPU Par | ameter) | | | | | |
| Insulation withstand voltag | ge | | | 3 Cycle (a | | | | | | | | | | |
| Insulation resistance | | 10 MΩ | and hig | her by Ins | sulation o | hmmete | • | | | | | | | |
| Common method | | 32 poi | ints / CO | M | | | | | | | | | | |
| Suitable cable size | | 0.3 ㎜ | : | | | | | | | | | | | |
| Current consumption(mA) | Current consumption(mA) | | | 60mA | | | | | | | | | | |
| Operation display | | LED On with Input On (32point LED on by switching) | | | | | | | | | | | | |
| External connection meth | od | 40point connector × 2 | | | | | | | | | | | | |
| Weight | | 0.15 k | g | | | | | | | | | | | |
| Circuit dia | agram | No | Contact | No | Contact | No | Contact | No | Contact | | | | | |
| | ⇔ DC5V ↔ | 1B20 | 0 | 1A20 | 16 | 2B20 | 32 | 2A20 | 48 | | | | | |
| 0 Photoco | | 1B19 | 1 | 1A19 | 17 | 2B19 | 33 | 2A19 | 49 | | | | | |
| | | 1B18 | 2 | 1A18 | 18 | 2B18 | 34 | 2A18 | 50 | B20 | 0 0 A20 | | | |
| | <u></u> | 1B17 | 3 | 1A17 | 19 | 2B17 | 35 | 2A17 | 51 | B19 B18 | 0 0 A18 | | | |
| 0 2A05 COM | - Internal I | 1B16 | 4 | 1A16 | 20 | 2B16 | 36 | 2A16 | 52 | B17 B16 | 0 0 A17 A16 | | | |
| | Circuit | 1B15 | 5 6 | 1A15 | 21 | 2B15 | 37 | 2A15 | 53 | B15 | 0 0 A15 | | | |
| DC24V | . [] | 1B14 1B13 | 7 | 1A14 1A13 | 22 | 2B14 2B13 | 38 39 | 2A14 2A13 | 54 55 | B14 B13 | 0 0 A14 0 0 A13 | | | |
| | A Switching Circuit | 1B13 | 8 | 1A13 | 23 24 | 2B13 | 40 | 2A13 | 56 | B12 B11 | 0 0 A12 | | | |
| | | 1B12 | 9 | 1A11 | 25 | 2B12 | 41 | 2A12 | 57 | B10 | 0 0 A10 | | | |
| * COM: 1B02, 1B01 2B02, 2B01 | A: Displaying 0~31 | 1B10 | 10 | 1A10 | 26 | 2B10 | 42 | 2A10 | 58 | B09 B08 | 0 0 A09 0 0 A08 | | | |
| , - | B: Displaying 32~63 | 1B09 | 11 | 1A09 | 27 | 2B09 | 43 | 2A09 | 59 | B07 B06 | 0 0 A07 | | | |
| م ا | | 1B08 | 12 | 1A08 | 28 | 2B08 | 44 | 2A08 | 60 | B05 | 0 0 A05 | | | |
| 90 | | 1B07 | 13 | 1A07 | 29 | 2B07 | 45 | 2A07 | 61 | B04 B03 | 0 0 A04 0 0 A03 | | | |
| 70 | | 1B06 | 14 | 1A06 | 30 | 2B06 | 46 | 2A06 | 62 | B02 B01 | 0 0 A02 A01 | | | |
| On rate 60 (%) 40 | DC28.8V | 1B05 | 15 | 1A05 | 31 | 2B05 | 47 | 2A05 | 63 | | | | | |
| 30 20 | | 1B04 | NC | 1A04 | NC | 2B04 | NC | 2A04 | NC | | | | | |
| 0 10 20 30 |) 40 50 55 | 1B03 | NC | 1A03 | NC | 2B03 | NC | 2A03 | NC | | | | | |
| Ambient te | mp(°C) | 1B02 | COM | 1A02 | NC | 2B02 | COM | 2A02 | NC | | | | | |
| Derating l | 1B01 | COM | 1A01 | NC | 2B01 | COM | 2A01 | NC | | | | | | |

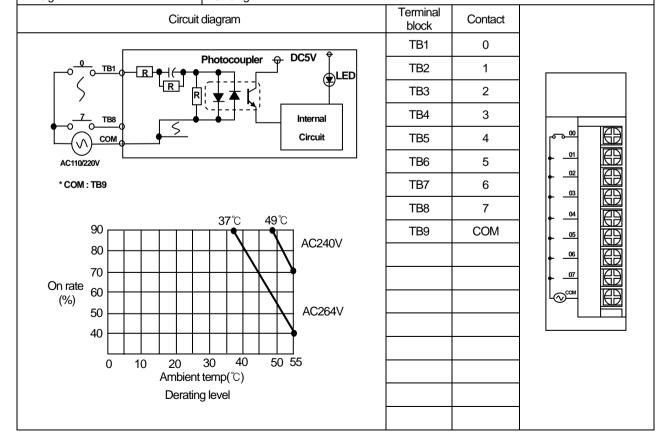
9.2.8 16 point AC110V input module

| | Module type | AC Input module | | | |
|----------------------|------------------------|---|--|--|--|
| Spec. | | XGI-A12A | | | |
| Input point | | 16 points | | | |
| Insulation metho | d | Photo coupler insulation | | | |
| Rated input volta | ige | AC100-120V(+10/-15%) 50/60 Hz(±3 Hz) (5% and lower distortion) | | | |
| Rated input curre | ent | Approx. 8 mA (AC100,60 Hz), approx. 7 mA (AC100,50 Hz) | | | |
| Inrush current | | Max. 200 ^{mA} 1 ^{ms} and lower(AC132V) | | | |
| Input derating | | Refer to the below derating level | | | |
| On voltage / On | current | AC80V and higher / 5 mA and higher (50 Hz,60 Hz) | | | |
| Off voltage / Off of | current | AC30V and lower / 1 mA and lower (50 Hz,60 Hz) | | | |
| Input resistance | | Approx. 12 k Ω (60 Hz), approx. 15 k Ω (50 Hz) | | | |
| Pagnanaa tima | $Off \rightarrow On$ | 15 ms and lower(AC100V 50 Hz,60 Hz) | | | |
| Response time | $On \rightarrow Off$ | 25 ms and lower(AC100V 50 Hz,60 Hz) | | | |
| Insulation withsta | and voltage | AC1780V rms/3 Cycle (altitude 2000m) | | | |
| Insulation resista | ince | 10 ^{MΩ} and higher by Insulation ohmmeter | | | |
| Common metho | d | 16 point/ COM | | | |
| Suitable cable size | ze | Stranded cable between 0.3~0.75 m² (2.8mm and smaller outer dia.) | | | |
| Suitable clamped | d terminal | R1.25-3 (Sleeve built-in clamped terminal is not available) | | | |
| Current consump | ption(^{mA}) | 30mA | | | |
| Operation displa | y | LED On with Input On | | | |
| External connect | tion method | 18point Terminal strip connector (M3 X 6 screws) | | | |
| Weight | | 0.13 kg | | | |



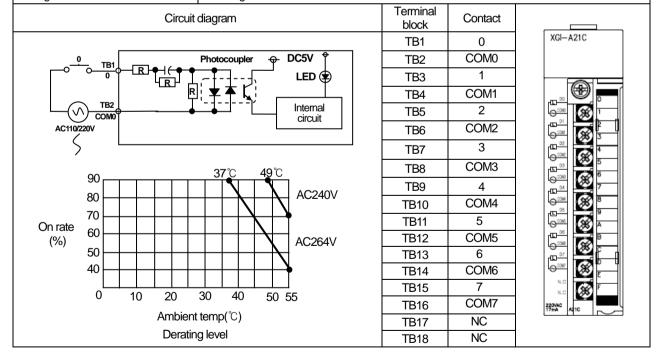
9.2.9 8 point AC220V input module

| | Module type | AC input module | | | | | |
|-------------------------|----------------------|--|--|--|--|--|--|
| Spec. | | XGI-A21A | | | | | |
| Input point | | 8 points | | | | | |
| Insulation metho | d | Photo coupler insulation | | | | | |
| Rated input volta | ge | AC100-240V(+10/-15%) 50/60 Hz(±3 Hz) (5% and lower distortion) | | | | | |
| Rated input curre | ent | Approx. 17 mA (AC200,60 Hz), approx. 14 mA (AC200,50 Hz) | | | | | |
| Inrush current | | Max. 500 mA 1 ms and lower(AC264V) | | | | | |
| Input derating | | Refer to the below derating level | | | | | |
| On voltage / On o | current | AC80V and higher / 5 mA and higher (50 Hz,60 Hz) | | | | | |
| Off voltage / Off of | current | AC30V and lower / 1 mA and lower (50 Hz,60 Hz) | | | | | |
| Input resistance | | Approx. 12 k Ω (60 Hz), approx. 15 k Ω (50 Hz) | | | | | |
| Despense time | $Off \rightarrow On$ | 15 ms and lower(AC200V 50 Hz,60 Hz) | | | | | |
| Response time | $On \rightarrow Off$ | 25 ms and lower(AC200V 50 Hz,60 Hz) | | | | | |
| Insulation withsta | and voltage | AC2830V rms/3 Cycle (altitude 2000m) | | | | | |
| Insulation resista | nce | 10 MΩ and higher by Insulation ohmmeter | | | | | |
| Common method | d | 8 points / COM | | | | | |
| Suitable cable siz | ze | Stranded cable between 0.3~0.75 mm² (2.8mm and smaller outer dia.) | | | | | |
| Suitable clamped | d terminal | R1.25-3 (Sleeve built-in clamped terminal is not available) | | | | | |
| Current consumption(mA) | | 20mA | | | | | |
| Operation display | y | LED On with Input On | | | | | |
| External connect | ion method | 9point Terminal strip connector (M3 X 6 screws) | | | | | |
| Weight | | 0.13 kg | | | | | |



9.2.10 8 point AC220V isolated input module

| | Module type | AC input module | | | | | |
|---------------------------|----------------------|--|--|--|--|--|--|
| Spec. | | XGI-A21C | | | | | |
| Input point | | 8 points | | | | | |
| Insulation method | b | Photo coupler insulation | | | | | |
| Rated input volta | ge | AC100-240V(+10/-15%) 50/60 Hz(±3 Hz) (5% and lower distortion) | | | | | |
| Rated input curre | ent | Approx. 17 mA (AC200,60 Hz), approx. 14 mA (AC200,50 Hz) | | | | | |
| Inrush current | | Max. 500 mA 1 ms and lower(AC264V) | | | | | |
| Input derating | | Refer to the below derating level | | | | | |
| On voltage / On o | current | AC80V and higher / 5 mA and higher (50 Hz,60 Hz) | | | | | |
| Off voltage / Off current | | AC30V and lower / 1 mA and lower (50 Hz,60 Hz) | | | | | |
| Input resistance | | Approx. 12 k Ω (60 Hz), approx. 15 k Ω (50 Hz) | | | | | |
| Deen anno timo | $Off \rightarrow On$ | 15 ms and lower(AC200V 50 Hz, 60 Hz) | | | | | |
| Response time | $On \rightarrow Off$ | 25 ms and lower(AC200V 50 Hz, 60 Hz) | | | | | |
| Insulation withsta | nd voltage | AC2830V rms/3 Cycle (altitude 2000m) | | | | | |
| Insulation resista | nce | 10 ^M Ω and higher by Insulation ohmmeter | | | | | |
| Common method | d | 1 point / COM | | | | | |
| Suitable cable siz | ze | Stranded cable between 0.3~0.75 mm² (2.8mm and smaller outer dia.) | | | | | |
| Suitable clamped | terminal | R1.25-3 (Sleeve built-in clamped terminal is not available) | | | | | |
| Current consumption(mA) | | 20mA | | | | | |
| Operation display | / | LED On with Input On | | | | | |
| External connect | ion method | 18 point Terminal strip connector (M3 X 6 screws) | | | | | |
| Weight | | 0.13 kg | | | | | |



9.3 Digital Output Module Spec.

9.3.1 8 point relay output module

| | Module type | Relay | y output module | | | | |
|---------------------|----------------------|---|--|--|--|--|--|
| Spec. | | | XGQ-RY1A | | | | |
| Output point | | 8 points | | | | | |
| Insulation met | hod | Relay insulation | | | | | |
| Rated load vol | tage/current | DC24V 2A(resistance load) / AC220V 2 | $A(COS\Psi = 1)$ | | | | |
| Min. load volta | ge / current | DC5V / 1mA | | | | | |
| Max. load volta | age / current | AC250V, DC125V | | | | | |
| Leakage curre | ent at Off | 0.1mA (AC220V, 60Hz) | | | | | |
| Max. switching | g frequency | 3,600 times/hr | | | | | |
| Surge killer | | None | | | | | |
| | Mechanical | 20 million and more times | | | | | |
| | | Rated load voltage/current 100 thousand | d and more times | | | | |
| Life | Florid 1 | AC200V / 1.5A, AC240V / 1A (COSΨ = | 0.7) 100 thousand and more times | | | | |
| | Electrical | AC200V / 1A, AC240V / 0.5A (COSΨ = | AC200V / 1A, AC240V / 0.5A (COS Ψ = 0.35) 100 thousand and more times | | | | |
| | | DC24V / 1A, DC100V / $0.1A$ (L / R = 7ms) 100 thousand and more times | | | | | |
| Response | Off → On | 10 ms and lower | | | | | |
| time | $On \rightarrow Off$ | 12 ms and lower | | | | | |
| Common met | hod | 1 point/ 1COM (Independent contact) | | | | | |
| Current consumption | | 260mA (when every point is On) | | | | | |
| Operation disp | olay | LED On with output On | | | | | |
| External conne | ection method | 18 point Terminal strip connector (M3 X 6 screws) | | | | | |
| Weight | | 0.13kg | | | | | |
| | (| Circuit diagram | Terminal Contact | | | | |
| | | | block Of mast | | | | |
| | | | TB2 COM | | | | |
| | ⊕ DC5V | | TB3 1 | | | | |
| | \downarrow | | TB4 COM TB5 2 | | | | |
| LED (| * | | TB6 COM | | | | |
| | | | TB7 3 🚾 💆 | | | | |
| Internal | | | TB8 COM | | | | |
| | circuit RY | J ol TB2 | TB9 4 | | | | |
| | | COMO | TB10 COM | | | | |
| | | AC 220V | TB11 5 | | | | |
| | | | TB13 6 LYSSELLEY | | | | |
| | | | TR14 COM SOME STATE OF TRAINING STATE OF TRAININ | | | | |
| | | | TB15 7 | | | | |
| | | | TB16 COM | | | | |
| | | | TB17 NC | | | | |
| | | | TB18 NC | | | | |

9.3.2 16 point relay output module

| | Module type | Relay | output module | | | | | |
|------------------|----------------------|---|---|--|--|--|--|--|
| Spec. | | > | (GQ-RY2A | | | | | |
| Output point | | 16 points | | | | | | |
| Insulation meth | od | Relay insulation | | | | | | |
| Rated load volta | age/current | DC24V 2A(resistance load) / AC220V 2A | $\Lambda(COS\Psi = 1)$ | | | | | |
| Min. load voltag | ge / current | DC5V / 1mA | | | | | | |
| Max. load volta | ge / current | AC250V, DC125V | | | | | | |
| Leakage currer | nt at Off | 0.1mA (AC220V, 60Hz) | | | | | | |
| Max. switching | frequency | 3,600 times/hr | | | | | | |
| Surge killer | | None | | | | | | |
| | Mechanical | 20 million and more times | | | | | | |
| - | | Rated load voltage/current 100 thousand | and more times | | | | | |
| Life | - 1 | AC200V / 1.5A, AC240V / 1A (COSΨ = 0 | 0.7) 100 thousand and more times | | | | | |
| | Electrical | AC200V / 1A, AC240V / 0.5A (COSΨ = | = 0.35) 100 thousand and more times | | | | | |
| | | DC24V / 1A, DC100V / $0.1A$ (L / R = 7ms) 100 thousand and more times | | | | | | |
| Response | $Off \rightarrow On$ | 10 ms and lower | | | | | | |
| time | $On \rightarrow Off$ | 12 ms and lower | | | | | | |
| Common meth | od | 16 point/ 1COM | | | | | | |
| Current consun | nption | 500mA (when every point is On) | | | | | | |
| Operation displ | ay | LED On with output On | | | | | | |
| External conne | ction method | 18point Terminal strip connector (M3 X 6 screws) | | | | | | |
| Weight | | 0.17kg | | | | | | |
| | C | ircuit diagram | Terminal block Contact | | | | | |
| | | | TB1 0 | | | | | |
| | | | TB2 1 | | | | | |
| • | DC5V | | TB3 2 TB4 3 | | | | | |
| LED (| | | TB5 4 | | | | | |
| | | TB1 | TB6 5 | | | | | |
| l la | nternal | | TB7 6 | | | | | |
| | ircuit RY | % I | TB9 8 | | | | | |
| | | | | | | | | |
| | | TB16 L | TB11 10 | | | | | |
| | | сом | TB12 11 + 12 12 13 15 15 15 15 15 15 15 | | | | | |
| | | | TB13 12 13 14 13 14 15 15 15 15 15 15 15 15 15 15 15 15 15 | | | | | |
| | | AC 220V | | | | | | |
| | | | TD46 45 | | | | | |
| | | * COM : TB17 | TB17 COM | | | | | |
| | | | TB18 NC | | | | | |

9.3.3 16 point relay output module (Surge Killer built-in type)

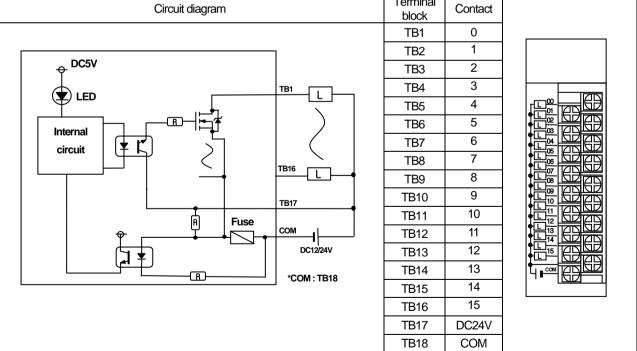
| | Module | | Relay | output mod | ule | | | | |
|----------------|----------------------|---|--|-------------------|-----------|-----------|--|--|--|
| type Spec. | | | X | GQ-RY2B | | | | | |
| Output point | | 16 points | | | | | | | |
| Insulation me | ethod | Relay insulation | | | | | | | |
| Rated load vo | oltage/current | DC24V 2A(resista | nce load) / AC220V 2A(| COSΨ = 1) | | | | | |
| Min. load volt | age / current | DC5V / 1mA | | | | | | | |
| Max. load vol | tage / current | AC250V, DC125V | / | | | | | | |
| Leakage curr | ent at Off | 0.1mA (AC220V, | 60Hz) | | | | | | |
| Max. switchin | ng frequency | 3,600 times/hr | | | | | | | |
| Surge killer | | Varistor (387 ~ 47) | 3V), C.R absorber | | | | | | |
| | Mechanical | 20 million and mor | re times | | | | | | |
| | | Rated load voltage | e/current 100 thousand a | and more time | S | | | | |
| Life | | AC200V / 1.5A, A | C240V / 1A (COSΨ = 0. | 7) 100 thousa | nd and mo | re times | | | |
| | Electrical | AC200V / 1A, AC2 | 240V / 0.5A (COSΨ = 0. | 35) 100 thous | and and m | ore times | | | |
| | | DC24V / 1A, DC100V / 0.1A (L / R = 7ms) 100 thousand and more times | | | | | | | |
| Response | Off → On | 10 ms and lower | | | | | | | |
| time | $On \rightarrow Off$ | 12 ms and lower | | | | | | | |
| Common me | thod | 16 point/ 1COM | | | | | | | |
| Current cons | umption | 500mA (when every point is On) | | | | | | | |
| Operation dis | splay | LED On with output On | | | | | | | |
| External conr | nection method | 18 point Terminal strip connector (M3 X 6 screws) | | | | | | | |
| Weight | | 0.19kg | | | | | | | |
| | | Circuit diagram | | Terminal block | Contact | | | | |
| | | | | TB1 | 0 | | | | |
| | DC5V | | ٦ | TB2 TB3 | 2 | | | | |
| | Ť | | | TB4 | 3 | | | | |
| LED | \bigoplus | | | TB5 | 4 | | | | |
| | <u> </u> | | TB1 | TB6 | 5 | | | | |
| | Internal | 1 [| | TB7 | 6 | | | | |
| | | ⊋╣≄ | | TB8 TB9 | 7 8 | | | | |
| | Sirouit | J L | | TB10 | 9 | | | | |
| | <u> </u> | | TB16 L | TB11 | 10 | | | | |
| | | | | TB12 | 11 | | | | |
| | | | $+$ com $-$ (\sim) $ -$ | TB13 | 12 | | | | |
| | | | | TB14 | 13 | | | | |
| | | | | TB15 | 14 | | | | |
| | | | * COM : TB17 | TB16 | 15 | | | | |
| | | | | TB17 | COM | | | | |
| | | | | TB18 | NC | | | | |

9.3.4 16 point Triac output module

| | lodule type | | Triac | output modul | е | | |
|--------------------|----------------------|--|-----------------------------|-------------------|---------|--|--|
| Spec. | | |) | KGQ-SS2A | | | |
| Output point | | 16 points | | | | | |
| Insulation me | ethod | Photo coupler | insulation | | | | |
| Rated load v | oltage | AC 100-240V | (50 / 60 Hz) | | | | |
| Max. load vo | ltage | AC 264V | | | | | |
| Max. load cu | rrent | 0.6A / 1 point, | 4A / 1COM | | | | |
| Min. load cur | rent | 20 mA | | | | | |
| Leakage curi | rent at Off | 2.5 mA (AC 22 | 20V 60 Hz) | | | | |
| Max. inrush o | current | 20A / Cycle ar | nd lower | | | | |
| Max. voltage | drop at On | AC 1.5V and I | ower (2A) | | | | |
| Surge killer | | Varistor (387 - | - 473V), C.R absorber | | | | |
| Response | $Off \rightarrow On$ | 1 ms and shor | ter | | | | |
| time | $On \rightarrow Off$ | 0.5 Cycle + 1 | ms and shorter | | | | |
| Common me | ethod | 16 point/ 1 COM | | | | | |
| Current cons | umption | 300 mA (wher | n every point is On) | | | | |
| Operation dis | splay | LED On with o | output On | | | | |
| External con | nection method | 18point Termi | nal strip connector (M3 X 6 | screw) | | | |
| Weight | | 0.2 kg | | | | | |
| | | Circuit diagram | | Terminal block | Contact | | |
| | | | | TB1 | 0 | | |
| | | | | TB2 | 1 | | |
| | → DC5V → | | | TB3 TB4 | 3 | | |
| LED | \rightarrow | | | TB5 | 4 | | |
| | ¥ , | | TB1 | TB6 | 5 | | |
| | ' | | | TB7 | 6 | | |
| Internal 🗓 💆 🔾 🛪 | | ¥₹Ÿ̈́ | | TB8 | 7 | | |
| | circuit \ | 勒4 图注 | | TB9 | 8 | | |
| L | <u>+</u> | - | TB16 | TB10 | 9 | | |
| | Tria | ac | | TB11 | 10 | | |
| | | | COM | TB12 | 11 | | |
| | | | COM (\(\sigma\) TB13 12 | | | | |
| | | | AC110/220V | TB14 | 13 | | |
| | | | | TB15 | 14 | | |
| | | | *COM: TB17 | TB16 | 15 | | |
| | | | COM. IDI/ | TB17 | COM | | |
| | | | | TB18 | NC | | |

9.3.5 16 point transistor output module (sink type)

| Module type | | Transistor output module | | | | | | |
|--------------------|----------------------|---|--|--|--|--|--|--|
| Spec. | | XGQ-TR2A | | | | | | |
| Output point | | 16 points | | | | | | |
| Insulation method | t | Photo coupler insulation | | | | | | |
| Rated load voltag | je | DC 12/24V | | | | | | |
| Operating load vo | oltage range | DC 10.2 ~ 26.4V | | | | | | |
| Max. load current | t | 0.5A / 1point, 4A / 1COM | | | | | | |
| Leakage current | at Off | 0.1mA and lower | | | | | | |
| Max. inrush curre | nt | 4A / 10 ms and lower | | | | | | |
| Max. voltage drop | o at On | DC 0.3V AND LOWER | | | | | | |
| Surge killer | | Zener diode | | | | | | |
| Fuse | | 4Ax2(not replaceable)(Fuse cap.:50A) | | | | | | |
| Fuse disconnection | on display | Yes(If a fuse is burnt out, it transfers a signal to CPU and LED is on) If external power supply is off, fuse status is not detected. | | | | | | |
| Doggoog time | $Off \rightarrow On$ | 1 ms and shorter | | | | | | |
| Response time | $On \rightarrow Off$ | 1 ms and shorter (Rated load, resistance load) | | | | | | |
| Common method | d | 16 point/ 1COM | | | | | | |
| Current consump | otion | 70mA (when every point is On) | | | | | | |
| External power | Voltage | DC12/24V ± 10% (4 Vp-p and lower ripple voltage) | | | | | | |
| supply Current | | 10mA and lower (if connected to DC24V) | | | | | | |
| Operation display | | LED On with output On | | | | | | |
| External connecti | on method | 18point Terminal strip connector | | | | | | |
| Weight | | 0.11kg | | | | | | |
| Cincui | | t diagram Terminal Contact | | | | | | |



9.3.6 32 point transistor output module(sink type)

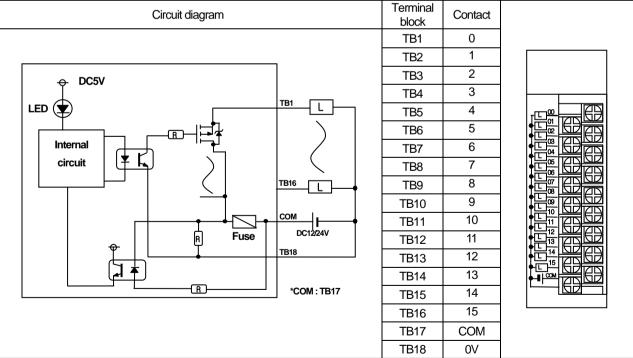
| | Module type | | Transi | stor outp | ut mod | lule | | | | | | |
|---------------------------|----------------------|--|---|--|---|--|--|---|--|--|--|--|
| Spec. | 7 | XGQ-TR4A | | | | | | | | | | |
| Output point | | 32 point | | | | | | | | | | |
| Insulation method | | Photo coupler insulation | | | | | | | | | | |
| Rated load voltage | | DC 12 / 24V | | | | | | | | | | |
| Operating load vol | tage range | DC 10.2 ~ 26.4V | | | | | | | | | | |
| Max. load current | | 0.1A / 1point, 2A / 1COM | | | | | | | | | | |
| Leakage current a | t Off | 0.1mA and lower | | | | | | | | | | |
| Max. inrush currer | nt | 0.7A / 10 ms and lower | | | | | | | | | | |
| Max. voltage drop | at On | DC 0.2V and lower | | | | | | | | | | |
| Surge killer | | Zener diode | | | | | | | | | | |
| - · | Off → On | 1 ms and shorter | | | | | | | | | | |
| Response time | $On \rightarrow Off$ | 1 ms and shorter (Rated load, | resistan | ce load) | | | | | | | | |
| Common method | | 32 points / 1COM | | | | | | | | | | |
| Current consumpt | ion | 130mA (when every point is C | n) | | | | | | | | | |
| External power | Voltage | DC12/24V ± 10% (4 Vp-p and | l lower rip | ople voltag | je) | | | | | | | |
| supply | Current | 10mA and lower (if connected to DC24V) | | | | | | | | | | |
| Operation display | | LED On with Input On | | | | | | | | | | |
| External connection | n method | 40 Pin Connector | | | | | | | | | | |
| Suitable cable size |) | 0.3 mm² | | | | | | | | | | |
| Weight | | 0.1 kg | | | | | | | | | | |
| | Circuit diag | ıram | No | Contact | No | Contact | | | | | | |
| DC5V LED Internal circuit | | B20 L A05 L B01,B02 COM DC12/24V | B20 B19 B18 B17 B16 B15 B14 B13 B12 B11 B10 B09 B08 B07 B06 B05 B04 | 0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 NC | A20 A19 A18 A17 A16 A15 A14 A13 A12 A11 A10 A09 A08 A07 A06 A05 A04 | 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 NC | B20 B19 B18 B17 B16 B15 B14 B13 B12 B11 B10 B09 B08 B07 B06 B05 B04 B03 | 000000000000000000000000000000000000000 | A20 A19 A18 A17 A16 A15 A14 A43 A12 A11 A10 A09 A08 A07 A06 A05 A04 A03 | | | |
| | | * COM : A02, A01 | B03 B02 B01 | NC DC12/ 24V | A03 A02 A01 | NC COM | B02 B01 | | A02 A01 | | | |

9.3.7 64 point transistor output module (sink type)

| | Module type | | | | Trans | sistor ou | itput mo | dule | | | | |
|-------------------------------|---------------------------------|--|--------------------------|--------------|------------|--------------|----------|--------------|----------|-------------------|-----|-------------------|
| Spec. | <i>"</i> | | XGQ-TR8A | | | | | | | | | |
| Output point | | 64 poin | ts | | | | | | | | | |
| Insulation system | | Photo | Photo coupler insulation | | | | | | | | | |
| Rated load voltage | | DC 12 | 2/24V | | | | | | | | | |
| Operating load volta | age range | DC 10 |).2 ~ 26.4 | V | | | | | | | | |
| Max. load current | | 0.1A/ | 1point, 2 | A/1COM | | | | | | | | |
| Leakage current at | Off | 0.1m/ | and low | er | | | | | | | | |
| Max. inrush current | | 0.7A/ | 10 ms ar | nd lower | | | | | | | | |
| Max. voltage drop a | at On | DC 0.2 | 2V and lo | wer | | | | | | | | |
| Surge killer | | Zener | diode | | | | | | | | | |
| Daniel dina | $Off \rightarrow On$ | 1 ms a | and short | er | | | | | | | | |
| Response time | $On \rightarrow Off$ | 1 ms a | and short | er (Rated | load, resi | stance lo | oad) | | | | | |
| Common method | | 16 poi | nt/ 1CON | 1 | | | | | | | | |
| Current consumption | on | 230m | A (when e | every poin | t is On) | | | | | | | |
| Common method | | 32 poi | nts / CON | Л | | | | | | | | |
| External power | Voltage | DC12 | /24V ± 10 |)% (4 Vp-p | and low | er ripple | voltage) | | | | | |
| supply | Current | 10mA and lower (if connected to DC24V) | | | | | | | | | | |
| Operation display | | LED On with Input On (32point LED on by switching) | | | | | | | | | | |
| External connection | n method | 40 Pin Connector x 2 | | | | | | | | | | |
| Suitable cable size | | 0.3 mm² | | | | | | | | | | |
| Weight | | 0.15 k | g | | | | | | | | | |
| Circuit | diagram | No | Contact | No | Contact | No | Contact | No | Contact | | | |
| | | 1B20 | 0 | 1A20 | 16 | 2B20 | 32 | 2A20 | 48 | | | |
| | | 1B19 | 1 | 1A19 | 17 | 2B19 | 33 | 2A19 | 49 | | ^ | |
| DC5V | 1B20 🗔 | 1B18 | 2 | 1A18 | 18 19 | 2B18 2B17 | 34 35 | 2A18 2A17 | 50 51 | B20 | 0 0 | A20 |
| LED 🎔 | | 1B17 1B16 | 3 | 1A17 1A16 | 20 | 2B17 | 36 | 2A17 | 52 | B19 | 0 0 | A19 |
| | ┤╬ <u>╫</u> │ | 1B15 | 5 | 1A15 | 21 | 2B15 | 37 | 2A15 | 53 | B18 | 0 0 | A18 |
| Internal | ´╙ <u>╀</u> | 1B14 | 6 | 1A14 | 22 | 2B13 | 38 | 2A14 | 54 | B17 | 0 0 | A17 |
| circuit [\vert \textbf{!}] | | 1B13 | 7 | 1A13 | 23 | 2B13 | 39 | 2A13 | 55 | B16 | 0 0 | A16 |
| $\sqcup \sqcup \sqcup \sqcup$ | 2A05 L | 1B12 | 8 | 1A12 | 24 | 2B12 | 40 | 2A12 | 56 | B15 | 0 0 | A15 |
| R | | 1B11 | 9 | 1A11 | 25 | 2B11 | 41 | 2A11 | 57 | B14 B13 | 0 0 | A14 A13 |
| | 1B02,1B01 | 1B10 | 10 | 1A10 | 26 | 2B10 | 42 | 2A10 | 58 | B12 | 0 0 | A12 |
| | 2B02, 2B01 | 1B09 | 11 | 1A09 | 27 | 2B09 | 43 | 2A09 | 59 | B11 | 0 0 | A11 |
| | | 1B08 | 12 | 1A08 | 28 | 2B08 | 44 | 2A08 | 60 | B10 | 0 0 | A10 |
| Switching Lo | | 1B07 | 13 | 1A07 | 29 | 2B07 | 45 | 2A07 | 61 | B09 B08 | 0 0 | A09 A08 |
| circuit | B COM I | 1B06 | 14 | 1A06 | 30 | 2B06 | 46 | 2A06 | 62 | B07 | 0 0 | A07 |
| | DC12/24V | 1B05 | 15 | 1A05 | 31 | 2B05 | 47 | 2A05 | 63 | B06 | 0 0 | A06 |
| | | 1B03 | NC | 1A04 | NC | 2B03 | NC | 2A04 | NC | B05 | 0 0 | A05 |
| A: displayir | - | 1B03 | NC | 1A03 | NC | 2B03 | NC | 2A03 | NC | B04 B03 | 0 0 | A04 |
| B: displayir | | 1B02 | 12/24 | 1A02 | | 2B02 | 12/24 | 2A02 | | B03 B02 B01 | 0 0 | A03 A02 A01 |
| | *COM : 1A02, 1A01 2A02, 2A01 | 1B01 | VDC | 1A01 | COM1 | 2B01 | VDC | 2A01 | COM2 | | | |

9.3.8 16 point transistor output module (source type)

| Module type | | Transistor output module | | | | | | |
|--------------------|----------------------|---|--|--|--|--|--|--|
| Spec. | | XGQ-TR2B | | | | | | |
| Output point | | 16 points | | | | | | |
| Insulation method | t | Photo coupler insulation | | | | | | |
| Rated load voltag | je | DC 12/24V | | | | | | |
| Operating load vo | oltage range | DC 10.2 ~ 26.4V | | | | | | |
| Max. load current | t | 0.5A / 1point, 4A / 1COM | | | | | | |
| Leakage current | at Off | 0.1mA and lower | | | | | | |
| Max. inrush curre | ent | 4A / 10 ms and lower | | | | | | |
| Max. voltage drop | o at On | DC 0.3V AND LOWER | | | | | | |
| Surge killer | | Zener diode | | | | | | |
| Fuse | | 4Ax2(not replaceable)(Fuse cap.:50A) | | | | | | |
| Fuse disconnection | on display | Yes(If a fuse is burnt out, it transfers a signal to CPU and LED is on) | | | | | | |
| Deen en en time | $Off \rightarrow On$ | 1 ms and shorter | | | | | | |
| Response time | $On \rightarrow Off$ | 1 ms and shorter (Rated load, resistance load) | | | | | | |
| Common method | d | 16 point/ 1COM | | | | | | |
| Current consump | otion | 70mA (when every point is On) | | | | | | |
| External power | Voltage | DC12/24V ± 10% (4 Vp-p and lower ripple voltage) | | | | | | |
| supply | Current | 10mA and lower (if connected to DC24V) | | | | | | |
| Operation display | 1 | LED On with output On | | | | | | |
| External connecti | on method | 18point Terminal strip connector | | | | | | |
| Weight | | 0.12kg | | | | | | |
| | | Terminal - | | | | | | |



9.3.9 32 point transistor output module (source type)

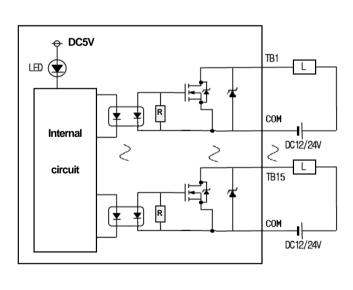
| | Module type | Transistor output module | | | | | | | | |
|---------------------|---|--|-----------------------|------------|----------|------------|---------|------------|-----|-----|
| Spec. | | | | XC | Q-TR4E | 3 | | | | |
| Output point | | 32 points | | | | | | | | |
| Insulation method | | Photo cou | upler insulation | | | | | | | |
| Rated load voltage | | DC 12/2 | 4V | | | | | | | |
| Operating load volt | DC 10.2 | ~ 26.4V | | | | | | | | |
| Max. load current | | 0.1A / 1pc | oint, 2A / 1COM | | | | | | | |
| Leakage current at | Off | 0.1mA and lower | | | | | | | | |
| Max. inrush current | i | 4A / 10 m | ns and lower | | | | | | | |
| Max. voltage drop a | at On | DC 0.3V | AND LOWER | | | | | | | |
| Surge killer | | Zener dio | ode | | | | | | | |
| Decrease time | $Off \rightarrow On$ | 1 ms and | shorter | | | | | | | |
| Response time | $On \rightarrow Off$ | 1 ms and | shorter (Rated load | , resistan | ce load) | | | | | |
| Common method | | 32points | /1COM | | | | | | | |
| Current consumption | on | 130mA (v | when every point is (| On) | | | | | | |
| External power | Voltage | DC12/24V \pm 10% (4 Vp-p and lower ripple voltage) | | | | | | | | |
| supply . | Current | 10mA an | d lower (if connected | to DC2 | 1V) | | | | | |
| Operation display | | LED On v | with Input On | | | | | | | |
| External connection | n method | 40 Pin Co | onnector | | | | | | | |
| Suitable cable size | | 0.3 mm² | | | | | | | | |
| Weight | | 0.1 kg | | | | | | | | |
| | Circuit diagra | m | | No | Contact | No | Contact | | | |
| | | | | B20 | 0 | A20 | 16 | | | ` |
| | | | | B19 | 1 | A19 | 17 | B20 | 0 0 | Aź |
| → DC5V | | | | B18 | 2 | A18 | 18 | B19 | 0 0 | I A |
| l 1 | | | B20 , | B17 | 3 | A17 | 19 | B18 B17 | 0 0 | A |
| LED 🕎 | Γ | | Ļ | B16 | 4 | A16 | 20 | B16 | 0 0 | ١, |
| | | <u>l</u> | \ | B15 | 5 | A15 | 21 | B15 | 0 0 | ١, |
| Internal | | J | <i>)</i> | B14 | 6 | A14 | 22 | B14 | 000 | A |
| circuit | [↓ [] \ | | / | B13 | 7 | A13 | 23 | B13 | 0 0 | A |
| January | \ \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | | (| B12 | 8 | A12 | 24 | B12 | 0 0 | A |
| | 一 / | | | B11 | 9 | A11 | 25 | B11 | 0 0 | A |
| | | | A05 | B10 | 10 | A10 | 26 | B10 B09 | 0 0 | ۸ ا |
| | _ | - ♦ | | B09 | 11 | A09 | 27 | B08 | 0 0 | ۸ ا |
| | | | СОМ | B08 | 12 | A08 | 28 | B07 | 0 0 | Ι Δ |
| | | | DC12/24V | B07 | 13 | A07 | 29 | B06 | 0 0 | А |
| | | | | B06 | 14 | A06 | 30 | B05 | 0 0 | Α |
| | | | A02, A01 | B05 | 15 | A05 | 31 | B04 | 0 0 | A |
| | | | | B04 | NC | A04 | NC | B03 | 0 0 | A |
| | | | * COM : B02, B01 | B03 | NC | A03 | NC | B02 B01 | 0 0 |) A |
| | | | | B02 | 110 | A02 | 140 | 301 | | - ~ |
| | | | | B02 | COM | A02 A01 | 0V | | | |
| | | | | 1 13077 | | | | | | |

9.3.10 64 point transistor output module (source type)

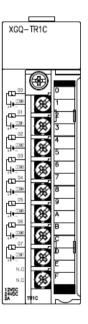
| | Modul | le type | | | | Trans | sistor ou | tput mo | dule | | | | |
|------------------------------|----------------|--|--|--|--|----------------------------------|--|----------------------------------|--|----------------------------------|--|--|----|
| Spec. | _ | | | | | | XGQ- | TR8B | | | | | |
| Output point | | | 64 po | ints | | | | | | | | | |
| Insulation method | | | Photo coupler insulation | | | | | | | | | | |
| Rated load voltage | | | DC 12/24V | | | | | | | | | | |
| Operating load voltage range | | | DC 10.2 ~ 26.4V | | | | | | | | | | |
| Max. load current | | | 0.1A/ | 1point, 2 | A/1CO | M | | | | | | | |
| Leakage current at Of | ff | | 0.1m/ | and low | er | | | | | | | | |
| Max. inrush current | | | 4A / 1 | 0 ms and | lower | | | | | | | | _ |
| Max. voltage drop at 0 | On | | DC 0.3 | 3V and k | ower | | | | | | | | _ |
| Surge killer | | | Zener | diode | | | | | | | | | _ |
| · · · · | Off - | → On | | and short | ter | | | | | | | | _ |
| Response time | On - | → Off | 1 ms a | and short | ter (Rate | d load, re | sistance | load) | | | | | |
| Common method | | | | nt / 1CON | | | | | | | | | |
| Current consumption | | | - | | | int is On) |) | | | | | | |
| Common method | | | | nt / COM | | | <u> </u> | | | | | | _ |
| External power | Volt | tage | DC12/24V ± 10% (4 Vp-p and lower ripple voltage) | | | | | | | | | | |
| supply | | rent | 10mA and lower (if connected to DC24V) | | | | | | | | | | |
| Operation display | | | LED On with Input On (32 point LED ON by switching) | | | | | | | | | | |
| External connection n | nethod | | 40 Pin Connector x 2 | | | | | | | | | | |
| Suitable cable size | | | 0.3 mm² | | | | | | | | | | _ |
| Weight | | | 0.15 k | | | | | | | | | | _ |
| Circuit | diagrar | n | No | Contact | No | Contact | No | Contact | No | Contact | | | _ |
| | | | 1B20 | 0 | 1A20 | 16 | 2B20 | 32 | 2A20 | 48 | | | |
| △ DC5V | |] | 1B19 | 1 | 1A19 | 17 | 2B19 | 33 | 2A19 | 49 | | _ | |
| | | | 1B18 | 2 | 1A18 | 18 | 2B18 | 34 | 2A18 | 50 | B20 | 0 0 |), |
| LED 🏵 | | 1B20 L | 1B17 | 3 | 1A17 | 19 | 2B17 | 35 | 2A17 | 51 | B19 | 0 0 | |
| | <u>.</u> ∤₁. | 7 | 1B16 | 4 | 1A16 | 20 | 2B16 | 36 | 2A16 | 52 | B18 | 0 0 | |
| Internal | # 7 |) | 1B15 | 5 | 1A15 | 21 | 2B15 | 37 | 2A15 | 53 | B17 | 0 0 | |
| (\dag{r}) | \] | / | 1B14 | 6 | 1A14 | 22 | 2B14 | 38 | 2A14 | 54 | B16 | 0 0 | |
| circuit Th |) | (| 1B13 | 7 | 1A13 | 23 | 2B13 | 39 | 2A13 | 55 | B15 B14 | 0 0 | |
| │ | / | | 1B12 | 8 | 1A12 | 24 | 2B12 | 40 | 2A12 | 56 | B13 | 0 0 | П |
| | | | | 9 | 1A11 | 25 | 2B11 | 41 | 2A11 | 57 | B12 | 0 0 | |
| | (| 2A05 | 1B11 | | | | | | | | | | |
| | | 2A05 | 1B10 | 10 | 1A10 | 26 | 2B10 | 42 | 2A10 | 58 | B11 | | L |
| R | | COM | 1B10 1B09 | 10 11 | 1A09 | 27 | 2B09 | 43 | 2A09 | 59 | B10 | 0 0 | |
| | | COM | 1B10 1B09 1B08 | 10 11 12 | 1A09 1A08 | 27 28 | 2B09 2B08 | 43 44 | 2A09 2A08 | 59 60 | B10 B09 | 0 0 0 0 0 0 | |
| | | COM DC12/24V | 1B10 1B09 1B08 1B07 | 10 11 12 13 | 1A09 1A08 1A07 | 27 28 29 | 2B09 2B08 2B07 | 43 44 45 | 2A09 2A08 2A07 | 59 60 61 | B10 | 0 0 0 0 0 0 | |
| | | COM | 1B10 1B09 1B08 1B07 1B06 | 10 11 12 13 14 | 1A09 1A08 1A07 1A06 | 27 28 29 30 | 2B09 2B08 2B07 2B06 | 43 44 45 46 | 2A09 2A08 2A07 2A06 | 59 60 61 62 | B10 B09 B08 | 0 0 0 0 0 0 0 0 | |
| | | COM DC12/24V | 1B10 1B09 1B08 1B07 1B06 1B05 | 10 11 12 13 14 15 | 1A09 1A08 1A07 1A06 1A05 | 27 28 29 30 31 | 2B09 2B08 2B07 2B06 2B05 | 43 44 45 46 47 | 2A09 2A08 2A07 2A06 2A05 | 59 60 61 62 63 | B10 B09 B08 B07 B06 B05 | 0 0 0 0 0 0 0 0 0 0 | |
| SwitchingOA | | COM DC12/24V | 1B10 1B09 1B08 1B07 1B06 1B05 1B04 | 10 11 12 13 14 15 NC | 1A09 1A08 1A07 1A06 1A05 1A04 | 27 28 29 30 31 NC | 2B09 2B08 2B07 2B06 2B05 2B04 | 43 44 45 46 47 NC | 2A09 2A08 2A07 2A06 2A05 2A04 | 59 60 61 62 63 NC | B10 B09 B08 B07 B06 B05 B04 | 0 0 0 0 0 0 0 0 | |
| | | COM DC12/24V 1A02, 1A01 2A02, 2A01 *COM : 1B02, 1B01 | 1B10 1B09 1B08 1B07 1B06 1B05 1B04 1B03 | 10 11 12 13 14 15 | 1A09 1A08 1A07 1A06 1A05 1A04 1A03 | 27 28 29 30 31 | 2B09 2B08 2B07 2B06 2B05 2B04 2B03 | 43 44 45 46 47 | 2A09 2A08 2A07 2A06 2A05 2A04 2A03 | 59 60 61 62 63 | B10 B09 B08 B07 B06 B05 B04 B03 | 0 0 0 0 0 0 0 0 | |
| Switching OR | g 0 ~31 | COM DC12/24V 1A02, 1A01 2A02, 2A01 | 1B10 1B09 1B08 1B07 1B06 1B05 1B04 | 10 11 12 13 14 15 NC | 1A09 1A08 1A07 1A06 1A05 1A04 | 27 28 29 30 31 NC | 2B09 2B08 2B07 2B06 2B05 2B04 | 43 44 45 46 47 NC | 2A09 2A08 2A07 2A06 2A05 2A04 | 59 60 61 62 63 NC | B10 B09 B08 B07 B06 B05 B04 | 0 0 0 0 0 0 0 0 0 0 0 0 | |

9.3.11 8 point transistor isolated output module

| | Module type | | Transis | tor output m | odule | | | |
|--------------------|----------------------|--|--|-------------------|---------|----------|--|--|
| Spec. | | | Х | GQ-TR1C | | | | |
| Output point | | 8 points | | | | | | |
| Insulation method | k | Photo coupler ins | sulation | | | | | |
| Rated load voltage | je | DC 12/24V | | | | | | |
| Operating load vo | oltage range | DC 10.2 ~ 26.4V | • | | | | | |
| Max. load current | İ | 2A / 1 point | | | | | | |
| Leakage current | at Off | 0.1mA and lower | ٢ | | | | | |
| Max. inrush curre | ent | 4A / 10 ms and | lower | | | | | |
| Max. voltage drop | o at On | DC 0.3V and low | /er | | | | | |
| Surge killer | | Zener diode | | | | | | |
| Doonanaa tima | $Off \rightarrow On$ | 3 ms and shorter | | | | | | |
| Response time | $On \rightarrow Off$ | 10 ms and shorter (Rated load, resistance load) | | | | | | |
| Common method | k | 1 point/ 1COM | | | | | | |
| Current consump | otion | 100mA (when ev | very points On) | | | | | |
| External power | Voltage | DC12/24V ± 10% (4 Vp-p and lower ripple voltage) | | | | | | |
| supply | Current | 10mA and lower | 10mA and lower (if connected to DC24V) | | | | | |
| Operation display | 1 | LED On with out | put On | | | | | |
| External connecti | on method | 18point Termina | l strip connector | | | | | |
| Weight | | 0.11kg | | | | | | |
| | Circui | t diagram | | Terminal block | Contact | | | |
| | | | | TB1 | P0 | XGQ-TR1C | | |
| | | | | TB2 | COM0 | | | |
| ↔ De | CEV. | |] | TB3 | P1 | | | |
| + | OJV . | | TR1 | TB4 | COM1 | | | |



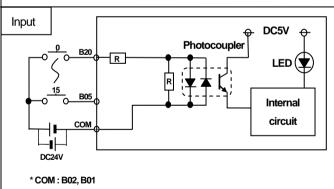
| block | Contact |
|-------|---------|
| TB1 | P0 |
| TB2 | COM0 |
| TB3 | P1 |
| TB4 | COM1 |
| TB5 | P2 |
| TB6 | COM2 |
| TB7 | P3 |
| TB8 | COM3 |
| TB9 | P4 |
| TB10 | COM4 |
| TB11 | P5 |
| TB12 | COM5 |
| TB13 | P6 |
| TB14 | COM6 |
| TB15 | P7 |
| TB16 | COM7 |
| TB17 | NC |
| TB18 | NC |



9.4 Digital I/O Module Specifications

9.4.1 32 point (DC input · transistor output) I/O combined module

| | XG | H-DT4A | | | | | | | | | | | | | |
|----------------------|---|---|--|--|---|-------------------|--|-------------------|--|-------------------|--|--------------------|--|------------|------------------|
| | Input | Output | | | | | | | | | | | | | |
| | 16 points | Output poin | t | 16 points | | | | | | | | | | | |
| nethod | Photo coupler insulation | Insulation method | | Photo cou | pler insulation | | | | | | | | | | |
| t voltage | DC 24V | Rated load | voltage | DC 12/24 | IV. | | | | | | | | | | |
| t current | Approx. 4 mA | Operating lo | oad voltage range | DC 10.2 ~ | 26.4V | | | | | | | | | | |
| voltage range | DC20.4~28.8V (5% and lower ripple rate) | Max. load current | | Max. load current | | Max. load current | | Max. load current | | Max. load current | | I May load current | | 0.1A / 1po | int, 1.6A / 1COM |
| voltage | AC560Vrms/3Cycle(altitude2000m) | Leakage cu | rrent at Off | 0.1mA and | d lower | | | | | | | | | | |
| /On current | DC 19V and higher / 3mA and higher | Max. inrush current | | 0.7A / 10 ms and lower | | | | | | | | | | | |
| /Off current | DC 11V and lower / 1.7mA and lower | Surge killer | | Zener diode | | | | | | | | | | | |
| ance | Approx. 5.6 kΩ | Max. voltage drop at On | | DC 0.2V and lower | | | | | | | | | | | |
| Off→On | 1ms/3ms/5ms/10ms/20ms/70ms/ 100ms(set by CPU parameter) Initial value:3ms | Response | Off→ On | 1 ms and | shorter | | | | | | | | | | |
| $On \rightarrow Off$ | 1ms/3ms/5ms/10ms/20ms/70ms/ 100ms(set by CPU parameter) Initial value:3ms | time | On → Off | 1 ms and shorter (Rated load, resistance load) | | | | | | | | | | | |
| ethod | 16 point/ COM | Common m | nethod | 16 point/ 1 | COM | | | | | | | | | | |
| isplay | LED On with input On | Operation d | isplay | LED On with output On | | | | | | | | | | | |
| sumption(mA) | 110mA (when ever point is on) | | | • | | | | | | | | | | | |
| connection | 40 Pin Connector x 1 | | | | | | | | | | | | | | |
| | 0.1 kg | | | | | | | | | | | | | | |
| | | | External | connection | | | | | | | | | | | |
| | t voltage t current voltage range voltage /On current /Off current ance Off On Off ethod splay sumption(mA) | Input 16 points nethod Photo coupler insulation t voltage DC 24V t current Approx. 4 mA //oltage range DC20.4~28.8V (5% and lower ripple rate) //on current DC 19V and higher / 3mA and higher //off current DC 11V and lower / 1.7mA and lower ance Approx. 5.6 kΩ 1ms/3ms/5ms/10ms/20ms/70ms/ 100ms(set by CPU parameter) Initial value:3ms 1ms/3ms/5ms/10ms/20ms/70ms/ 100ms(set by CPU parameter) Initial value:3ms ethod 16 point/ COM splay LED On with input On sumption(mA) 110mA (when ever point is on) connection 40 Pin Connector × 1 | 16 points Output point point point proto coupler insulation t voltage DC 24V Rated load to trum to trum to trum to voltage t current Approx. 4 mA Operating to Max. load of the foliation protocological protoc | Input 16 points Output point nethod Photo coupler insulation Insulation method t voltage DC 24V Rated load voltage t current Approx. 4 mA Operating load voltage range voltage range DC20.4-28.8V (5% and lower ripple rate) Max. load current voltage AC560Vrms/3Cycle(altitude2000m) Leakage current at Off /On current DC 19V and higher / 3mA and higher Max. inrush current /Off current DC 11V and lower / 1.7mA and lower Surge killer ance Approx. 5.6 kΩ Max. voltage drop at On Off→ On 1ms/3ms/5ms/10ms/20ms/70ms/ 100ms(set by CPU parameter) Initial value:3ms Response time On → Off On → Off on → Off Common method tethod 16 point/ COM Common method splay LED On with input On Operation display sumption(mA) 110mA (when ever point is on) connection 40 Pin Connector x 1 0.1 kg | Input Output 16 points Output point 16 points nethod Photo coupler insulation Insulation method Photo coupler insulation it outlage DC 24V Rated load voltage DC 12/24 it current Approx. 4 mA Operating load voltage range DC 10.2 ~ voltage range DC 20.4~28.8V (5% and lower ripple rate) Max. load current 0.1A / 1po voltage AC560Vrms/3Cycle(altitude2000m) Leakage current at Off 0.1mA and /On current DC 19V and higher / 3mA and higher Max. inrush current 0.7A / 1or /Off current DC 11V and lower / 1.7mA and lower Surge killer Zener dioc ance Approx. 5.6 kΩ Max. voltage drop at On DC 0.2V at 1 ms/3ms/5ms/10ms/20ms/70ms/ 0ff → On 1ms/3ms/5ms/10ms/20ms/70ms/ 10ms(set by CPU parameter) Off → On 1 ms and s(Rated load (Rated loa | | | | | | | | | | |



| Output | | |
|--------|-------------------------|--|
| Int | Photocouple ernal rcuit | A20 L A05 L A04, A03 A02, A01 DC12224V |

| No | Contact | No | Contact |
|-----|---------|-----|---------|
| B20 | 0 | A20 | 16 |
| B19 | 1 | A19 | 17 |
| B18 | 2 | A18 | 18 |
| B17 | 3 | A17 | 19 |
| B16 | 4 | A16 | 20 |
| B15 | 5 | A15 | 21 |
| B14 | 6 | A14 | 22 |
| B13 | 7 | A13 | 23 |
| B12 | 8 | A12 | 24 |
| B11 | 9 | A11 | 25 |
| B10 | 10 | A10 | 26 |
| B09 | 11 | A09 | 27 |
| B08 | 12 | 80A | 28 |
| B07 | 13 | A07 | 29 |
| B06 | 14 | A06 | 30 |
| B05 | 15 | A05 | 31 |
| B04 | NC | A04 | DC12 |
| B03 | NC | A03 | /24V |
| B02 | COM | A02 | 0)/ |
| B01 | COM | A01 | 0V |

9.5 Event Input Module

9.5.1 Event Input Module (Source/Sink type)

| Specification | | | XGF-S | OEA | | |
|--------------------------|--|------------|--------------|------------|-----------|---|
| Input point | 32 point | | | | | |
| Insulation method | Photo coupler insulation | | | | | |
| Memory size | Records 1Mbit event information (3 | 00 ever | nt informati | ion per 2 | XGF-SOE | :A module) |
| Precision | 1 ms (±2ms : error between mode | ules) | | | | |
| Rated input voltage | DC24V | | | | | |
| Rated input current | About 4mA | | | | | |
| Used voltage range | DC20.4 ~ 28.8V (within ripple rate 5 | 5%) | | | | |
| On voltage/On current | DC19V or above /3 mA or ab | ove | | | | |
| Off voltage/ Off current | DC11V or less / 1.7 mA or less | | | | | |
| Input resistance | About 5.6 kΩ | | | | | |
| Response Off → On | H/W delay (10/4s: Normal) + input fi | Iter time | (user sett | ing: 0~1 | 00ms) + C | CPU scan time delay (50#s) |
| time On → Off | H/W delay (84//s: Normal) + input fi | | ` | | • | • • • • |
| Working voltage | AC560V rms/3 Cycle (Altitude 2000 | | | | • | |
| Insulation resistance | Insulation resistance 10 MΩ or above | e (DC5 | 00V) | | | |
| COMM method | 32 point / COM | | | | | |
| Current consumption (A) | 0.7(MAX) | | | | | |
| Operation indicator | LED is on when input is on | | | | | |
| External connection | | | | | | |
| method | 40 pin connector | | | | | |
| Size | 27x98x90 | | | | | |
| Weight | 0.2 kg | | | | | |
| Circ | uit configuration | No | Contact | No | Contact | |
| | Photo coupler DC5V | B20 | 0 | A20 | 16 | |
| 0 B20 R | Photo coupler LED | B19 B18 | 2 | A19 A18 | 17 18 | B20 O O A20 A19 |
| | | B17 | 3 | A17 | 19 | B18 O O A18 |
| 31 A05 | Internal | B16 | 4 | A16 | 20 | B17 O O A17 A16 |
| COM | circuit | B15 | 5 | A15 | 21 | B15 0 0 A15 |
| | Silout | B14 | 6 | A14 | 22 | B14 0 0 A14 |
| DC24V | | B13 | 7 | A13 | 23 | B13 O O A13 |
| * COM : B02, B01 | | B12 | 8 | A12 | 24 | B11 0 0 A11 |
| 90 | \ | B11 | 9 | A11 | 25 | B10 O O A10 B09 O O A09 |
| 80 | | B10 | 10 11 | A10 | 26 | O O |
| 70 | DC28.8V | B09 B08 | 12 | A09 A08 | 27 | B07 0 0 A07 |
| On rate (%) | | B07 | 13 | A08 | 28 29 | $\frac{B06}{B05}$ o o $\frac{A06}{A05}$ |
| 50 | +++++ | B06 | 14 | A06 | 30 | B04 0 0 A04 |
| 40 | | B05 | 15 | A05 | 31 | B03 O O A03 B02 O O A02 |
| | | B04 | RX+ | A04 | SG | B01 0 9 A02 A01 |
| | 20 30 40 50 55 | B03 | RX- | A03 | SG | 1 |
| | Ambient temp (°C) | B02 | COM | A02 | COM | 1 |
| L | erating diagram | B01 | COM | A01 | COM | 1 |

9.6 Smart Link

9.6.1 Modules accessible to Smart Link

From digital I/O modules used for XGT Series, the modules accessible to Smart Link are as follows. 32 point modules need a Connector(40 Pin x 1), 64 point modules need 2 connectors(40 Pin x 2)

| oz point modules need a connected (40 f in x 1), of point modules need 2 connected (40 f in x 2) | | | | | | | |
|--|--|----------------------|--|--|--|--|--|
| Model | Specification | No. of Pins | | | | | |
| XGI-D24A/B | DC input 32 point module | 40 Pin Connector × 1 | | | | | |
| XGI-D28A/B | DC input 64 point module | 40 Pin Connector x 2 | | | | | |
| XGQ-TR4A | TR output 32 point module(sink type) | 40 Pin Connector x 1 | | | | | |
| XGQ-TR8A | TR output 64 point module(sink type) | 40 Pin Connector x 2 | | | | | |
| XGQ-TR4B | TR output 32 point module(source type) | 40 Pin Connector x 1 | | | | | |
| XGQ-TR8B | TR output 64 point module(source type) | 40 Pin Connector x 2 | | | | | |
| XGF-SOEA | Event input module | 40 Pin Connector x 1 | | | | | |

9.6.2 Smart Link Components

The company prepares smart link products for the convenience of using our Connector type I/O modules. For further information, please refer to the data sheet contained in a smart link product. (Refer to 7.6.6 to confirm the differences between TG7-1H40CA and TG7-1H40S)

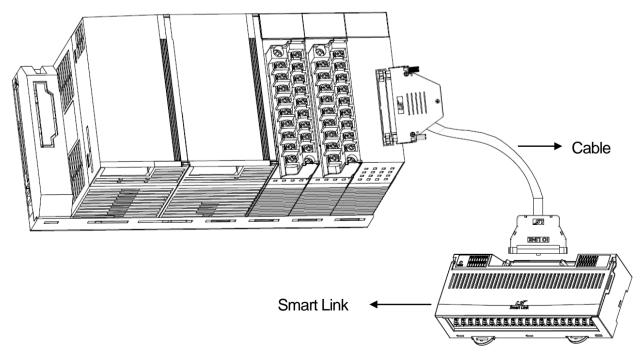
| | Model | Cable | Length of Cable | | | | |
|----------|------------------------------------|-----------------|-----------------|--|--|--|--|
| Terminal | | C40HF-05PB-1B | 0.5m | | | | |
| | | C40HF-10PB-1B | 1m | | | | |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m | | | | |
| | | C40HF-20PB-1B | 2m | | | | |
| | | C40HF-30PB-1B | 3m | | | | |
| board | | C40HF-05PB-1B | 0.5m | | | | |
| | TO7.411400A | C40HF-10PB-1B | 1m | | | | |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B | 1.5m | | | | |
| | (Common Zor in Addod) | C40HF-20PB-1B | 2m | | | | |
| | | C40HF-30PB-1B | 3m | | | | |
| | | C40HF-05PB-1 | 0.5m | | | | |
| | DOOG NOTA 40D | C40HF-10PB-1 | 1m | | | | |
| | R32C-NS5A-40P (Sink type) | C40HF-15PB-1 | 1.5m | | | | |
| Relay | (On incrypto) | C40HF-20PB-1 | 2m | | | | |
| board | | C40HF-30PB-1 | 3m | | | | |
| | D000 D054 40D | C40HF-05PB-XGP1 | 0.5m | | | | |
| | R32C-PS5A-40P (Source type) | C40HF-10PB-XGP1 | 1m | | | | |
| | (333.30 (300) | C40HF-20PB-XGP1 | 2m | | | | |

9.6.3 Smart Link Mapping Table

1 : Module using 1ea Cable 2 : Module using 2ea Cable

| | | | | | XGT P | LC (D | igital 1 | I/O M | odule) | | | |
|---------------------------|-----------------------------|------------------------------|------|---|----------|----------|----------|----------|----------|----------|----------|----------|
| | LS Smart Link Mapping Table | | | | XGQ-TR4B | XGQ-TR8A | XGQ-TR8B | XGI-D24A | XGI-D24B | XGI-D28A | XGI-D28B | XGI-SOEA |
| | Cable | Description | Sets | 1 | 1 | 2 | 2 | 1 | 1 | 2 | 2 | 1 |
| | C40HF-05PB-1B | PLC,CABLE ASS'Y,40p-40p,0.5m | 0.5 | 1 | 1 | 2 | 2 | 1 | 0 | 2 | 2 | 1 |
| OCA OCA | C40HF-10PB-1B | PLC,CABLE ASS'Y,40p-40p,1m | 1.0 | 1 | 0 | 2 | 2 | 0 | 0 | 2 | 2 | 0 |
| TG7-1H40S TG7-1H40CA | C40HF-15PB-1B | PLC,CABLE ASS'Y,40p-40p,1.5m | 1.5 | 1 | 0 | 2 | 2 | 0 | 0 | 2 | 2 | 0 |
| TG; | C40HF-20PB-1B | PLC,CABLE ASS'Y,40p-40p,2m | 2.0 | 1 | 0 | 2 | 2 | 0 | 0 | 2 | 2 | 1 |
| | C40HF-30PB-1B | PLC,CABLE ASS'Y,40p-40p,3m | 3.0 | 0 | 0 | 2 | 2 | 0 | 0 | 2 | 2 | 0 |
| | C40HF-05PB-1 | PLC,CABLE ASSY,40p-40p,0.5m | 0.5 | 1 | | 2 | | | | | | |
| 440E | C40HF-10PB-1 | PLC,CABLE ASS'Y,40p-40p,1m | 1.0 | 0 | | 0 | | | | | | |
| R32C-NS5A-40P (SINK) | C40HF-15PB-1 | PLC,CABLE ASS'Y,40p-40p,1.5m | 1.5 | 1 | | 2 | | | | | | |
| 32C | C40HF-20PB-1 | PLC,CABLE ASS'Y,40p-40p,2m | 2.0 | 0 | | 0 | | | | | | |
| <u>.</u> | C40HF-30PB-1 | PLC,CABLE ASS'Y,40p-40p,3m | 3.0 | 0 | | 2 | | | | | | |
| | C40HF-05PB-XGP1 | PLC,CABLE ASS'Y,40p-40p,0.5m | 0.5 | | 0 | | 2 | | | | | |
| A-40F e) | C40HF-10PB-XGP1 | PLC,CABLE ASS'Y,40p-40p,1m | 1.0 | | 0 | | 2 | | | | | |
| C-PS5A- (Source) | C40HF-15PB-XGP1 | PLC,CABLE ASS'Y,40p-40p,1.5m | 1.5 | | | | | | | | | |
| R32C-PS5A-40P (Source) | C40HF-20PB-XGP1 | PLC,CABLE ASS'Y,40p-40p,2m | 2.0 | | 0 | | 2 | | | | | |
| - | C40HF-30PB-XGP1 | PLC,CABLE ASS'Y,40p-40p,3m | 3.0 | | | | | | | | | |

9.6.4 Smart Link Connection



9.6.5 Smart Link Connection Diagram

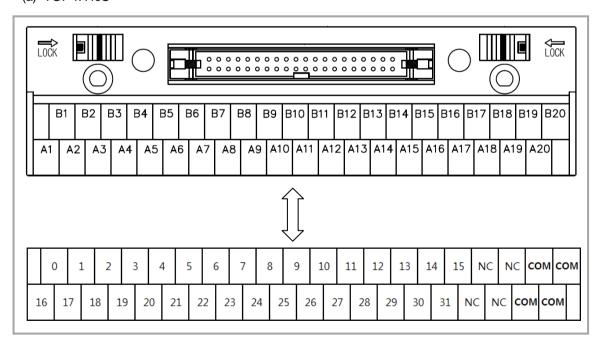
(1) XGI-D24A/B

1) Applicable Smart Link

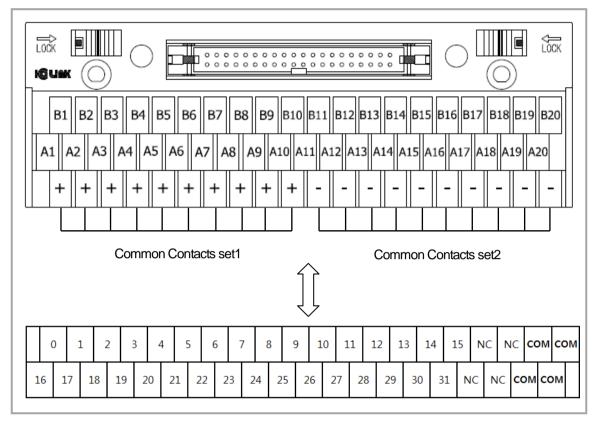
| | Model | Cable | Length of Cable |
|----------|------------------------------------|---------------|-----------------|
| | | C40HF-05PB-1B | 0.5m |
| | | C40HF-10PB-1B | 1m |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m |
| | | C40HF-20PB-1B | 2m |
| Terminal | | C40HF-30PB-1B | 3m |
| board | | C40HF-05PB-1B | 0.5m |
| | TO7 411400A | C40HF-10PB-1B | 1m |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B | 1.5m |
| | (Common Zor III Added) | C40HF-20PB-1B | 2m |
| | | C40HF-30PB-1B | 3m |

2) Connection Diagram (XGI-D24A/B)

(a) TG7-1H40S



(b) TG7-1H40CA



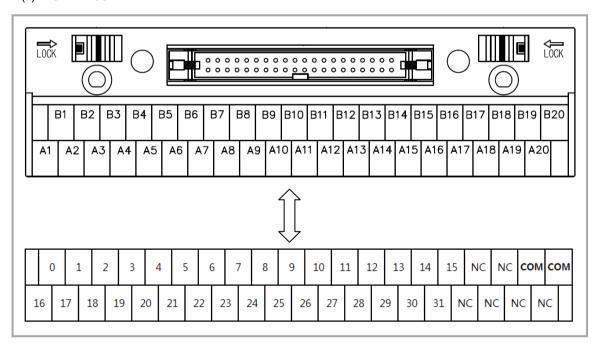
(2) XGI-D28A/B

1) Applicable Smart Link

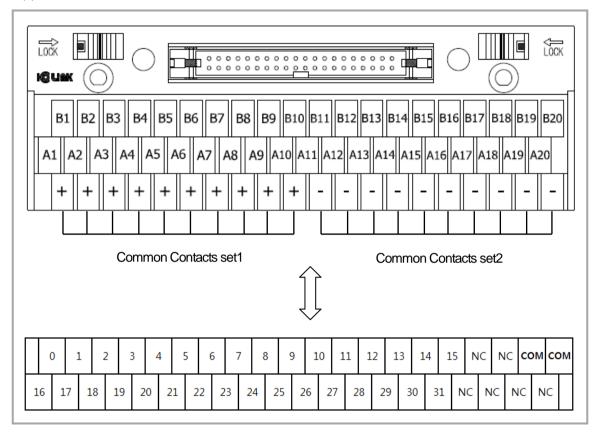
| | Model | Cable | Length of Cable |
|----------|------------------------------------|---------------|-----------------|
| | | C40HF-05PB-1B | 0.5m |
| | | C40HF-10PB-1B | 1m |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m |
| | | C40HF-20PB-1B | 2m |
| Terminal | | C40HF-30PB-1B | 3m |
| board | | C40HF-05PB-1B | 0.5m |
| | TO7 41 400 A | C40HF-10PB-1B | 1m |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B | 1.5m |
| | (Common 201 in Added) | C40HF-20PB-1B | 2m |
| | | C40HF-30PB-1B | 3m |

2) Connection Diagram (XGI-D28A/B)

(a) TG7-1H40S



(b) TG7-1H40CA



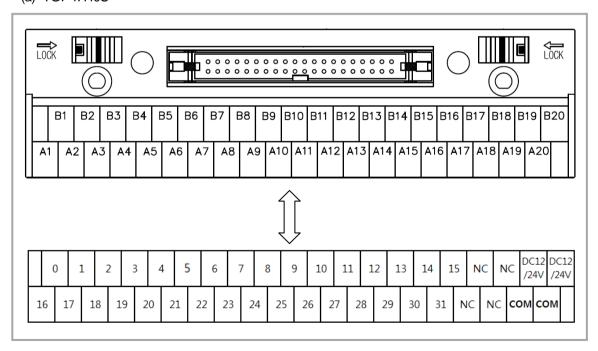
(3) XGQ-TR4A/8A

1) Applicable Smart Link

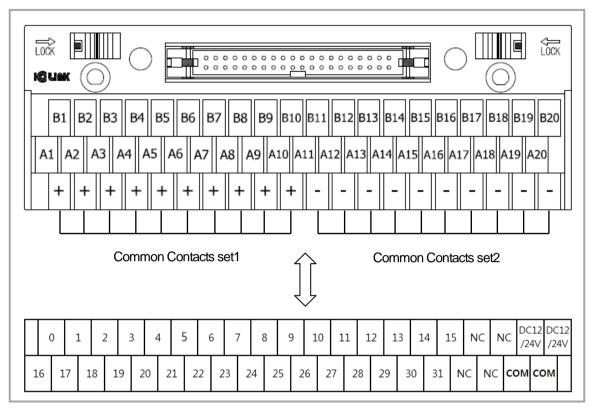
| | Model | Cable | Length of Cable |
|----------------|------------------------------------|---------------|-----------------|
| | | C40HF-05PB-1B | 0.5m |
| | | C40HF-10PB-1B | 1m |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m |
| | | C40HF-20PB-1B | 2m |
| Terminal | | C40HF-30PB-1B | 3m |
| board | | C40HF-05PB-1B | 0.5m |
| | TO7 41 400 A | C40HF-10PB-1B | 1m |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B | 1.5m |
| | (Common Zor in Added) | C40HF-20PB-1B | 2m |
| | | C40HF-30PB-1B | 3m |
| | | C40HF-05PB-1 | 0.5m |
| | D000 N054 40D | C40HF-10PB-1 | 1m |
| Relay board | R32C-NS5A-40P (Sink type) | C40HF-15PB-1 | 1.5m |
| Doard | | C40HF-20PB-1 | 2m |
| | | C40HF-30PB-1 | 3m |

2) Connection Diagram (XGQ-TR4A/8A)

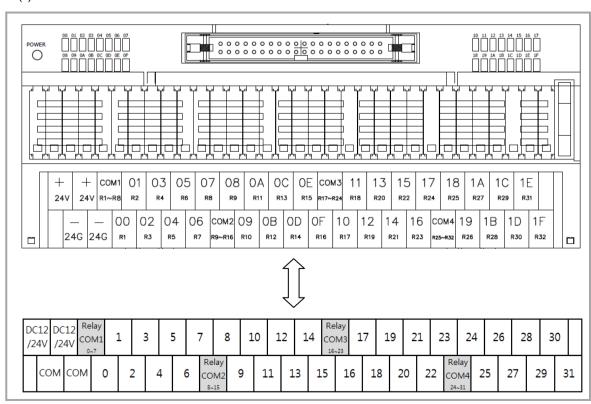
(a) TG7-1H40S



(b) TG7-1H40CA



(c) R32C-NS5A-40P



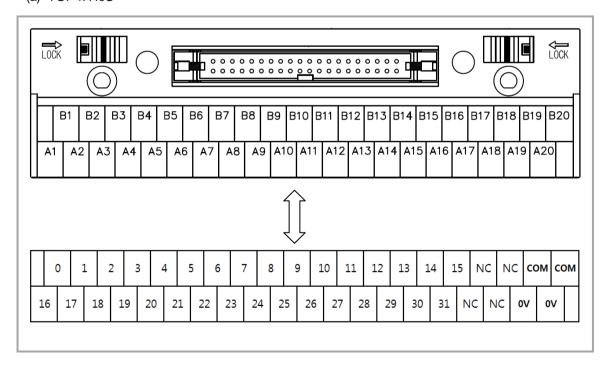
(4) XGQ-TR4B/8B

1) Applicable Smart Link

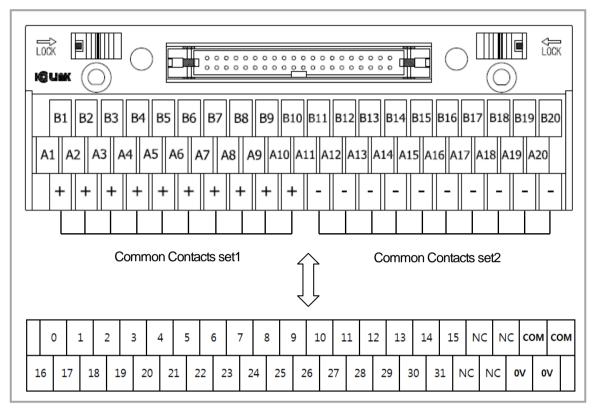
| | Model | Cable | Length of Cable |
|----------------|------------------------------------|--------------------|-----------------|
| | | C40HF-05PB-1B | 0.5m |
| | | C40HF-10PB-1B | 1m |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m |
| | | C40HF-20PB-1B | 2m |
| Terminal | | C40HF-30PB-1B | 3m |
| board | | C40HF-05PB-1B | 0.5m |
| | T07 41400A | C40HF-10PB-1B | 1m |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B 1.5m | |
| | (Common zor in Added) | C40HF-20PB-1B | 2m |
| | | C40HF-30PB-1B | 3m |
| | | C40HF-05PB-XGP1 | 0.5m |
| Dulan | D000 D054 40D | C40HF-10PB-XGP1 | 1m |
| Relay board | R32C-PS5A-40P (Source type) | C40HF-20PB-XGP1 | 2m |
| Doard | (Codioc typo) | - | - |
| | | - | - |

2) Connection Diagram (XGQ-TR4B/8B)

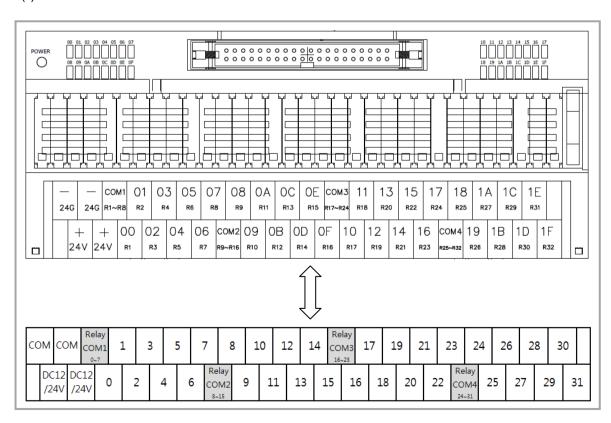
(a) TG7-1H40S



(b) TG7-1H40CA



(c) R32C-PS5A-40P



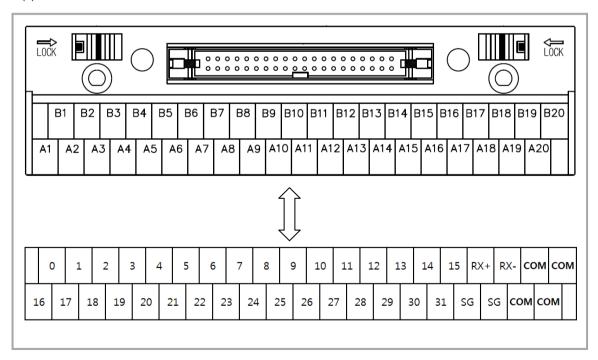
(5) XGF-SOEA

1) Applicable Smart Link

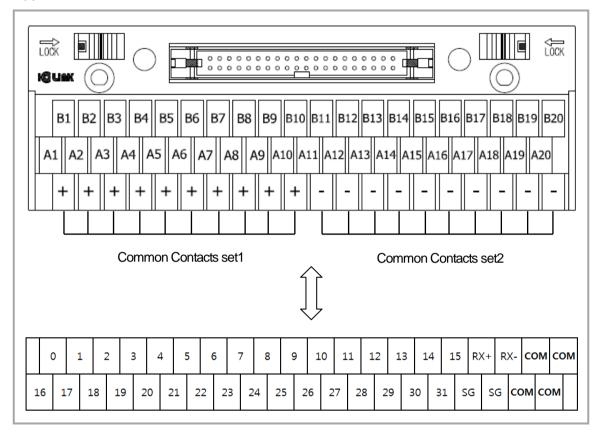
| | Model | Cable | Length of Cable |
|----------|------------------------------------|---------------|-----------------|
| | | C40HF-05PB-1B | 0.5m |
| | | C40HF-10PB-1B | 1m |
| | TG7-1H40S | C40HF-15PB-1B | 1.5m |
| | | C40HF-20PB-1B | 2m |
| Terminal | | C40HF-30PB-1B | 3m |
| board | | C40HF-05PB-1B | 0.5m |
| | T07 41400A | C40HF-10PB-1B | 1m |
| | TG7-1H40CA (Common 20Pin Added) | C40HF-15PB-1B | 1.5m |
| | (Common Zorin Added) | C40HF-20PB-1B | 2m |
| | | C40HF-30PB-1B | 3m |

2) Connection Diagram (XGF-SOEA)

(a) TG7-1H40S



(b) TG7-1H40CA



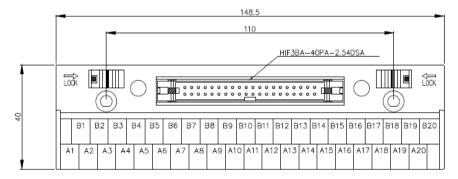
9.6.6 Smart Link Specifications & Dimensions

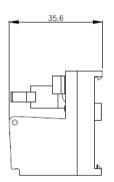
(1) TG7-1H40S

1) Specifications

| Rated Voltage | AC, DC 125V |
|-----------------------|-------------------------------|
| Rated Current | 1A |
| Withstanding Voltage | 600V 1min |
| Insulation resistance | 100MΩ (DC 500V) |
| Applicable Wire | 1.25 mm² /MAX |
| T/B Screw | M3 X 10L |
| Screw Torque | 1.2N • m(12Kgf • cm) |
| Case | Modified PPO(Noryl)(UL 94V-0) |

2) Dimensions(mm)



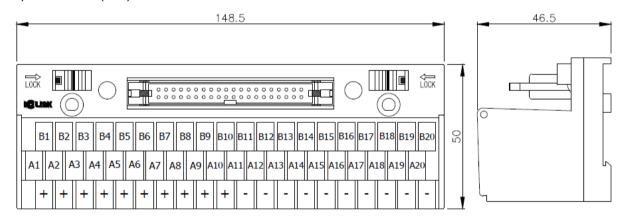


(2) TG7-1H40CA

1) Specifications

| Rated Voltage | | 125V AC / 24V DC |
|------------------------|-----------|--|
| Rated | Ю | 1A |
| Current | Common | 10A (Total) |
| Insulation res | sistance | 100MΩ (DC 500V) |
| Withstanding | g Voltage | AC500V 1min |
| Applicable W | /ire | AWG22-16 (MAX / 1.5 mm) |
| Contact Screw | | M3 X 10L |
| Screw Torque | | 1.2N • m(12Kgf • cm) |
| Ambient Temperature | | -10 $^{\circ}$ C ~ +50 $^{\circ}$ C (Non-condensing) |
| Terminal Block & Cover | | Modified PPO |
| Protective Cover | | Polycarbonate |
| PCB | | Epoxy 1.6t |

2) Dimensions(mm)



(3) R32C-N(P)S5A-40P

1) Specifications

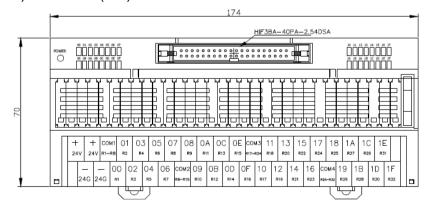
(a) Relay Board

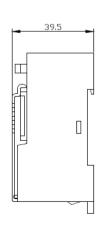
| Case | Modified PPO |
|---------------------|--------------------------------|
| Protective Cover | Polycarbonate |
| PCB | Epoxy 1.6t / 2oz |
| Applicable Wire | AWG22-16 (MAX / 1.5 mm) |
| T/B Screw | M3 X 8L |
| Screw Torque | 1.2N • m(12Kgf • cm) |
| Ambient Temperature | -10°C ~ +50°C (Non-condensing) |

(b) Relay

| (b) Itolay | Specification | PA1a-24V |
|---|----------------------------|------------------------|
| | Arrangement | 1a |
| | Nominal switching capacity | 5A 250V AC / 5A 30V DC |
| Contact | Max. switching current | 5A |
| | Max. switching voltage | 250V AC / 110V DC |
| | Rated Voltage | 24V DC |
| | Pick-up voltage | 16.8V |
| Coil | Drop-out voltage | 1.2V DC |
| | Coil resistance | 3,200Ω |
| | Rated operation power | 180mW |
| Surge voltage between contact and coil | | 4,000V |
| Initial breakdown voltage Between contact and coil | | 2,000V rms |

2) Dimensions(mm)





Chapter 8 Power Module

Here describes the selection method, type and specification of power module.

8.1 Selection Method

The selection of power module is determined by the current that voltage and power module of input power supply to the system, that is, the sum of current consumption of digital I/O module, special module and communication module which are installed on the same base as power module.

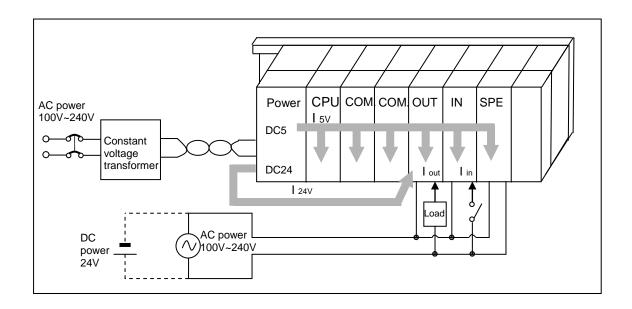
If exceeded the rated output capacity of power module, the system does not operate normally. In case of system configuration, consider the current consumption of each module before selecting the power module.

- For consumption current of each module, refer to user manual or data sheet of each module.
- 1) Current consumption per module (DC 5V)

(unit: mA)

| (unit:r | | | | | |
|----------------------|------------------|------------|-----------------------------------|----------|-------------|
| Item | Model | Consumpti | Item | Model | Consumpt |
| | | on current | | VOE AVOA | ion current |
| | | | | XGF-AV8A | 420 |
| | XGK-CPUA, | 960 | Analog input module | XGF-AC8A | 420 |
| CPU module | H, U, SN, HN, UN | | | XGF-AD4S | 200 |
| | , 0, 0.1,, 0.1 | | | XGF-DV4A | 190 (250) |
| | XGKCPUE,S | 940 | | XGF-DC4A | 190 (400) |
| | XGI-D21A | 20 | Analog output module | XGF-DC4S | 200 (200) |
| | XGI-D22A | 30 | Arialog output module | XGF-DV8A | 190 (250) |
| DCO4\/imm.st | XGI-D22B | 30 | | XGF-DC8A | 190 (400) |
| DC24V input module | XGI-D24A | 50 | | XGF-DV4S | 200 (500) |
| module | XGI-D24B | 50 | High speed counter | XGF-HO2A | 270 |
| | XGI-D28A | 60 | module | XGF-HD2A | 330 |
| | XGI-D28B | 60 | | XGF-PO3A | 400 |
| AC110V input module | XGI-A12A | 30 | | XGF-PO2A | 360 |
| AC220V input module | XGI-A21A | 20 | Positioning module | XGF-PO1A | 336 |
| 5.1 | XGQ-RY1A | 250 | | XGF-PD3A | 860 |
| Relay output module | XGQ-RY2A | 500 | | XGF-PD2A | 790 |
| module | XGQ-RY2B | 500 | | XGF-PD1A | 510 |
| | XGQ-TR2A | 70 | Thermocouple input module | XGF-TC4S | 610 |
| | XGQ-TR2B | 70 | RTD input module | XGF-RD4A | 490 |
| Transistor output | XGQ-TR4A | 130 | Motion control module | XGF-M16M | 640 |
| module | XGQ-TR4B | 130 | Insulation type conversion module | XGF-AD4S | 200 |
| | XGQ-TR8A | 230 | Rnet I/F module | XGL-RMEA | 410 |
| | XGQ-TR8B | 230 | Pnet I/F module | XGL-PMEA | 560 |
| Triac output module | XGQ-SS2A | 300 | Dnet I/F module | XGL-DMEA | 440 |
| I/O mixed module | XGH-DT4A | 110 | | XGL-C22A | 330 |
| FEnet I/F module | XGL-EFMF | 650 | Cnet I/F module | XGL-C42A | 300 |
| (Optical/electrical) | XGL-EFMT | 420 | | XGL-CH2A | 340 |
| FDEnet I/F module | XGL-EDMF | 650 | - | - | - |
| (Master) | XGL-EDMT | 420 | - | - | - |

Value in () means consumption current for external DC24V



8.2 Specifications

| Items | | XGP-ACF1 | XGP-ACF2 | XGP-AC23 | XGP-DC42 |
|---------------------|---------------------------------|---|---------------------|------------------------|-----------------|
| Rated input voltage | | AC110V/220V AC220V | | DC24V | |
| | Input voltage range | AC85V ~ | AC264V | AC170V ~ AC264V | - |
| | Input frequency | 5 | 60 / 60 Hz (47 ~ 63 | B Hz) | - |
| Input | Inrush current | 20APeak or less | | 3 | 80APeak or less |
| | Efficiency | | 65% or more | | 60% or more |
| | Input fuse | Built-in (user no | change), UL stand | dard (Slow Blow Type) | |
| | Allowable moment shutdown | | W | ithin 10 ms | |
| | Output voltage | | DC5V (±2%) | | DC5V (±2%) |
| Output | Output current | 3 A | 6 A | 8.5 A | 6A |
| 1 | Overcurrent protect | 3.2A or more | 6.6 A or more | 9A or more | 6.6 A or more |
| | Overvoltage protect | | 5.5V ~ 6.5V | | |
| | Output voltage | DC24V (±10%) | | | |
| Output | Output current | 0.6 A | | _ | _ |
| 2 | Overcurrent protect | 0.7 A or more | | | - |
| | Overvoltage protect | None | | | |
| | Application | RUN contact (Refer to the section 8.3) | | | |
| | Rated switching voltage/current | DC24V, 0.5A | | | |
| Relay Output | Minimum switching load | DC5V,1 mA | | | |
| | Response time | 0 | ff→On/ On→Off: | 10 ms or less/12 ms or | less |
| | Life | Mechanical: More than 20,000,000 times Electrical: More than 100,000 times at rated switching voltage/current | | | |
| RUN signal output | | Relay output, Rating: DC24V, 0.5A | | | |
| Voltage indicator | | Output voltage normal, LED On | | | |
| Cable specification | | 0.75 ~ 2 mm ² | | | |
| Compre | ssed terminal | RAV1.25-3.5,RAV2-3.5 | | | |
| Weight | | 0 | .4 kg | 0.6 kg | 0.5 kg |

Notes

1) Allowable Momentary Power Failure Time

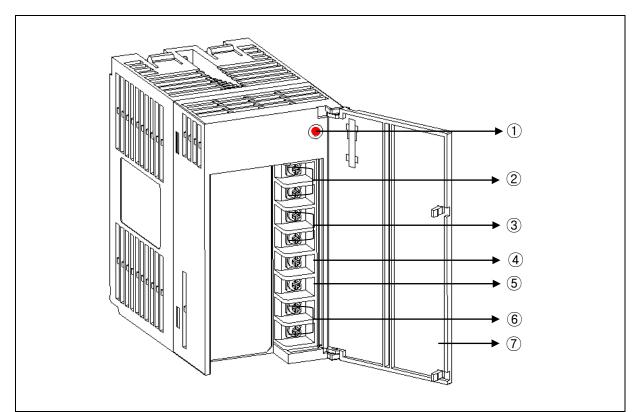
The time that input voltage keeps normal output voltage (normal operation) in the state that AC110/220V voltage is below rated value (AC85 / 170V).

- 2) Over current protection
 - (1) If the current over the standard flows in DC5V, DC24V circuit, the over current protection device shutdowns the circuit to stop the system.
 - (2) In case of over current, remove the causes such as lack of current capacity or short circuits etc. and then restart the system.
- 3) Over voltage protection

If the voltage over the standard is applied in DC5V circuit, the over voltage protection device shutdowns the circuit to stop the system.

8.3 Part Names

Here describes the names of each part and its purpose of power module.



| NO. | Names | Purpose |
|-----|----------------------|---|
| 1 | Power LED | DC5V power indication LED |
| 2 | DC24V, 24G terminal | Power supply to the module required for DC24V in output module. ▶ XGP-ACF2, XGP-ACF3 does not print out DC24V. |
| 3 | RUN terminal | Indicates RUN state of system. ▶ Off when CPU STOP error occurs. ▶ Off when CPU mode is changed to STOP mode. |
| 4 | PE terminal | Ground terminal for electric shock prevention |
| 5 | LG terminal | Ground terminal of power filter |
| 6 | Power input terminal | Power input terminal ► XGP-ACF1, XGP-ACF2, XGP-ACF3:AC100~240V connection ► XGP-DC42:DC24V connection |
| 7 | Terminal cover | Terminal block protection cover |

8.4 Current Consumption/Power Calculation Example

Here describes which power module should be used in case of XGK system that the following module is mounted.

| Time | Model | Number of cotur | Voltage system | | |
|---------------------------|-------------|-----------------|---------------------|-----|--|
| Туре | Wiodei | Number of setup | 5V | 24V | |
| CPU module | XGK-CPUH | 1 | 0.96A | - | |
| 12 Slot main base | XGB-B12M | - | - | - | |
| Input module | XGI-D24A | 4 | 0.2A | - | |
| Output module | XGQ-RY2A | 4 | 2.0A | - | |
| FDEnet module | XGL-EDMF 2 | | 1.3A | - | |
| Profibus-DP | XGL-PMEA 2 | | 1.12A | - | |
| Commant as as a summation | Calculation | | 0.96+0.2+2+1.3+1.12 | - | |
| Current consumption | Result | | 5.58A | - | |
| F | Calculation | | 5.58×5V | - | |
| Energy consumption | Result | | 27.9W | - | |

As the value of 5V current consumption is 5.58A, use XGP-ACF2(5V:6A) or XGP-AC23(5V:8.5A). If used XGP-ACF1(5V:3A), the system does not operate.

Chapter 9 Base and Extended Cable

9.1 Specification

9.1.1 Main Base

Main base installs Power Module, CPU Module, I/O Module and Special Communication Module.

| Model Items | XGB-M12A | XGB-M08A | XGB-M06A | XGB-M04A |
|------------------------------------|-----------------------------|---------------|---------------|---------------|
| I/O module setup | 12 module | 8 module | 6 module | 4 module |
| Dimension (mm) | 426 X 98 X 19 | 318 X 98 X 19 | 264 X 98 X 19 | 210 X 98 X 19 |
| Hole distance for panel attachment | 406 X 75 | 298 X 75 | 244 X 75 | 190 X 75 |
| Hole spec. for panel attachment | φ 4.5 (M4 screw) | | | |
| Screw spec. for PE connection | (+)PHM 3 X 6 washer(\phi 5) | | | |
| Weight (kg) | 0.54 | 0.42 | 0.34 | 0.28 |

9.1.2 Expansion Base

Expansion base installs Power Module, I/O Module and Special Communication Module.

| Model Items | XGB-E12A | XGB-E08A | XGB-E06A | XGB-E04A |
|------------------------------------|--------------------------|---------------|---------------|---------------|
| I/O module setup | 12 module 8 module | | 6 module | 4 module |
| Dimension (mm) | 426 X 98 X 19 | 318 X 98 X 19 | 264 X 98 X 19 | 210 X 98 X 19 |
| Hole distance for panel attachment | 406 X 75 | 298 X 75 | 244 X 75 | 190 X 75 |
| Hole spec. for panel attachment | φ 4.5 (M4 screw) | | | |
| Screw spec. for PE connection | (+)PHM 3 X 6 washer(φ 5) | | | |
| Weight (kg) | 0.59 | 0.47 | 0.39 | 0.33 |

9.1.3 Extended Cable

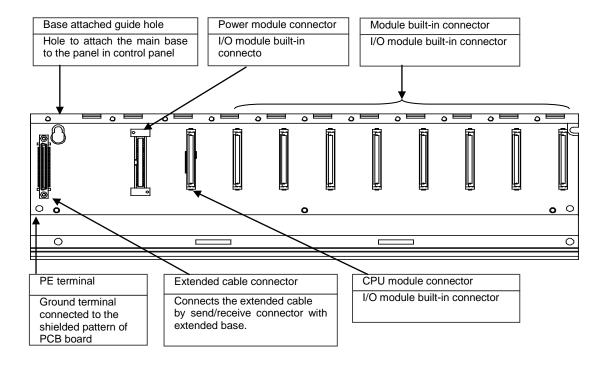
| Model | XGC- |
|-------------|------|------|------|------|------|------|------|
| Items | E041 | E061 | E121 | E301 | E501 | E102 | E152 |
| Length (m) | 0.4 | 0.6 | 1.2 | 3 | 5 | 10 | 15 |
| Weight (kg) | 0.15 | 0.16 | 0.22 | 0.39 | 0.62 | 1.2 | 1.8 |

Notes

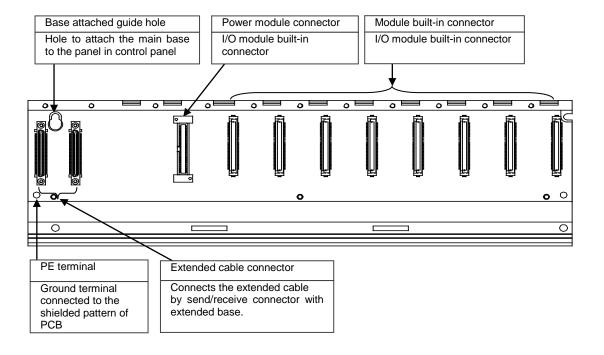
In case of combination of extended cable, do not exceed 15m.

9.2 Part Names

9.2.1 Main Base



9.2.2 Expansion Base



Chapter 10 Built-in PID Functions

This chapter describes the XGK Series CPU built-in PID function.

Sections 10.2 and 10.3 cover the principles and structure of PID control; the subsequent sections are dedicated to the PID function built into XGK Series.

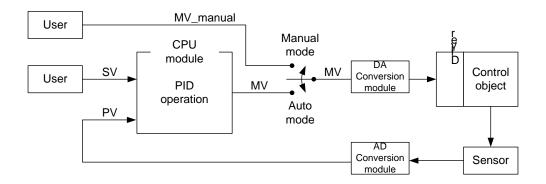
10.1 Features

The features of the PID function built into XGK Series (XGK-CPUH, XGK-CPUA, XGK-CPUS, XGK-CPUE, XGK-CPUU) are as follows.

- (1) Enables high-precision control operation.
- (2) Supports a high-speed operation cycle of 0.6 ms.
- (3) Provides a symbol function for easy setting and monitoring.
- (4) Supports the forward and reverse processes.
- (5) Effectively prevents over/undershoot by means of powerful dual anti-windup.
- (6) Allows operation by external equipment(HMI).
- (7) Protects the system by limiting the maximum variation of PV.
- (8) Protects the driver by limiting the maximum variation, maximum value and minimum value of MV.
- (9) Enables PID control by the Auto-tuning function.
- (10) Enables the cascade PID control.

10.2 PID Control

PID control is a control method to keep the state of the control object at the Set Value. In case there exists an error between the preset Set Value and the value measured by the detector (current value), the controller operates to adjust the output (control signal) so that the current value can reach the Set Value.



As illustrated in the figure above, the PLC functions as a controller for the whole control system. The sensor and driver are used respectively for the state detection and driving of the control object.

The sensor detects the current states of the control object and transmits them to the controller, the PLC transfers the proper output to the driver, the driver drives the control object according to the controller output, then again the sensor detects the changed states and transmits them to the PLC (Closed Loop Control). The process of going around the control loop once is repeated at intervals ranging from a few seconds to hundreds of microseconds. The time taken is called the control cycle.

10.3 PID Control Operation

10.3.1 Terms

Below are the terms used to describe the PID control operation.

SV : The target state the control object should reach

T_s (Ts) : Sampling time (Control cycle)
K_p (Kp) : Proportional coefficient
T_i (Ti) : Integral time constant
T_d (Td) : Differntial time constant

PV : Current state of the control object, which is detected by the sensor ERR : Current error of the control object, which is represented by (SV – PV)

MV : Control input or controller output MV_p (MVp): Proportaional component of MV MV_i (MVi) : Integral component of MV MV_d (MVd): Derivative component of MV

10.3.2 PID expressions

PID expressions are as follows.

$$E = SV - PV \tag{10.3.1}$$

$$MV_p = K_p E ag{10.3.2}$$

$$MV_i = \frac{K_p}{T_i} \int E \, dt \tag{10.3.3}$$

$$MV_d = K_p T_d \frac{dE}{dt}$$
 (10.3.4)

$$MV = MV_p + MV_i + MV_d (10.3.5)$$

An error is a mathematical expression that tells about how far the current system is from the state desired by the user.

Here is an example; a user wants the water in a electric pot to be kept at 50 $^{\circ}$ C and the current water temperature is 35 $^{\circ}$ C. Then, SV is 50 $^{\circ}$ C, PV is 35 $^{\circ}$ C. The error (E) is 15 $^{\circ}$ C, the difference between SV and PV. Upon detection of the error, the controller performs PID operation.

Note that, as shown in (10.3.5), MV is the sum of the P, I and D components (MV_p, MV_i, and MV_d). Therefore, if the D component is excluded from the PID control expression, then the PI control results and, if the I and D components are excluded, then P control results.

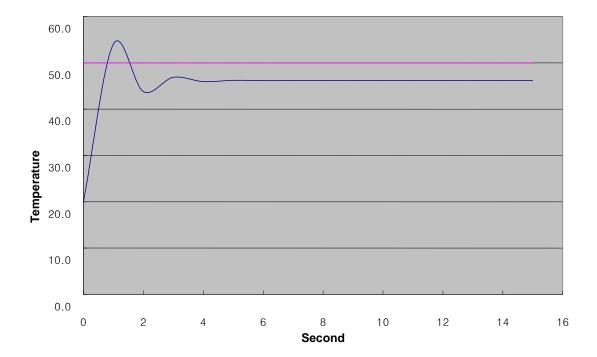
10.3.3 P control

As shown in the following expression (10.3.7), MV in P control is composed of the proportional term operation MV_p only. The proportional term operates in the form of the multiplication of the error by the proportional coefficient. The user must set the proportional coefficient properly according to the system. The greater the proportional coefficient is set, the more sensitive the system becomes to the error.

$$MV_p = K_p E ag{10.3.6}$$

$$MV = MV_{p} (10.3.7)$$

The development of P control of any virtual system has the following characteristics. The virtual system below is designed for better understanding by the user, but may be different from an actual temperature system.



In the simulation above, SV is 50.0. the K_p value is properly adjusted to obtain the PV development above. Four seconds after the operation starts at the initial temperature of 20 $^{\circ}$ C, the system settles into the stable state and thereafter remains constant at 46.2 $^{\circ}$ C. The offset is 3.8 $^{\circ}$ C (around 7.6%). The reason there exists a permanent offset in P control is that, as PV approaches SV, the E gets smaller and also MV gets smaller and comes into equilibrium at the equilibrium point with K_pat the equilibrium point (46.2 $^{\circ}$ C). The offset inherent in the P controller can be compensated by using PI control.

10.3.4 PI control

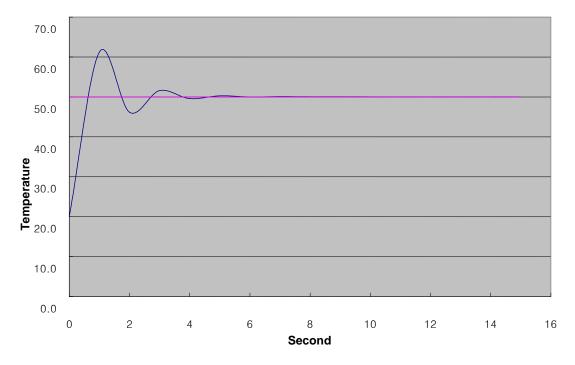
As shown in the following expression (10.3.10), PI (Proportional-Integral) control is calculated as the sum of the proportional and integral terms. To reduce the offset, the shortcoming of the proportional term, PI control uses the integrated error.

$$MV_p = K_p E ag{10.3.8}$$

$$MV_i = \frac{K_p}{T_i} \int E \, dt \tag{10.3.9}$$

$$MV = MV_p + MV_i ag{10.3.10}$$

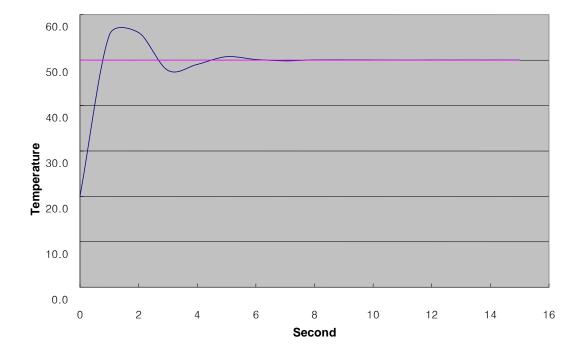
If the error, though constant, is integrated until it is reduced to zero, the integral amount is accumulated over time. Therefore the PI controller can be used to compensate for the offset characteristic of P control. It should be noted that the integral time constant (Ti) is the denominator of the integral term, therefore, the smaller the Ti value, the larger the integral effect. The following graph shows the result of PI control of the previously described P controlled system.



As a result of adding the integral effect, the offset disappears and the system converges exactly to 50 the initial control, however, there occurs an overshoot in which the temperature rises to 61.2 An excessive overshoot imposes a burden on the system or, in some cases, unstabilizes the system, therefore, it should be reduced through proper coefficient tuning or can be improved through PID control using the integral effect.

10.3.5 PID control

As shown by $(10.3.1) \sim (10.3.5)$, PID control reduces vibration during PI control by adding the derivative effect to PI control. The derivative effect operates only when the system state changes, regardless of the system error value. When the PV measurement signal at the system sensor is not clean or mixed with noise, however, an undesired derivative effect is created and causes an unstable operation of the heater or pump. To be sure that the derivative effect is not caused by such trivial changes as noise in the system, it is required to install a filter at the sensor input and set the derivative coefficient to a low value: in case of an actual system, it is common to set the derivative coefficient between $0.001 \sim 0.1$.

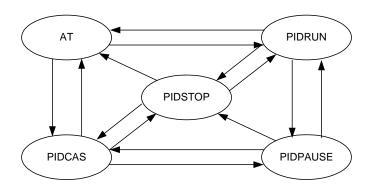


10.4 PID Instructions

10.4.1 PID loop states

A PID loop has 5 states: PIDSTOP, AT (Auto-tuning), PIDRUN, PIDCAS, and PIDPAUSE.

- (1) PIDSTOP is a state in which the output (MV) is represented by MV_min, the internal states are initialized, and user settings are maintained. Under this condition, it is impossible to enter into PIDPAUSE.
- (2) AT can be entered into by, in PIDSTOP only, setting the PIDxx_AT_EN bit to On and then executing the PIDRUN instruction. Once the AT operation is completed, the system automatically enters into PIDRUN. Tasks in AT include monitoring the system's response to a series of inputs and determining the PID coefficients (K_p, T_i, T_d) and operation cycle (T_s). Upon completion of AT, those values are updated and the previous coefficients are lost.
- (3) PIDRUN is a state in which the PID loop executes a normal control operation. MV by PID operation is output and the changed settings are all applied since each scan operation is executed independently. If the contact in front of the PIDRUN instruction is set to On or if the PIDRUN instruction exists on the ladder program and PIDxx_REM_RUN is set to On, then it is possible to enter into PIDRUN.
- (4) PIDCAS is a state in which twoo loops (master and slave loops) execute a control operation. Setting the two loops in the same way as with PIDRUN and then using the PIDCAS instruction enables to enter into PIDCAS, and the internal connection necessary for the interworking between the two loops is automatically generated allowing data exchange between the loops. Loops operated in cascade are displayed in the state flag PIDxx_STATE, under which state the remote operation PIDxx_REM_RUM bit does not operate.
- (5) PIDPAUSE is a state in which output, internal states and user settings are all maintained and the control operation is paused. Setting PIDxx_PAUSE bit to On or using the PIDPAUSE instruction enables to enter into PIDPAUSE. But, this is only possible when the previous state is PIDRUN.



10.4.2 PID instruction group

The PID instruction group includes 5 instructions: PIDRUN, PIDCAS, PIDINIT, PIDPRMT, and PIDPAUSE. In fact, all operations of the PID function are performed by the PIDRUN or PIDCAS instruction. The three other additional instructions (PIDINIT, PIDPRMT, PIDPAUSE) operate normally when the PIDRUN or PIDCAS instruction also exists on the ladder program. They are for the convenience in using the PIDRUN or PIDCAS instruction.

(1) PIDRUN

PIDRUN is the most basic PID control instruction that is responsible for single PID loop control.



Operand S has the range 0 ~ 31 (constants) and means the loop number.

(2) PIDCAS

PIDCAS is a instruction to implement a cascade control using two loops.



Operand M is the master loop with the range $0 \sim 31$ (constants) and means the loop number. Operand S is the slave loop with the range $0 \sim 31$ (constants) and means the loop number.

Note

Operands M and S in PIDCAS cannot be the same.

Operand M means the number of the master loop during cascade PID operation, while operand S means the number of the slave loop.

Basically, the master loop inputs its MV into SV of the slave loop during operation, while the slave loop executes its operation using the SV value input thorugh the master loop.

In addition, the two loops observe each other's operation information (wind-up, manual mode, auto mode shift, etc).

(3) PIDINIT

PIDINIT is used to initialize the settings and states of the current PID loop. All the setting values of the corresponding loop are initialized as 0 (Off in case of bit).



Operand S has the range 0 ~ 31 (constants) and means the loop number.

(4) PIDPRMT

PIDPRMT facilitates parameter changes in the loop memory configuration. As soon as the contact is On, the main setting values of the PIDRUN instruction (SV, T_s, K_p, T_i, T_d) are simultaneously changed to the values set by the user. Make sure that each of the 5 setting values holds its respective data type as shown the table below.

| Device | Parameter | Data Type | Setting Ex. | Actual Unit |
|--------|-----------|--------------|-------------|-------------|
| S+0 | SV | [WORD] | 5000 | |
| S+1 | Ts | [WORD] | 1000 | 0.1 msec |
| S+2 | Кр | [REAL] | 3.32 | sec |
| S+4 | Ti | [REAL] | 9.3 | sec |
| S+6 | Td | [REAL] 0.001 | | sec |

Operand S represents the first word address of the place the parameter to be changed is stored. Operand D has the range $0 \sim 31$ (constants) and means the loop number.

(5) PIDPAUSE

PIDPAUSE is used to switch the corresponding loop from the PIDRUN state to the PIDPAUSE state.



Operand S has the range 0 ~ 31 (constants) and means the loop number.

10.5 PID Flag Configuration

The table below shows the PID flag configuration for use of the built-in PID function.

| | | | use of the built-in PID function. |
|-----------------|-------------------|-----------|--|
| KDevice Zone | Symbol | Data Type | Content |
| K10000+m | _PIDn_MAN | Bit | PID Output Select (0:Auto, 1:Manual) |
| K10020+m | _PIDn_PAUSE | Bit | PID Pause (0: STOP/RUN 1:PAUSE) |
| K10040+m | _PIDn_REV | Bit | PID Operation Select (0:Fwd, 1:Rev) |
| K10060+m | _PIDn_AW2D | Bit | PID Anti Wind-up2 Prohibited (0:Operated, 1:Prohibited) |
| K10080+m | _PIDn_REM_RUN | Bit | PID Remote (HMI) Run bit (0:STOP, 1:RUN) |
| K10100+m | _PIDn_P_on_PV | Bit | PID Proportional Calculation Source Select (0:ERR, 1:PV) |
| K10120+m | _PIDn_D_on_ERR | Bit | PID Derivative Calculation Source Select (0:PV, 1:ERR) |
| K10140+m | _PIDn_AT_EN | Bit | PID Auto-tuning Setting (0:Disable, 1:Enable) |
| K10160+m | _PIDn_MV_BMPL | Bit | MV Non-impact Conversion for PID Mode Conversion (A/M) (0:Disable, 1:Enable) |
| K1024+32n | _PIDn_SV | INT | PID Set Value (SV) - Loop n |
| K1025+32n | _PIDn_T_s | WORD | PID Operation Cycle (T_s)[0.1msec] - Loop n |
| K1026+32n | _PIDn_K_p | REAL | PID P - Constant (K_p) - Loop n |
| K1028+32n | _PIDn_T_i | REAL | PID I - Constant (T_i)[sec] - Loop n |
| K1030+32n | _PIDn_T_d | REAL | PID D - Constant (T_d)[sec] - Loop n |
| K1032+32n | _PIDn_d_PV_max | WORD | PID PV Variation Limit - Loop n |
| K1033+32n | _PIDn_d_MV_max | WORD | PID MV Variation Limit - Loop n |
| K1034+32n | _PIDn_MV_max | INT | PID MV Maximum Value Limit - Loop n |
| K1035+32n | _PIDn_MV_min | INT | PID MV Minimum Value Limit - Loop n |
| K1036+32n | _PIDn_MV_man | INT | PID Manual Output (MV_man) – Loop n |
| K1037+32n | _PIDn_STATE | WORD | PID State - Loop n |
| K10370+320n | PIDn ALARM0 | Bit | PID Alarm 0 (1:T_s The setting is low) - Loop n |
| K10371+320n | PIDn ALARM1 | Bit | PID Alarm 1 (1:K_p is 0) - Loop n |
| K10372+320n | _PIDn_ALARM2 | Bit | PID Alarm 2 (1:PV Variation Limited) - Loop n |
| K10373+320n | PIDn_ALARM3 | Bit | PID Alarm 3 (1:MV Variation Limited) - Loop n |
| K10374+320n | _PIDn_ALARM4 | Bit | PID Alarm 4 (1:MV Maximum Value Limited) - Loop n |
| K10375+320n | _PIDn_ALARM5 | Bit | PID Alarm 5 (1:MV Manimum Value Limited) - Loop n |
| K10376+320n | _PIDn_ALARM6 | Bit | PID Alarm 6 (1:AT Abnormal Cancel)- Loop n |
| K10377+320n | _PIDn_ALARM7 | Bit | PID Alarm 7 - Loop n |
| K10378+320n | _PIDn_STATE0 | Bit | PID State 0 (0:PID_STOP, 1:PID_RUN) - Loop n |
| K10379+320n | _PIDn_STATE1 | Bit | PID State 1 (0:AT_STOP, 1:AT_RUN) - Loop n |
| K1037A+320n | _PIDn_STATE2 | Bit | PID State 2 (0:AT_UNDONE, 1:DONE) - Loop n |
| K1037B+320n | _PIDn_STATE3 | Bit | PID State 3 (0:REM_STOP, 1:REM_RUN) - Loop n |
| K1037C+320n | _PIDn_STATE4 | Bit | PID State 4 (0:AUTO_OUT, 1:MAN_OUT) - Loop n |
| K1037D+320n | _PIDn_STATE5 | Bit | PID State 5 (0:CAS_STOP, CAS_RUN) - Loop n |
| K1037E+320n | _PIDn_STATE6 | Bit | PID State 6 (0:SLV/SINGLE, 1:CAS_MST) - Loop n |
| K1037F+320n | _PIDn_STATE7 | Bit | PID State 7 (0:AW_STOP, 1:AW_ACT) - Loop n |
| K1038+32n | PIDn_PV | INT | PID Current Value (PV) - Loop n |
| K1039+32n | _PIDn_PV_old | INT | PID Previoius Current Value (PV_old) - Loop n |
| K1040+32n | _PIDn_MV | INT | PID Output Value (MV) - Loop n |
| K1041+32n | _PIDn_MV_BMPL_val | WORD | PID Non-impact Operation Memory - Loop n |
| K1042+32n | _PIDn_ERR | DINT | PID Control Error Value - Loop n |
| K1044+32n | PIDn MV p | REAL | PID Output Value P Component - Loop n |
| K1046+32n | _PIDn_MV_i | REAL | PID Output Value I Component - Loop n |
| K1048+32n | PIDn_MV_d | REAL | PID Output Value D Component - Loop n |
| K1050+32n | PIDn DB W | WORD | PID Dead Band Setting (Operation after Stabilization) – Loop n |
| K1051+32n | _PIDn_Td_lag | WORD | PID Differention Function Lag Filter – Loop n |
| K1052+32n | _PIDn_AT_HYS_val | WORD | PID Auto-tuning Hysteresis Setting - Loop n |
| K1052+32n | PIDn_AT_SV | INT | PID SV Setting for Auto-tuning - Loop n |
| K1054+32n | _PIDn_AT_step | WORD | PID Auto-tuning Display (User Setting Prohibited) - Loop n |
| K1055+32n | PIDn_INT_MEM | WORD | PID Internal Memory (User Setting Prohibited) – Loop n |
| · Llear cotting | | VVOIND | The machial womery (Oser Scaling Frombited) - Loop II |

^{* :} User setting prohibited
* n : PID loop number in decimal form

The PID instruction uses part of the K device to perform operation. When the PID function is not used, the K device can be used as a general Keep Relay.

The area of K0000 ~ K0999 is not used by the PID function so as to guarantee compatability with previous PLC models and secure the user's area.

K10000 ~ K1023F is the common bit area for all PID loops. The bit states and settings of the loops are collectively arranged in the front part of the PID area. Thirty two - the maximum number of loops that can be used by the PID function - bits comprise a double word and the states and settings of each loop are stored in each bit order. But the loop number is represented in hexadecimal form.

K1024 ~ K1055 is the individual data area for PID Loop 0, where the settings and states of Loop 0 are stored. In this area are stored the settings for PID Loop 0 (SV, dPV_max, MV_man, T_s, Kp, Ti, Td, MV_max, MV_min, dMV_max) and, while the PID function is performed, the states for PID Loop 0 (PV, ETC, MV, MV_rvs, ERR, MVp, Mvi, MVd, PV). By writing data into the set memory area, the user can change the PID setting at any time even during operation and obtain the corresponding results in the next cycle.

 $K1056 \sim K2047$ is the memory part of Loops 1 \sim 31 that are in the same form as Loop 0. Each loop operates independently. If the user wants a dependent operation such as application of cascade, then he must do some work to connect the states and settings of the loop.

In addition, please refer to the K device memory configuration in the latter part of this manual for an understanding of the accurate memory location of PID.

For performance improvement of the product, the location and order of the memory area is subject to change without prior notice.

Note

1) PID Memory Description Format

_PIDn_MAN n: Loop number Ex) PID10 MAN: Means MAN of Loop 10.

2) Common Bit Area

Ex) K10040+(25) = K10040+(19h) = K10059: PID25_REV bit of Loop 25

3) Individual Data Area

Ex) K1024+(32*1) = K1056: SV of Loop 1

10.5.1 Common bit area

The common bit area is the part that contain all bit data for the 32 loops. All information 32 loops have for a signel item is combined to take the form of 32 bit double word; the nth bit provides information on the nth loop; m is the hexadecimal value of loop number n.

(1) _PIDn_MAN (PID MANual operation enable)

- Setting Area

K Device Area: K10000+m

Unit: Bit

This allows you to determine whether the PID function of the nth loop will operate in AUTO or in Manual. In AUTO, the result of performing a normal PID operation is output; In MANUAL, a random Set Value desired by the user (_PIDn_MV_man) is output without performing the PID operation. If the corresponding bit is Off, then it is set to [Default] AUTO.

(2) _PIDn_PAUSE (PID PAUSE mode)

- Setting Area

K DEVICE AREA: K10020+m

Unit: Bit

This allows the nth PID Loop to enter into PAUSE

Even when switching from PAUSE to RUN again, the control continues to operate. If the system state is changed in PAUSE, the control system may produce an unexpected result. So, be very careful when using the the PAUSE function.

If the corresponding bit is Off, [Default] PAUSE is cleared.

(3) _PIDn_REV (PID REVerse operation)

- Setting Area

K DEVICE AREA: K10040+m

Unit: Bit

This allows you to set the control system as Forward system or Reverse system.

If the system state rises as the system input value rises, it is defined as Forward system; If the system states falls as the system input value rises, it is Reverse system.

A boiler is a Forward system because the temperature rises as the system input rises; a cooler is a Reverse system because the temperature falls as the system input rises.

If the corresponding bit is Off, it is set to [Default] Forward system.

Note

_PIDn_PAUSE

- (1) Putting the PID loop into PAUSE by using PIDn_PAUSE and PIDPAUSE brings all operations to a stop and outputs the last calculation values before PAUSE. If the system state is changed but proper control is not exercised, the control system may produce an unexpected result. So, be very careful when using the the PAUSE function.
- (2) In the first PLC scan, PIDRUN performs initialization to turn the PAUSE bit to Off. If PLC is turned on in PAUSE, it guits the PAUSE mode and enters into the STOP or Run mode.

(4) _PIDn_AW2D (PID Anti Wind-up 2 Disable)

- Setting Area

K DEVICE AREA: K10060+m

Unit: Bit

If this bit is turned OFF at the user's will, The Anti Wind-up2 function is inactivated.

The Anti Wind-up function is described in detail in 10.6.

If the corresponding bit is Off, [Default] Anti Wind-up2 is enabled.

(5) _PIDn_REM_RUN (PID REMote RUN)

- Setting Area

K DEVICE AREA: K10080+m

Unit: Bit

This is the external operation instruction of PIDRUN and has the same effect as when the contact of PIDRUN is turned On/Off. In fact, PIDRUN performs an OR operation of the "PIDRUN input oondition" contact and the corresponding bit in order to decide whether to perform the operation. Using this function enables you to assign the operation contact of PIDRUN to a fixed address, facilitating easier use of external input/output devices such as HMI.

If the corresponding bit is Off, [Default](the contact is Off) PIDRUN comes to STOP.

(6) _PIDn_P_ov_PV (PID P on PV)

- Setting Area

K DEVICE AREA: K10100+m

Unit: Bit

This sets the P operation source of the corresponding PID loop to PV. P operation is performed on ERR or PV. P operation moves relatively slowly to a stable state when using PV than when using ERR under the unstable instantaneous control due to initial response or disturbance. This implies that the change in output is slow and a heavy load is not imposed on the driver. But, with the change in the range of the internal operation value, the Anti Wind-up function does not operate.

If the corresponding bit is Off, PID performs P operation on the ERR value and, if it is On, P operation is performed on the PV value.

(7) _PIDn_D_on_ERR (PID D on ERRor)

- Setting Area

K DEVICE AREA: K10120+m

Unit: Bit

This sets the D operation source of the corresponding PID loop to ERR. D operation is performed on ERR or PV. In case of D operation using ERR, D response shows a dramatic change at the moment SV is changed by the user and an excessive input may be applied to the driver. To prevent this, the method of using PV for D operation is used and the [Default] value is also set to support D operation using PV. Using ERR without this algorithm turns the corresponding bit On.

If the corresponding bit is Off, PID performs D operation on the PV value and, if it is On, D operation is performed on the ERR value.

Note

_PIDn_REM_RUN

This bit is stored in the K device even though the PLC stops. If the PLC is stopped and restarted with this bit On (eg. power outage), the system is initialized at the first scan and then PIDRUN operates.

(8) _PIDn_AT_EN (PID Auto-Tuning ENable)

- Setting Area

K DEVICE AREA: K10140+m

Unit: Bit

This performs AT (Auto-tuning) of the corresponding PID loop. The approximate T_s (operation cycle) and PID coefficients (K_p, T_i, T_d) of the systemare are determined through AT. Do not forget to set the PIDn_HYS_val item before starting AT. The AT function is described in detail in 10.6.

If the corresponding bit is Off, the [Default] AT function is Disabled and AT is performed in the rising edge.

(9) _PIDn_MV_BMPL (PID MV BuMPLess changeover)

- Setting Area

K DEVICE AREA: K10160+m

Unit: Bit

This allows to not only determine an appropriate MV value through operation so that MV can continue smoothly when the corresponding PID loop changes from manual to auto output mode, but also reflect the MV value to the internal state so as to stabilize MV. This function shows an algorithm difference between single operation and cascade operation, but both operations are performed by this bit. If the corresponding bit (in cascade operation, the corresponding bit of the master loop) is On, Bumpless changeover is performed. If it is Off, The [Default] Bumpless changeover function is Disabled.

Note

PIDn AT EN

This bit is initialized as Off when the PLC changes to Run mode. If the PLC is stopped and restarted with this bit On (eg. power outage), the system is initialized at the first scan but does not enter into AT mode again. Since there is no change in the PID settings, the system operates in the state before the PLC stops.

PIDn MV BMPL

Assuming that the manual output value is 1000 and the auto output of 2000 is required, the driver receives the value of 1000 for system operation and instantly receives 2000 at the time of mode conversion. If the corresponding bit is On, the corresponding PID loop outputs 1000 at the time of mode conversion and performs an operation in order that the output gradually increases to 2000.

10.5.2 Individual data area

The individual data area is in the range of K1024 ~ K2047 and a 32 word length is assigned for each of 32 loops. So, the individual data area of the nth loop is K (1024+32n) ~ K (1055+32n).

(1) PIDn SV (PID Set-point Value)

- Setting Area

K DEVICE AREA: K1024+32n Unit: INT [-32768 ~ 32767]

This is the SV setting part of the corresponding loop.

As described in the previous section, this is used to set the system state as desired by the user. The system state is displayed in numeral and must be input after converted to PV according to the system gain.

In case of a system in which PV is sensed as 5000 at the temperature of 50

°C, if the temperature

controlled at 50 °C, SV is set to 5000.

(2) _PIDn_T_s (PID Sampling Time)

- Setting Area

K DEVICE AREA: K1025+32n Unit: WORD [0 ~ 65535]

This sets the sampling time of the corresponding loop.

The sampling time is a time cycle in which a control operation is performed. This can be set in the range of 0.1msec to 6553.5 msec in the unit of 0.1msec; an integer value of 1 is assigned for each 0.1ms. If 100ms of sampling time is required, 1000 is input to _PIDn_T_s.

If the user sets the sampling time to 0, the scan cycle control mode is also set. In this case, as a control operation occurs in each scan, a full speed control operation is performed in the current environment. When the current scan speed is exceeded due to the too short sampling time, The ALARM bit of PIDn STATE is displayed.

(3) _PIDn_K_p (PID Propotional Gain)

- Setting Area

K DEVICE AREA: K1026+32n

Unit: REAL [-3.40282347e+38 ~ -1.17549435e-38, 0, 1.17549435e-38 ~ 3.40282347e+38] This sets the proportional constant for the corresponding loop. As K_p is multiplied into the P, I, D (Proportional, Integral, Derivative) terms, the larger K p is, the larger the proportional and derivative effects are and the smaller the integral effect is.

If _PIDn_K_p is set to 0, P control is not performed. For more details, refer to 10.6.

K p can be set in the short/long real number (REAL) range.

Note

_PIDn_SV

PID changes the output (MV) through several times of operations until SV equals PV. So, when SV is 0, PIDRUN may be seen as inoperable.

If SV of a simple heater with the current temperature of 20°C and PV of 2000 (20 PID will output 0 as MV and will not output until PV goes below 0 (0

(4) _PIDn_T_i (PID integral Time gain)

- Setting Area

K DEVICE AREA: K1028+32n

Unit: REAL [-3.40282347e+38 ~ -1.17549435e-38, 0, 1.17549435e-38 ~ 3.40282347e+38]

This sets the integral time constant (T_i) of the corresponding loop. As T_i divides the I (integral) term, the larger T_i, the smaller the integral effect.

If _PIDn_T_i is set to 0, I control is not performed. For more details, refer to 10.6.

T_i can be set in the short/long real number (REAL) range.

(5) _PIDn_T_d (PID derivative Time gain)

- Setting Area

K DEVICE AREA: K1030+32n

Unit: REAL [-3.40282347e+38 \sim -1.17549435e-38 , 0 , 1.17549435e-38 \sim 3.40282347e+38] This sets the derivative time constant (T_d) of the corresponding loop. As T_d is multiplied into the D (derivative) term, the larger T_d, the larger the derivative effect.

If _PIDn_T_d is set to 0, D control is not performed. For more details, refer to 10.6.

T_d can be set in the short/long real number (REAL) range.

(6) PIDn dPV max(PID delta PV MAXimum limit)

- Setting Area

K DEVICE AREA : K1032+32n Unit : WORD [0 ~ 65535]

This limits the PV variation of the corresponding loop.

In actual control, PV does not always reflect the exact system state. Unwanted signals caused by sensor malfunction, noise or disturbance can be mixed and reflected in PV. Like this, PV often undergoes a sudden change and causes a large change in PID output. It is a priority to prevent a PV change greater than the value set in _PIDn_dPV_max. Meanwhile, if _PIDn_dPV_max is set too small, the system change is slowly reflected and the convergence time takes longer. Therefore, setting should be made according to the system features.

If this is set to 0, the function does not operate.

(7) _PIDn_dMV_max (PID delta MV MAXimum limit)

- Setting Area

K DEVICE AREA : K1033+32n Unit : WORD [0 ~ 65535]

This limits the MV variation of the corresponding loop. A sudden change in the output of the control system may cause a system instability or impose a heavy load on the driver resulting in failure or unstable operation. To prevent this, this item limits the controller output variation. If this is set to 0, the function does not operate.

(8) _PIDn_MV_max (PID MV MAXimum limit)

- Setting Area

K DEVICE AREA : K1034+32n Unit : INT [-32768 ~ 32767]

This limits the maximum MV value of the corresponding loop.

This prevents overload and system errors by limiting the maximum value of the controller output transferred to the output equipment. This also prevents the transfer of an unwanted value by overflow. If PIDn_MV_max and PIDn_MV_min are both set to 0, this function does not operate.

(9) _PIDn_MV_min (PID MV MINimum limit)

- Setting Area

K DEVICE AREA : K1035+32n Unit : INT [-32768 ~ 32767]

This limits the minimum MV value of the corresponding loop.

This prevents system errors by limiting the minimum value of the controller output transferred to the output equipment. This also prevents the transfer of an unwanted value by overflow.

(10) _PIDn_MV_man (PID MANual MV variable)

- Setting Area

K DEVICE AREA : K1036+32n Unit : INT [-32768 ~ 32767]

When the corresponding loop is set to manual operation, this designates MV.

If _PIDn_MAN in the common bit area is ON, the PIDn_MV_man value is output as the MV value of the corresponding loop.

(11) _PIDn_STATE (PID STATE)

- Setting Prohibited

K DEVICE AREA: K1037+32n or K10370+320n ~ K1037F+320n

Unit: WORD [h00 ~ hff] or BIT

This displays the state or abnomalities of the corresponding loop.

This is located at the address K1037+32n and each of the 16 bits has its own meaning. Only some of the 16 bits are currently in use.

STATE turns On when the corresponding operation occurs and returns Off when it is cleared.

The upper 8 bits of STATE (PIDn ALARM 0~ PIDn ALARM 7) display abnormalities of the loop.

The lower 8 bits of STATE (_PIDn_STATE 0~_PIDn_STATE 7) displays the control state of the loop. Each bit is assigned as follows.

PIDn ALARM 0 (K10370+32n): Indicates the operation is skipped because T s is set too small set.

_PIDn_ALARM 1 (K10371+32n): Indicates the K_p value is 0.

_PIDn_ALARM 2 (K10372+32n): Indicates the PV variation is limited.

_PIDn_ALARM 3 (K10373+32n): Indicates the MV variation is limited.

PIDn ALARM 4 (K10374+32n): Indicates the maximum MV value is limited.

_PIDn_ALARM 5 (K10375+32n): Indicates the minimum MV value is limited.

_PIDn_ALARM 6 (K10376+32n): Indicates AT has been canceled abnormally.

_PIDn_STATE 0 (K10378+32n): Indicates PID operation is performed. (valid in case of PLC Run)

PIDn STATE 1 (K10379+32n): Indicates PID AT is being performed.

_PIDn_STATE 2 (K1037A+32n): Idicates PID AT has been completed.

_PIDn_STATE 3 (K1037B+32n): Indicates PID is in remode operation by _PIDn_REM_RUM bit.

_PIDn_STATE 4 (K1037C+32n): Indicates PID is in manual output mode.

PIDn STATE 5 (K1037D+32n): Indicates the PID loop belongs to cascade.

_PIDn_STATE 6 (K1037E+32n): Indicates the PID loop is the cascade master loop.

_PIDn_STATE 7 (K1037F+32n): Indicates Aniti Wind-up is in operation during PID operation.

(12) _PIDn_PV (PID Process Variable)

- Input/Output Area

K DEVICE AREA : K1038+32n Unit : INT [-32768 ~ 32767]

This displays the PV of the corresponding loop.

PV is an indicator of the current state of the system. In general, the input from the sensor is stored on the U device of the CPU via an input device such as A/D conversion module: At each scan, this value should be transferred to _PIDn_PV using a instruction such as MOV. Please refer to the program examples in the latter part of this manual.

(13) _PIDn_PV_old (PID previous PV)

- Setting Prohibited

K DEVICE AREA : K1039+32n Unit : INT [-32768 ~ 32767]

This is used internally for derivative and integral operations at a step prior to the PV state of the corresponding loop. This can be referred to when necessary. Input of a random value will lead to a malfunction.

(14) _PIDn_MV (PID Manipulated output Variable)

- Input/Output Area

K DEVICE AREA : K1040+32n Unit : INT [-32768 ~ 32767]

This displays the MV of the corresponding loop.

MV is a signal source for system startup. Contrary to the description of _PID_PV in (12), this values is transferred at each scan to the U device using a instruction such as MOV and then used as a system startup input via an output device such as D/A conversion module. Please refer to the program examples in the latter part of this manual.

(15) _PIDn_MV_BMPL_val (PID MV BuMPLess changeover VALue)

- Setting Prohibited

K DEVICE AREA : K1041+32n Unit : WORD [0 ~ 65535]

This stores the information necessary for the Bumpless changeover operation of the corresponding loop. The corresponding memory is automatically set and input by PID-internal operation and this value should not be set by the user.

Note

Bumpless Change Over

When the PID controller is converted to manual output mode and back again to auto output mode, the output is increased again from 0 as in a freshly started control system. This causes a mode conversion impact to the system. To avoid this, the MV_BMPL function is used; when the current system is converted to auto mode with the corresponding bit authorized, this senses the system's last state in manual mode and lets the control output continue smoothly from that point. Furthermore, with the master loop MV_BMPL in cascade control authorized, the master loop senses the state of the slave loop and generates a smoothly continuing control output.

(16) _PIDn_ERR (PID ERRor value)

- Setting Prohibited

K DEVICE AREA: K1042+32n

Unit: DINT [-2747483648 ~ 2747483647]

This is the current error value of the corresponding loop.

An error value in PID is defined as SV - PV. This is used as an indicator of how far the current state is from the desired state. If the error is 0, it means the control system reaches its desired state. The control system can be considered ideal if, when a control starts, the error rapidly decreases in the transient state and, when it reaches the normal state, vibration is minimized and the offset(the error in the stable state) is kept at 0.

(17) _PIDn_MV_p (PID MV Propotional component)

- Setting Prohibited

K DEVICE AREA: K1044+32n

Unit: REAL [-3.40282347e+38 ~ -1.17549435e-38, 0, 1.17549435e-38 ~ 3.40282347e+38]

This displays the proportional control value of the corresponding loop. If the error of the current system is known, its integral and derivative control output values can also be calculated independently. Comparing the 3 output values enables to determine the exact operational state of the control system and PID control. MV is the sum of MV_p, MV_i, and MV_d.

(18) _PIDn_MV_i (PID MV Integral component)

- Setting Prohibited

K DEVICE AREA: K1046+32n ~ K1047+32n

Unit: REAL [-3.40282347e+38 ~ -1.17549435e-38, 0, 1.17549435e-38 ~ 3.40282347e+38]

This displays the integral control value of the corresponding loop.

(19) PIDn_MV_d (PID MV Derivative component)

- Setting Prohibited

K DEVICE AREA: K1048+32n ~ K1049+32n

Unit: REAL [-3.40282347e+38 ~ -1.17549435e-38, 0, 1.17549435e-38 ~ 3.40282347e+38]

This displays the derivative control value of the corresponding loop.

(20) _PIDn_DB_W (PID DeadBand Width)

- Setting Area

K DEVICE AREA : K1050+32n Unit : WORD [0 ~ 65535]

This sets the deadband of the corresponding loop. The deadband is set to a positive value and operates in the range from [SV – DB_W] ~ [SV + DB_W]. If PV enters the area, SV is assigned to the PV value. If this value is set to 0, the corresponding function does not operate.

Note

Deadband

This is used to let PV fully approach SV during system control so as to eliminate fine output viariations due to fine state changes. Input of a value to DB_W during PID control forms a deadband from [SV – DB_W] ~ [SV + DB_W]. If PV follows SV into the deadband during control, ERR is forcibly calculated as 0 and, as far as PV remains in this area, the MV variation stops. This has the same effect as stopping the controller for a while in the stabilization area and helps avoiding a heavy load on the driver during stabilization operation. It is recommended to fully stabilize the system before use in the area to be set as the deadband. Otherwise, when entering the deadband, the controller experiences a temporary output excess.

(21) _PIDn_Td_lag (PID Td lag filter)

- Setting Area

K DEVICE AREA : K1051+32n Unit : WORD [0 ~ 65535]

This sets the primary delay filter for the corresponding loop so as to allow the derivative effect acting as an instantaneous impact to act more slowly and continuously. If the corresponding value is set high, the derivative effect becomes smoother and, if it set to 0, the corresponding function does not operate. The derivateive value leads the system output to low vibration and helps avoid a heavy load on the driver.

(22) _PIDn_AT_HYS_val (PID Auto-Tuning HYSteresis value)

- Setting Area

K DEVICE AREA : K1052+32n Unit : INT [-32768 ~ 32767]

This sets a directional deadband appropriate for AT. The _PIDn_AT_HYS_val value operates differently as a upper deadband when PV increases and as a lower deadband when PV decreases. Proper setting of this value is critical for successful AT. Setting _PIDn_AT_HYS_val is described in 10.7.4.

(23) _PIDn_AT_SV (PID Auto-Tuning SV)

- Setting Area

K DEVICE AREA : K1053+32n Unit : INT [-32768 ~ 32767]

This separately sets AT_SV to be used as SV for AT of the corresponding loop. AT enables PV to vibrate 3 times up and down around AT_SV.

(24) _PIDn_AT_step (PID Auto-Tuning step)

- Setting Prohibited

K DEVICE AREA : K1054+32n Unit : INT [-32768 ~ 32767]

This displays the AT operation state of the corresponding loop. _PIDn_AT_step has values from 0 to 7; 0 indicates "before AT operation" and 7 indicates "AT operation completed". 1, 3 and 5 indicate the PV-increasing areas and 2, 4 and 6 indicate the PV-decreasing area.



Caution

- Setting Prohibited: The items marked with Setting Prohibited are prohibited from being set by the user. The corresponding area not only provides the user with operational information but also stores information necessary for operations. A random setting of the corresponding area causes the malfunction of the control system.
- 2) Input/Output Area: _PIDn_PV and _PIDn_MV belong to -Input/Output Area, so use them in a way they are connected to external equipment (AD, DA device).

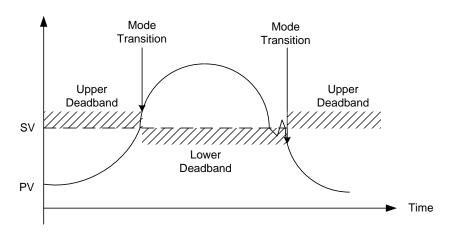
Note

Transient and Normal States

- Transien State: A state during which the control system starts its control operatoin and reaches the desired control state; there often occurs an instantaneous output variation and, while the integral value approaches stability, there may occur a vibration or overshoot.
- 2) Normal State: A state during which the control system reaches the desired state after passing through the transient state; vibration is eliminated, there may occur an offset and there is little change in the output value.

Upper / Lower Deadbands

When the analog output of the sensor is converted into a digital signal by means of an AD device, much of the signal is mixed with noise. The PID control instruction executes Autotuning using this converted value; it enables PV to increase and dedcrease 3 times up and down at SV. In the course of this process, if noise is input at the time when SV equals PV, a single up and down conversion is incorrectly perceived as multiple conversions. This is the same effect as the chattering of the digital switch. To overcome this, the PID controller uses a unidirectional deadband (Hysteresis); when the PV value of the system increases toward SV, the set deadband value operates in the upper part of SV and when the PV value passes SV and decreases, the set deadband value operates only in the lower part of SV.



10.6 Convenient Additional Functions of PID Instructions

This section describes additional functions that can be conveniently used in combination with the PID instructions.

10.6.1 Various PID-based control methods

Commonly used among PID controls are P control, PI control, PD control and PID control. When a certain feature (mostly stabilization) is required, ID control, I control or D control is often used though they are somehow more complicated. To implement these various controls, PIDRUN includes functions that allow or prevent controls by P, I, and D, respectively. In case of P control, the P controller can be configured by setting _PIDn_Ti and _PIDn_Td to 0. Similary, the ID controller can be obtained by setting _PIDn_Kp to 0 and assigning ID control coefficients to _PIDn_Ti and _PIDn_Td.

One special thing about the PIDRUN instructions is that, in case of ID control, setting $_PIDn_Kp$ to 0 theoretically results in the controller output of 0. (Refer to Expressions 10.3.2 ~ 10.3.5) Actually, however, PIDRUN, if 0 is input to $_PIDn_Kp$, internally calculates as MVp = 0 and $K_p = 1$, thus enabling ID, I control and D control.

For example, when PI control is required, only _PIDn_Kp and _PIDn_Ti are set and 0 is input to _PIDn_Td. When ID control is required, _PIDn_Kp is set to 0 and only _PIDn_Ti and _PIDn_Td are set.

10.6.2 Operation and function of anti wind – up

PIDRUN provides 2 Wind-up prevention functions: Anti Wind-up 1 and Anti Wind-up 2. The more basic of the two, Anti Wind-up 1 operates for all I-related controls - I control, PI control, ID control and PID control - and cannot be cleared. This operates by limiting Mvi (the integral term results) using _PIDn_MV_max, _PIDn_MV_min.

Aniti Wind-up 2 is organically connected to MVp (the proportional term results). In case MV reaches \pm (_PIDn_MV_max) on MVp only, regardless of the MVi and MVd values, due to a large system error, Mvi does not perform a calculation but keeps the previous value. In case the error is large, PV is brought near SV (operating point) by MVp, not by Mvi or MVd, and then I control is resumed to prevent and excessive value from being entered into Mvi. The operation of Anti Wind-up 2 can be cleared by the user by setting the _PIDn_AW2D bit on the common bit area to On. This operates only during PI control or during a control combining P control and I control, e.g. PID control.

10.6.3 Operation and function of Auto-tuning (AT)

PIDRUN has an AT function that enables to test operate the system though several basic settings and calculate _PIDn_T_s, _PIDn_K_p, _PIDn_T_i and _PIDn_T_d appropriate for the system. The values of _PIDn_MV_min, _PIDn_MV_max, _PIDn_AT_HYS_val, and _PIDn_AT_SV should be set before AT. Based on these values, the AT function sets and operates MV over 3 different times in order, examines the repeated system state (PV) reaction, measures the time taken for the system state (PV) to reach the AT Set Value ((AT_SV) and the vibration level, and accordingly calculates _PIDn_T_s, _PIDn_K_p, _PIDn_T_i and PIDn T d. To calculate the exact tuning value, please refer to "AT Setting" in1.7.4 for proper AT operation.

Note

Deletion of Previious Data upon Completionof Auto-tuning (AT)

When the AT operation described in 10.6.3 is completed, the new values of _PIDn_T_s, _PIDn_K_p, _PIDn_T_i and _PIDn_T_d are automatically substituted for the existing values. Note, therefore, that the previous value of _PIDn_T_s, _PIDn_K_p, _PIDn_T_i and _PIDn_T_d are deleted.

10.6.4 Operation and function of cascade (CAS)

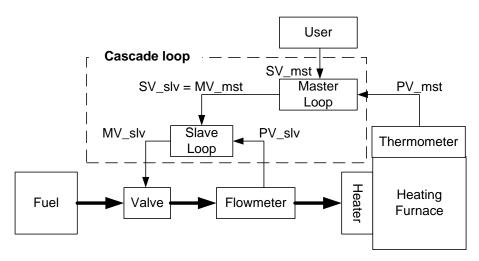
PDCAS performs cascade PID control through sequential operation of two PID loops. Generally, cascade PID control is used for temperature control through chemical process or fuel control; The two loops used here are called master loop and slave loop. As an example of temperature control through fuel flow, in case of a single loop PID control, the fuel valve is opened and closed to control the fuel flow and consequenctly control the temperature of the heating furnace. This is, therefore, a system in which a single PID loop indirectly controls temperature through fuel flow control. In this case, equipping the system with a fuel flow meter enables cascade PID control that consists of flow control and temperature control: the slave loop controls the flow using the valve and the master loop controls temperature using the flow. The master loop transfers the desired flow to the slave loop, while the slave loop monitors the flow meter and adjusts the flow using the valve so that fuel corresponding to the flow desired by the master loop is injected. The slave loop operates on the flow Set Value set by the master loop, regardless of temperature.

In terms of the internal cascade operation, the master loop measures the temperature (PV_mst) in a more delayed manner than the slave loop and transfers the flow value (MV_mst) computed for the user's desired temperature (MV_mst) to the slave loop. The slave loop sets the flow value (MV_mst) transferred from the master loop as the Set Value (SV_slv) and measures the fuel injection amount (PV_slv) in a more frequent manner than the master loop in order to control the valve opening and closing (MV_slv).

Cascade, therefore, functions to transfer MV (MV_mst) of the master loop to SV (SV _slv) of the slave loop when two loops are in operation.

If the slave loop is converted to manual output mode, the master output is not used and the master loop is also converted to manual output mode. The manual mode _PIDn_MAN bit is not turned ON in the master loop. If the slave loop is converted to auto output mode again, the master loop is also turned to auto output mode. If _PIDn_MV_BMPL is set to On, state data is exchanged between the two loops to ensure a smooth conversion.

If the slave loop is in Anti Wind-up mode, the master loop operates in PIDPAUSE mode. When there is a need to increase or descrease the slave Set Value (SV_mst) despite the occurrence of anti wind-up, this function prevents the occurrence of 2nd wind-up for the whole cascade loop. This function always operates according to the corresponding conditions and the _PIDn_PAUSE bit is not turned On.



Note

Auto-tuning (AT) of Cascade System

In case of AT of a cascade system, AT of the slave loop precedes AT of the master loop. For AT of the slave loop, it is required to predict how much SV the slave loop receives from the master loop and setting AT_SV to this value enables the slave loop to operate as an independent loop. AT performance may differ according to the predicted value. Upon completion of AT of the slave loop, AT of the master loop starts.

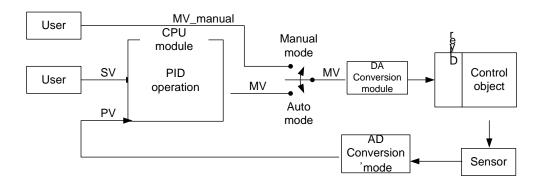
10.7 How to Use PID Instructions

This section describes how to use PID instructions.

For detailed description of the functions of the CPU, specific modules and XG5000, refer to the corresponding manuals.

10.7.1 Hardware configuration

The example system has a configuration as shown below.



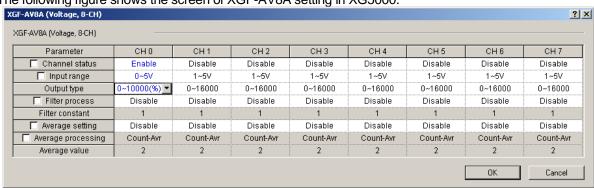
(1) CPU (XGK-CPUH)

The CPU is where PID operation occurs and so can be called "PID controller". The controller receives data sensed from the input module, calculates a proper output through operation, and then transfers it to the output module. What the user should do is to connect input and output and design the interior of the PID controller (tuning). Generally, analog input module and analog output modules are used for input and output, respectively.

(2) Analog Input Module (XGF-AV8A)

This functions to receive the state of the control object from the sensor and transfer it to the CPU. The analog input module channel 0 enables to receive a voltage of 0 V \sim 5 V as input and transfer its digital value to the PLC as output. There are 8 channels (CH 0 \sim CH 7) in XGF-AV8A. The setting for XGXGF-AV8A can be changed through the I/O parameter setting window that appears when selecting I/O Parameter from the parameter items in the project window. Channel 0 is changed to "Operation" mode and the input range is set to 0 \sim 5 V (according to the sensor). The output data type is the PV value of the PID controller. For PID control, the range of its value is set to 0 \sim 10000.

The $0 \sim 5$ V signal detected from the sensor during analog input module operation is converted 2,000 times to a digital value of $0 \sim 10000$ and then transferred to the PLC.



The following figure shows the screen of XGF-AV8A setting in XG5000.

(3) Analog output Module (XGF-DV4A)

The analog output module converts a controller output digital value generated through control operation in the PLC to $4\text{mA} \sim 20\text{mA}$ and transfers it to the driver of the control object. The XGF-DV4A model has 4 channels and its setting can be changed through the I/O parameter setting window, as in XGXGF-AV8A. Channel 0 is changed to "Operation" mode and the input range is set to 0 \sim 5 V (according to the driver). The 0 \sim 10000 MV digital output generated through PID control operation is reduced to 1/2000 and then transferred to the signal of the driver. The following figure shows the screen of XGF-DV4A setting in XG5000.

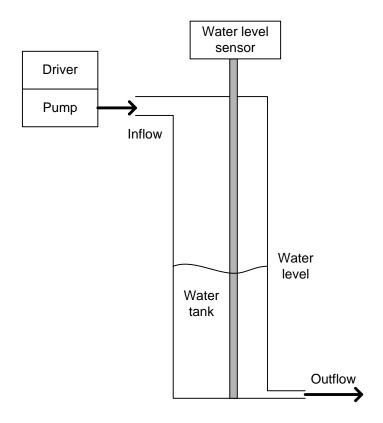


(4) Sensor and Driver

Along with the analog output module and analog input module, the sensor and driver respectively function as the media to transfer the state of the control object to the controller and transfer the controller output to the control object. The output generated from the sensor should be able to be used as the input of the analog input module and the output generated from the analog output module should be able to be used as the input of the driver. For an easy example, if the sensor's current mode is $4mA \sim 20mA$, the analog input module's current mode should be $4mA \sim 20mA$; if the driver's voltage mode is $0V \sim 5V$, the analog output module's voltage mode should be $0V \sim 5V$. The output of the analog output module used as the driving signal of the driver. Using it as the power of the driver may cause malfunction of the PLC due to power loss.

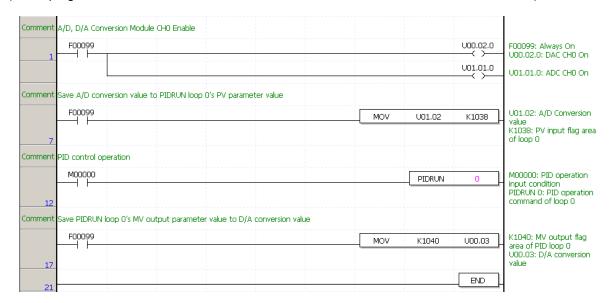
(5) Control Object

The current system uses a water level control system as the control object. A water level control system is a stem to maintain a desired water level by pumping water into a water tank whose lower part has a small opening for outflow of water. The water in the tank flows out at a constant rate. The decision to increase or decrease the water level is based on the water inflow. The structure of a water level control system is shown below.



10.7.2 Program example 1

The following figure shows a program example of performing PID control using analog modules. (In this program, the PID constant value and SV value are set in the Variable Monitor window.)

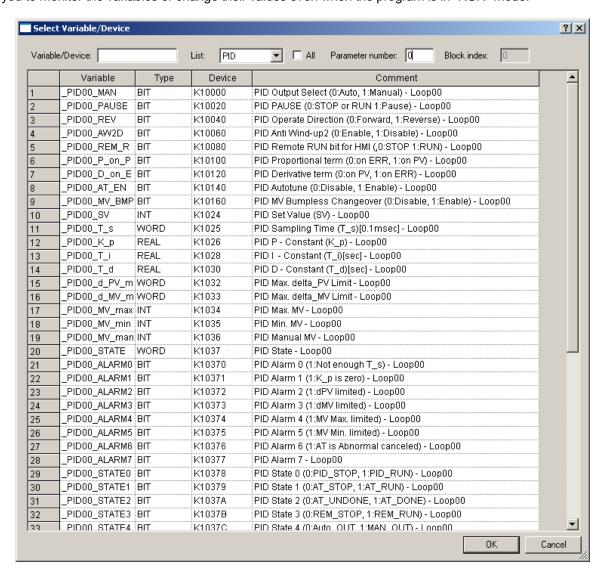


- Step 1: Each channel 0 of the analog input and output modules is enabled using the regular On contact.
- Step 7: The analog input module input data are transferred to PIDRUN Loop 0 PV using the regular On contact.
- Step 12: If the user turns the M00000 bit On, control operation of PIDRUN Loop 0 is performed.
- Step 17: MV output of PIDRUN Loop 0 is transferred to analog output module output data.
- Step 21: The scan is completed.

10.7.3 PID controlling

(1) Variable Registration

Control settings is performed by registering PID variables in the Variable Monitor" window. Clicking the right button of the mouse and then selecting "Register in Variable/Description" in the Variable Monitor window allows you to see the "Variable/Device Select" window. Selecting PID in the "List" box and deselecting "All" and then entering 0 (loop number) in "Parameter Number" allows you to see the variables to store all the settings and states for Loop 0. Selecting all variables and then clicking "Confirm" enables you to monitor the variables or change their values even when the program is in "RUN" mode.

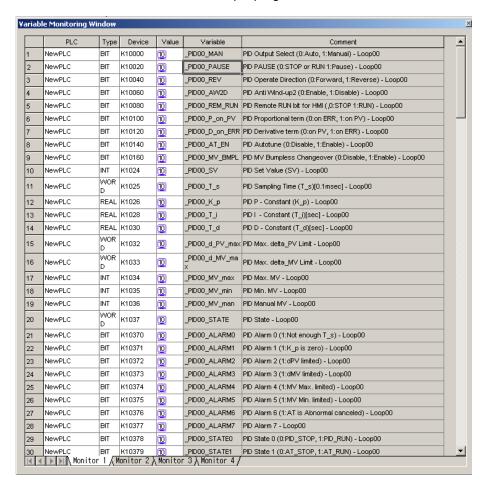


(2) Determination of SV

In order to set SV, the PV value of the system desired by the user should be determined. To put it easily, in order to maintain the water level at 250mm, the PV value for 250mm should be determined. This value can be determined through numerical analysis of the system but it will be more exactly determined by experimenting with the reaction of the control object. Analysis with the current system suggests that, with the water level of 250mm, PV outputs the value of 8333, but an actual operation showed that, with the water level of 250mm, the sensor output value was 3250. The reasons for such an error are the inaccurary of the sensor, the error of the measuring base point, etc. So, the actually measured value of 8250 should be used as the state value when the water level is 250mm. This value will be used as the SV value for control of 250mm.

(3) Control Setting

After the previously developed program is downloaded to the PLC, then monitoring begins. The next step is to set the variables registered in the Variable Monitor window. The following figure shows the screen of settings in the Variable Monitor window of the example program.

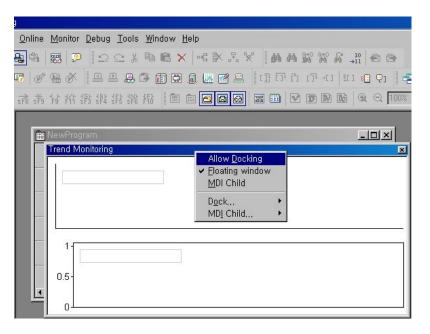


Settings were made for SV, K_p, and MV_max.

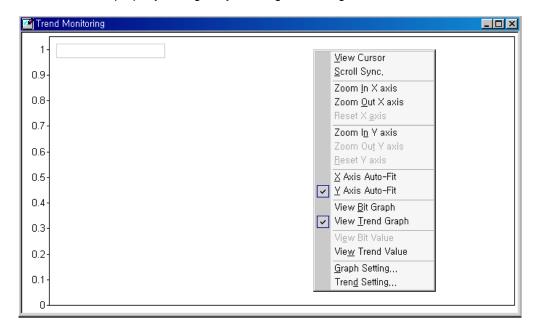
The actually measured value of 8250 was set for SV and 5 was randomly selected for Kp. MV_max, an item to limit the maximum value of MV, was set to 10000 according to the analog module.

(4) Observation of Control States Using the Trend Monitor

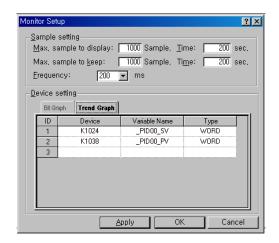
You can enable the trend monitor, one of the monitor functions of XG5000.



The trend monitor can be properly arranged by allowing its docking.



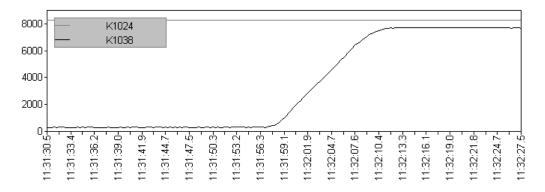
Data to be observed are registered through the trend setting.



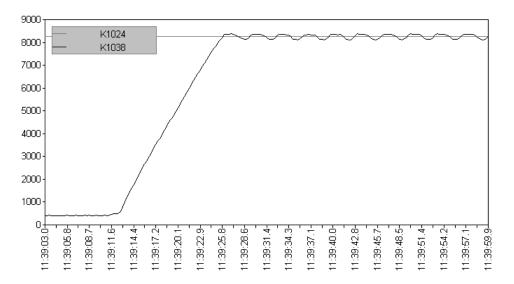
The monitoring cycle is set to 200m and, after the trend graph tap in the lower part is selected, SV and PV of Loop 0 are registered as INT.

(5) Program Run (Here an example is given to show how to find a parameter manually. For auto tuing, refer to the method below.)

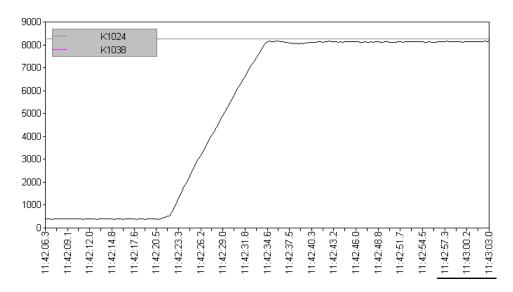
When the contact (M00000) is turned On, the system starts up.



After increasing K_p to 100, the system is started again.

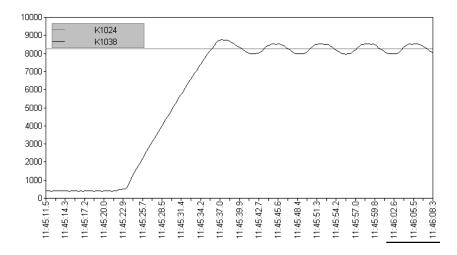


Because K_p is set too large, the system vibrates in a permanent and regular manner. Settings are made as follows: $K_p = 20$, $T_i = 100$



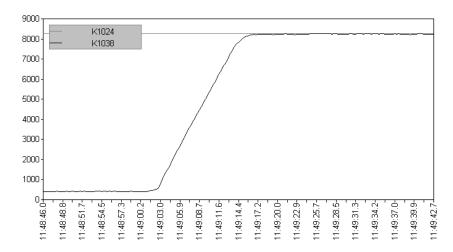
Because the T_i value is too large, the normal state offset lasts long and there occurs a slight overshoot.

Settings are mede as follows: K_p = 10, T_i = 1.



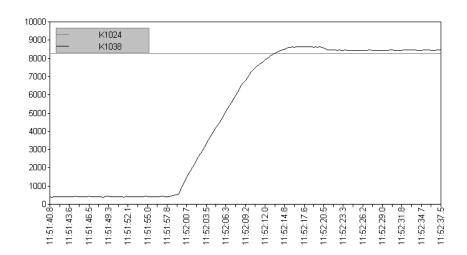
Because T_i is too small, PV fluctuates slowly.

Settings are made as follows: K_p = 10, T_i = 5



This is a satisfactory result.

After changing T_d to 0.1, the system is started again.



The system rocks and the error increases.

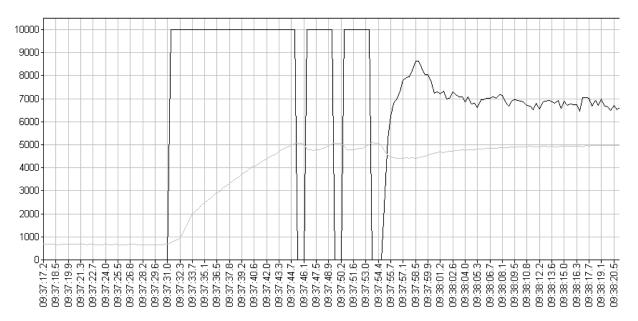
Since the current system is a slow system that can be fully controlled by PI, only PI control is required. Therefore, the tuning results are as follows: $K_p = 10$, $T_i = 5$, $T_d = 0$

10.7.4 How to start up using AT (Auto-tuning)

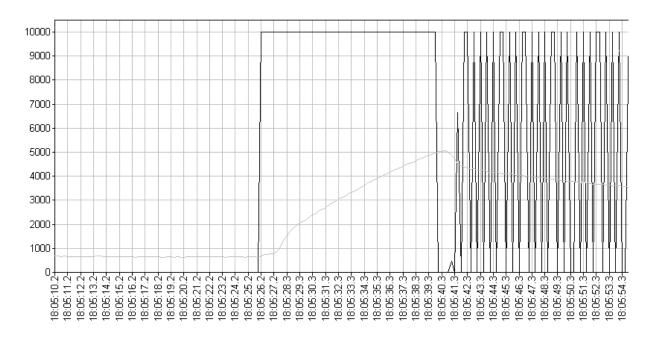
This section explains the correct AT setting method through operating the system described in 10.7.3 using the AT function. The basic AT function properly operates when the system is not started yet or when the system has PV at least smaller (larger in case of reverse operation) than the _PIDn_AT_SV value. Basically, AT performs different operations in different steps. The step increases from 0 to 7 and the step of the current loop can be known by _PIDn_AT_step. In PIDSTOP mode, the AT step is 0 and increases (automatically) as AT starts. When it reaches 7, AT is completed. The user's random manipulation of the step may cause malfunction.

To avoid redundant descriptions, the procedures from 10.7.3 (1) to (4) are first implemented and then the present settings are applied. First, _PIDn_AT_SV is set. Though the _PIDn_SV value has been already set above, the system is vibrated during Auto-tuning so that PV is more than the _PIDn_SV value. To prevent any harm to the system in the course, an appropriate SV value should be set in _PIDn_AT_SV. For other cases, _PIDn_AT_SV should be set the same with _PIDn_SV. The _PIDn_AT_SV value is used only during AT and, upon completion of AT, the system is automatically started based on _PIDn_SV. Next, _PIDn_MV_min and _PIDn_MV_max are set. During AT, the _PIDn_MV_min and _PIDn_MV_max values are respectively considered as the minimum/maximum output of the system. During AT, the two values differ each other in 3 cycles depending on the system speed (how fast PV reaches around SV). For example, with _PIDn_MV_min = 0, _PIDn_MV_max = 10000, the system driving signal (MV) transferred to the motor or heater repeats the "0 \rightarrow 10000 \rightarrow 0" output 3 times. If there is a possibility that such a radical change may put a heavy load on the system, _PIDn_dMV should be set.

Next, the PIDn_HYS_val value is set. _PIDn_HYS_val is used only during AT. This is a deadband that occurs when PV reaches around SV. When PV increases, it occurs above the baseline and, when PV decreases, it occurs below the baseline. If SV is 5000 and _PIDn_HYS_val is 100, AT increases PV until 5100 (SV + _PIDn_HYS_val) while maintaining MV at _PIDn_MV_max. Afterward, it decreases PV until 4900 (SV - PIDn HYS val) while maintaining MV at _PIDn MV min.



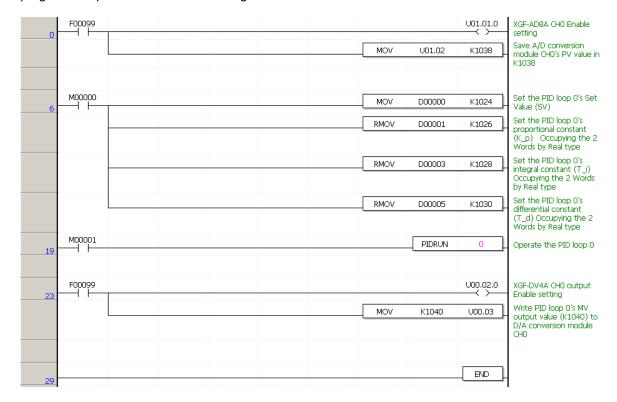
The above graph shows a water level waveform obtained by setting an appropriate _PIDn_HYS_val value (50 in the figure). A rectangular waveform should appear in MV 3 times.



The above graph shows a water level waveform obtained by setting _PIDn_HYS_val too small (10 in the figure). If a rectangular waveform does not appear 3 times in MV, a correct AT operation cannot be guranteed. Setting _PIDn_HYS_val too large may cause system slowdown.

10.7.5 Program example 2

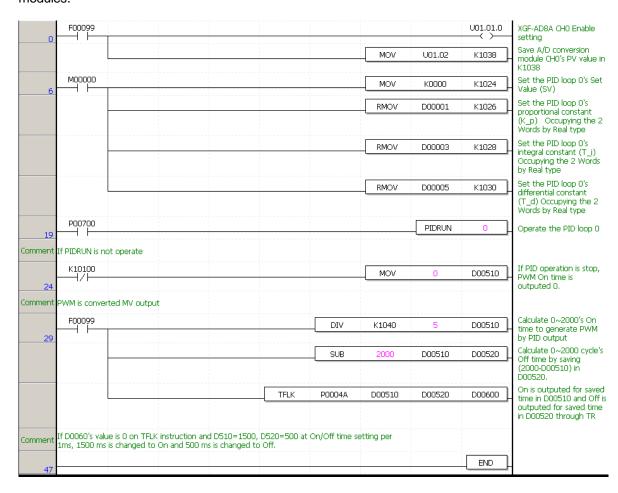
The following figure shows the screen of the PID constant value and SV value settings in the 10.7.2 program that performs PID control using the A/D and D/A conversion modules.



10.7.6 Startup using PWM

Input is done using the A/D conversion module as shown in the simulation above and the output signal is converted to PWM to control the system using a relay module or TR module.

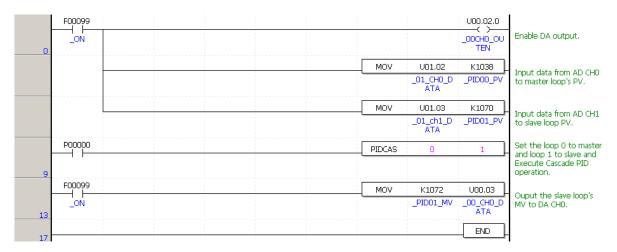
The following figure shows a program example of performing PID control using A/D and D/A conversion modules.



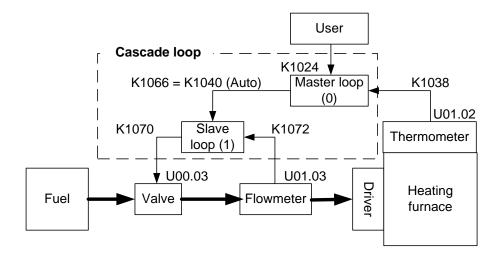
- Step 1: The A/D conversion module channel 0 is enabled using the regular On contact and the A/D conversion module input data are transferred to PIDRUN Loop 0 PV.
- Step 7: If the user turns the P00700 bit On, control operation of PIDRUN Loop 0 is performed.
- Step 12: If PIDRUN Loop 0 is in stop mode, the PWM On time is set to 0 and the output to OFF.
- Step 17 : PIDRUN Loop 0 MV output (0 ~ 10000) is divided by 5 into (0 ~ 2000) using the regular On contact. D00510 is used as the PWM On time and D00520, the remaining time subtracted from 2000 by D00510, is used as the PWM OFF time.

 A PWM signal with a cycle of 20000 (2 sec) can be obtained using D00510 and D00520. The corresponding output device is driven by controling the P0004A bit using the generated PWM.
- Step 34: The scan is completed.

10.7.7 Cascade startup



The ladder program above is a cascade startup program based on the block diagram below.



Chapter 11 Installation and Wiring

11.1 Installation

11.1.1 Installation Environment

This equipment has a high reliability regardless the installation environment. However, cares should be taken for the following items in order to secure the reliability and stability.

1) Environment Condition

- (1) Install in control panel with water-proof and vibration-proof.
- (2) Free from impact or vibration.
- (3) Do not expose directly to the sun.
- (4) No condensing by sudden temperature change.
- (5) Ambient temperature: 0 ~ 55°C.
- (6) Incremental Humidity: 5 ~ 95%.
- (7) Free from corrosive gas or inflammable gas

2) Installation Construction

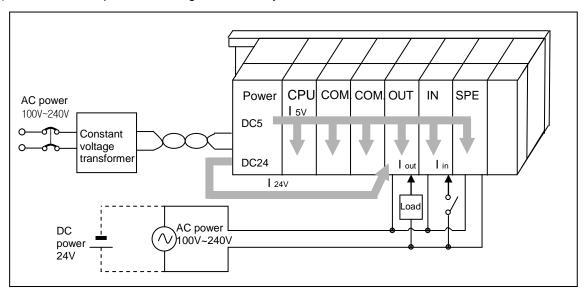
- (1) In case of processing of screw hole or wiring, do not enter the wiring fragments into PLC.
- (2) Select the installation place good for operation.
- (3) Do not install the equipment in the same panel with high voltage device.
- (4) Keep more than 50mm from wiring duct or surrounding module.
- (5) Grounding at the place where surrounding noise environment is good.

3) Heat Protection Design of Control Panel

- (1) In case that PLC is installed in the airtight control panel, the heat protection design shall be carried out considering radiation of other equipment as well as the heat of PLC itself. In case of air circulation using the vent or general fan, PLC system may be influenced by the flow of dust or gas etc.
- (2) It is recommended to install a filter or use the airtight heat exchanger.

The following shows the method to calculate the current consumption of PLC system itself necessary for heat protection design.

4) Current Consumption Block Diagram of PLC System



- 5) Current Consumption of Each Part
 - (1) Current Consumption of Power Module

Current conversion efficiency of power module is about 70% and 30% is consumed by the radiation, and 3/7 of output power shall be a current consumption itself. Accordingly, the calculation formula is as below.

• $W_{pw} = 3/7 \{(I_{5} \lor X_{5}) + (I_{24} \lor X_{24})\} (W)$

lsv: Current consumption of DC5V circuit of each module

(internal current consumption)

l₂₄v: Average current consumption of DC24V of output module

(current consumption of simultaneous On point)

Not available in case that DC24V is supplied from outside or power module without DC24V output is used.

(2) Sum of DC5V circuit current consumption

DC5V output circuit current of power module is the sum of current consumption of each module.

- W₅∨ = I₅∨ X 5 (W)
- (3) DC24V Average current consumption (current consumption of simultaneous On point) DC24V output circuit average current of power module is the sum of current consumption of each module.
 - W₂₄V = I₂₄V X 24 (W)
- (4) Average current consumption by output voltage drop of output module (current consumption of simultaneous On point)
 - Wout = lout X Vdrop X output point X simultaneous On rate (W)

lout: output-current (current in actual use) (A)

Vdrop: voltage drop of each output module (V)

- (5) Input average current consumption of input module (current consumption of simultaneous On point)
 - Win = Iin X E X input point X simultaneous On rate (W)

lin: Input current (actual value in case of AC) (A)

E: Input voltage (voltage in actual use) (V)

- (6) Current consumption of Special module power
 - Ws = I5V X 5 + I24V X 24 + I100V X 100 (W)

As above, the value that added the current consumption calculated per each block is total current consumption of PLC system.

• W = WPW + W5V + W24V + Wout + Win + Ws (W)

Calculate the radiation amount according to this total current consumption (W) and review the temperature rising in control panel.

The calculation formula of temperature rising in control panel is shown as below.

 $T = W / UA [^{\circ}C]$

- W: Total current consumption of PLC system(the value obtained on the above
- A: Surface area in control panel [m²]
- U: In case of making the temperature in control panel by fan etc. - 6 In case that the air in control panel is not circulated-----4

11.1.2 Handling Precautions

Here describes the notices in handling from the opening of each module to installation.

- Do not fall or apply the deep impact.
- Do not remove PCB from the case. It may cause the failure.
- Cares should be taken so that foreign materials such as wiring fragments are not entered into the upper part of module. If entered, remove it.

1) Notices in Handling I/O Module

Here describes the notices for the cases of handling or installing I/O module.

(1) Recheck of I/O module specification

For input module, you must consider input voltage and for output module, if the voltage exceeding max. open/close capacity is applied, it may cause the failure, destroy or fire.

(2) Use cable

Cable shall be selected considering ambient temperature and allowable current and min. spec. of cable should be more than AWG22(0.3mm²).

(3) Environment

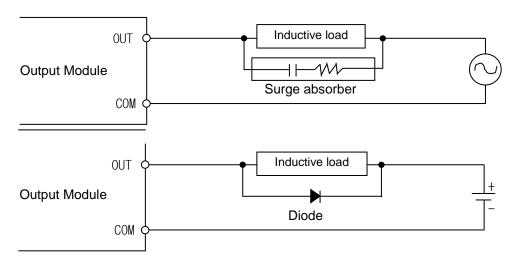
In case of wiring I/O module, if it is too close to the equipment with high heat or the wiring is directly touched to the oil for a long time, it may cause the short circuit or occur the breakage or abnormal operation.

(4) Polarity

For the module having the polarity in terminal block, it is required to check the polarity before applying the power.

(5) Wiring

- In case of wiring that I/O wiring is carried out with high voltage cable or power cable, it may occur the inductive disturbance which result in abnormal operation or failure.
- Do not allow the cables to pass in front of I/O operation indicator (LED). (It is not possible to distinguish I/O indicator correctly.)
- In case that the inductive load is connected to output module, connect the surge absorber or diode to the load in parallel. The cathode of diode shall be connected to (+)pole of power.

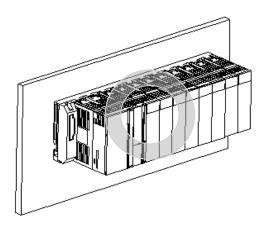


- (6) Terminal Block
 - Check the compression state of terminal block and pay attention not to enter the fragments of cable into PLC in case of wiring of terminal block or processing the screw hole. If not, it may cause the abnormal operation or the failure.
- (7) Except the examples above, do not apply deep impact to I/O module or remove PCB board from the case.

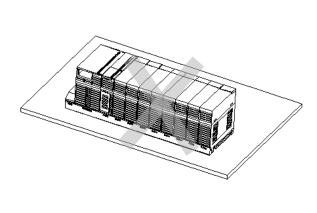
2) Notices in Attaching Base

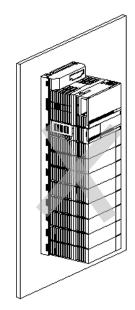
Here describes the notices in case of attaching PLC to the control panel.

- (1) Keep the distance enough between the upper part of module and the structures or parts in order to make a ventilation good and change the module easily.
- (2) Avoid the longitudinal connection or horizontal attachment considering a ventilation.
- (3) Use the panel different from the vibration sources of large sized electronic contactor or no fuse breaker etc., or keep the clearance when installing.
- (4) Install the wiring duct if necessary. But cares should be taken for the following notices in case the dimension of the upper or lower part of PLC is smaller than that of Figure 11.1.
 - In case of installing on the upper part of PLC, keep the height of wiring duct less than 50mm for good ventilation. And keep the distance from the upper part of PLC enough to press the hook on the upper part of Base.
 - In case of installing on the lower part of PLC, consider the connection of optical cable or coaxial cable and minimum radius of cables.
- (5) PLC should be installed to the direction as shown on the following Figure for good ventilation against radiation.

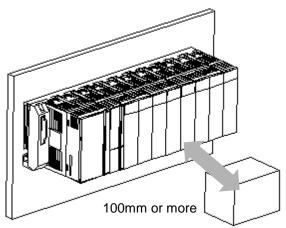


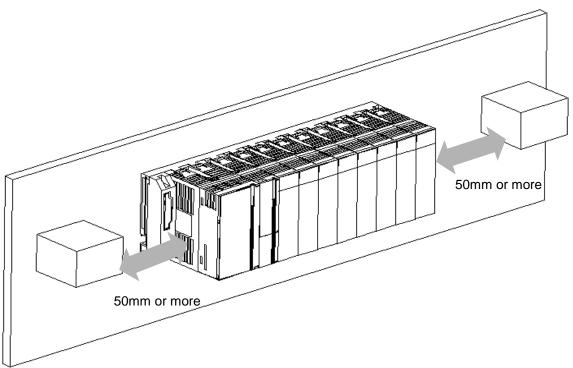
(6) Do not install PLC to the direction as below.





(7) When installing PLC or other equipment (Relay, electronic contactor), keep the distance to avoid radiant noise or heat.

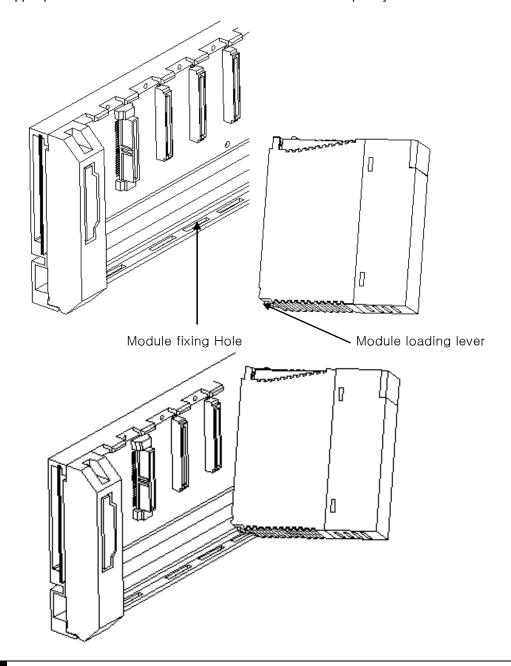




11.1.3 Attachment/Detachment of Module

Here describes the method to attach each module to the base or remove it.

- 1) Attachment of Module
 - Insert a fixed projection of the lower part of PLC into the module fixed hole of the base.
 - Slide the upper part of module to fix to the base, and then fit it to the base by using the module fixed screw.
 - Pull the upper part of module to check if it is installed to the base completely.

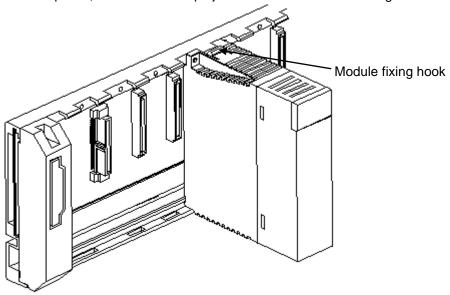


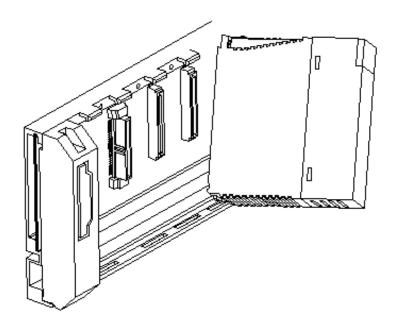
Notes

1) For Module installation, it is required to insert the fixed projection of module into the module fixing hole and then fix it. If forced to attach it, module may be broken.

2) Detachment of Module

- Loosen the fixed screws of the upper part of module from the base.
- Hold the module by both hands and press the fixed hook of module thoroughly.
- By pressing the hook, pull the upper part of module from the axis of the lower part of module.
- By lifting the module upward, remove the fixed projection of module from the fixing hole.





Notes

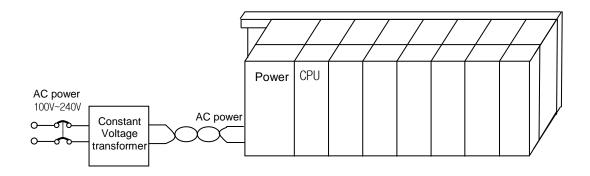
1) In case of detachment of module, press the hook and remove the module from the base, and then remove the fixed project of module from the fixed hole of module. In this case, if forced to detach the module, a hook or the fixed projection of module may be broken.

11.2 Wiring

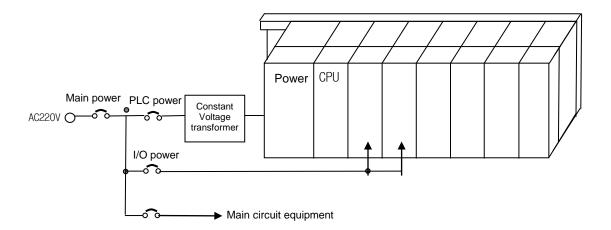
Here describes the items to know related to the wiring, in case of using the system.

11.2.1 Power Wiring

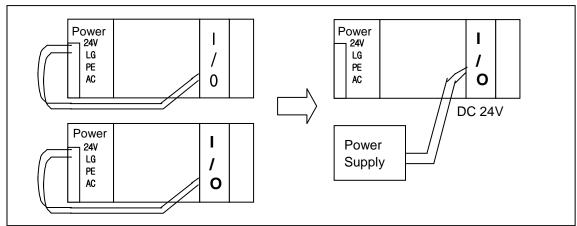
1) In case that the power change is larger than the range of standard, connect the voltage regulated transformer.



- 2) Connect the power having the small noise between cables or between earths. (In case of having lots of noise, connect the insulation transformer.)
- 3) For PLC power, I/O machine and power machine, divide the system as below.



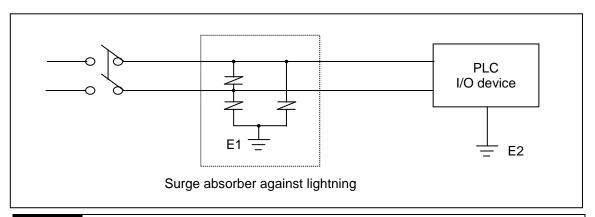
- 4) In case of using a DC24V output of Power Module
 - Do not connect a DC24V output of several power module in parallel. If connected in parallel, the module may be broken.
 - In case that DC24V output capacity of one power module is not enough, supply the external DC24V power as below.



- 5) AC110V, AC220V, DC24V cables should be twisted tightly and connected within the shortest distance.
- 6) AC110V, AC220V cables use the thick cable (2mm²) to reduce the voltage drop.

AC110V, DC24V cables should not approach to main circuit (high voltage, high current) cable or I/O signal cable. Keep more than 100mm if possible.

7) Use the surge absorber against lightning as shown in the figure below.

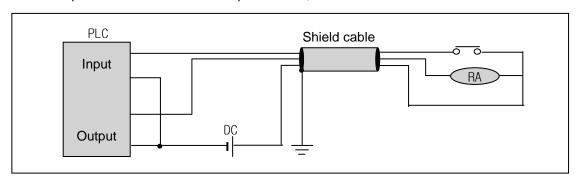


Notes

- 1) Separate PLC earth(E2) from the earth(E1) of surge absorber against lightning.
- 2) Select the surge absorber against lightning not to exceed max. allowable voltage of surge absorber in case of rising the power voltage at max.
- 8) Use the shielded insulation trans or noise filter when a noise invasion is expected.
- 9) The wiring of each input power should be twisted shortly if possible, and the shielded trans or noise filter wiring should be done without passing the duct.

11.2.2 I/O Device Wiring

- 1) The spec. of cable for I/O wiring shall be 0.3~2 mm² but it is recommend to use the convenient cable spec.(0.3 mm²).
- 2) Separate Input cable and Output cable for wiring.
- 3) I/O signal cable should be separated more than 100mm from main circuit cable of high voltage/high current.
- 4) If not possible to separate main circuit cable and power cable, use the shielded cable all and earth a PLC.

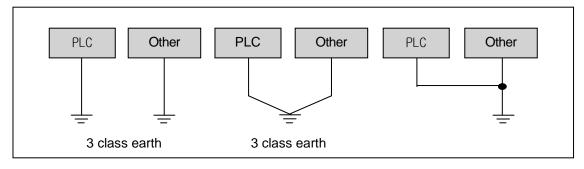


- 5) In case of pipe wiring, check the pipe completely for earth.
- 6) Separate output cable of DC24V from AC110V cable or AC220V cable.

For the long distance wiring more than 200m, as it is expected to have problem by leakage current caused by the capacity between cables, please refer to 12.4 Various Cases.

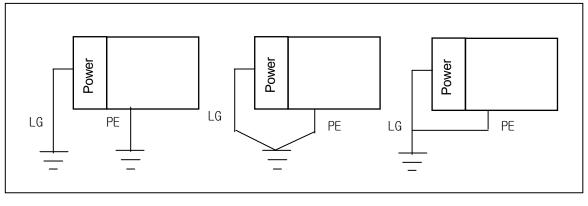
11.2.3 Earth Wiring

- 1) As this PLC has a sufficient measures against noise, it is possible to use it without earth except the case having specially lots of noises.
- 2) Use the dedicated earth if possible. In case of Earth works, use 3 class earth (earth resistance 100 Ω or less).
- 3) If not possible to use dedicated earth, use the common earth as shown on the Figure B] as below.



- A) Dedicated earth: Best
- B) Common earth: Good
- C) Common earth: Poor

- 4) Use more than 2 mm² cable for earth. Place the earth point near this PLC as possible to have the short length of earth cable.
- 5) Separate LG of power module and PE of base board for earth.



- A) dedicated earth : Best
- B) common earth: Good
- C) common earth: Poor
- 6) If the abnormal operation is found according to the earth, separate PE of the base from the earth.

11.2.4 Cable Specification for Wiring

The specification of cable used for wiring is as below.

| Type of External | Cable specification (mm ²) | | | |
|------------------|--|-------------|--|--|
| Connection | Low limit | High limit | | |
| Digital Input | 0.18 (AWG24) | 1.5 (AWG16) | | |
| Digital Output | 0.18 (AWG24) | 2.0 (AWG14) | | |
| Analog I/O | 0.18 (AWG24) | 1.5 (AWG16) | | |
| Communication | 0.18 (AWG24) | 1.5 (AWG16) | | |
| Main power | 1.5 (AWG16) | 2.5 (AWG12) | | |
| Protection earth | 1.5 (AWG16) | 2.5 (AWG12) | | |

Chapter 12 Maintenance and Repair

Please carry out Daily Checking and Regular Checking to maintain PLC in best condition.

12.1 Repair and Checking

As I/O module is mainly consisted of semiconductor elements, the life seems to be semi-permanent. But the error in the elements may occur by surrounding environment and thus the regular checking is needed. For the items to check 1~2 times every 6 months, please refer to the following table.

| Checking items | | Judgment basis | Actions |
|-----------------------------|--|--|---|
| Power Supply | | Power change range (within -15% / +10%) | Change the power so that it should be within the allowable voltage range. |
| I/O power | | I/O specifications of each module | Change the power so that it should be within the allowable voltage range of each module |
| | Temperature 0 ~ + 55°C Adjust the ambient temperature and hu | | Adjust the ambient temperature and humidity to be in |
| Surrounding environment | Humidity | 5 ~ 95%RH | proper range. |
| | Vibration | No vibration | Use the vibration-proof rubber or take other measures to prevent the vibration. |
| Shaking of eac | h module | No shaking | All module should not be shaken. |
| Loosening of terminal screw | | No loosening | Tighten the loosened screw. |
| Spare parts | | The possessing amount and preservation state | Fill the lack and improve the preservation state |

12.2 Daily Checking

The items to check daily are as follows.

| Checking items | | Contents | Judgment Basis | Action |
|---------------------------------|--------------|--|--|---------------|
| Base attac | chment state | Check the loosening of attached screw. | Complete tightening | Tighten screw |
| I/O module attachment state | | Check if the attached screw of module is tightened completely. Check if the upper cover of module is removed. | Complete tightening | Check screw |
| | | Loosening of terminal screw | No loosening | Tighten screw |
| Connection terminal be extended | lock and | Approach between compressed terminal | Proper interval | Adjust |
| | | Connector of extended cable | No connector loosening | Adjust |
| | Power LED | Check LED ON | LED ON (off is abnormal) | Ref. Cha.13 |
| | RUN LED | Check LED ON during Run state | LED ON (off or blink is abnormal) | Ref. Cha.13 |
| LED STORES | STOP LED | Check LED OFF during Run state | Blink is abnormal. | Ref. Cha.13 |
| | Input LED | Check LED ON/OFF | Input On, LED ON Input Off, LED OFF | Ref. Cha.13 |
| | Output LED | Check LED ON/OFF | Output On, LED ON Output Off, LED OFF | Ref. Cha.13 |

12.3 Regular Checking

Check the following items 1~2 times every 6 months and take a necessary actions.

| Checking items | | Contents | Judgment Basis | Action |
|-------------------------|---------------------------------|---|--|--|
| | Temperature | Thermometer/humidifier | 0 ~ 55 °C | Adjust to meet general |
| Surrounding environment | Humidity | corrosive gas | 5 ~ 95%RH | specification (environment standard in |
| | Pollution degree | measurement | No corrosive gas | control panel) |
| DI O | loosening, shaking | Move each module | Complete tightening | Tighten screw |
| PLC state | Dust, foreign materials | Macrography | No attachment | - |
| | Screw loosening | Tighten by driver | No loosening | Tighten |
| Connection state | Approach of compressed terminal | Macrography | Proper interval | Adjust |
| | Connector loosening | Macrography | No loosening | Tighten connector screw |
| Power voltage | e checking | Check the power voltage of the power input terminal using a tester. | AC100~240V: AC85~ 264V DC24V:DC19.2 ~ 28.8V | Change the power supply |
| Battery | | Check the battery change period and voltage drop indication. | Check total shutdown time and warranty No indication of battery voltage drop | Change the battery if exceeding the warranty without battery capacity indication |
| Fuse | | Macrography | No cutoff | Change it regularly as deterioration of element may occur by inrush current. |

Chapter 13 EMC Directive

13.1 Requirements for Conformance to EMC Directive

The EMC Directive specifies the products must "be so constructed that they do not cause excessive electromagnetic interference (emissions) and are not unduly affected by electromagnetic interference (immunity)". The applicable products are requested to meet these requirements.

This section summarizes the precautions on conformance to the EMC Directive of the machinery assembled using PLC XGK series. The details of these precautions are based on the requirements and the applicable standards control. However, LSIS will not guarantee that the overall machinery manufactured according to the these details conforms to the below-described directives. The method of conformance to the EMC directive and the judgment on whether or not the machinery conforms to the EMC Directive must be determined finally by the manufacturer of the machinery.

13.1.1 EMC Standard

The standards applicable to the EMC Directive are listed below.

Table13-1

| Specification | Test item | Test details | Standard value | |
|---------------|---------------------------|---|---|--|
| EN50081-2 | EN55011 Radiated noise | Electromagnetic emissions from the product are measured | 30~230 Mb QP: 50 dB \(\mu \rangle \mu \rangle m \ \ \ \ 230~1000 Mb QP: 57 dB \(\mu \rangle m | |
| | * 2 | p | 250~1000 m2 Q1 . 57 45 px //111 | |
| | EN55011 | Electromagnetic emissions from the | 150~500 kHz QP: 79 dB Mean: 66 dB | |
| | Conducted noise | product to the power line is measured | 500~230 Mt QP: 73 dB Mean: 60 dB | |
| EN61131-2 | EN61000-4-2 | Immunity test in which static electricity | 15 kV Aerial discharge | |
| | Electrostatic immunity | is applied to the case of the equipment | 8 kV Contact discharge | |
| | EN61000-4-4 | Immunity test in which burst noise is | Power line: 2 kV | |
| | Fast transient | applied to the power line and signal | Digital /O : 1 ^{kV} | |
| | burst noise | lines | Analog I/O, signal lines: 1 kV | |
| | EN61000-4-3 | Immunity test in which field is | 10Vm,26~1000 MHz | |
| | Radiated field AM | irradiated to the product | 80%AM modulation@ 1 kHz | |
| | modulation | | | |
| | EN61000-4-12 | Immunity test in which a damped | Power line: 1 kV | |
| | Damped | oscillatory wave is superimposed on | Digital I/O (24V or higher): 1 kV | |
| | oscillatory wave | the power line | | |
| | immunity | | | |

^{* 1)} QP: Quasi-peak value, Mean: Average value

^{* 2)} The PLC is an open type device (device installed to another device) and must be installed in a conductive control panel. The tests for the corresponding items were performed while the PLC was installed inside a control panel.

13.1.2 Control Panel

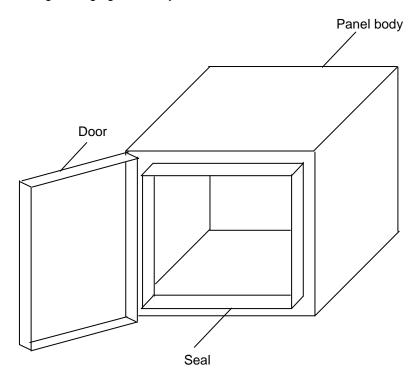
The PLC is an open type device (device installed to another device) and must be installed in a control panel. This is needed to prevent electric shock by touching XGK PLC and reduce the PLC-generated noise. Install the XGK PLC in a metallic panel to reduce PLC-generated EMI (Electro-magnetic interference), The specifications for the control panel are as follows:

1) Control panel

The PLC control panel must have the following features:

- (1) Use SPCC (Cold Rolled Mild Steel) for the control panel.
- (2) The steel plate should be thicker than 1.6mm.
- (3) Use isolating transformers to protect the power supply from external surge voltage.
- (4) The control panel must have a structure which the radio waves does not leak out.

For example, make the door as a box-structure so that the panel body and the door are overlapped each other. This structure reduces the surge voltage generate by PLC.



(5) To ensure good electrical contact with the control panel or base plate, mask painting and weld so that good surface contact can be made between the panel and plate.

2) Connection of power and earth wires

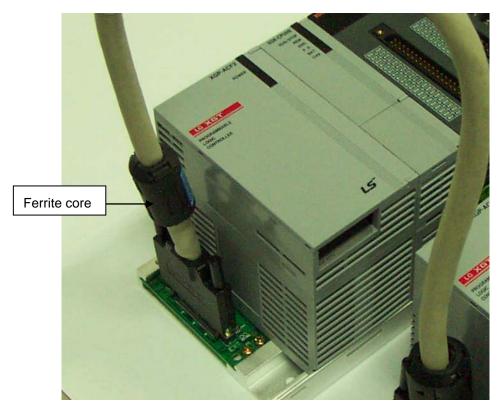
Earthing and power supply wires for the PLC system must be connected as described below.

- (1) Earth the control panel with a thick wire so that a low impedance connection to ground can be ensured even at high frequencies.
- (2) The function of LG (Line Ground) and PE (Protective Earth) terminals is to pass the noise generated in the PLC system to the ground, so an impedance that is as low as possible must be ensured.
- (3) The earthing wire itself can generate the noise, so wire as short and thick to prevent from acting as an antenna.

13.1.3 Cables

1) Extension cable connection

The extension cables contain a high frequency noise. Therefore, a ferrite core is attached to the extension cable as shown in the picture below to meet the CE conformance.



| Model | Manufacturer | Remarks |
|---------------|--------------------|---------|
| CU1330D | E-TECH ELECTRONICS | - |
| ZCAT3035-1330 | TDK | - |

2) Cable connection method for the inside control panel

In the case that the extension cable is connected to the metal panel, a space of at least 1cm is needed from the panel. The metal board of the control panel has a shielding effect that blocks noise, but it could be served as an antenna when in contact with a cable which would create a noise source.

Keep all high-speed signal transmission cables at a safe distance from the metal board.

13.2 Requirement to Conform to the Low-voltage Directive

The low-voltage directive requires each device that operates with the power supply ranging from 50V to 1000VAC and 75V to 1500VDC to satisfy the safety requirements. Cautions and installation and wiring of the PLC XGK series to conform to the low-voltage directive are described in this section.

The described contents in this manual are based on the requirements and the applicable standards control. However, LSIS will not guarantee that the overall machinery manufactured according to the these details conforms to the above regulation. The method of conformance to the EMC directive and the judgment on whether or not the machinery conforms to the EMC Directive must be determined finally by the manufacturer of the machinery.

13.2.1 Standard Applied for XGK Series

The XGK series follow EN6100-1 (safety of devices used in measurement rooms, control rooms, or laboratories). And the XGK series modules which operate at the rated voltage of AC50V/DC75V or above are also developed to conform the above standard.

13.2.2 XGK Series PLC Selection

(1) Power module

There are dangerous voltages (voltages higher than 42.4 peak) inside the power supply modules of the AC110/220V rated I/O voltages. Therefore, the CE mark-compliant models are enhanced in insulation internally between the primary and secondary.

(2) I/O module

There are dangerous voltages (voltages higher than 42.4V peak) inside the I/O modules of the AC110/220V rated I/O voltages. Therefore, the CE mark-compliant models are enhanced in insulation internally between the primary and secondary.

The I/O modules of DC24V or less rating are out of the low-voltage directive application range.

(3)CPU module. Base unit

The above modules are using DC5V and 3.3V circuits inside, so they are out of the low-voltage directive application range.

(4) Special module, Communication module

The special module and communication modules are DC24V or less in rated voltage, therefore they are out of the low-voltage directive application range.

Chapter 14 Troubleshooting

Here describes the contents of various errors to be occurred while operating the system, the methods to find the causes and the actions.

14.1 Basic Procedure for Troubleshooting

It is important to use the high reliable machine to increase the system reliability but it is important to take a prompt action when the trouble occurs as well.

To start the system promptly, it is more important to find the trouble occurring cause promptly and take the necessary action. The basic items to comply when taking this trouble shooting are as follows.

1) Check by the naked eye

Check the following items by the naked eye.

- Machine operation state (STOP, RUN)
- Power supply state
- I/O machine state
- Wiring state (I/O cable, extended and communication cable)
- After checking the indication state of each indicator (Power LED, Run LED, Stop LED, I/O LED etc.), connect the peripheral device and check PLC operation state and program contents.

2) Trouble Checking

Examine how the trouble is changed by the following action.

Place the key switch on STOP position and apply the power ON/OFF.

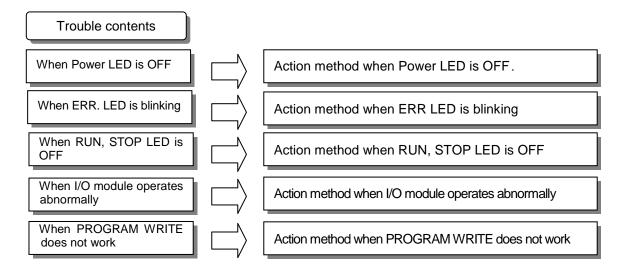
3) Limit range

Estimate what is the trouble cause using the above method.

- Is it from PLC itself? Or external cause?
- Is it from I/O module? Or other cause?
- Is it from PLC program?

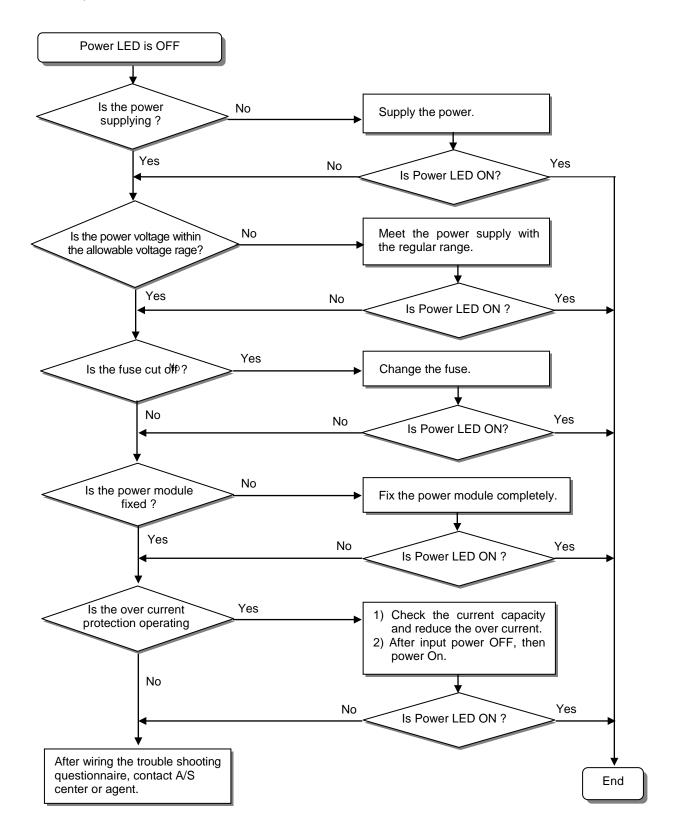
14.2 Troubleshooting

Here describes the method to find the trouble, the error code and the actions on the above by dividing them per phenomenon.



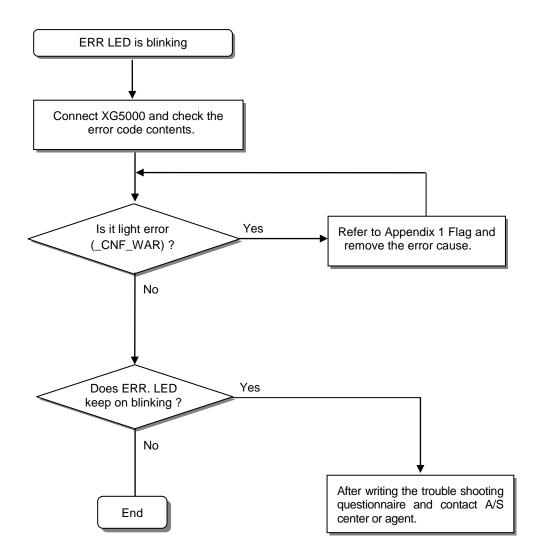
14.2.1 Action when Power LED is OFF

Here describes the action procedure when Power LED is OFF while supplying the power or during operation.



14.2.2 Action when ERR LED is blinking

Here describes the action procedure when ERROR LED is blinking in case of power supply, or when operation starts, or during operation.

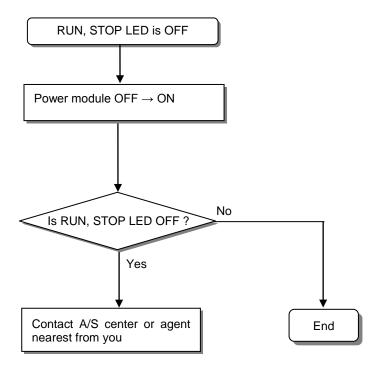


Notes

1) In case of light error, PLC system does not stop but you should check the error contents promptly and take an action. If not, it may cause the heavy error.

14.2.3 Action when Run, Stop LED is OFF

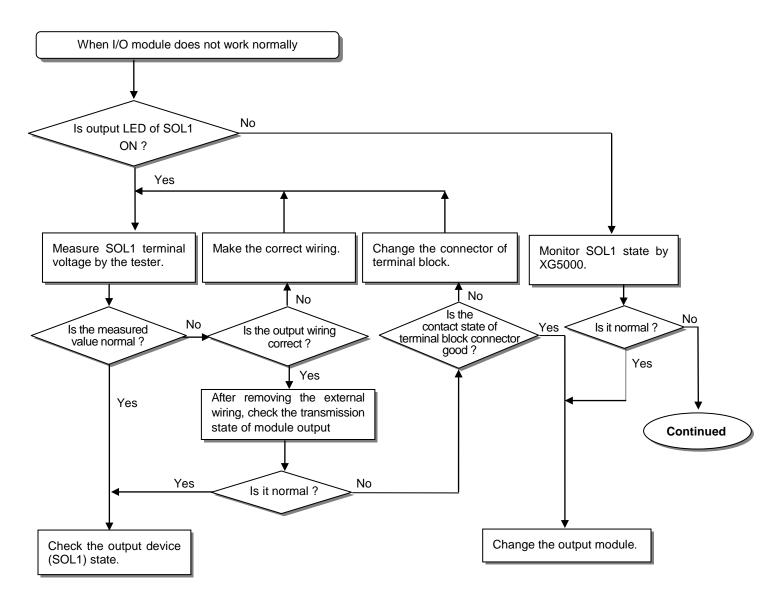
Here describes the action procedure when RUN, STOP LED is OFF in case of power supply, when operation starts or during operation.

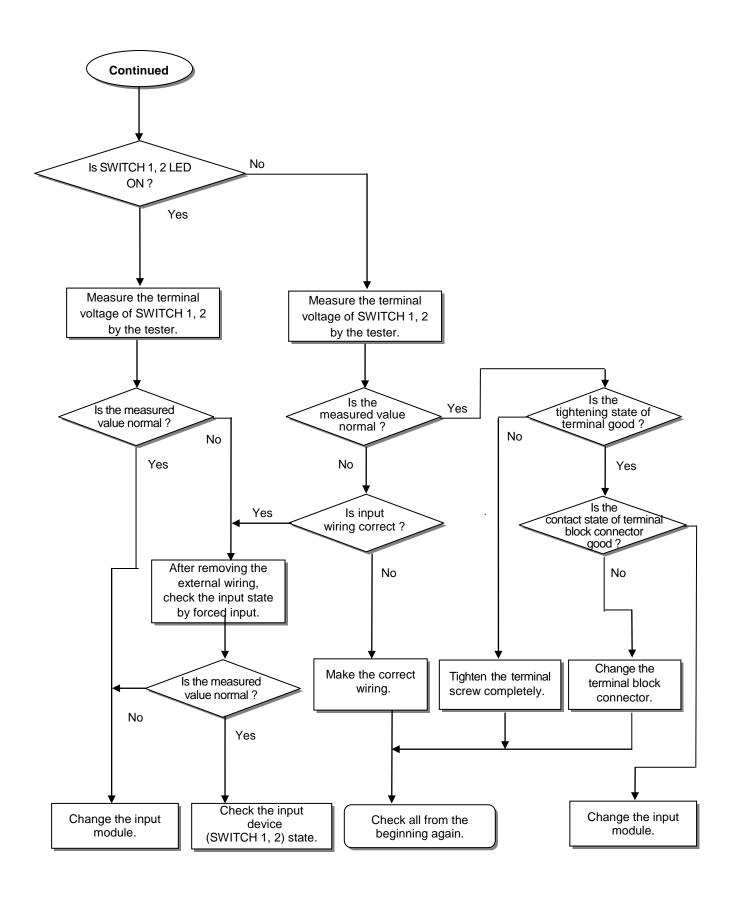


14.2.4 Action when I/O Module does not work normally

Here describes the action procedure when I/O Module does not work normally during operation, as shown on the program example below.

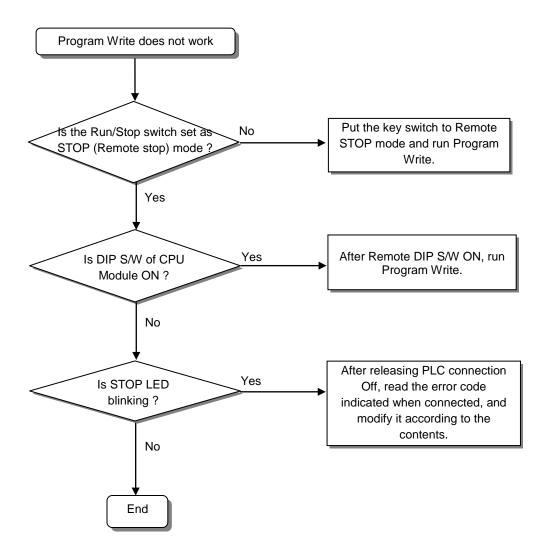






14.2.5 Action when PROGRAM WRITE does not work

Here describes the action procedure when PROGRAM WRITE does not work in CPU Module.



14.3 Questionnaire for Troubleshooting

If the trouble occurs when using XGK series, fill in the following questionnaire and then contact customer's service center by phone or FAX.

| For the error related to special manual of the corresponding p | | e, fill in the questionnaire attached to the user | 's |
|---|--------------------------------|---|----|
| 1. User Contact point: | TEL) | FAX) | |
| 2. Model: | | | |
| 3. Applied Device details | | | |
| – CPU module details | OS version (|) - Serial no. of product (| |
| – XG5000 version no. us | sed in program compile (|) | |
| 4. Brief description of control | object machine and syster | ·m: | |
| 5. Using module of CPU mod - Operation by key swite - XG5000 or operation I | ch () – Memory | y module operation () | |
| 6. STOP LED of CPU module | e ON ? Yes(|), No() | |
| 7. Error message content by | XG5000: | | |
| 8. Action trial status for the e | rror code of item 7 on the a | above: | |
| 9. Trouble shooting method f | or other error action: | | |
| 10. Error features | | | |
| • Repeat(): perio | odical(), specific se | equence level related() | |
| envi | ironment related() | | |
| • Intermittent (): | general error interval: | | |
| 11. Detailed description for the | e error phenomena: | | |
| 12. Configuration diagram of a | applied system: | | |

14.4 Cases

Here describes the trouble type and measures for each circuit.

14.4.1 Input Circuit Error Type and Corrective Actions

Here describes the trouble examples of input circuit and its measures.

| Phenomena | es the trouble examples of input circuit and its mea Causes | Measures |
|---|---|--|
| Input signal not OFF | Leakage current of external device (In case of running by approach switch) AC input External device | Connect the proper resistance and capacity so that the voltage between terminals of input module is below return voltage. AC input |
| Input signal not OFF (sometimes neon lamp ON) | Leakage current of external device (run by limit switch with neon lamp) AC input Leakage current | • CR value is determined by leakage current. - Recommended C : 0.1 ~ 0.47Uf R : 47 ~ 120 Ω (1/2W) or make the circuit independently and install a separate circuit. |
| Input signal not OFF | Leakage current by capacity between wiring cables AC input External device External device | • Install the power on the external device as below. AC input External device |
| Input signal not OFF | Leakage current of external device (run by switch with LED indicator) DC input External device | Connect the proper resistance as below so that the voltage between input module terminal and common terminal exceeds OFF voltage. DC input |
| Input signal not OFF | Circulated current by double power DC input In case of E1 > E2, circulated. | Double power> single power. Connect purified current prevent diode. (as below) E1 DC input |

14.4.2 Output Circuit Error Types and Corrective Actions Here describes the trouble examples of output circuit and its measures.

| Phenomena | Causes | Measures |
|--|---|---|
| Over voltage applied to the load if case of output contact OFF | In case that the load is semi-sine inside, (solenoid valve) If power polarity is ←, C is charged, if polarity is ↑, voltage charged to C +power voltage is applied to both sides of diode(D). Max. voltage is about 2√2. | • Connect several dozens k Ω ~ hundreds k Ω resistance to the load in parallel. |
| | ← Load ← Load | T C Load |
| | Note) If used as above, output element does not make trouble but the function of diode(D) built-in the load becomes low which causes the trouble. | |
| The load is not OFF | Leakage current by surge absorption circuit connected with output element in parallel Output Load Leakage current C Leakage current | • Connect CR with several dozens kΩ or equivalent impedance to the load in parallel. Note) If wiring length is long from output module to the load, leakage current by capacity between cables. |
| Time trouble in case the load is C–R type timer. | Leakage current by surge absorption circuit connected with output elements in parallel Output Output | Run C-R type timer by Relay. Use the timer except C-R type timer. Note) There is the timer that internal circuit is semi-sine. |
| | Leakage current | Output |
| load is not OFF (AC) | • Circulation current by two different powers Output Load Te1 | Double power> single power. Connect purified current prevention diode.(as below) Output Load Load E |
| | If E1< E2, circulated If E1 is Off(E2 On), circulated | Note) If load is Relay, it is required to connect reverse voltage absorption diode as dot line on the above figure |

| Phenomena | Causes | Measures |
|--|---|---|
| Off Response time of load is | Over current when Off [In case of running the inductive load of current such as solenoid (time constant L/R is large) directly by transistor output. | Insert the magnetic contactor that time constant is small and run the load by the contact as below. |
| long abnormally. | Output Current when off Load E | Output Load |
| | As the current flows through diode when transistor output OFF, more than 1 second may be delayed according to the load. | |
| Output transistoris destroyed. | Inrush current of incandescent light | To control the inrush current, it need to flow 1/3 ~ 1/5 dark current of rated current of incandescent light. |
| , and the second | Output TE1 | Output |
| | When light ON, more than 10 times of inrush current may flow. | Sink type transistor output |
| | | Output R F |
| | | Source type transistor output |

14.5 Error Code List

14.5.1 Error Code during CPU Operation

| Error | Error cause | Action (restart mode after taking an action) | Operatio n status | LED status | Diagnosi s point |
|-------|--------------------------------|--|----------------------|---|-----------------------------------|
| 2 | Data Bus error | If it occurs repeatedly when power reinput, request service center. | Fail | Blink by the order of total LED. | Power input |
| 3 | Data RAM error | If it occurs repeatedly when power reinput, request service center. | Fail | Blink by the order of total LED. | Power input |
| 4 | Clock IC(RTC) error | If it occurs repeatedly when power reinput, request service center. | Fail | ERR: On | Power input |
| 6 | Program memory error | If it occurs repeatedly when power reinput, request service center. | Fail | ERR: On | Power input |
| 10 | USB IC error | If it occurs repeatedly when power reinput, request service center. | Fail | ERR: On | Power input |
| 11 | Backup RAM error | If it occurs repeatedly when power reinput, request service center. | Fail | ERR: On | Power input |
| 12 | Backup Flash error | If it occurs repeatedly when power reinput, request service center. | Fail | ERR: On | Power input |
| 13 | Base information error | If it occurs repeatedly when power reinput, request service center. | Stop | ERR : ON | Power input RUN mode switching |
| 22 | Poor Backup Flash program | Reoperate after modifying the backup flash program. | Fail | ERR: On | Reset RUN mode switching |
| 23 | Program to execute is abnormal | Start after reloading the program, Change battery if it has a problem. Check the preservation status after program reloading and if error occurs, change the CPU module. | Stop | ERR: On | Reset RUN mode switching |
| 24 | I/O parameter error | Start after reloading I/O parameter, Battery change if battery has a problem. Check the preservation status after I/O parameter reloading and if error occurs, change the CPU module. | Stop | ERR: On | Reset RUN mode switching |
| 25 | Basic parameter error | Start after reloading Basic parameter, Change battery if it has a problem. Check the preservation status after Basic parameter reloading and if error occurs, change the CPU module. | Stop | ERR: On | Reset RUN mode switching |
| 26 | Exceed execution range error | Start after reloading program. If it occurs repeatedly, request service center | Stop | ERR : ON | Reset RUN mode switching |
| 27 | Compile error | Start after reloading program. If it occurs repeatedly, request service center | Stop | ERR : ON | Reset RUN mode switching |

| Error | _ | Action | Operatio | LED | Diagnosi |
|-------|---|---|---------------|-----------------------------|------------------------------------|
| code | Error cause | (restart mode after taking an action) | n status | status | s point |
| 30 | Module set in parameter and the installed module does not match | After checking the wrong position of slot by XG5000, modify the module or parameter and then restart. Reference flag: module type discord error flag | Stop (Run) | ERR: On (P.S.: On) | RUN mode switching |
| 31 | Module falling during operation or additional setup | After checking the position of falling/adding slot by XG5000, modify the installation status of module and then restart (according to parameter). Reference flag: module removable Reference flag: module removable error | Stop (Run) | ERR: On (P.S.: On) | Scan end |
| 32 | Fuse cutoff of fuse built-in module during operation | After checking the position of slot where the fuse cutoff occurs by XG5000, change the fuse and then restart (according to parameter Reference flag: fuse cutoff error flag | Stop (Run) | ERR: On (P.S.: On) | Scan end |
| 33 | Data of I/O module does not access normally during operation. | After checking the position of slot where the access error occurs by XG5000, change the module and restart (acc.to parameter. Reference flag: I/O module Read/Write error flag | Stop (Run) | ERR: On (P.S.: On) | Scan end |
| 34 | Normal access of special/link module data during operation not available. | After checking the position of slot that access error occurred by XG5000, change the module and restart (acc.to parameter). Reference flag: special/link module interface error | Stop (Run) | ERR: On (P.S.: On) | Scan end |
| 39 | Abnormal stop of CPU or malfunction | Abnormal system end by noise or hard ware error. 1) If it occurs repeatedly when power reinput, request service center 2) Noise measures | Stop | RUN: On ERR: On | Ordinary time |
| 40 | Scan time of program during operation exceeds the scan watchdog time designated by parameter. | After checking the scan watchdog time designated by parameter, modify the parameter or the program and then restart. | Stop | RUN: On ERR: On | In operation |
| 41 | Operation error occurs while running the user program. | Remove operation error → reload the program and restart. <check method=""> Stop: Check operation error information through XG5000 and modify the program. Run: Refer to F area Error step.</check> | Stop (Run) | ERR : ON (CHK: blink) | While running the program |
| 42 | The stack exceeds the normal range while running the program | Restart | Stop | RUN: On ERR: On | While running the program |
| 43 | Base double setting error | After checking base setting switch, reset | Stop | ERR: On | Reset RUN mode switching |
| 44 | Timer index user error | After reloading a timer index program modification, start | Stop (Run) | RUN: On ERR: On | Scan end |
| 50 | Heavy error of | Heavy error detection of external | Stop | ERR: On | Scan end |

Chapter 14 Troubleshooting

| Error | Error cause | Action | Operatio | LED | Diagnosi |
|-------|---------------------------------|---|---------------|------------|----------|
| code | Lifoi cause | (restart mode after taking an action) | n status | status | s point |
| | external device | device | (Run) | (P.S.: On) | |
| | detected by the | Refer to flag to repeat the device and | | | |
| | user program | then restart (according to parameter) | | | |
| | The number of | If it occurs repeatedly after restart, | Stop (Run) | | While |
| 55 | running standby | check the installation environment (if | | ERR: On | running |
| | task exceeds the | error continues, request service center) | | (P.S.: On) | the |
| | designated range | error continues, request service center) | | | program |
| 60 | E_STOP function | After removing error causes which | Stop | | While |
| | | starts E_STOP function in program, | | RUN: On | running |
| | executed | power reinput | | ERR: On | the |
| | | | | | program |
| | Operation error | STOP: after checking the detailed | - . | | While |
| 61 | | information of operation error by | Stop | ERR: On | running |
| | | XG5000, modify the program. | (Run) | (P.S.: On) | the |
| | | RUN : refer to error step | | | program |
| 500 | Data memory backup not possible | If not error in battery, power reinput | 0. | ERR: On | Б., |
| 500 | | Remote mode is switched to STOP | Stop | | Reset |
| | | mode. | | | 0 " |
| 501 | Time data error | If no error in battery, reset the time by | - | CHK: On | Ordinary |
| | | XG5000 | | | time |
| 502 | Battery voltage | Battery change in the state of power | - | BAT: On | Ordinary |
| | falling | input | | | time |

Notes

- 1) If error codes 2 to 13 are displayed, check with your local service center.
- 2) Error code numbers greater than 22 can be checked with XG5000 Error History.

14.5.2 Error Code of Program Operation

| Code | Error | CPU Status | Causes | Measure | |
|------|---|--|--|-------------------------------------|--|
| 16 | Indirect designation/ Index error | | Designations are out of range | Designate within the range | |
| 17 | Group command range setting error | | Designations are out of range | Designate within the range | |
| 18 | 0 divider error | | Divided by 0 (except RDIV, LDIV) | Don't divide by 0 | |
| 19 | BCD conversion error | According to the Basic Parameter Settings, the CPU will Run or | | Designate within the BCD data range | |
| 20 | File bank setting error | | | Set the value within the range | |
| 21 | Floating point operation error | | Floating point operation error | Correct the data | |
| 22 | Data type conversion error | | Data size is different when converting from real to integer numbers | Correct the data | |
| 23 | BMOV error | | Set value is over than 16 | Correct the set value | |

| Code | Error | CPU Status | Causes | Measure |
|------|--------------------------------|--|---|-----------------------------|
| 24 | DECO/ENCO error | | Set value is over than 8 | Correct the set value |
| 25 | DIS/UNI error | | The value of N is over 4 | Correct the N value |
| 26 | Data control error | | Over the range | Correct the range |
| 27 | Time data error | | Time data error | Correct the time data |
| 28 | MUX error | | Set value error | Correct the set value |
| 29 | Data table error | | Set value error | Correct the set value |
| 30 | SEG error | | Number of conversion data is greater than 4 | Correct the set value |
| 31 | ASCII code error | | ASCII data error | Correct the data |
| 32 | Positioning axes setting error | According to the Basic | Setting axes greater than 3 | Correct the number of axes |
| 33 | Character string error | Parameter Settings, the CPU will | Character string instruction error | Correct the instruction |
| 34 | SORT error | Run or Stop. | SORT/DSORT instruction error | Correct the set value |
| 35 | FOR nesting error | | The number of nesting number is over 16 | Correct the program |
| 36 | Task number error | | The Task number exceeds 96 | Correct the task number |
| 37 | Device range check error | | Out of the device range | Set within the device range |
| 38 | P2P data error | | Settings of P2P are out of range | Set within the range |
| 39 | Module Configuration error | | The module can't be set properly | Set the module properly |

Notes

- 1) If the basic parameter is set to "Continue running when error occurs," the program operation error code can be checked using XG5000 system history.
- 2) If "Continue running when error occurs" is removed, it can be checked with XG5000 error history.

Appendix 1 Flag List

App.1.1 Special Relay (F) List

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|-------|----------------|----------------------|---|
| F0000 | | DWORD | _SYS_STATE | Mode and state | Indicates PLC mode and operation state |
| | F00000 | BIT | _RUN | Run | Run state |
| | F00001 | BIT | _STOP | Stop | Stop state |
| | F00002 | BIT | _ERROR | Error | Error state |
| | F00003 | BIT | _DEBUG | Debug | Debug state |
| | F00004 | BIT | _LOCAL_CON | Local control | Local control mode |
| | F00005 | BIT | _MODBUS_CON | Mode bus mode | Mode bus control mode |
| | F00006 | BIT | _REMOTE_CON | Remote mode | Remote control mode |
| | F00008 | BIT | _RUN_EDIT_ST | Editing during RUN | Editing program download during RUN |
| | F00009 | BIT | _RUN_EDIT_CHK | Editing during RUN | Internal edit processing during RUN |
| | F0000A | BIT | _RUN_EDIT_DONE | Edit done during RUN | Edit is done during RUN |
| | F0000B | BIT | _RUN_EDIT_END | Edit end during RUN | Edit is ended during RUN |
| | F0000C | BIT | _CMOD_KEY | Operation mode | Operation mode changed by key |
| | F0000D | BIT | _CMOD_LPADT | Operation mode | Operation mode changed by local PADT |
| | F0000E | BIT | _CMOD_RPADT | Operation mode | Operation mode changed by Remote PADT |
| | F0000F | BIT | _CMOD_RLINK | Operation mode | Operation mode changed by Remote communication module |
| | F00010 | BIT | _FORCE_IN | Forced input | Forced input state |
| | F00011 | BIT | _FORCE_OUT | Forced output | Forced output state |
| | F00012 | BIT | _SKIP_ON | I/O SKIP | I/O SKIP on execution |
| | F00013 | BIT | _EMASK_ON | Error mask | Error mask on execution |
| | F00014 | BIT | _MON_ON | monitor | Monitor on execution |
| | F00015 | BIT | _USTOP_ON | Stop | Stop by Stop function |
| | F00016 | BIT | _ESTOP_ON | EStop | Stop by EStop function |
| | F00017 | BIT | _CONPILE_MODE | Compile | Compile on execution |
| | F00018 | BIT | _INIT_RUN | Initialize | linitialization task on execution |
| | F0001C | BIT | _PB1 | Program Code 1 | Program Code 1 selected |
| | F0001D | BIT | _PB2 | Program Code 2 | Program Code 2 selected |
| | F0001E | BIT | _CB1 | Compile Code 1 | Compile Code 1 selected |
| | F0001F | BIT | _CB2 | Compile Code2 | Compile Code 2 selected |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|-------|----------------|--------------------------------|--|
| F0002 | | DWORD | _CNF_ER | System error | Reports heavy error state of system |
| | F00020 | BIT | _CPU_ER | CPU error | CPU configuration error |
| | F00021 | BIT | _IO_TYER | Module Type error | Module Type does not match |
| | F00022 | BIT | _IO_DEER | Module detachment error | Module is detached. |
| | F00023 | BIT | _FUSE_ER | Fuse error | Fuse is cutoff |
| | F00024 | BIT | _IO_RWER | Module I/O error | Module I/O error |
| | F00025 | BIT | _IP_IFER | Module interface error | Special/communication module interface error |
| | F00026 | BIT | _ANNUM_ER | External device error | Detected heavy error in external device |
| | F00028 | BIT | _BPRM_ER | Basic parameter | Basic parameter error |
| | F00029 | BIT | _IOPRM_ER | IO parameter | I/O configuration parameter error |
| | F0002A | BIT | _SPPRM_ER | Special module parameter | Special module parameter is abnormal |
| | F0002B | BIT | _CPPRM_ER | Communication module parameter | Communication module parameter is abnormal |
| | F0002C | BIT | _PGM_ER | Program error | Program error |
| | F0002D | BIT | _CODE_ER | Code error | Program Code error |
| | F0002E | BIT | _SWDT_ER | System watchdog | System watchdog operated |
| | F0002F | BIT | _BASE_POWER_ER | Power error | Base power error |
| | F00030 | BIT | _WDT_ER | Scan watchdog | Scan watchdog operated |
| F0004 | | DWORD | _CNF_WAR | System warning | Reports light error state of system |
| | F00040 | BIT | _RTC_ER | RTC error | RTC data error |
| | F00041 | BIT | _DBCK_ER | Backup error | Data backup error |
| | F00042 | BIT | _HBCK_ER | Restart error | Hot restart not possible |
| | F00043 | BIT | _ABSD_ER | Operation shutdown error | Stop by abnormal operation |
| | F00044 | BIT | _TASK_ER | Task collision | Task collision |
| | F00045 | BIT | _BAT_ER | Battery error | Battery error |
| | F00046 | BIT | _ANNUM_WAR | External device error | Detected light error of external device |
| | F00047 | BIT | _LOG_FULL | Memory full | Log memory is full. |
| | F00048 | BIT | _HS_WAR1 | High speed link 1 | High speed link – parameter 1 error |
| | F00049 | BIT | _HS_WAR2 | High speed link 2 | High speed link – parameter 2 error |
| | F0004A | BIT | _HS_WAR3 | High speed link 3 | High speed link – parameter 3 error |
| | F0004B | BIT | _HS_WAR4 | High speed link 4 | High speed link – parameter 4 error |
| | F0004C | BIT | _HS_WAR5 | High speed link 5 | High speed link – parameter 5 error |
| | F0004D | BIT | _HS_WAR6 | High speed link 6 | High speed link – parameter 6 error |
| | F0004E | BIT | _HS_WAR7 | High speed link 7 | High speed link – parameter 7 error |
| | F0004F | BIT | _HS_WAR8 | High speed link 8 | High speed link – parameter 8 error |
| | F00050 | BIT | _HS_WAR9 | High speed link 9 | High speed link – parameter 9 error |
| | F00051 | BIT | _HS_WAR10 | High speed link 10 | High speed link – parameter 10 error |
| | F00052 | BIT | _HS_WAR11 | High speed link 11 | High speed link - parameter 11 error |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|------|--------------|---------------------|--------------------------------------|
| | F00053 | BIT | _HS_WAR12 | High speed link 12 | High speed link - parameter 12 error |
| | F00054 | BIT | _P2P_WAR1 | P2P parameter 1 | P2P – parameter 1 error |
| | F00055 | BIT | _P2P_WAR2 | P2P parameter 2 | P2P – parameter 2 error |
| | F00056 | BIT | _P2P_WAR3 | P2P parameter 3 | P2P – parameter 3 error |
| | F00057 | BIT | _P2P_WAR4 | P2P parameter 4 | P2P – parameter 4 error |
| | F00058 | BIT | _P2P_WAR5 | P2P parameter 5 | P2P – parameter 5 error |
| | F00059 | BIT | _P2P_WAR6 | P2P parameter 6 | P2P – parameter 6 error |
| | F0005A | BIT | _P2P_WAR7 | P2P parameter 7 | P2P – parameter 7 error |
| | F0005B | BIT | _P2P_WAR8 | P2P parameter 8 | P2P – parameter 8 error |
| | F0005C | BIT | _CONSTANT_ER | Constant error | Constant error |
| F0009 | | WORD | _USER_F | User contact | Timer used by user |
| | F00090 | BIT | _T20MS | 20ms | 20ms cycle Clock |
| | F00091 | BIT | _T100MS | 100ms | 100ms cycle Clock |
| | F00092 | BIT | _T200MS | 200ms | 200ms cycle Clock |
| | F00093 | BIT | _T1S | 1s | 1s cycle Clock |
| | F00094 | BIT | _T2S | 2s | 2s cycle Clock |
| | F00095 | BIT | _T10S | 10s | 10s cycle Clock |
| | F00096 | BIT | _T20S | 20s | 20s cycle Clock |
| | F00097 | BIT | _T60S | 60s | 60s cycle Clock |
| | F00099 | BIT | _ON | Ordinary time On | Always On state Bit |
| | F0009A | BIT | _OFF | Ordinary time Off | Always Off state Bit |
| | F0009B | BIT | _10N | 1scan On | First scan ON Bit |
| | F0009C | BIT | _10FF | 1scan Off | First scan OFF bit |
| | F0009D | BIT | _STOG | Reversal | Reversal every scan |
| F0010 | | WORD | _USER_CLK | User Clock | Clock available for user setting |
| | F00100 | BIT | _USR_CLK0 | Setting scan repeat | On/Off as much as set scan Clock 0 |
| | F00101 | BIT | _USR_CLK1 | Setting scan repeat | On/Off as much as set scan Clock 1 |
| | F00102 | BIT | _USR_CLK2 | Setting scan repeat | On/Off as much as set scan Clock 2 |
| | F00103 | BIT | _USR_CLK3 | Setting scan repeat | On/Off as much as set scan Clock 3 |
| | F00104 | BIT | _USR_CLK4 | Setting scan repeat | On/Off as much as set scan Clock 4 |
| | F00105 | BIT | _USR_CLK5 | Setting scan repeat | On/Off as much as set scan Clock 5 |
| | F00106 | BIT | _USR_CLK6 | Setting scan repeat | On/Off as much as set scan Clock 6 |
| | F00107 | BIT | _USR_CLK7 | Setting scan repeat | On/Off as much as set scan Clock 7 |

| Device1 | Device2 | Туре | Variables Function | | Description |
|---------|---------|-------|---|--------------------------|---|
| F0011 | | WORD | _LOGIC_RESULT | Logic result | Indicates logic results |
| | F00110 | BIT | _LER operation error ON during 1 scan in ca | | ON during 1 scan in case of operation error |
| | F00111 | BIT | _ZERO | Zero flag | ON when operation result is 0 |
| | F00112 | BIT | _CARRY | Carry flag | ON when carry occurs during operation |
| | F00113 | BIT | _ALL_OFF | All output OFF | ON in case that all output is Off |
| | F00115 | BIT | _LER_LATCH | Operation error Latch | Keeps ON during operation error |
| F0012 | | WORD | _CMP_RESULT | Comparison result | Indicates the comparison result. |
| | F00120 | BIT | _LT | LT flag | ON in case of "less than" |
| | F00121 | BIT | _LTE | LTE flag | ON in case of "equal or less than" |
| | F00122 | BIT | _EQU | EQU flag | On in case of "equal" |
| | F00123 | BIT | _GT | GT flag | ON in case of "greater than" |
| | F00124 | BIT | _GTE | GTE flag | ON in case of "equal or greater than" |
| | F00125 | BIT | _NEQ | NEQ flag | ON in case of "not equal" |
| F0013 | | WORD | _AC_F_CNT | Moment shutdown | Indicates moment shutdown times |
| F0014 | | WORD | _FALS_NUM | FALS no. | Indicates FALS no. |
| F0015 | | WORD | _PUTGET_ERR0 PUT/GET error 0 Main base Put / Ge | | Main base Put / Get error |
| F0016 | | WORD | _PUTGET_ERR1 PUT/GET error 1 Extended base 1 | | Extended base 1 step Put/Get error |
| F0017 | | WORD | _PUTGET_ERR2 | PUT/GET error 2 | Extended base 2 step Put/Get error |
| F0018 | | WORD | _PUTGET_ERR3 | PUT/GET error 3 | Extended base 3 step Put/Get error |
| F0019 | | WORD | _PUTGET_ERR4 | PUT/GET error 4 | Extended base 4 step Put/Get error |
| F0020 | | WORD | _PUTGET_ERR5 | PUT/GET error 5 | Extended base 5 step Put/Get error |
| F0021 | | WORD | _PUTGET_ERR6 | PUT/GET error 6 | Extended base 6 step Put/Get error |
| F0022 | | WORD | _PUTGET_ERR7 | PUT/GET error 7 | Extended base 7 step Put/Get error |
| F0023 | | WORD | _PUTGET_NDR0 | PUT/GET end 0 | Main base Put/Get end |
| F0024 | | WORD | _PUTGET_NDR1 | PUT/GET end 1 | Extended base 1 step Put/Get end |
| F0025 | | WORD | _PUTGET_NDR2 | PUT/GET end 2 | Extended base 2 step Put/Get end |
| F0026 | | WORD | _PUTGET_NDR3 | PUT/GET end 3 | Extended base 3 step Put/Get end |
| F0027 | | WORD | _PUTGET_NDR4 | PUT/GET end 4 | Extended base 4 step Put/Get end |
| F0028 | | WORD | _PUTGET_NDR5 | PUT/GET end 5 | Extended base 5 step Put/Get end |
| F0029 | | WORD | _PUTGET_NDR6 | PUT/GET end 6 | Extended base 6 step Put/Get end |
| F0030 | | WORD | _PUTGET_NDR7 | PUT/GET end 7 | Extended base 7 step Put/Get end |
| F0044 | | WORD | _CPU_TYPE | CPU Type | Indicates information for CPU Type. |
| F0045 | | WORD | _CPU_VER | CPU version | Indicates CPU version |
| F0046 | | DWORD | _OS_VER | OS version | Indicates OS version |
| F0048 | | DWORD | _OS_DATE | OS date | Indicates OS distribution date. |
| F0050 | | WORD | _SCAN_MAX | Max. scan time | Indicates max. scan time. |
| F0051 | | WORD | _SCAN_MIN | Min. scan time | Indicates min. scan time. |
| F0052 | | WORD | _SCAN_CUR | Current scan time | Current scan time |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|-------|-----------------|-------------------------|---|
| F0053 | | WORD | _MON_YEAR | Month/Year | PLC month, year data |
| F0054 | | WORD | _TIME_DAY | Time/Day | PLC time, day data |
| F0055 | | WORD | _SEC_MIN | Sec/Min | PLC second, minute data |
| F0056 | | WORD | _HUND_WK | Hundred year/Weekday | PLC hundred year, weekday data |
| F0057 | | WORD | _FPU_INFO | FPU operation result | Fixed decimal operation result |
| | F00570 | BIT | _FPU_LFLAG_I | Incorrect error latch | Latch in case of incorrect error |
| | F00571 | BIT | _FPU_LFLAG_U | Underflow latch | Latch in case of underflow |
| | F00572 | BIT | _FPU_LFLAG_O | Overflow latch | Latch in case of overflow |
| | F00573 | BIT | _FPU_LFLAG_Z | Zero(0) divide latch | Latch in case of zero(0) divide |
| | F00574 | BIT | _FPU_LFLAG_V | Invalid operation latch | Latch in case of invalid operation |
| | F0057A | BIT | _FPU_FLAG_I | Incorrect error | Reports incorrect error |
| | F0057B | BIT | _FPU_FLAG_U | Underflow | Reports underflow |
| | F0057C | BIT | _FPU_FLAG_O | Overflow | Reports overflow |
| | F0057D | BIT | _FPU_FLAG_Z | Zero divide | Reports in case of zero divide |
| | F0057E | BIT | _FPU_FLAG_V | Invalid operation | Reports in case of invalid operation |
| | F0057F | BIT | _FPU_FLAG_E | Irregular input | Reports in case of irregular input |
| F0058 | | DWORD | _ERR_STEP | Error step | Saves error step |
| F0060 | | DWORD | _REF_COUNT | Refresh | Increase when module Refresh |
| F0062 | | DWORD | _REF_OK_CNT | Refresh OK | Increase when module Refresh is normal |
| F0064 | | DWORD | _REF_NG_CNT | Refresh NG | Increase when module Refresh is abnormal |
| F0066 | | DWORD | _REF_LIM_CNT | Refresh Limit | Increase when module Refresh is abnormal (Time Out) |
| F0068 | | DWORD | _REF_ERR_CNT | Refresh Error | Increase when module Refresh is abnormal |
| F0070 | | DWORD | _MOD_RD_ERR_CNT | Module Read Error | Increase when reading module 1 word abnormally |
| F0072 | | DWORD | _MOD_WR_ERR_CNT | Module Write Error | Increase when module 1 word abnormally |
| F0074 | | DWORD | _CA_CNT | Block service | Increase when module block data service |
| F0076 | | DWORD | _CA_LIM_CNT | Block service Limit | Increase when block data service is limited |
| F0078 | | DWORD | _CA_ERR_CNT | Block service Error | Increase in case of block data service error |
| F0080 | | DWORD | _BUF_FULL_CNT | Buffer Full | Increase when CPU internal buffer is full. |
| F0082 | | DWORD | _PUT_CNT | Put count | Increase when Put count |
| F0084 | | DWORD | _GET_CNT | Get count | Increase when Get count |
| F0086 | | DWORD | _KEY | Current key | indicates the current state of local key. |
| F0088 | | DWORD | _KEY_PREV | Previous key | indicates the previous state of local key |
| F0090 | | WORD | _IO_TYER_N | Mismatch slot | Module Type mismatched slot no. |
| F0091 | | WORD | _IO_DEER_N | Detach slot | Module detached slot no. |
| F0092 | | WORD | _FUSE_ER_N | Fuse cutoff slot | Fuse cutoff slot no. |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|------|------------|-----------------------|--|
| F0093 | | WORD | _IO_RWER_N | RW error slot | Module read/write error slot no. |
| F0094 | | WORD | _IP_IFER_N | IF error slot | Module interface error slot no. |
| F0096 | | WORD | _IO_TYER0 | Module Type 0 error | Main base module Type error |
| F0097 | | WORD | _IO_TYER1 | Module Type 1 error | Extended base 1 step module Type error |
| F0098 | | WORD | _IO_TYER2 | Module Type 2 error | Extended base 2 step module Type error |
| F0099 | | WORD | _IO_TYER3 | Module Type 3 error | Extended base 3 step module Type error |
| F0100 | | WORD | _IO_TYER4 | Module Type 4 error | Extended base 4 step module Type error |
| F0101 | | WORD | _IO_TYER5 | Module Type 5 error | Extended base 5 step module Type error |
| F0102 | | WORD | _IO_TYER6 | Module Type 6 error | Extended base 6 step module Type error |
| F0103 | | WORD | _IO_TYER7 | Module Type 7 error | Extended base 7 step module Type error |
| F0104 | | WORD | _IO_DEER0 | Module detach 0 error | Main base module detach error |
| F0105 | | WORD | _IO_DEER1 | Module detach 1 error | Extended base 1 step module detach error |
| F0106 | | WORD | _IO_DEER2 | Module detach 2 error | Extended base 2 step module detach error |
| F0107 | | WORD | _IO_DEER3 | Module detach 3 error | Extended base 3 step module detach error |
| F0108 | | WORD | _IO_DEER4 | Module detach 4 error | Extended base 4 step module detach error |
| F0109 | | WORD | _IO_DEER5 | Module detach 5 error | Extended base 5 step module detach error |
| F0110 | | WORD | _IO_DEER6 | Module detach 6 error | Extended base 6 step module detach error |
| F0111 | | WORD | _IO_DEER7 | Module detach 7 error | Extended base 7 step module detach error |
| F0112 | | WORD | _FUSE_ER0 | Fuse cutoff 0 error | Main base fuse cutoff error |
| F0113 | | WORD | _FUSE_ER1 | Fuse cutoff 1 error | Extended base 1 step fuse cutoff error |
| F0114 | | WORD | _FUSE_ER2 | Fuse cutoff 2 error | Extended base 2 step fuse cutoff error |
| F0115 | | WORD | _FUSE_ER3 | Fuse cutoff 3 error | Extended base 3 step fuse cutoff error |
| F0116 | | WORD | _FUSE_ER4 | Fuse cutoff 4 error | Extended base 4 step fuse cutoff error |
| F0117 | | WORD | _FUSE_ER5 | Fuse cutoff 5 error | Extended base 5 step fuse cutoff error |
| F0118 | | WORD | _FUSE_ER6 | Fuse cutoff 6 error | Extended base 6 step fuse cutoff error |
| F0119 | | WORD | _FUSE_ER7 | Fuse cutoff 7 error | Extended base 7 step fuse cutoff error |
| F0120 | | WORD | _IO_RWER0 | Module RW 0 error | Main base module read/write error |
| F0121 | | WORD | _IO_RWER1 | Module RW 1 error | Extended base1 step module read/ write error |
| F0122 | | WORD | _IO_RWER2 | Module RW 2 error | Extended base 2 step module read/ write error |
| F0123 | | WORD | _IO_RWER3 | Module RW 3 error | Extended base 3 step module read/ write error |
| F0124 | | WORD | _IO_RWER4 | Module RW 4 error | Extended base 4 step module read/ write error |
| F0125 | | WORD | _IO_RWER5 | Module RW 5 error | Extended base 5 step module read/ write error |
| F0126 | | WORD | _IO_RWER6 | Module RW 6 error | Extended base 6 step module read/ write error |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|-------|-----------------|---|--|
| F0127 | | WORD | _IO_RWER7 | Module RW 7 error | Extended base 7 step module read/ write error |
| F0128 | | WORD | _IO_IFER_0 | Module IF 0 error | Main base module interface error |
| F0129 | | WORD | _IO_IFER_1 | Module IF 1 error | Extended base 1step module interface error |
| F0130 | | WORD | _IO_IFER_2 | Module IF 2 error | Extended base 2step module interface error |
| F0131 | | WORD | _IO_IFER_3 | Module IF 3 error | Extended base 3step module interface error |
| F0132 | | WORD | _IO_IFER_4 | Module IF 4 error | Extended base 4step module interface error |
| F0133 | | WORD | _IO_IFER_5 | Module IF 5 error | Extended base 5step module interface error |
| F0134 | | WORD | _IO_IFER_6 | Module IF 6 error | Extended base 6step module interface error |
| F0135 | | WORD | _IO_IFER_7 | Module IF 7 error | Extended base 7step module interface error |
| F0136 | | WORD | _RTC_DATE | RTC date | RTC current date |
| F0137 | | WORD | _RTC_WEEK | RTC weekday | RTC current weekday |
| F0138 | | DWORD | _RTC_TOD | RTC time | RTC current time (ms unit) |
| F0140 | | DWORD | _AC_FAIL_CNT | Power shutdown times | Saves the times of power shutdown |
| F0142 | | DWORD | _ERR_HIS_CNT | Error occur times | Saves the times of error occur |
| F0144 | | DWORD | _MOD_HIS_CNT | Mode conversion times | Saves the times of mode conversion |
| F0146 | | DWORD | _SYS_HIS_CNT | History occur times | Saves the times of system history |
| F0148 | | DWORD | _LOG_ROTATE | Log Rotate | Saves log rotate information |
| F0150 | | WORD | _BASE_INFO0 | Slot information 0 | Main base slot information |
| F0151 | | WORD | _BASE_INFO1 | Slot information 1 | Extended base 1step slot information |
| F0152 | | WORD | _BASE_INFO2 | Slot information 2 | Extended base 2step slot information |
| F0153 | | WORD | _BASE_INFO3 | Slot information 3 | Extended base 3step slot information |
| F0154 | | WORD | _BASE_INFO4 | Slot information 4 | Extended base 4step slot information |
| F0155 | | WORD | _BASE_INFO5 | Slot information 5 | Extended base 5step slot information |
| F0156 | | WORD | _BASE_INFO6 | Slot information 6 | Extended base 6step slot information |
| F0157 | | WORD | _BASE_INFO7 | Slot information 7 | Extended base 7step slot information |
| F0158 | | WORD | _RBANK_NUM | Use block no. | Current using block no. |
| F0159 | | WORD | _RBLOCK_STATE | Flash state | Flash block state |
| F0164 | | DWORD | _RBLOCK_ER_FLAG | Flash error | Error during flash NBlock service |
| F0160 | | DWORD | _RBLOCK_RD_FLAG | Flash read | ON when reading flash Nblock data |
| F0162 | | DWORD | _RBLOCK_WR_FLAG | Flash write | ON when writing flash Nblock data |
| F0178 | | DWORD | _OS_VER_PATCH | OS patch version | Indicates OS version to second decimal places. |
| F09320 | | BIT | _FUSE_ER_PMT | Setting in case of fuse error | Ignores fuse error |
| F09321 | | BIT | _IO_ER_PMT | Setting in case of I/O error | Ignores I/O module error |
| F09322 | | BIT | _SP_ER_PMT | Setting in case of special module error | Ignores special module error |

| Device1 | Device2 | Туре | Variables | Function | Description | |
|---------|---------|-------|----------------------|--|---|--|
| F09323 | | BIT | _CP_ER_PMT | Setting in case of communication error | Ignores communication module error | |
| F0934 | | DWORD | _BASE_EMASK_INFO | Base fault mask | Base fault mask information | |
| F0936 | | DWORD | _BASE_SKIP_INFO | Base Skip | Base skip information | |
| F0938 | | WORD | _SLOT_EMASK_INFO_0 | Slot fault mask | Slot fault mask information (BASE 0) | |
| F0939 | | WORD | _SLOT_EMASK_INFO_1 | Slot fault mask | Slot fault mask information (BASE 1) | |
| F0940 | | WORD | _SLOT_EMASK_INFO_2 | Slot fault mask | Slot fault mask information (BASE 2) | |
| F0941 | | WORD | _SLOT_EMASK_INFO_3 | Slot fault mask | Slot fault mask information (BASE 3) | |
| F0942 | | WORD | _SLOT_EMASK_INFO_4 | Slot fault mask | Slot fault mask information (BASE 4) | |
| F0943 | | WORD | _SLOT_EMASK_INFO_5 | Slot fault mask | Slot fault mask information (BASE 5) | |
| F0944 | | WORD | _SLOT_EMASK_INFO_6 | Slot fault mask | Slot fault mask information (BASE 6) | |
| F0945 | | WORD | _SLOT_EMASK_INFO_7 | Slot fault mask | Slot fault mask information (BASE 7) | |
| F0946 | | WORD | _SLOT_SKIP_INFO_0 | Slot skip | Slot skip information (BASE 0) | |
| F0947 | | WORD | _SLOT_SKIP_INFO_1 | Slot skip | Slot skip information (BASE 1) | |
| F0948 | | WORD | _SLOT_SKIP_INFO_2 | Slot skip | Slot skip information (BASE 2) | |
| F0949 | | WORD | _SLOT_SKIP_INFO_3 | Slot skip | Slot skip information (BASE 3) | |
| F0950 | | WORD | _SLOT_SKIP_INFO_4 | Slot skip | Slot skip information (BASE 4) | |
| F0951 | | WORD | _SLOT_SKIP_INFO_5 | Slot skip | Slot skip information (BASE 5) | |
| F0952 | | WORD | _SLOT_SKIP_INFO_6 | Slot skip | Slot skip information (BASE 6) | |
| F0953 | | WORD | _SLOT_SKIP_INFO_7 | Slot skip | Slot skip information (BASE 7) | |
| F1024 | | WORD | _USER_WRITE_F | User contact | User contact from Program | |
| | F10240 | BIT | _RTC_WR | RTC RW | Write and Read the data to RTC | |
| | F10241 | BIT | _SCAN_WR | Scan WR | Scan value initialize | |
| | F10242 | BIT | _CHK_ANC_ERR | External heavy error request | Requests heavy error detection from external device | |
| | F10243 | BIT | _CHK_ANC_WAR | External light error request | Requests light error detection from external device | |
| F1025 | | WORD | _USER_STAUS_F | User contact | User contact | |
| | F10250 | BIT | _INIT_DONE | Initialize end | Initialization task is done | |
| F1026 | | WORD | _ANC_ERR | External heavy error information | Indicates heavy error information of external device. Indicates light error information of | |
| F1027 | | WORD | _ANC_WAR | External light Indicates light error informati error warning external device | | |
| F1034 | | WORD | _MON_YEAR_DT | Month/year Clock information data (month/year | | |
| F1035 | | WORD | _TIME_DAY_DT | Time/day Clock information data (time/day | | |
| F1036 | | WORD | _SEC_MIN_DT | Sec/min Clock information data (sec/min) | | |
| F1037 | | WORD | _HUND_WK_DT | weekday | • | |
| F0176 | | WORD | _SOE_READ_LOG_CNT | - | | |
| F0177 | | WORD | _SOE_READ_LOG_ROTATE | Rotate information | Rotate information of SOE event count read by user | |
| F0954 | | WORD | _SOE_LOG_CNT | Event count occurred | SOE event count occurred | |
| F0955 | | WORD | _SOE_LOG_ROTATE | Rotate information | SOE event rotate information | |

| Device1 | Device2 | Туре | Variables | Function | Description |
|---------|---------|------|------------------------------|--------------------------|---|
| F09600 | | BIT | _HS1_ENABLE_STATE | High speed link state | High speed link 1 enable/disable current state |
| ~ | | BIT | _HSx_ENABLE_STATE | High speed link state | High speed link x enable/disable current state |
| F0960B | | BIT | _HS12_ENABLE_STATE | High speed link state | High speed link 12 enable/disable current state |
| F10300 | | BIT | _HS1_REQ | High speed link request | High speed link 1 enable/disable request |
| ~ | | BIT | _HSx_REQ | High speed link request | High speed link x enable/disable request |
| F1030B | | BIT | _HS12_REQ | High speed link request | High speed link 12 enable/disable request |
| F10310 | | BIT | _HS1_REQ_NUM | High speed link setting | High speed link 1 enable/disable setting |
| ~ | | BIT | _HSx_REQ_NUM | High speed link setting | High speed link x enable/disable setting |
| F1031B | | BIT | _HS12_REQ_NUM | High speed link setting | High speed link 12 enable/disable setting |
| F09620 | | BIT | _P2P1_ENABLE_STATE | P2P state | P2P 1 enable/disable current state |
| ~ | | BIT | _P2Px_ENABLE_STATE | P2P state | P2P x enable/disable current state |
| F09627 | | BIT | _P2P8_ENABLE_STATE | P2P state | P2P 8 enable/disable current state |
| F10320 | | BIT | _P2P1_REQ | P2P request | P2P 1 enable/disable request |
| ~ | | BIT | _P2Px_REQ | P2P request | P2P x enable/disable request |
| F10327 | | BIT | _P2P8_REQ | P2P request | P2P 8 enable/disable request |
| F10330 | | BIT | _P2P1_REQ_NUM | P2P setting | P2P 1 enable/disable setting |
| ~ | | BIT | _P2Px_REQ_NUM | P2P setting | P2P x enable/disable setting |
| F10337 | | BIT | _P2P8_REQ_NUM | P2P setting | P2P 8 enable/disable setting |
| F0190 | | WORD | _CYCLE_TASK_SCAN0_MAX | Maximum scan time | Fixed cycle task 0 maximum scan time |
| F0191 | | WORD | _CYCLE_TASK_SCAN0_MIN | Minimum scan time | Fixed cycle task 0 minimum scan time |
| F0192 | | WORD | _CYCLE_TASK_SCAN0_CUR | Current scan time | Fixed cycle task 0 current scan time |
| ~ | | WORD | _CYCLE_TASK_SCANx_MAX | Maximum scan time | Fixed cycle task x maximum scan time |
| ~ | | WORD | _CYCLE_TASK_SCANx_MIN | Minimum scan time | Fixed cycle task x minimum scan time |
| ~ | | WORD | _CYCLE_TASK_SCANx_CUR | Current scan time | Fixed cycle task x current scan time |
| F0283 | | WORD | _CYCLE_TASK_SCAN31_MAX | Maximum scan time | Fixed cycle task 31 maximum scan time |
| F0284 | | WORD | _CYCLE_TASK_SCAN31_MIN | Minimum scan time | Fixed cycle task 31 minimum scan time |
| F0285 | | WORD | _CYCLE_TASK_SCAN31_CUR | Current scan time | Fixed cycle task 31 current scan time |
| F10248 | | BIT | _CYCLE_TASK_SCAN_WR | Scan time initialization | Initialize fixed cycle task's scan time |
| F996 | | WORD | _SOCKET_CLOSE_COU NTER[0] | close number each socket | Close number (Socket 0) |
| F997 | | WORD | _SOCKET_CLOSE_COU NTER[1] | close number each socket | Close number (Socket 1) |
| F998 | | WORD | _SOCKET_CLOSE_COU NTER[2] | close number each socket | Close number (Socket 2) |
| F999 | | WORD | _SOCKET_CLOSE_COU NTER[3] | close number each socket | Close number (Socket 3) |

Appendix 1.2 Communication Relay (L) List

Here describes data link communication relay(L).

[Table 1] Communication Flag List according to High speed link no. (High speed link no. 1 ~ 12)

| | able 1] Communication Flag List according to High speed link no. (High speed link no. 1 ~ 12) | | | |
|-------------------------|---|--------------|---|--|
| No. | Keyword | Туре | Contents | Description |
| L000000 | _HS1_RLINK | Bit | High speed link parameter 1 normal operation of all station | Indicates normal operation of all station according to parameter set in High speed link, and ON under the condition as below. 1. In case that all station set in parameter is RUN mode and no error, 2. All data block set in parameter is communicated normally, and 3. The parameter set in each station itself is communicated normally. Once RUN_LINK is ON, it keeps ON unless stopped by LINK_DISABLE. |
| L000001 | _HS1_LTRBL | Bit | Abnormal state after _HS1RLINK ON | In the state of _HSmRLINK flag ON, if communication state of the station set in the parameter and data block is as follows, this flag shall be ON. 1. In case that the station set in the parameter is not RUN mode, or 2. There is an error in the station set in the parameter, or 3. The communication state of data block set in the parameter is not good. LINK TROUBLE shall be ON if the above 1, 2 & 3 conditions occur, and if the condition return to the normal state, it shall be OFF again. |
| L000020 ~ L00009F | _HS1_STATE[k] (k=000~127) | Bit Array | High speed link parameter 1, k block general state | Indicates the general state of communication information for each data block of setting parameter. HS1STATE[k]=HS1MOD[k]&_HS1TRX[k]&(~_HSmERR[k]) |
| L000100 ~ L00017F | _HS1_MOD[k] (k=000~127) | Bit Array | High speed link parameter 1, k block station RUN operation mode | Indicates operation mode of station set in k data block of parameter. |
| L000180 ~ L00025F | _HS1_TRX[k] (k=000~127) | Bit Array | Normal communication with High speed link parameter 1, k block station | Indicates if communication state of k data of parameter is communicated smoothly according to the setting. |
| L000260 ~ L00033F | _HS1_ERR[k] (k=000~127) | Bit Array | High speed link parameter 1, k block station operation error mode | Indicates if the error occurs in the communication state of k data block of parameter. |
| L000340 ~ L00041F | _HS1_SETBLOC K[k] | Bit Array | High speed link parameter 1, k block setting | Indicates whether or not to set k data block of parameter. |

| Notes | | |
|------------------------|-----------------|--|
| High speed link no. | L area address | Remarks |
| 2 | L000500~L00099F | Comparing with High speed link 1 from [Table 1], the flag address of different |
| 3 | L001000~L00149F | high speed link station no. is as follows by a simple calculation formula. |
| 4 | L001500~L00199F | * Calculation formula :L area address = L000000 + 500 x (High speed link |
| 5 | L002000~L00249F | no. – 1) |
| 6 | L002500~L00299F | , |
| 7 | L003000~L00349F | In case of using high speed line flag for Program and monitoring, you can use |
| 8 | L003500~L00399F | the flag map registered in XG5000 conveniently. |
| 9 | L004000~L00449F | |
| 10 | L004500~L00499F | |
| 11 | L005000~L00549F | |

k means block no. and appears 8 words by 16 per 1 word for 128 blocks from 000~127.

For example, mode information (_HS1MOD) appears from block 0 to block 15 for L00010, and block 16 \sim 31, 32 \sim 47, 48 \sim 63, 64 \sim 79, 80 \sim 95, 96 \sim 111, 112 \sim 127 information for L00011, L00012, L00013, L00014, L00015, L00016, L00017. Thus, mode information of block no. 55 appears in L000137.

| [Table 2] | [Table 2] Communication Flag List according to P2P Service Setting P2P parameter: 1~8, P2P block: 0~63 | | | | | | |
|-----------|--|----------------|---|---|--|--|--|
| No. | Keyword | Туре | Contents | Description | | | |
| L006250 | _P2P1_NDR00 | Bit | P2P parameter 1, 00 Block service normal end | Indicates P2P parameter 1, 0 Block service normal end | | | |
| L006251 | _P2P1_ERR00 | Bit | P2P parameter 1, 00 Block service abnormal end | Indicates P2P parameter 1, 0 Block service abnormal end | | | |
| L00626 | _P2P1_STATUS00 | Word | P2P parameter 1, 00 Block service abnormal end error Code | Indicates error code in case of P2P parameter 1, 0 Block service abnormal end | | | |
| L00627 | _P2P1_SVCCNT00 | Double word | P2P parameter 1, 00 Block service normal count | Indicates P2P parameter 1, 0 Block service normal count | | | |
| L00629 | _P2P1_ERRCNT00 | Double word | P2P parameter 1, 00 Block service abnormal count | Indicates P2P parameter 1, 0 Block service abnormal count | | | |
| L006310 | _P2P1_NDR01 | Bit | P2P parameter 1, 01 Block service normal end | P2P parameter 1, 1 Block service normal end | | | |
| L006311 | _P2P1_ERR01 | Bit | P2P parameter 1, 01 Block service abnormal end | P2P parameter 1, 1 Block service abnormal end | | | |
| L00632 | _P2P1_STATUS01 | Word | P2P parameter 1, 01 Block service abnormal end error Code | Indicates error code in case of P2P parameter 1, 1 Block service abnormal end | | | |
| L00633 | _P2P1_SVCCNT01 | Double word | P2P parameter 1, 01 Block service normal count | Indicates P2P parameter 1, 1 Block service normal connt | | | |
| L00635 | _P2P1_ERRCNT01 | Double word | P2P parameter 1, 01 Block service abnormal count | Indicates P2P parameter 1, 1 Block service abnormal count | | | |

Appendix 1.3 Link Register (N) List

[Table 1] Link Register List according to P2P no. P2P no. : 1~8, P2P block : 0~63

| No. | Keyword | Туре | Contents | Description |
|--------------------|-----------|---------------------|---|--|
| N00000 | _P1B00SN | Word | P2P parameter 1, 00 block another station no. | Saves another station no. of P2P parameter 1, 00 block. In case of using another station no. at XG-PD, it is possible to edit during RUN by using P2PSN command. |
| N00001 ~ N00004 | _P1B00RD1 | Device structure | Area device 1 to read P2P parameter 1, 00 block | Saves area device 1 to read P2P parameter 1, 00 block. |
| N00005 | _P1B00RS1 | word | Area size 1 to read P2P parameter 1, 00 block | Saves area size 1 to read P2P parameter 1, 00 block. |
| N00006 ~ N00009 | _P1B00RD2 | Device structure | Area device 2 to read P2P parameter 1, 00 block | Saves area device 2 to read P2P parameter 1, 00 block. |
| N00010 | _P1B00RS2 | word | Area size 2 to read P2P parameter 1, 00 block | Saves area size 2 to read P2P parameter 1, 00 block. |
| N00011 ~ N00014 | _P1B00RD3 | Device structure | Area device 3 to read P2P parameter 1, 00 block | Saves area device 3 to read P2P parameter 1, 00 block. |
| N00015 | _P1B00RS3 | word | Area size 3 to read P2P parameter 1, 00 block | Saves area size 3 to read P2P parameter 1, 00 block. |
| N00016 ~ N00019 | _P1B00RD4 | Device structure | Area device 4 to read P2P parameter 1, 00 block | Saves area device 4 to read P2P parameter 1, 00 block. |
| N00020 | _P1B00RS4 | Word | Area size 4 to read P2P parameter 1, 00 block | Saves area size 4 to read P2P parameter 1, 00 block. |
| N00021 ~ N00024 | _P1B00WD1 | Device structure | Area device 1 to save P2P parameter 1, 00 block | Saves area device 1 to save P2P parameter 1, 00 block. |
| N00025 | _P1B00WS1 | Word | Area size 1 to save P2P parameter 1, 00 block | Saves area size 1 to save P2P parameter 1, 00 block. |
| N00026 ~ N00029 | _P1B00WD2 | Device structure | Area device 2 to save P2P parameter 1, 00 block | Saves area device 2 to save P2P parameter 1, 00 block. |
| N00030 | _P1B00WS2 | Word | Area size 2 to save P2P parameter 1, 00 block | Saves area size 2 to save P2P parameter 1, 00 block. |
| N00031 ~ N00034 | _P1B00WD3 | Device structure | Area device 3 to save P2P parameter 1, 00 block | Saves area device 3 to save P2P parameter 1, 00 block. |
| N00035 | _P1B00WS3 | Word | Area size 3 to save P2P parameter 1, 00 block | Saves area size 3 to save P2P parameter 1, 00 block. |
| N00036 ~ N00039 | _P1B00WD4 | Device structure | Area device 4 to save P2P parameter 1, 00 block | Saves area device 4 to save P2P parameter 1, 00 block. |
| N00040 | _P1B00WS4 | Word | Area size 4 to save P2P parameter 1, 00 block | Saves area size 4 to save P2P parameter 1, 00 block. |

| No. | Keyword | Туре | Contents | Description |
|--------------------|---------------|---------------------|---|--|
| N00041 | _P1B01SN | Word | P2P parameter 1, 01 block another station no. | Saves another station no. of P2P parameter 1, 01 block. In case of using another station no. at XG-PD, it is possible to edit during RUN by using P2PSN command. |
| N00042 ~ N00045 | _P1B01RD1 | Device structure | Area device 1 to read P2P parameter 1, 01 block | Saves area device 1 to read P2P parameter 1, 01 block. |
| N00046 | _P1B01RS1 | Word | Area size 1 to read P2P parameter 1, 01 block | Saves area size 1 to read P2P parameter 1, 01 block. |
| N00047 ~ N00050 | _P1B01RD2 | Device structure | Area device 2 to read P2P parameter 1, 01 block | Saves area device 2 to read P2P parameter 1, 01 block. |
| N00051 | _P1B01RS2 | Word | Area size 2 to read P2P parameter 1, 01 block | Saves area size 2 to read P2P parameter 1, 01 block. |
| N00052 ~ N00055 | _P1B01RD3 | Device structure | Area device 3 to read P2P parameter 1, 01 block | Saves area device 3 to read P2P parameter 1, 01 block. |
| N00056 | _P1B01RS3 | Word | Area size 3 to read P2P parameter 1, 01 block | Saves area size 3 to read P2P parameter 1, 01 block. |
| N00057 ~ N00060 | _P1B01RD4 | Device structure | Area device 4 to read P2P parameter 1, 01 block | Saves area device 4 to read P2P parameter 1, 01 block. |
| N00061 | _P1B01RS4 | Word | Area size 4 to read P2P parameter 1, 01 block | Saves area size 4 to read P2P parameter 1, 01 block. |
| N00062 ~ N00065 | _P1B01WD 1 | Device structure | Area device 1 to save P2P parameter 1, 01 block | Saves area device 1 to save P2P parameter 1, 01 block. |
| N00066 | _P1B01WS1 | Word | Area size 1 to save P2P parameter 1, 01 block | Saves area size 1 to save P2P parameter 1, 01 block. |
| N00067 ~ N00070 | _P1B01WD 2 | Device structure | Area device 2 to save P2P parameter 1, 01 block | Saves area device 2 to save P2P parameter 1, 01 block. |
| N00071 | _P1B01WS2 | Word | Area size 2 to save P2P parameter 1, 01 block | Saves area size 2 to save P2P parameter 1, 01 block. |
| N00072 ~ N00075 | _P1B01WD 3 | Device structure | Area device 3 to save P2P parameter 1, 01 block | Saves area device 3 to save P2P parameter 1, 01 block. |
| N00076 | _P1B01WS3 | Word | Area size 3 to save P2P parameter 1, 01 block | Saves area size 3 to save P2P parameter 1, 01 block. |
| N00077 ~ N00080 | _P1B01WD 4 | Device structure | Area device 4 to save P2P parameter 1, 01 block | Saves area device 4 to save P2P parameter 1, 01 block. |
| N00081 | _P1B01WS4 | Word | Area size 4 to save P2P parameter 1, 01 block | Saves area size 4 to save P2P parameter 1, 01 block. |

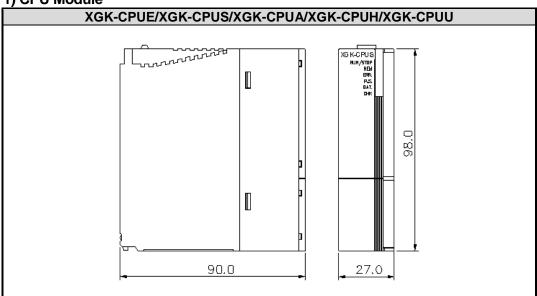
Notes

N area shall be set automatically when setting P2P parameter by using XG-PD and available to modify during RUN by using P2P dedicated command.

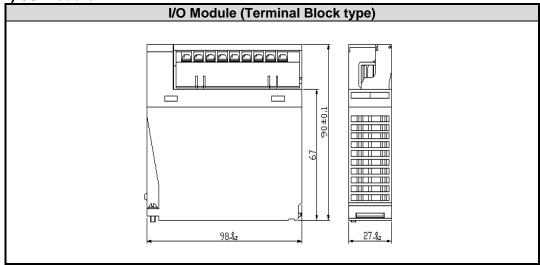
N area has a different address classified according to P2P parameter setting no., block index. The area not used by P2P service as address is divided, can be used by internal device.

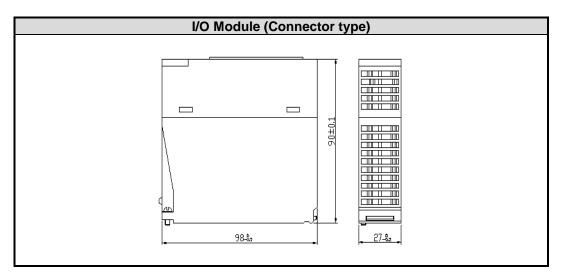
Appendix 2 Dimensions (Unit: mm)

1) CPU Module



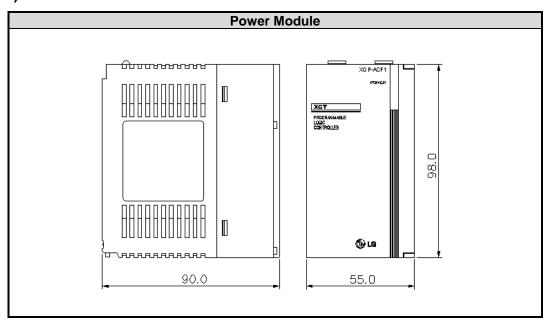
2) I/O Module



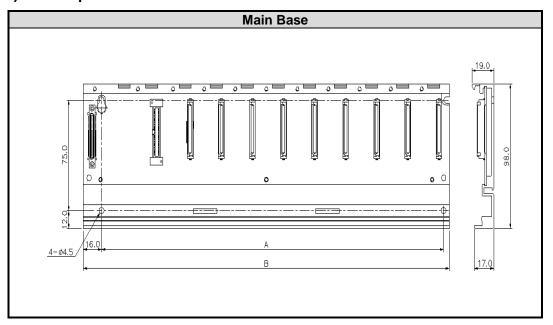


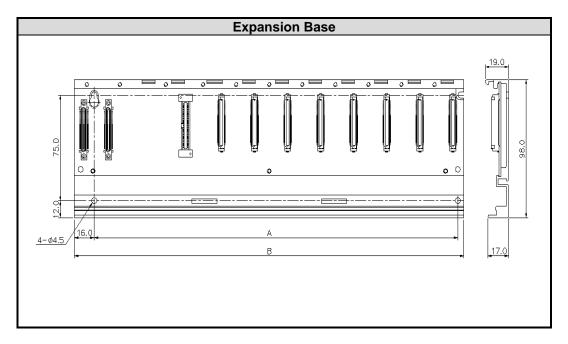
App. 2-1

3) Power Module



4) Main/Expansion Base





| Classification | А | В |
|-------------------|-----|-----|
| XGB-M04A/XGB-E04A | 190 | 210 |
| XGB-M06A/XGB-E06A | 244 | 264 |
| XGB-M08A/XGB-E08A | 298 | 318 |
| XGB-M12A/XGB-E12A | 406 | 426 |

Appendix 3 Compatibility with MASTER-K

App. 3.1 Special Flag Compatibility

1) F Area Relay

| MASTER-K | | XGK | | | |
|------------------|------------------------|----------------|------------------|--|--|
| Device | Function | Symbol | Device | Function | |
| F0000 | RUN mode | _RUN | F0000 | RUN Edit mode | |
| F0001 | Program mode | _STOP | F0001 | Program mode | |
| F0002 | Pause mode | _ERROR | F0002 | Error mode | |
| F0003 | Debug mode | _DEBUG | F0003 | Debug mode | |
| F0004 | N/A | _LOCAL_CON | F0006 | Remote mode | |
| F0005 | N/A | _MODBUS_CON | F0006 | Remote mode | |
| F0006 | Remote mode | _REMOTE_CON | F0006 | Remote mode | |
| F0007 | User memory setup | - | F0007 | N/A | |
| F0008 | N/A | _RUN_EDIT_ST | F0008 | Editing during RUN | |
| F0009 | N/A | _RUN_EDIT_CHK | F0009 | Editing during RUN | |
| F000A | User memory operation | _RUN_EDIT_DONE | F000A | Edit done during RUN | |
| F000B | N/A | _RUN_EDIT_END | F000B | Edit end during RUN | |
| F000C | N/A | _CMOD_KEY | F000C | Operation mode change by KEY | |
| F000D | N/A | _CMOD_LPADT | F000D | Operation mode change by PADT | |
| F000E | N/A | _CMOD_RPADT | F000E | Operation mode change by Remote PADT | |
| F000F | STOP command execution | _CMOD_RLINK | F000F | Operation mode change cause by remote communication module | |
| F0010 | Ordinary time On | _FORCE_IN | F0010 | Forced input | |
| F0011 | Ordinary time Off | _FORCE_OUT | F0011 | Forced output | |
| F0012 | 1 Scan On | _SKIP_ON | F0012 | I/O Skip execution | |
| F0013 | 1 Scan Off | _EMASK_ON | F0013 | Error mask execution | |
| F0014 | Reversal every Scan | _MON_ON | F0014 | Monitor execution | |
| | | _USTOP_ON | F0015 | Stop by Stop Function | |
| | | _ESTOP_ON | F0016 | Stop by ESTOP Function | |
| | | _CONPILE_MODE | F0017 | Compile | |
| | | _INIT_RUN | F0018 | Initialize | |
| F0015 ~ F001F | N/A | - | F0019 ~ F001F | N/A | |
| F001C | N/A | _PB1 | F001C | Program Code 1 | |
| F001D | N/A | _PB2 | F001D | Program Code 2 | |
| F001E | N/A | _CB1 | F001E | Compile code 1 | |
| F001F | N/A | _CB2 | F001F | Compile code 2 | |

| MASTER-K | | | | XGK | |
|------------------|-------------------------|--------------------|------------------|---|--|
| Device | Function | Symbol | Device | Function | |
| F0020 | 1 Step RUN | _CPU_ER | F0020 | CPU configuration error | |
| F0021 | Break Point RUN | _IO_TYER | F0021 | Module type mismatch error | |
| F0022 | Scan RUN | _IO_DEER | F0022 | Module detach error | |
| F0023 | Contact value match RUN | _FUSE_ER | F0023 | Fuse cutoff error | |
| F0024 | Word value match RUN | _IO_RWER | F0024 | I/O module read/write error | |
| | | _IP_IFER | F0025 | Special/communication module interface error | |
| | | _ANNUM_ER | F0026 | Heavy error detection of external equipment error | |
| | | - | F0027 | N/A | |
| | | _BPRM_ER | F0028 | Basic parameter error | |
| | | _IOPRM_ER | F0029 | I/O configuration parameter error | |
| | | _SPPRM_ER | F002A | Special module parameter error | |
| | | _CPPRM_ER | F002B | Communication module parameter error | |
| | | _PGM_ER | F002C | Program error | |
| | | _CODE_ER | F002D | Program Code error | |
| | | _SWDT_ER | F002E | System watchdog error | |
| F0025 ~ F002F | N/A | _BASE_POWER _ER | F002F | Base power error | |
| F0030 | Heavy error | _WDT_ER | F0030 | Scan watchdog | |
| F0031 | Light error | | F0031 | | |
| F0032 | WDT error | | F0032 | | |
| F0033 | I/O combination error | | F0033 | | |
| F0034 | Battery voltage error | | F0034 | | |
| F0035 | Fuse error | | F0035 | | |
| F0036 ~ F0038 | N/A | | F0036 ~ F0038 | | |
| F0039 | Backup normal | | F0039 | | |
| F003A | Clock data error | | F003A | | |
| F003B | Program change | | F003B | | |
| F003C | Program change error | | F003C | | |
| F003D ~ F003F | N/A | - | F003D ~ F003F | N/A | |
| | | _RTC_ER | F0040 | RTC data error | |
| | | _DBCK_ER | F0041 | Data backup error | |
| | | _HBCK_ER | F0042 | Hot restart disabled error | |
| | | _ABSD_ER | F0043 | Abnormal operation stop | |
| | | _TASK_ER | F0044 | Task collision | |
| | | _BAT_ER | F0045 | Battery error | |
| | | _ANNUM_ER | F0046 | Light error detection of external equipment | |

| MAS | STER-K | XGK | | | |
|---------------|-------------------|--------------|---------------|------------------------------------|--|
| Device | Function | Symbol | Device | Function | |
| | | _LOG_FULL | F0047 | Log memory full warning | |
| | | _HS_WAR1 | F0048 | High speed link parameter 1 error | |
| | | _HS_WAR2 | F0049 | High speed link parameter 2 error | |
| | | _HS_WAR3 | F0049 | High speed link parameter 3 error | |
| | | _HS_WAR4 | F0049 | High speed link parameter 4 error | |
| | | _HS_WAR5 | F0049 | High speed link parameter 5 error | |
| | | _HS_WAR6 | F0049 | High speed link parameter 6 error | |
| | | _HS_WAR7 | F0049 | High speed link parameter 7 error | |
| | | _HS_WAR8 | F0049 | High speed link parameter 8 error | |
| | | _HS_WAR9 | F0050 | High speed link parameter 9 error | |
| | | _HS_WAR10 | F0051 | High speed link parameter 10 error | |
| | | _HS_WAR11 | F0052 | High speed link parameter 11 error | |
| | | _HS_WAR12 | F0053 | High speed link parameter 12 error | |
| | | _P2P_WAR1 | F0054 | P2P parameter 1 error | |
| | | _P2P_WAR2 | F0055 | P2P parameter 2 error | |
| | | _P2P_WAR3 | F0056 | P2P parameter 3 error | |
| | | _P2P_WAR4 | F0057 | P2P parameter 4 error | |
| | | _P2P_WAR5 | F0058 | P2P parameter 5 error | |
| F0040 ~ F005F | N/A | _P2P_WAR6 | F0059 | P2P parameter 6 error | |
| F0040 ~ F005F | N/A | _P2P_WAR7 | F005A | P2P parameter 7 error | |
| F0040 ~ F005F | N/A | _P2P_WAR8 | F005B | P2P parameter 8 error | |
| F0040 ~ F005F | N/A | _Constant_ER | F005C | Constant error | |
| F0040 ~ F005F | N/A | - | F005D ~ F005F | N/A | |
| F0060 ~ F006F | Error Code save | - | F0060 ~ F006F | N/A | |
| F0070 ~ F008F | Fuse cutoff save | - | F0070 ~ F008F | N/A | |
| F0090 | 20ms cycle Clock | _T20MS | F0090 | 20ms cycle Clock | |
| F0091 | 100ms cycle Clock | _T100MS | F0091 | 100ms cycle Clock | |
| F0092 | 200ms cycle Clock | _T200MS | F0092 | 200ms cycle Clock | |
| F0093 | 1s cycle Clock | _T1S | F0093 | 1s cycle Clock | |
| F0094 | 2s cycle Clock | _T2S | F0094 | 2s cycle Clock | |
| F0095 | 10s cycle Clock | _T10S | F0095 | 10s cycle Clock | |
| F0096 | 20s cycle Clock | _T20S | F0096 | 20s cycle Clock | |
| F0097 | 60s cycle Clock | _T60S | F0097 | 60s cycle Clock | |
| | | - | F0098 | N/A | |
| | | _ON | F0099 | Ordinary time On | |
| | | _OFF | F009A | Ordinary time Off | |

| MA | ASTER-K | XGK | | | |
|-----------------|------------------------------|-----------------|---------------|-----------------------------|--|
| Device Function | | Symbol | Device | Function | |
| | | _10N | F009B | 1 Scan On | |
| | | _1OFF | F009C | 1 Scan Off | |
| | | _STOG | F009D | Reversal every Scan | |
| F0098 ~ F009F | | - | F009B ~ F009F | N/A | |
| F0100 | User Clock 0 | | F0100 | User Clock 0 | |
| F0101 | User Clock 1 | | F0101 | User Clock 1 | |
| F0102 | User Clock 2 | | F0102 | User Clock 2 | |
| F0103 | User Clock 3 | | F0103 | User Clock 3 | |
| F0104 | User Clock 4 | | F0104 | User Clock 4 | |
| F0105 | User Clock 5 | | F0105 | User Clock 5 | |
| F0106 | User Clock 6 | | F0106 | User Clock 6 | |
| F0107 | User Clock 7 | | F0107 | User Clock 7 | |
| F0108 ~ F010F | | - | F0108 ~ F010F | N/A | |
| F0110 | Operation error flag | _Ler | F0110 | Operation error flag | |
| F0111 | Zero flag | _Zero | F0111 | Zero flag | |
| F0112 | Carry flag | _Carry | F0112 | Carry flag | |
| F0113 | Full output Off | _AII_Off | F0113 | Full output Off | |
| F0114 | Common RAM R/W error | - | F0114 | N/A | |
| F0115 | Operation error flag (latch) | _Ler_Latch | F0115 | Operation error flag(latch) | |
| F0116 ~ F011F | | - | F0116 ~ F011F | N/A | |
| F0120 | LT flag | _LT | F0120 | LT flag | |
| F0121 | LTE flag | _LTE | F0121 | LTE flag | |
| F0122 | EQU flag | _EQU | F0122 | EQU flag | |
| F0123 | GT flag | _GT | F0123 | GT flag | |
| F0124 | GTE flag | _GTE | F0124 | GTE flag | |
| F0125 | NEQ flag | _NEQ | F0125 | NEQ flag | |
| F0126 ~ F012F | N/A | - | F0126 ~ F012F | N/A | |
| F0130~ F013F | AC Down Count | _AC_F_CNT | F0130~ F013F | AC Down Count | |
| F0140~ F014F | FALS no. | _FALS_NUM | F0140~ F014F | FALS no. | |
| F0150~ F015F | PUT/GET error flag | _PUTGET_ERR | F0150~ F030F | PUT/GET error flag | |
| | | CPU TYPE | F0440 ~ F044F | CPU TYPE | |
| | | CPU VERSION | F0450 ~ F045F | CPU VERSION | |
| | | O/S version no. | F0460 ~ F047F | System O/S version no. | |
| F0160~ F049F | N/A | O/S date | F0480 ~ F049F | System O/S DATE | |

| MA | ASTER-K | XGK | | | |
|-----------------------------|---------------------------------|-----------------|---------------|------------------------------------|--|
| Device | Function | Symbol | Device | Function | |
| F0500~ F050F | Max. Scan time | _SCAN_MAX | F0500~ F050F | Max. Scan time | |
| F0510~ F051F Min. Scan time | | _SCAN_MIN | F0510~ F051F | Min. Scan time | |
| F0520~ F052F | Current Scan time | _SCAN_CUR | F0520~ F052F | Current Scan time | |
| F0530~ F053F | Clock data (year/month) | _YEAR_MON | F0530~ F053F | Clock data (year/month) | |
| F0540~ F054F | Clock data (day/hr) | _DAY_TIME | F0540~ F054F | Clock data(day/hr) | |
| F0550~ F055F | Clock data (min/sec) | _MIN_SEC | F0550~ F055F | Clock data(min/sec) | |
| F0560~ F056F | Clock data (100year/weekday) | _HUND_WK | F0560~ F056F | Clock data(100year/weekday) | |
| | | _FPU_LFlag_I | F0570 | Incorrect error latch flag | |
| | | _FPU_LFlag_U | F0571 | Underflow error latch flag | |
| | | _FPU_LFlag_O | F0572 | Overflow error latch flag | |
| | | _FPU_LFlag_Z | F0573 | Zero divide error latch flag | |
| | | _FPU_LFlag_V | F0574 | Invalid operation error latch flag | |
| | | • | F0575 ~ F0579 | N/A | |
| | | _FPU_Flag_I | F057A | Incorrect error flag | |
| | | _FPU_Flag_U | F057B | Underflow error flag | |
| | | _FPU_Flag_O | F057C | Overflow error flag | |
| | | _FPU_Flag_Z | F057D | Zero divide error flag | |
| | | _FPU_Flag_V | F057E | Invalid operation error flag | |
| | | _FPU_Flag_E | F057F | Irregular value Input error flag | |
| F0570~ F058F | N/A | _ERR_STEP | F0580~ F058F | Error step save | |
| F0590~ F059F | Error step save | - | F0590~ F059F | N/A | |
| F0600~ F060F | FMM detailed error information | _REF_COUNT | F060~F061 | Refresh Count | |
| F0610~ F063F | N/A | _REF_OK_CNT | F062~F063 | Refresh OK Count | |
| | | _REF_NG_CNT | F064~F065 | Refresh NG Count | |
| | | _REF_LIM_CNT | F066~F067 | Refresh Limit Count | |
| | | _REF_ERR_CNT | F068~F069 | Refresh Error Count | |
| | | _MOD_RD_ERR_CNT | F070~F071 | MODULE Read Error Count | |
| | | _MOD_WR_ERR_CNT | F072~F073 | MODULE Write Error Count | |
| | | _CA_CNT | F074~F075 | Cmd Access Count | |
| | | _CA_LIM_CNT | F076~F077 | Cmd Access Limit Count | |
| | | _CA_ERR_CNT | F078~F079 | Cmd Access Error Count | |
| | | _BUF_FULL_CNT | F080~F081 | Buffer Full Count | |

Notes

For flag over F0820 added at XGK, refer to Appendix 1.

Warranty

1. Terms of warranty

LSIS provides an 18-month warranty starting from the date of production.

2. Range of warranty

For problems within the terms of the warranty, LSIS will replace the entire PLC or repair the defective parts free of charge except for the following cases.

- (1) Problems caused by improper conditions, environment or treatment.
- (2) Problems caused by external devices.
- (3) Problems caused by the user remodeling or repairing the PLC.
- (4) Problems caused by improper use of the product.
- (5) Problems caused by circumstances where the expectations exceed that of the science and technology level when LSIS produced the product.
- (6) Problems caused by natural disaster.
- 3. This warranty is limited to the PLC itself only. It is not valid for the whole system which the PLC is attached to.



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Always at your service, standing for our customers.

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